

## EMI Suppression Filters (for DC)/ Chip Inductors for Automotive



#### Explanation of category in this catalog

#### Infotainment

The product for entertainment equipment like car navigations, car audios, and body control equipment like wipers, power windows.

### **Powertrain, Safety**

The product for high reliability applications like powertrain and safety, in addition to infotainment applications.

#### Explanation of symbols in this catalog



#### All Products



AEC-Q200 compliant product\*



Reflow soldering applicable



Flow soldering applicable

#### EMI Suppression Filters (for DC)



Meets large current lines



Meets high frequency noise up to 1-2GHz



Meets ultra high frequency noise up to 10GHz

#### **Chip Inductors**



Max height xxmm



Low DC resistance type



Bias current characteristics improved



E12 step inductance variation



E24 step inductance variation



Hi Q type



Tight inductance tolerance available

#### **EU RoHS Compliant**

- · All the products in this catalog comply with EU RoHS.
- •EU RoHS is "the European Directive 2011/65/EU on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment.'
- $\cdot$  For more details, please refer to our website 'Murata's Approach for EU RoHS' (http://www.murata.com/info/rohs.html).



<sup>\*</sup> Deviation may be submitted. Please contact us for details.

## Contents

Product specifications are as of July 2014.

Application Examples	2
M EMI Suppression Filters (for DC)	
Contents	7
EMI Suppression Filters (for DC) Product Guide ·······	8
●BL□ Chip Ferrite Bead ······	10
NF□ Chip EMIFIL®	82
$\bullet DL\Box/PL\Box$ Chip Common Mode Choke Coil	102
●BNX Block Type EMIFIL® ·····	125
$\bullet$ DS/VF/BNX EMI Suppression Filters (Lead Type) $\cdot\cdot$	131
●DX□ Microchip Transformer (Balun) ······	144
Chip Inductors	
Contents	151
Contents  Classification and Structure of Chip Inductors	151 152
Classification and Structure of Chip Inductors	152
Classification and Structure of Chip Inductors  Chip Inductors Product Guide	152 154
Classification and Structure of Chip Inductors  Chip Inductors Product Guide	152 154 156
Classification and Structure of Chip Inductors  Chip Inductors Product Guide  Inductors for Power Lines  Inductors for General Circuits	152 154 156 197
Classification and Structure of Chip Inductors  Chip Inductors Product Guide  Inductors for Power Lines  Inductors for General Circuits  RF Inductors	152 154 156 197 207

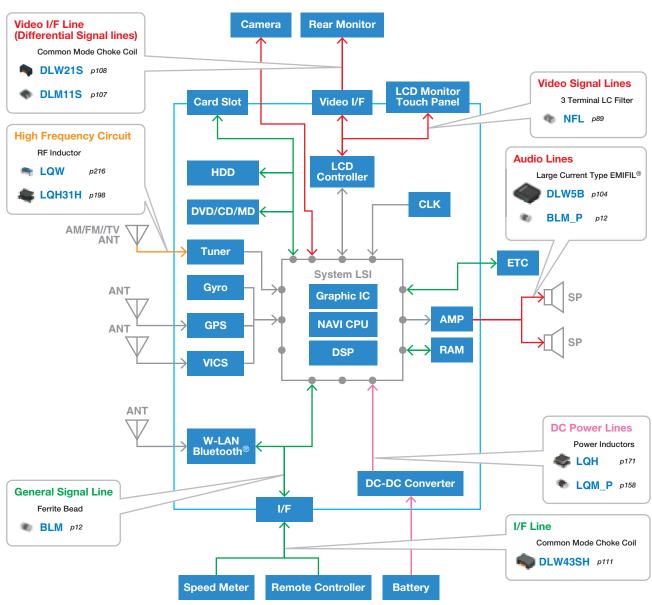






## Car Navigation System



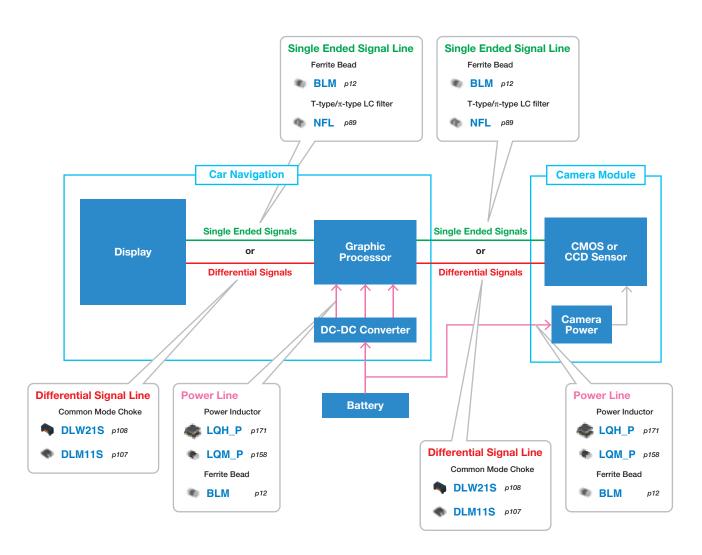






## Car Camera System

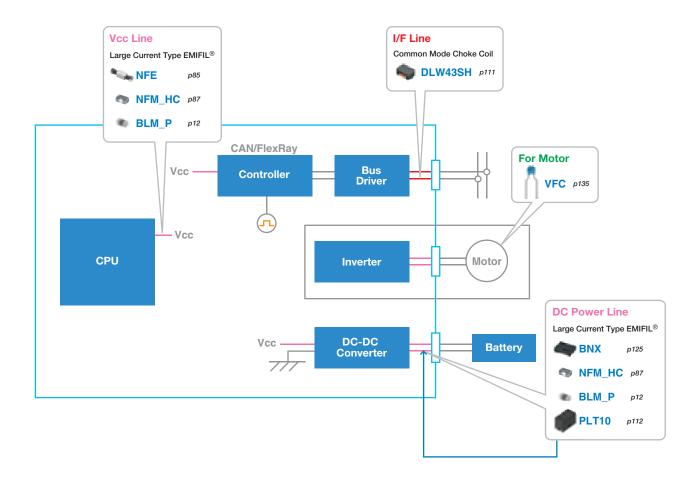






## Electronic Control Unit



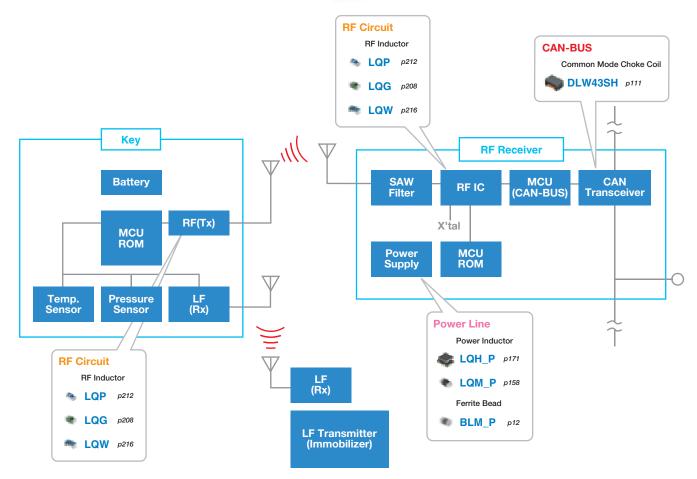






## Smart Keyless Entry





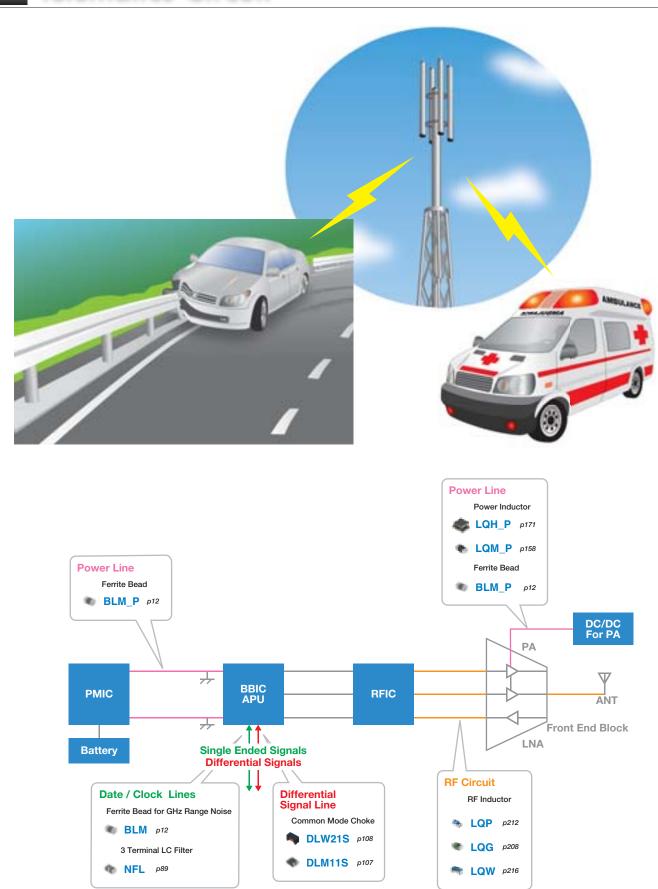
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## Telematics Circuit







Product Guide	8
●BL□ Chip Ferrite Bead	
Part Numbering ·····	10
Product Detail ·····	12
	76
Soldering and Mounting	77
Packaging ·····	81
NF□ Chip EMIFIL®	
Part Numbering ·····	82
Product Detail ······	85
①Caution/Notice	94
Soldering and Mounting	96
Packaging ·····	
	101
$\bullet$ DL $\Box$ /PL $\Box$ Chip Common Mode Choke Co	
Part Numbering ·····	
Product Detail ·····	_
Soldering and Mounting	
Packaging ·····	123
BNX Block Type EMIFIL®	
Product Detail	105
©Caution/Notice	
Soldering and Mounting	
Packaging	
Раскадінд	130
•DS/VF/BNX EMI Suppression Filters (Lead Ty	pe)
Part Numbering ·····	
Product Detail ·····	133
	138
Soldering and Mounting	140
Packaging ·····	143
■DX□ Microchip Transformer (Balun)	
Part Numbering ·····	144
Product Detail ·····	
Soldering and Mounting	
Packaging ·····	

## EMI Suppression Filters (for DC) Product Guide

JL	Inductor Type Series			Size Code in inch (in mm)	Impedance (Ω) at 100MHz  Effective Frequency Range (Applicable Frequency Ranges are only for reference 10kHz 100kHz 10MHz 10MHz 10HHz 10GHz
	[ Power Lines /		BLM03AX P15	0201 (0603)	10 80 120 240 600 1000
			BLM15AX	0402 (1005)	10 30 70 120 220 600 1000
			BLM03AG	0201 (0603)	80 10 70 120 240 600 1000
		For General	BLM15AG	0402 (1005)	
		Signal Lines	BLM18AG	0603 (1608)	220 470 120150 330 600 1000
5	Signal Lines		BLM21AG	0805 (2012)	220 470
	Туре		BLM03B	0201 (0603)	33 56 80 600 10 22 47 75 120 240 470
o l		For	BLM15B	0402 (1005)	47 240 600 1800 5 10 22 33 75 120 220 470 1000
Noise		High Speed Signal Lines	BLM18B	0603 (1608)	75 140 220 420 600 1500 2200 5 10 22 47 60 120150 330 470 1000 1800 2500
For General Band Noise			BLM21B	0805 (2012)	75 200 330 470 750 1500 2200 2700 5 60 120150 220 420 600 1000 1800 2250
al B			BLM03PX* P13	0201 (0603)	33 (1.5A) 22 (1.8A) 80 (1A)
ener			BLM03PG	0201 (0603)	33 (0.75A) 22 (0.9A)
or G			BLM15PX* P21	0402 (1005)	60 (Z.SA) 120 (ZA) 220 (1.4A) 470 (1A)
۳			BLM15PG/PD*	0402 (1005)	10 (1A) 60 (1.7A) 120 (1.3A)
			BLM18PG*	0603 (1608)	30 (1A) 60 (0.3A) 180 (1.3A) 330 (1.2A)
	Power Lines Type		BLM21PG* p49	0805 (2012)	30 (4A) 220 (2A) 22 (6A) 60 (3.5A)120 (3A) 330 (1.5A)
			BLM31PG*	1206 (3216)	50 (3.5A) 390 (2A) 33 (6A) 120 (3.5A) 600 (1.5A)
			BLM41PG*	1806 (4516)	60 (6A) 160 (3.5A) 1000 (1.5A)
			BLM18KG* p37 (Low DC Resistance Type)	0603 (1608)	26 (6A) 100 (3A) 120 (3A) 330 (1.7A) 600 (1.3A)
			BLM18SG* p39 (Low DC Resistance Type)	0603 (1608)	70 (4A) 220 (2.5A) 26 (6A) 120 (3A) 330 (1.5A)
			BLE32PN	1210 (3225)	30
			BLM03EB*	0201 (0603)	25 (0.6A) 50 (0.4A)
		sal Type r Lines /	BLM15EG*	0402 (1005)	120 (1.5A)
	-	Lines ]	BLM18EG*	0603 (1608)	120 (2A) 330 (0.5A) 470 (0.5A) 100 (2A) 220 (2A/1A) 390 (0.5A) 600 (0.5A)
L			BLM18HE*	0603 (1608)	600 (U.SA) 1500 (U.SA)
oise			BLM03HG	0201 (0603)	600 1200
Band Noise			BLM03HD	0201 (0603)	330 470 1000
z Ba			BLM03HB	0201 (0603)	190
r GHz			BLM15HG	0402 (1005)	600 1000
P <sub>O</sub>	Signal Li	nes Type	BLM15HD	0402 (1005)	600 1000 1800
			BLM15HB	0402 (1005)	
			BLM18HG	0603 (1608)	470 1000
			BLM18HD	0603 (1608)	600 470 1000
			BLM18HB	0603 (1608)	120 220 330
oise			BLM15GG	0402 (1005)	220 470
Band Noise	Signal Li	nes Type	BLM15GA	0402 (1005)	75
Ba			BLM18GG	0603 (1608)	470

<sup>\*</sup> The derating of rated current is required for some items according to the operating temperature on each product page.

NF			
Capacitor Type	Series	Size Code in inch (in mm)	Capacitance (F)  Capacitance (F)  Selfective Frequency Range (Applicable Frequency Ranges are only for reference.)  10p 100p 1000p 10000p 0.1µ 1µ 10µ 10kHz
Universal Type	NFM21HC	0805 (2012)	22 47 100 220 1000 22000 0.22 0.22
[ Power Lines / Signal Lines ]	NFM31HK* P88	1206 (3216)	15000 0.1 10000 22000

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LC Combined Type	Series	Size Code in inch (in mm)	Cut-off Frequency (MHz)  Cut-off Frequency (MHz)  Effective Frequency Range (Applicable Frequency Ranges are only for reference.)  10 100 500 10kHz 10kHz 10kHz 10kHz 100kHz 16Hz 10kHz
Signal Lines Type	NFL18ZT	0603 (1608)	50 70 100 200 300 500
LC Combined Type	Series	Size Code in inch (in mm)	Capacitance (pF)  Capacitance (pF)  Effective Frequency Range (Applicable Frequency Ranges are only for reference.)  10 100 1000 10000 10000 1000Hz 10HHz 10MHz 100MHz 1GHz 10GHz
Universal Type	NFE31ZT	1206 (3216)	22 47 100 220 2200
[ Power Lines / Signal Lines ]	NFE61HT	2706 (6816)	100 360 1000 33 68 180 680 3300
Inductor Type	Series	Size Code in inch (in mm)	Impedance (Ω) at 1MHz         Effective Frequency Range (Applicable Frequency Ranges are only for reference.)           1         10         100         1000         10kHz 100kHz 1MHz 10MHz 100MHz 1GHz 10GHz
Universal Type [ Power Lines / Signal Lines ]	NFZ32BW	1210 (3225)	3.3 6.8 8.4 9.8 15 21 32 52 70 110 220 450 880 3.6 7.4 9 12 19 31 42 65 100 150 290 620

$DI \sqcap$							
Common Mod	e Choke Coils	Series	Size Code in inch (in mm)	Common M	ode Impedance (Ω)	at 100MHz 1000	Effective Frequency Range (Applicable Frequency Ranges are only for reference.) 100kHz 1MHz 10MHz 100MHz 1GHz 10GHz
		DLM11S P107	0504 (1210)	45 90	ı	Ţ.	
Signal Lines Type	For Differential Signal Lines	DLW21S P108	0805 (2012)	90 67 120 180	260 490		
		DLW31S P110	1206 (3216)			2200	
Univers	sal Type	DLW5BS*	2020 (5050)		500 600	800	
[ Power Lines	/ Signal Lines ]	DLW5AT*/DLW5BT*	2014 /2020 (5036) /(5050)	50 110 45 100 150	230 330 500 250 400	1000 1400 850 1100	
Common Mode	e Choke Coils	Series	Size Code in inch (in mm)	Common Mo	ode Inductance (µH)	at 100MHz	Effective Frequency Range (Applicable Frequency Ranges are only for reference.) 100kHz 1MHz 10MHz 100MHz 1GHz 10GHz
Signal Lines Type	For Differential Signal Lines	DLW43S P111	1812 (4532)	11	22 51	100	

PI ¬							_
Large Current Common Mode Choke Coil for Automotive Available	Series	Size Code in inch (in mm)		on Mode Impedan	ice (Ω) a	at 10MHz 1000	Effective Frequency Range (Applicable Frequency Ranges are only for reference.) 100kHz 1MHz 10MHz 10Hz 1GHz 10GHz
Power Lines Type	PLT10H*	-	45 100	400	500	900 1000	
1 Ower Emes Type	PLT5BP*	-	100	200 300	500		

## **BNX**

Block EMIFIL®		Series	Height (mm)	Rated Voltage (Vdc)	Rated Current (A)	Effective Frequency Range (Applicable Frequency Ranges are only for reference.) 10kHz 100kHz 1MHz 10MHz 10MHz 1GHz 1GHz
		BNX024H01* P125	3.5	50	15	
	SMD Type	BNX025H01* p125	3.5	25	15	
Power Lines Type		BNX026H01* p125	3.5	50	15	
21.		BNX027H01* p125	3.5	16	15	
	Lead Type	BNX012H01* p136	8.5 max.	50	15	

$DS_{\square}$							
3-Terminal Capacitor Lead Type	Series	Height (mm)	10p 100p	Capacitance (	( <b>F)</b>	100n	Effective Frequency Range (Applicable Frequency Ranges are only for reference.) 10kHz 100kHz 1MHz 10MHz 100MHz 1GHz 10GHz
Universal Type [ Power Lines / Signal Lines ]	DSS1 p133	7.5 max.		70 470 1.0 2.2 330 680 1.5 3.		100	

٦	<b>VF</b> □				
	Lead Type Capacitor with Varistor Function	Series	Height (mm)	Capacitance	Varistor Voltage
	Power Lines Type	VFC2	6.0 max.	1.0µF	27V

<sup>\*</sup> The derating of rated current is required for some items according to the operating temperature on each product page.



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# M B L Chip Ferrite Bead Part Numbering

(Part Number) 102

#### Product ID Product ID BL Chip Ferrite Beads

<b>2</b> Type	
Code	Туре
E	DC Bias Characteristics Improved Type
M	Ferrite Bead Single Type

3Dimensions (LXW)							
Code	Dimensions (L×W)	EIA					
03	0.6×0.3mm	0201					
15	1.0×0.5mm	0402					
18	1.6×0.8mm	0603					
21	2.0×1.25mm	0805					
31	3.2×1.6mm	1206					
32	3.2×2.5mm	1210					
41	4.5×1.6mm	1806					

#### 6 Impedance

Expressed by three figures. The unit is in ohm  $(\Omega)$  at 100MHz. The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

#### **6**Electrode

Expressed by a letter.

Ex.)	Code	Electrode
	S/T	Sn Plating
	Α	Au Plating
	W	Ag/Pd

#### Category

Code	Category			
Z	For Automotive	Infotainment		
Н	For Automotive	Powertrain, Safety		

#### Number of Circuits

Code	Number of Circuits
1	1 Circuit

#### **4**Characteristics/Applications

Code *1	Characteristics/Applications	Series		
AG	For General Use	BLM03/15/18/21		
AX	For General Ose	BLM03/15		
ВА		BLM15/18		
ВВ		BLM03/15/18/21		
ВС	For High-speed Signal Lines	BLM03/15		
BD		BLM03/15/18/21		
вх		BLM15		
PD		BLM15		
PG	For Power Lines	BLM03/15/18/21/31/41		
PN	1 of 1 ower Lines	BLE32		
PX		BLM03/15		
KG	For Power Lines (Low DC Resistance Type)	BLM18		
SG	Tof Fower Lines (Low Do Hesistance Type)	DLIVITO		
HG	For GHz Band General Use	BLM03/15/18		
EB	For GHz Band High-speed Signal Lines (Low Direct Current Type)	BLM03		
EG	For GHz Band General Use (Low DC Resistance Type)	BLM15/18		
НВ		BLM03/15/18		
HD	For GHz Band High-speed Signal Lines	BLM03/15/18		
HE		BLM18		
GA	For High-GHz Band High-speed Signal Lines	BLM15		
GG	For High-GHz Band General Use	BLM15/18		

<sup>\*1</sup> Frequency characteristics vary with each code.

Continued on the following page.



#### Packaging

Code	Packaging	Series	
K	Embossed Taping (ø330mm Reel)	BLE, BLM21* <sup>1</sup> /31/41	
L	Embossed Taping (ø180mm Reel)	DLE, DLW21 /31/41	
В	Bulk	All Series	
J	Paper Taping (ø330mm Reel)	BLM03/15/18/21 *2	
D	Paper Taping (ø180mm Reel)	DLIVIU3/13/10/21	

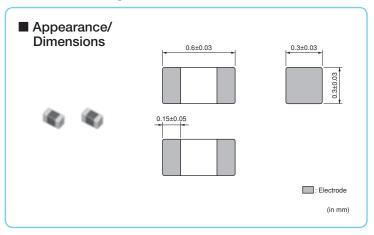
<sup>\*&</sup>lt;sup>1</sup> BLM21BD222S□1/BLM21BD272S□1 only.



<sup>\*2</sup> Except for BLM21BD222S $\square$ 1/BLM21BD272S $\square$ 1

## BLM03PG<sub>Series</sub> 0201/0603 (inch/mm)

### 0201 size for power lines.



Packaging

<u> </u>					
Code	ode Packaging				
D	ø180mm Paper Taping	15000			
J	ø330mm Paper Taping	50000			
В	Packing in Bulk	1000			





■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

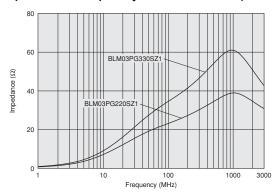
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

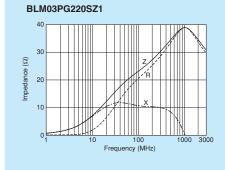
Part Number		Impedance	pedance Batad Command	DO Basistanas	Operating Temperature Range	
	For Infotainment	For Powertrain/Safety	(at 100MHz/20°C) Rated Current DC Resistance			
	BLM03PG220SZ1□	_	22Ω ±25%	900mA	0.065Ω max.	-55°C∼+125°C
	BLM03PG330SZ1□	_	33Ω ±25%	750mA	0.090 Ω max.	-55°C∼+125°C

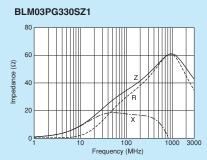
Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)



#### ■ Impedance-Frequency Characteristics



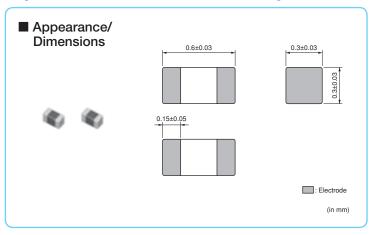




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# BLM03PX Series 0201/0603 (inch/mm)

### Improved DC resistance meets larger current.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



#### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

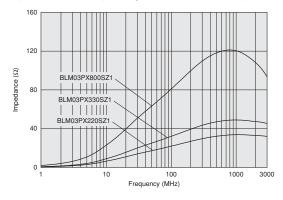
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

		onaging oodo,				
Part Number		Impedance	Rated Current	DC Resistance	Operating	
	For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nateu Current	DO Nesistance	Temperature Range
	BLM03PX220SZ1□	_	22Ω ±25%	1800mA	$0.040\Omega$ max.	-55°C∼+125°C
	BLM03PX330SZ1□	_	33Ω ±25%	1500mA	$0.055\Omega$ max.	-55°C∼+125°C
	BLM03PX800SZ1□	_	80Ω ±25%	1000mA	$0.130\Omega$ max.	-55°C∼+125°C

Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)

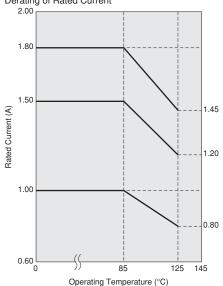


#### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM03PX S□1 series.

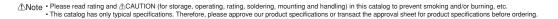
Please apply the derating curve shown in chart according to the operating temperature.





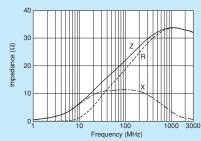
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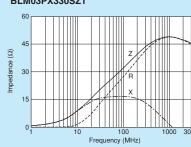




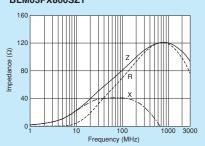
#### BLM03PX220SZ1

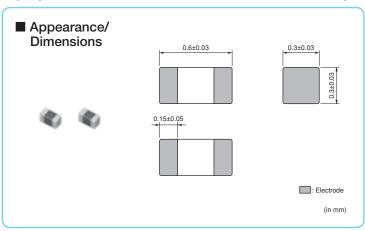


#### BLM03PX330SZ1



#### BLM03PX800SZ1





#### ■ Packaging

Code	Packaging	Minimum Quantity
D ø180mm Paper Taping		15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000





#### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

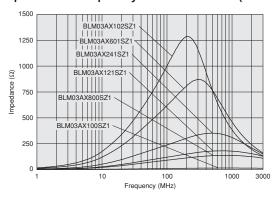
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

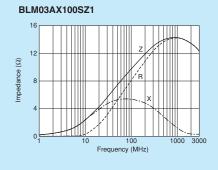
Part Number		Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nateu Current	DO Nesistance	Temperature Range
BLM03AX100SZ1□	_	10Ω (Typ.)	1000mA	$0.05\Omega$ max.	-55°C∼+125°C
BLM03AX800SZ1□	_	80Ω ±25%	500mA	0.18Ω max.	-55°C∼+125°C
BLM03AX121SZ1□	_	120Ω ±25%	450mA	$0.23\Omega$ max.	-55°C∼+125°C
BLM03AX241SZ1□	_	240Ω ±25%	350mA	0.38Ω max.	-55°C∼+125°C
BLM03AX601SZ1□	_	600Ω ±25%	250mA	$0.85\Omega$ max.	-55°C∼+125°C
BLM03AX102SZ1□	_	1000Ω ±25%	200mA	1.25Ω max.	-55°C∼+125°C

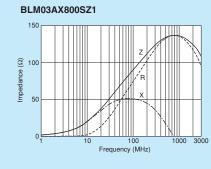
Number of Circuits: 1

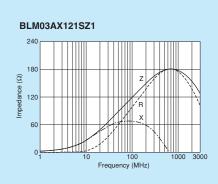
#### ■ Impedance-Frequency Characteristics (Main Items)



#### ■ Impedance-Frequency Characteristics



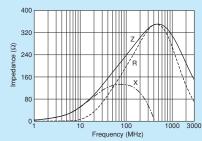




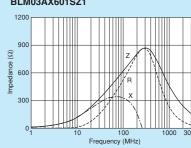
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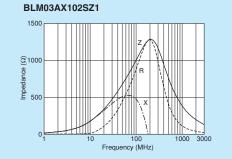
♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

#### BLM03AX241SZ1



#### BLM03AX601SZ1



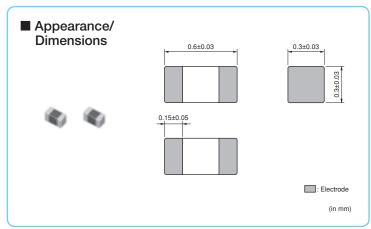




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# BLM03AG<sub>Series</sub> 0201/0603 (inch/mm)

## 0201 size for general signal lines.



#### ■ Packaging

Code Packaging		Minimum Quantity
D ø180mm Paper Tapin		15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

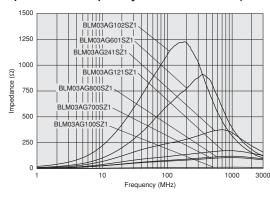
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

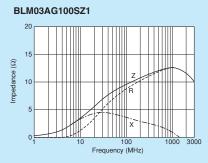
Trated Value ( packaging code)					
Part Number		Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Hated Odifert	DO Hesistance	Temperature Range
BLM03AG100SZ1□	_	10Ω (Typ.)	500mA	$0.1\Omega$ max.	-55°C∼+125°C
BLM03AG700SZ1□	_	70Ω (Typ.)	200mA	$0.4\Omega$ max.	-55°C∼+125°C
BLM03AG800SZ1□	_	80Ω ±25%	200mA	$0.4\Omega$ max.	-55°C∼+125°C
BLM03AG121SZ1□	_	120Ω ±25%	200mA	0.5Ω max.	-55°C∼+125°C
BLM03AG241SZ1□	_	240Ω ±25%	200mA	0.8Ω max.	-55°C∼+125°C
BLM03AG601SZ1□	_	600Ω ±25%	100mA	1.5Ω max.	-55°C∼+125°C
BLM03AG102SZ1□	_	1000Ω ±25%	100mA	2.5Ω max.	-55°C∼+125°C

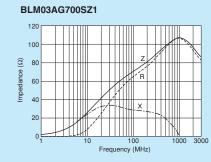
Number of Circuits: 1

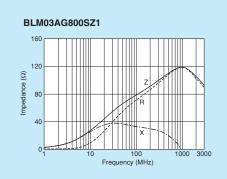
#### ■ Impedance-Frequency Characteristics (Main Items)



#### **■** Impedance-Frequency Characteristics



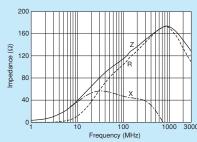




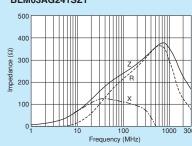
Continued on the following page.

♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

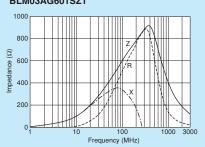
#### BLM03AG121SZ1



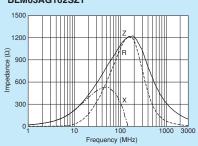
#### BLM03AG241SZ1



#### BLM03AG601SZ1



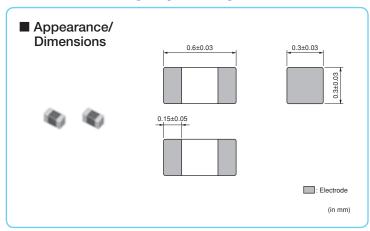
#### BLM03AG102SZ1



⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## BLM03B<sub>Series</sub> 0201/0603 (inch/mm)

### 0201 size for high speed signal lines.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

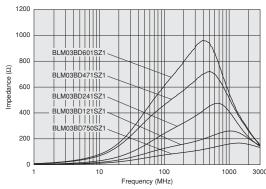
#### ■ Rated Value (□: packaging code)

■ Rated Value (⊔: packaging code)						
Part N	umber	Impedance	Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nated Current	DC nesistance	Temperature Range	
BLM03BD750SZ1□	_	75Ω ±25%	300mA	0.4Ω max.	-55°C∼+125°C	
BLM03BD121SZ1□	_	120Ω ±25%	250mA	0.5Ω max.	-55°C∼+125°C	
BLM03BD241SZ1□	_	240Ω ±25%	200mA	0.8Ω max.	-55°C∼+125°C	
BLM03BD471SZ1□	_	470Ω ±25%	215mA	1.5Ω max.	-55°C∼+125°C	
BLM03BD601SZ1□	_	600Ω ±25%	200mA	$1.7\Omega$ max.	-55°C∼+125°C	
BLM03BB100SZ1□	_	10Ω ±25%	300mA	0.4Ω max.	-55°C∼+125°C	
BLM03BB220SZ1□	_	22Ω ±25%	200mA	$0.5\Omega$ max.	-55°C∼+125°C	
BLM03BB470SZ1□	_	47Ω ±25%	200mA	0.7Ω max.	-55°C∼+125°C	
BLM03BB750SZ1□	_	75Ω ±25%	200mA	1.0Ω max.	-55°C∼+125°C	
BLM03BB121SZ1□	_	120Ω ±25%	100mA	1.5Ω max.	-55°C∼+125°C	
BLM03BC330SZ1□	_	33Ω ±25%	150mA	0.85Ω max.	-55°C∼+125°C	
BLM03BC560SZ1□	_	56Ω ±25%	100mA	1.05Ω max.	-55°C∼+125°C	
BLM03BC800SZ1□	_	80Ω ±25%	100mA	1.40Ω max.	-55°C∼+125°C	

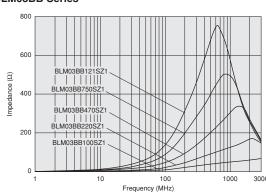
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

#### **BLM03BD Series**



#### **BLM03BB Series**



Continued on the following page.

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BLM03BD121SZ1

BLM03BD601SZ1

BLM03BB470SZ1

BLM03BC330SZ1

ĝ

200

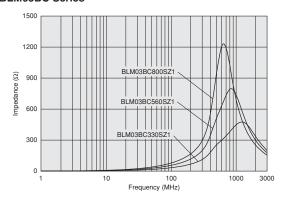
100

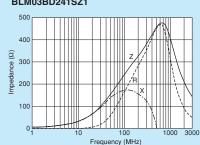
180

120

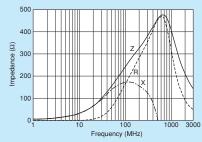
1000

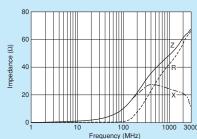
#### ■ Impedance-Frequency Characteristics (Main Items) **BLM03BC Series**

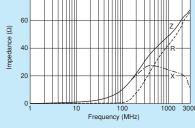




#### BLM03BD241SZ1







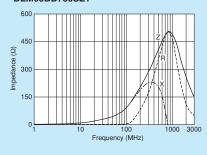
#### BLM03BB750SZ1

1000 3000

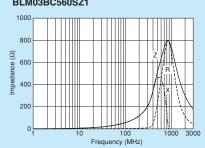
100 Frequency (MHz)

Frequency (MHz)

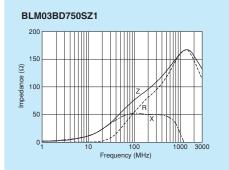
BLM03BB100SZ1



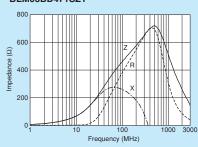
#### BLM03BC560SZ1



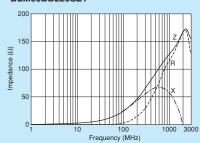
#### ■ Impedance-Frequency Characteristics



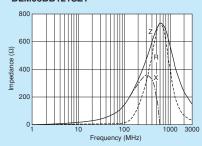
#### BLM03BD471SZ1



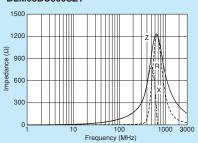
#### BLM03BB220SZ1



#### BLM03BB121SZ1



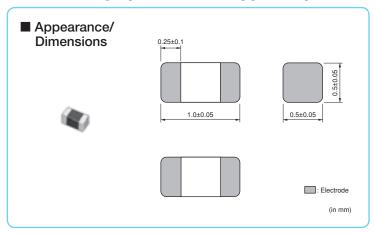
#### BLM03BC800SZ1



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## BLM15PX Series 0402/1005 (inch/mm)

## 3A max., high performance type for power lines up to 600ohm.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000







#### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

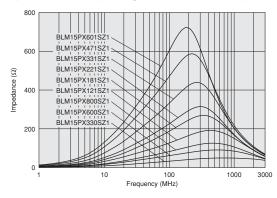
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

Part Number		Impedance	Date d O	DC Decisteres	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Rated Current	DC Resistance	Temperature Range
BLM15PX330SZ1□	_	33Ω ±25%	3000mA	0.022Ω max.	-55°C∼+125°C
BLM15PX600SZ1□	_	60Ω ±25%	2500mA	$0.032\Omega$ max.	-55°C∼+125°C
BLM15PX800SZ1□	_	80Ω ±25%	2300mA	$0.038\Omega$ max.	-55°C∼+125°C
BLM15PX121SZ1□	_	120Ω ±25%	2000mA	$0.055\Omega$ max.	-55°C∼+125°C
BLM15PX181SZ1□	_	180Ω ±25%	1500mA	$0.090\Omega$ max.	-55°C∼+125°C
BLM15PX221SZ1□	_	220Ω ±25%	1400mA	0.10Ω max.	-55°C∼+125°C
BLM15PX331SZ1□	_	330Ω ±25%	1200mA	$0.15\Omega$ max.	-55°C∼+125°C
BLM15PX471SZ1□	_	470Ω ±25%	1000mA	$0.20\Omega$ max.	-55°C∼+125°C
BLM15PX601SZ1□	_	600Ω ±25%	900mA	0.23Ω max.	-55°C∼+125°C

Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)

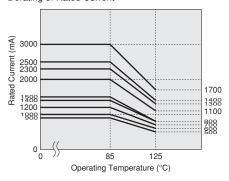


#### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM15PX series.

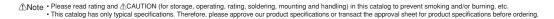
Please apply the derating curve shown in chart according to the operating temperature.

#### **Derating of Rated Current**



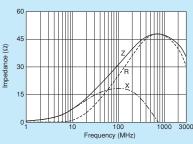
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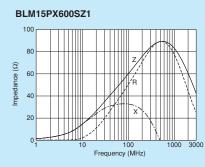


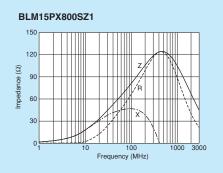


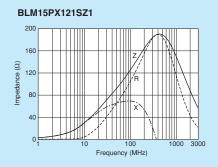


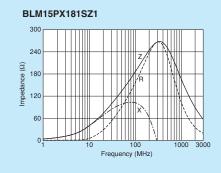
# BLM15PX330SZ1

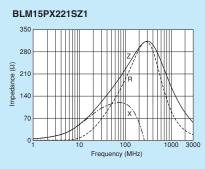


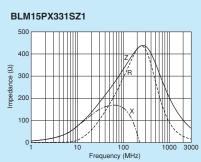


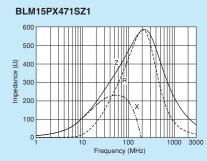


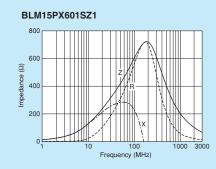










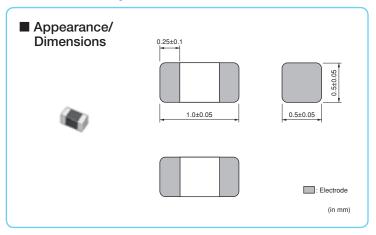




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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### 5PG/BLM15P Series 0402/1005 (inch/mm)

### 0402 size for power lines.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



#### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

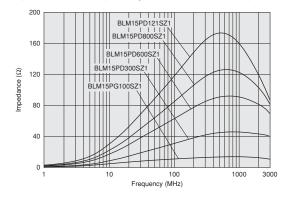
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

= rated value (=: packaging educ)					
Part N	Part Number		Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nated Odifert	Doriesistance	Temperature Range
BLM15PG100SZ1□	_	10Ω (Typ.)	1000mA	$0.025\Omega$ max.	-55°C∼+125°C
BLM15PD300SZ1□	_	30Ω ±25%	2200mA	$0.035\Omega$ max.	-55°C∼+125°C
BLM15PD600SZ1□	_	60Ω ±25%	1700mA	$0.06\Omega$ max.	-55°C∼+125°C
BLM15PD800SZ1□	_	80Ω ±25%	1500mA	0.07Ω max.	-55°C∼+125°C
BLM15PD121SZ1□	_	120Ω ±25%	1300mA	0.09Ω max.	-55°C∼+125°C

Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)

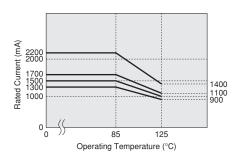


#### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM15PD series.

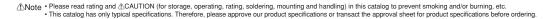
Please apply the derating curve shown in chart according to the operating temperature.

#### Derating of Rated Current



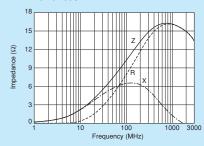
Continued on the following page.



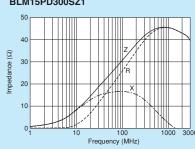




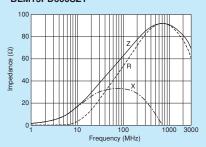
#### BLM15PG100SZ1



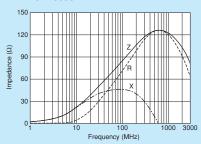
#### BLM15PD300SZ1



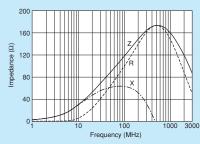
BLM15PD600SZ1



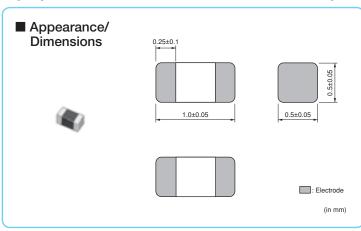
#### BLM15PD800SZ1



#### BLM15PD121SZ1







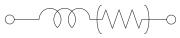
■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000





**■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

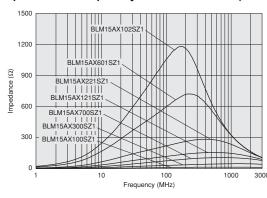
Refer to pages from p.77 to p.80 for mounting information.

■ Rated Value (□: packaging code)

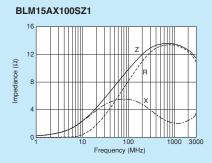
Trated value ( packaging code)					
Part Number		Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nated Odifert	Dorlesistance	Temperature Range
BLM15AX100SZ1□	1	10Ω ±5Ω	1740mA	$0.015\Omega$ max.	-55°C∼+125°C
BLM15AX300SZ1□	1	30Ω ±25%	1100mA	$0.06\Omega$ max.	-55°C∼+125°C
BLM15AX700SZ1□		70Ω ±25%	780mA	$0.1\Omega$ max.	-55°C∼+125°C
BLM15AX121SZ1□	_	120Ω ±25%	700mA	0.13Ω max.	-55°C∼+125°C
BLM15AX221SZ1□		220Ω ±25%	600mA	$0.18\Omega$ max.	-55°C∼+125°C
BLM15AX601SZ1□		600Ω ±25%	500mA	$0.34\Omega$ max.	-55°C∼+125°C
BLM15AX102SZ1□	_	1000Ω ±25%	350mA	$0.49\Omega$ max.	-55°C∼+125°C

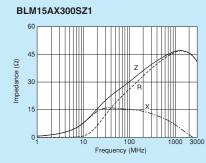
Number of Circuits: 1

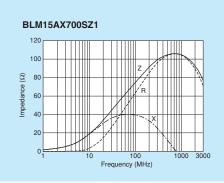
#### ■ Impedance-Frequency Characteristics (Main Items)



#### ■ Impedance-Frequency Characteristics



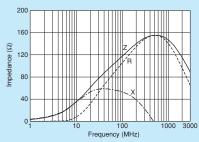




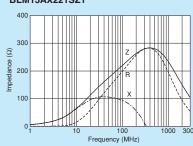
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♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

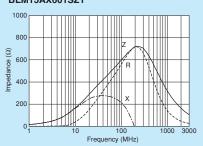
#### BLM15AX121SZ1



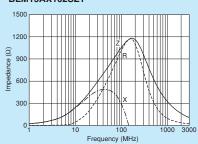
#### BLM15AX221SZ1



#### BLM15AX601SZ1



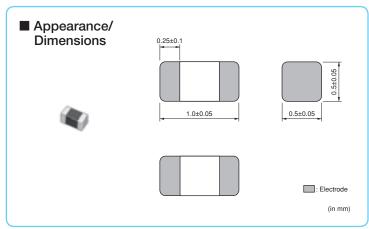
#### BLM15AX102SZ1



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# BLM15AG<sub>Series 0402/1005</sub> (inch/mm)

## 0402 size for general signal lines.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000

**■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

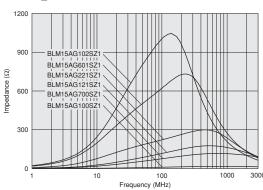
#### ■ Rated Value (□: packaging code)

Part N	umber For Powertrain/Safety	Impedance (at 100MHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range
For initialiment	For Fowertrain/Salety	(41 100141112/20 0)			remperature riange
BLM15AG100SZ1□	BLM15AG100SH1□	10Ω (Typ.)	1000mA	$0.025\Omega$ max./ $0.05\Omega$ max.	-55°C∼+125°C
BLM15AG700SZ1□	BLM15AG700SH1□	70Ω (Typ.)	600mA/500mA	0.15Ω max.	-55°C∼+125°C
BLM15AG121SZ1□	BLM15AG121SH1□	120Ω ±25%	550mA/500mA	$0.19\Omega$ max./ $0.25\Omega$ max.	-55°C∼+125°C
BLM15AG221SZ1□	BLM15AG221SH1□	220Ω ±25%	450mA/300mA	$0.29\Omega$ max./ $0.35\Omega$ max.	-55°C∼+125°C
BLM15AG601SZ1□	BLM15AG601SH1□	600Ω ±25%	300mA	$0.52\Omega$ max./ $0.6\Omega$ max.	-55°C∼+125°C
BLM15AG102SZ1□	BLM15AG102SH1□	1000Ω ±25%	300mA/200mA	$0.65\Omega$ max./ $1.0\Omega$ max.	-55°C∼+125°C

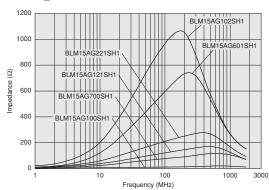
Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)

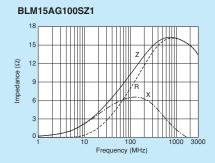
#### BLM15AG\_SZ Series



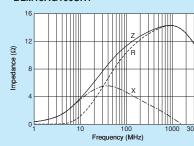
#### BLM15AG\_SH Series

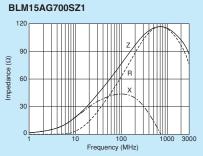


#### ■ Impedance-Frequency Characteristics



#### BLM15AG100SH1

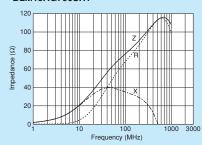




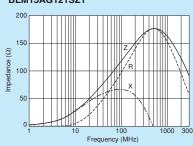
Continued on the following page.

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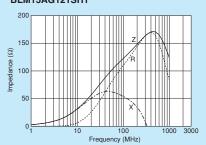
#### BLM15AG700SH1



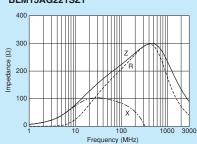
#### BLM15AG121SZ1



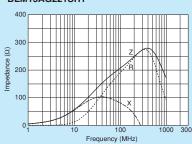
#### BLM15AG121SH1



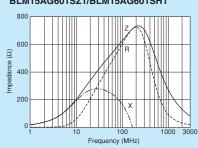
#### BLM15AG221SZ1



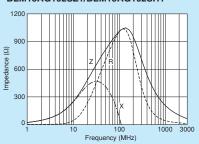
#### BLM15AG221SH1



#### BLM15AG601SZ1/BLM15AG601SH1



#### BLM15AG102SZ1/BLM15AG102SH1

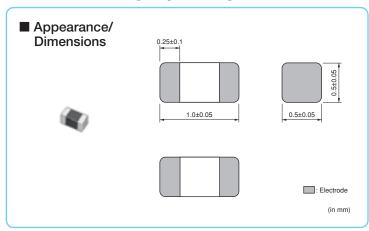




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## BLM15BX<sub>Series 0402/1005</sub> (inch/mm)

### 0402 size for high speed signal lines, low DC resistance.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



**■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

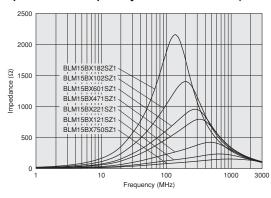
Refer to pages from p.77 to p.80 for mounting information.

#### ■ Rated Value (□: packaging code)

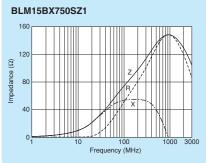
■ Natice Value (□. packaging code)								
Part Number		Impedance	Rated Current	DC Resistance	Operating			
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riated ourrent	Donesistance	Temperature Range			
BLM15BX750SZ1□	1	75Ω ±25%	600mA	$0.15\Omega$ max.	-55°C∼+125°C			
BLM15BX121SZ1□	_	120Ω ±25%	600mA	0.17Ω max.	-55°C∼+125°C			
BLM15BX221SZ1□		220Ω ±25%	450mA	$0.27\Omega$ max.	-55°C∼+125°C			
BLM15BX471SZ1□	_	470Ω ±25%	350mA	$0.41\Omega$ max.	-55°C∼+125°C			
BLM15BX601SZ1□		600Ω ±25%	350mA	$0.46\Omega$ max.	-55°C∼+125°C			
BLM15BX102SZ1□	_	1000Ω ±25%	300mA	$0.65\Omega$ max.	-55°C∼+125°C			
BLM15BX182SZ1□	_	1800Ω ±25%	250mA	0.90Ω max.	-55°C∼+125°C			

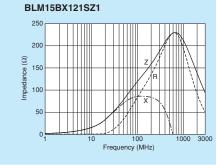
Number of Circuits: 1

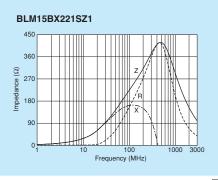
#### ■ Impedance-Frequency Characteristics (Main Items)



#### **■** Impedance-Frequency Characteristics



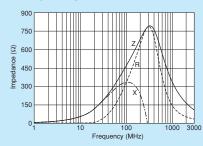




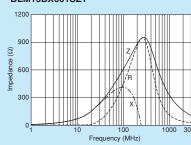
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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

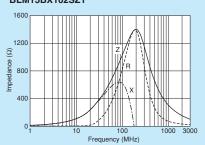
#### BLM15BX471SZ1



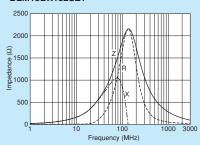
#### BLM15BX601SZ1



#### BLM15BX102SZ1



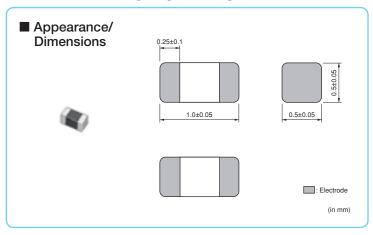
#### BLM15BX182SZ1



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## BLM 15B<sub>Series</sub> 0402/1005 (inch/mm)

## 0402 size for high speed signal lines.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000



#### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

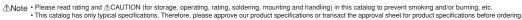
Refer to pages from p.77 to p.80 for mounting information.

■ Rated Value (□: packaging code)								
Part Number		Impedance	Rated Current	DC Resistance	Operating			
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Hateu Current	DC Nesistance	Temperature Range			
BLM15BD750SZ1□	_	75Ω ±25%	300mA	0.20 Ω max.	-55°C∼+125°C			
BLM15BD121SZ1□	_	120Ω ±25%	300mA	0.30 Ω max.	-55°C∼+125°C			
BLM15BD221SZ1□	_	220Ω ±25%	300mA	0.40 Ω max.	-55°C∼+125°C			
BLM15BD471SZ1□	BLM15BD471SH1□	470Ω ±25%	200mA	0.60 Ω max.	-55°C∼+125°C			
BLM15BD601SZ1□	BLM15BD601SH1□	600Ω ±25%	200mA	0.65Ω max.	-55°C∼+125°C			
BLM15BD102SZ1□	BLM15BD102SH1□	1000Ω ±25%	200mA	0.90 Ω max.	-55°C∼+125°C			
BLM15BD182SZ1□	BLM15BD182SH1□	1800Ω ±25%	100mA/200mA	1.40Ω max.	-55°C∼+125°C			
BLM15BB050SZ1□	BLM15BB050SH1□	5Ω ±25%	500mA	0.08Ω max.	-55°C∼+125°C			
BLM15BB100SZ1□	BLM15BB100SH1□	10Ω ±25%	300mA	0.10 Ω max.	-55°C∼+125°C			
BLM15BB220SZ1□	BLM15BB220SH1□	22Ω ±25%	300mA	0.20 Ω max.	-55°C∼+125°C			
BLM15BB470SZ1□	BLM15BB470SH1□	47Ω ±25%	300mA	0.35Ω max.	-55°C∼+125°C			
BLM15BB750SZ1□	BLM15BB750SH1□	75Ω ±25%	300mA	0.40Ω max.	-55°C∼+125°C			
BLM15BB121SZ1□	BLM15BB121SH1□	120Ω ±25%	300mA	0.55Ω max.	-55°C∼+125°C			
BLM15BB221SZ1□	BLM15BB221SH1□	220Ω ±25%	200mA	0.80Ω max.	-55°C∼+125°C			
BLM15BC121SZ1□	_	120Ω ±25%	350mA	0.45Ω max.	-55°C∼+125°C			
BLM15BC241SZ1□	_	240Ω ±25%	250mA	0.70 Ω max.	-55°C∼+125°C			
BLM15BA050SZ1□	_	5Ω ±25%	300mA	0.10Ω max.	-55°C∼+125°C			
BLM15BA100SZ1	_	10Ω ±25%	300mA	0.20Ω max.	-55°C∼+125°C			
BLM15BA220SZ1□	_	22Ω ±25%	300mA	0.30 Ω max.	-55°C∼+125°C			
BLM15BA330SZ1□	_	33Ω ±25%	300mA	0.40 Ω max.	-55°C∼+125°C			
BLM15BA470SZ1□	_	47Ω ±25%	200mA	0.60 Ω max.	-55°C∼+125°C			
BLM15BA750SZ1□	_	75Ω ±25%	200mA	0.80 Ω max.	-55°C∼+125°C			

Number of Circuits: 1

Continued on the following page.



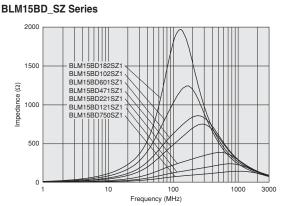




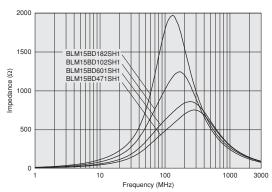


EM

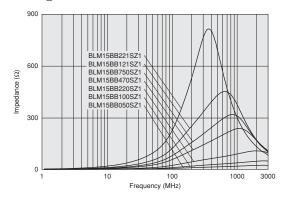
### ■ Impedance-Frequency Characteristics (Main Items)



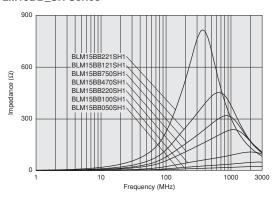
#### BLM15BD\_SH Series



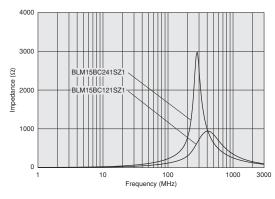
#### BLM15BB\_SZ Series



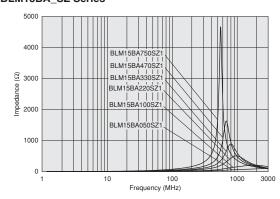
#### BLM15BB\_SH Series



#### BLM15BC\_SZ Series



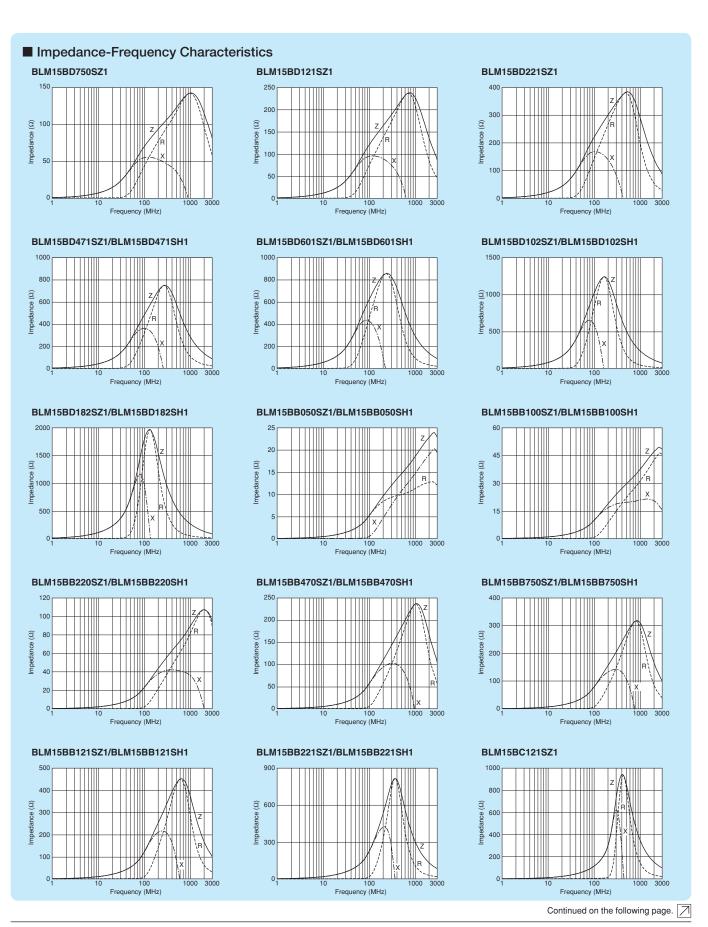
#### BLM15BA\_SZ Series

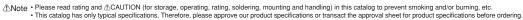


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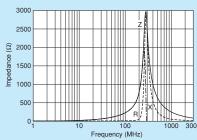




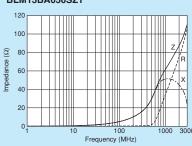




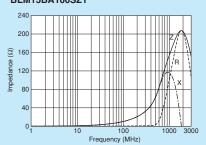




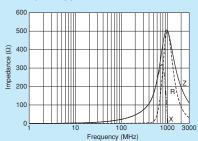
#### BLM15BA050SZ1



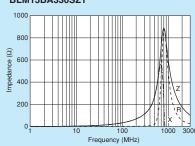
#### BLM15BA100SZ1



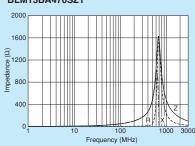
#### BLM15BA220SZ1



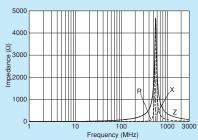
#### BLM15BA330SZ1



#### BLM15BA470SZ1



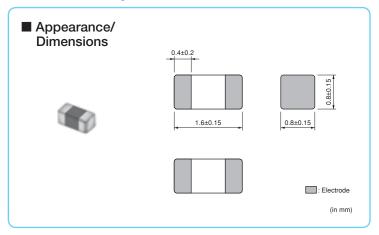
#### BLM15BA750SZ1



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# BLM 18PG Series 0603/1608 (inch/mm)

### 0603 size for power lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

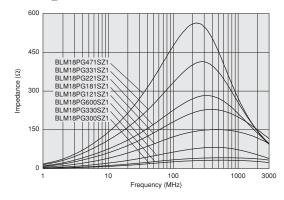
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

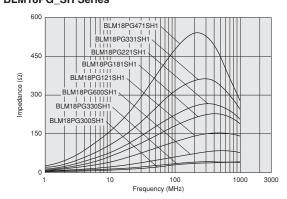
= rates value (= packaging educ)						
Part Number  For Infotainment For Powertrain/Safety		Impedance (at 100MHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range	
1 of infotaliment	Tor Towertrain/Galety	(40.1002720.0)			. oporanaro mango	
BLM18PG300SZ1□	BLM18PG300SH1□	30Ω (Typ.)	1000mA	0.05Ω max.	-55°C∼+125°C	
BLM18PG330SZ1□	BLM18PG330SH1□	33Ω ±25%	3000mA	0.025Ω max.	-55°C∼+125°C	
BLM18PG600SZ1□	BLM18PG600SH1□	60Ω (Typ.)	500mA	0.10 Ω max.	-55°C∼+125°C	
BLM18PG121SZ1□	BLM18PG121SH1□	120Ω ±25%	2000mA	0.05Ω max.	-55℃~+125℃	
BLM18PG181SZ1□	BLM18PG181SH1□	180Ω ±25%	1500mA	0.09Ω max.	-55°C∼+125°C	
BLM18PG221SZ1□	BLM18PG221SH1□	220Ω ±25%	1400mA	0.10Ω max.	-55°C∼+125°C	
BLM18PG331SZ1□	BLM18PG331SH1□	330Ω ±25%	1200mA	0.15Ω max.	-55°C∼+125°C	
BLM18PG471SZ1□	BLM18PG471SH1□	470Ω ±25%	1000mA	0.20Ω max.	-55°C∼+125°C	

Number of Circuits: 1

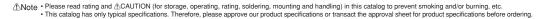
### ■ Impedance-Frequency Characteristics (Main Items) BLM18PG\_SZ Series



### BLM18PG\_SH Series







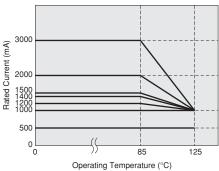


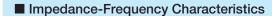
### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM18PG series.

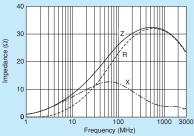
Please apply the derating curve shown in chart according to the operating temperature.

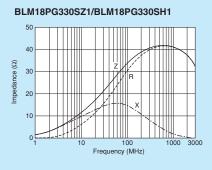
**Derating of Rated Current** 



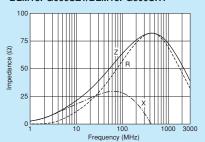


BLM18PG300SZ1/BLM18PG300SH1

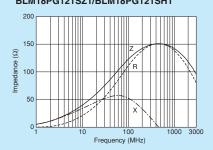




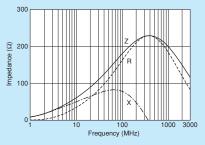
BLM18PG600SZ1/BLM18PG600SH1



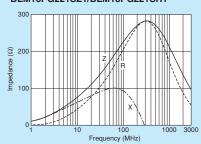
BLM18PG121SZ1/BLM18PG121SH1

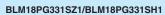


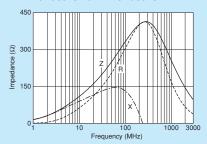
BLM18PG181SZ1/BLM18PG181SH1



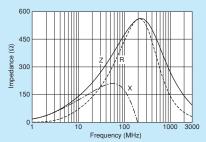
BLM18PG221SZ1/BLM18PG221SH1



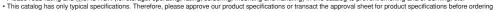




### BLM18PG471SZ1/BLM18PG471SH1

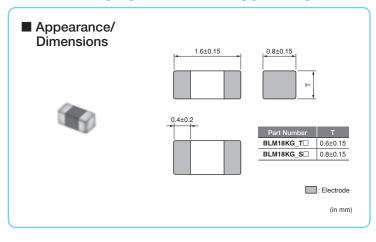


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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## BLM18KG<sub>Series 0603/1608 (inch/mm)</sub>

### 6A max., high performance type for power lines up to 600ohm.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

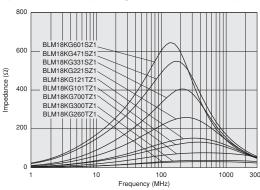
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

Part Number		Impedance	Data d Comment	DO D	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Rated Current	DC Resistance	Temperature Range
BLM18KG260TZ1□	_	26Ω ±25%	6000mA	0.007Ω max.	-55°C∼+125°C
BLM18KG300TZ1□	_	30Ω ±25%	5000mA	$0.010\Omega$ max.	-55°C∼+125°C
BLM18KG700TZ1□	_	70Ω ±25%	3500mA	$0.022\Omega$ max.	-55°C∼+125°C
BLM18KG101TZ1□	_	100Ω ±25%	3000mA	$0.030\Omega$ max.	-55°C∼+125°C
BLM18KG121TZ1□	_	120Ω ±25%	3000mA	$0.030\Omega$ max.	-55°C∼+125°C
BLM18KG221SZ1□	_	220Ω ±25%	2200mA	$0.050\Omega$ max.	-55°C∼+125°C
BLM18KG331SZ1□	_	330Ω ±25%	1700mA	$0.080\Omega$ max.	-55°C∼+125°C
BLM18KG471SZ1□	_	470Ω ±25%	1500mA	0.130 Ω max.	-55°C∼+125°C
BLM18KG601SZ1□	_	600Ω ±25%	1300mA	0.150 Ω max.	-55°C∼+125°C

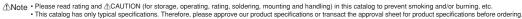
Number of Circuits: 1

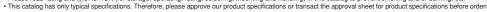
### ■ Impedance-Frequency Characteristics (Main Items)











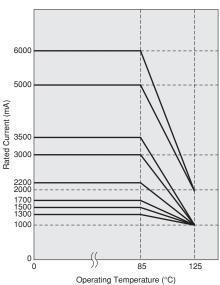


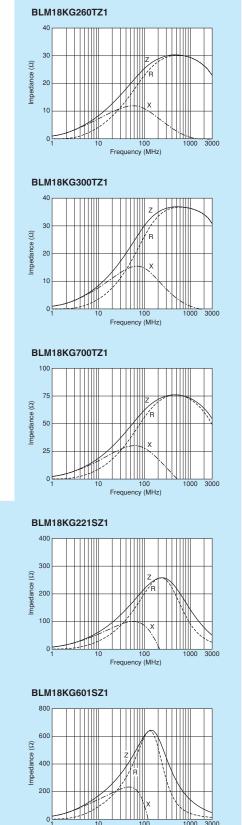
### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM18KG series.

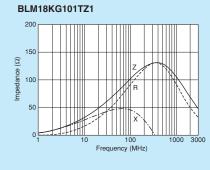
Please apply the derating curve shown in chart according to the operating temperature.

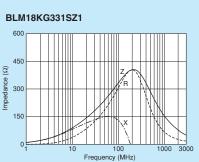
**Derating of Rated Current** 

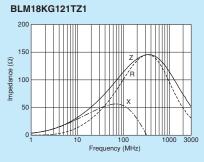


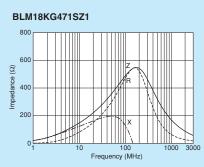


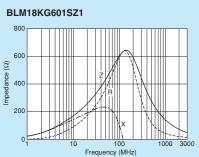
■ Impedance-Frequency Characteristics









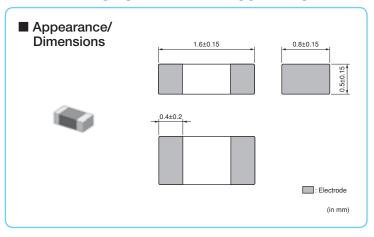


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# BLM18SG<sub>Series</sub> 0603/1608 (inch/mm)

## 6A max., high performance type for power lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	30000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

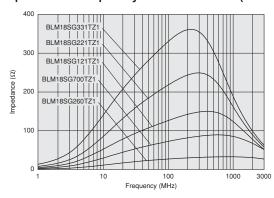
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

= : tates : tates (=:   partagg code)						
Part Number		Impedance	Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riated Odirent	Do nesistance	Temperature Range	
BLM18SG260TZ1□	_	26Ω ±25%	6000mA	$0.007\Omega$ max.	-55°C∼+125°C	
BLM18SG700TZ1□	_	70Ω ±25%	4000mA	0.020 Ω max.	-55°C∼+125°C	
BLM18SG121TZ1□	_	120Ω ±25%	3000mA	$0.025\Omega$ max.	-55°C∼+125°C	
BLM18SG221TZ1□	_	220Ω ±25%	2500mA	0.040 Ω max.	-55°C∼+125°C	
BLM18SG331TZ1□	_	330Ω ±25%	1500mA	0.070 Ω max.	-55°C∼+125°C	

Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

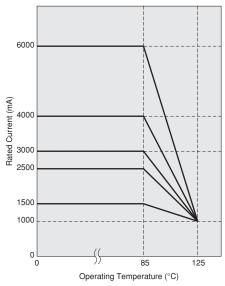


### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM18SG series.

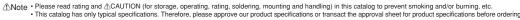
Please apply the derating curve shown in chart according to the operating temperature.

### Derating of Rated Current





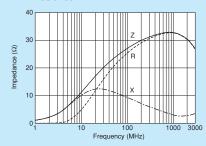




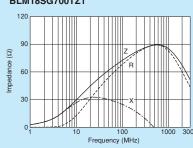


### ■ Impedance-Frequency Characteristics

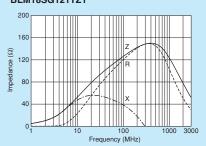
### BLM18SG260TZ1



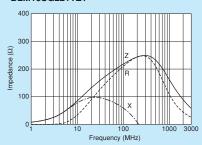
### BLM18SG700TZ1



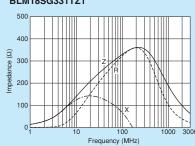
BLM18SG121TZ1



### BLM18SG221TZ1



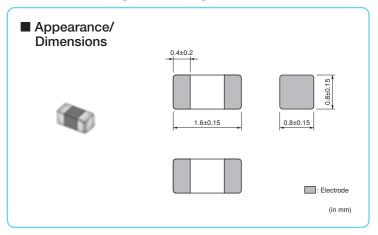
### BLM18SG331TZ1



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## BEM18AG\_Series 0603/1608 (inch/mm)

### 0603 size for general signal lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

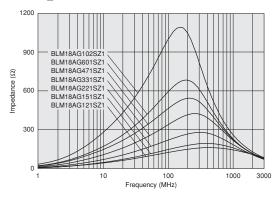
### ■ Rated Value (□: packaging code)

Trated Value (E. paskaging seas)						
Part Number		Impedance	Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Hated Ourient	DO Hesistance	Temperature Range	
BLM18AG121SZ1□	BLM18AG121SH1□	120Ω ±25%	500mA	0.18Ω max.	-55°C∼+125°C	
BLM18AG151SZ1□	BLM18AG151SH1□	150Ω ±25%	500mA	0.25Ω max.	-55°C∼+125°C	
BLM18AG221SZ1□	BLM18AG221SH1□	220Ω ±25%	500mA	$0.25\Omega$ max.	-55°C∼+125°C	
BLM18AG331SZ1□	BLM18AG331SH1□	330Ω ±25%	500mA	$0.30\Omega$ max.	-55°C∼+125°C	
BLM18AG471SZ1□	BLM18AG471SH1□	470Ω ±25%	500mA	$0.35\Omega$ max.	-55°C∼+125°C	
BLM18AG601SZ1□	BLM18AG601SH1□	600Ω ±25%	500mA	0.38Ω max.	-55°C∼+125°C	
BLM18AG102SZ1□	BLM18AG102SH1□	1000Ω ±25%	400mA	$0.50\Omega$ max.	-55°C∼+125°C	

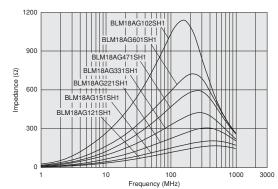
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

### BLM18AG\_SZ Series



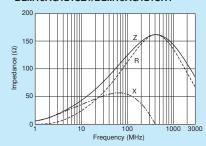
### **BLM18AG\_SH Series**



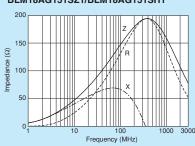


### ■ Impedance-Frequency Characteristics

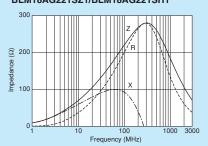
### BLM18AG121SZ1/BLM18AG121SH1



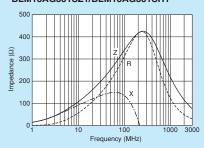
### BLM18AG151SZ1/BLM18AG151SH1



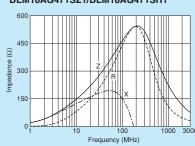
### BLM18AG221SZ1/BLM18AG221SH1



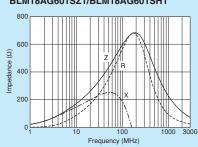
### BLM18AG331SZ1/BLM18AG331SH1



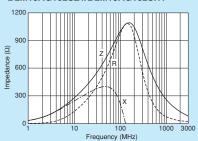
### BLM18AG471SZ1/BLM18AG471SH1



### BLM18AG601SZ1/BLM18AG601SH1



### BLM18AG102SZ1/BLM18AG102SH1

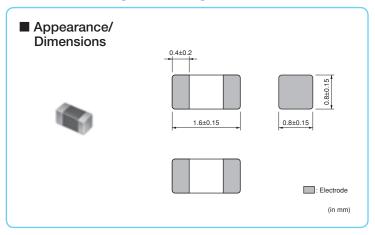




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# M18AG\_W<sub>Series</sub> 0603/1608 (inch/mm)

### 0603 size for general signal lines. for conductive glue mounting.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000







(Resistance element becomes dominant at high frequencies.)

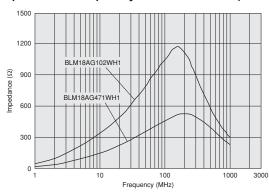
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

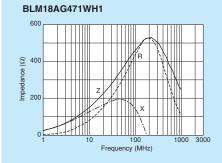
Part Number		Impedance Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nateu Current	DC nesistance	Temperature Range
_	BLM18AG471WH1□	470Ω ±25%	200mA	0.20Ω max.	-55°C∼+150°C
_	BLM18AG102WH1□	1000Ω ±25%	200mA	0.70Ω max.	-55°C∼+150°C

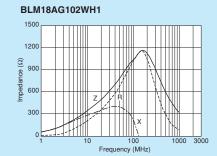
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)



### ■ Impedance-Frequency Characteristics





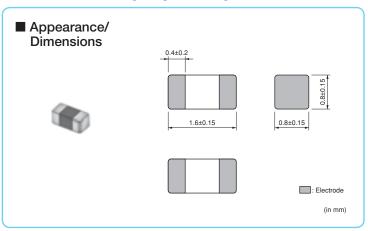


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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### **Signal Lines Type**

## BLM18B<sub>Series</sub> 0603/1608 (inch/mm)

### 0603 size for high speed signal lines.



### Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000









(Resistance element becomes dominant at high frequencies.)

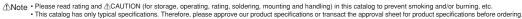
Refer to pages from p.77 to p.80 for mounting information.

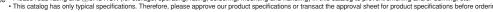
### ■ Rated Value (□: packaging code)

■ Rated Value (⊔: packaging code)					
Part N	umber	Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riatoa Garrent	Do Hoolotanoo	Temperature Range
BLM18BD470SZ1□	BLM18BD470SH1□	47Ω ±25%	500mA	$0.30\Omega$ max.	-55°C∼+125°C
BLM18BD121SZ1□	BLM18BD121SH1□	120Ω ±25%	200mA	$0.40\Omega$ max.	-55°C∼+125°C
BLM18BD151SZ1□	BLM18BD151SH1□	150Ω ±25%	200mA	$0.40\Omega$ max.	-55°C∼+125°C
BLM18BD221SZ1□	BLM18BD221SH1□	220Ω ±25%	200mA	$0.45\Omega$ max.	-55°C∼+125°C
BLM18BD331SZ1□	BLM18BD331SH1□	330Ω ±25%	200mA	$0.50\Omega$ max.	-55°C∼+125°C
BLM18BD421SZ1□	BLM18BD421SH1□	420Ω ±25%	200mA	$0.55\Omega$ max.	-55°C∼+125°C
BLM18BD471SZ1□	BLM18BD471SH1□	470Ω ±25%	200mA	$0.55\Omega$ max.	-55°C∼+125°C
BLM18BD601SZ1□	BLM18BD601SH1□	600Ω ±25%	200mA	$0.65\Omega$ max.	-55°C∼+125°C
BLM18BD102SZ1□	BLM18BD102SH1□	1000Ω ±25%	100mA	$0.85\Omega$ max.	-55°C∼+125°C
BLM18BD152SZ1□	BLM18BD152SH1□	1500Ω ±25%	50mA	1.20Ω max.	-55°C∼+125°C
BLM18BD182SZ1□	BLM18BD182SH1□	1800Ω ±25%	50mA	1.50 Ω max.	-55°C∼+125°C
BLM18BD222SZ1□	BLM18BD222SH1□	2200Ω ±25%	50mA	1.50 Ω max.	-55°C∼+125°C
BLM18BD252SZ1□	BLM18BD252SH1□	2500Ω ±25%	50mA	1.50 Ω max.	-55°C∼+125°C
BLM18BB050SZ1□	BLM18BB050SH1□	5Ω ±25%	700mA	0.05Ω max.	-55°C∼+125°C
BLM18BB100SZ1□	BLM18BB100SH1□	10Ω ±25%	700mA	$0.10\Omega$ max.	-55°C∼+125°C
BLM18BB220SZ1□	BLM18BB220SH1□	22Ω ±25%	600mA	$0.20\Omega$ max.	-55°C∼+125°C
BLM18BB470SZ1□	BLM18BB470SH1□	47Ω ±25%	550mA	$0.25\Omega$ max.	-55°C∼+125°C
BLM18BB600SZ1□	BLM18BB600SH1□	60Ω ±25%	550mA	0.25Ω max.	-55°C∼+125°C
BLM18BB750SZ1□	BLM18BB750SH1□	75Ω ±25%	500mA	$0.30\Omega$ max.	-55°C∼+125°C
BLM18BB121SZ1□	BLM18BB121SH1□	120Ω ±25%	500mA	0.30 Ω max.	-55°C∼+125°C
BLM18BB141SZ1□	BLM18BB141SH1□	140Ω ±25%	450mA	$0.35\Omega$ max.	-55°C∼+125°C
BLM18BB151SZ1□	BLM18BB151SH1□	150Ω ±25%	450mA	0.37Ω max.	-55°C∼+125°C
BLM18BB221SZ1□	BLM18BB221SH1□	220Ω ±25%	450mA	0.45Ω max.	-55°C∼+125°C
BLM18BB331SZ1□	BLM18BB331SH1□	330Ω ±25%	400mA	0.58Ω max.	-55°C∼+125°C
BLM18BB471SZ1□	BLM18BB471SH1□	470Ω ±25%	300mA	0.85Ω max.	-55°C∼+125°C
BLM18BA050SZ1□	BLM18BA050SH1□	5Ω ±25%	500mA	0.20 Ω max.	-55°C∼+125°C
BLM18BA100SZ1□	BLM18BA100SH1□	10Ω ±25%	500mA	0.25Ω max.	-55°C∼+125°C
BLM18BA220SZ1□	BLM18BA220SH1□	22Ω ±25%	500mA	0.35 Ω max.	-55°C∼+125°C
BLM18BA470SZ1□	BLM18BA470SH1□	47Ω ±25%	300mA	0.55Ω max.	-55°C∼+125°C
BLM18BA750SZ1□	BLM18BA750SH1□	75Ω ±25%	300mA	0.70Ω max.	-55°C∼+125°C
BLM18BA121SZ1□	BLM18BA121SH1□	120Ω ±25%	200mA	0.90Ω max.	-55°C∼+125°C

Number of Circuits: 1

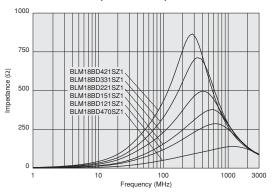




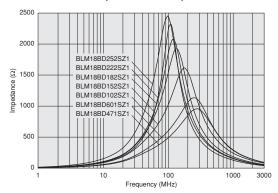




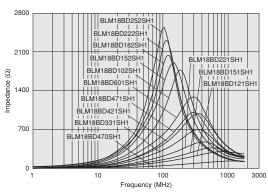
### ■ Impedance-Frequency Characteristics (Main Items) BLM18BD\_SZ Series (47 $\Omega$ ~420 $\Omega$ )



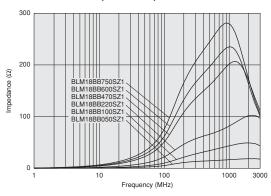
### BLM18BD\_SZ Series (470 $\Omega$ ~2500 $\Omega$ )



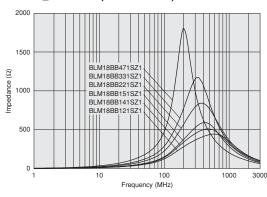
### BLM18BD\_SH Series



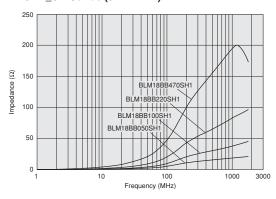
BLM18BB\_SZ Series ( $5\Omega \sim 75\Omega$ )



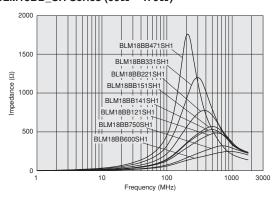
### BLM18BB\_SZ Series (120 $\Omega$ ~470 $\Omega$ )



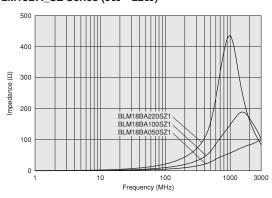
BLM18BB\_SH Series (5 $\Omega$ ~47 $\Omega$ )

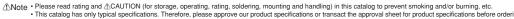


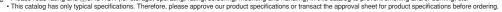
### BLM18BB\_SH Series ( $60\Omega \sim 470\Omega$ )



### BLM18BA\_SZ Series ( $5\Omega\sim$ 22 $\Omega$ )



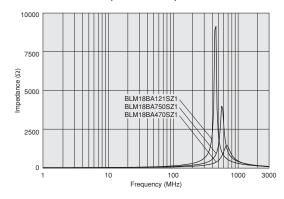




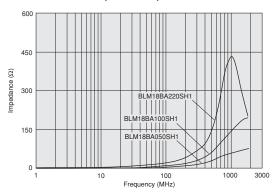


### ■ Impedance-Frequency Characteristics (Main Items)

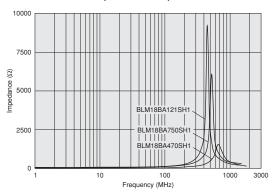




### BLM18BA\_SH Series (5 $\Omega$ ~22 $\Omega$ )

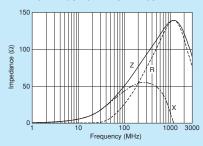


### BLM18BA\_SH Series (47 $\Omega$ $\sim$ 120 $\Omega$ )

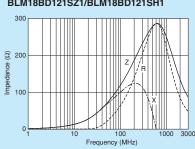


### ■ Impedance-Frequency Characteristics

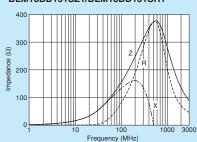
BLM18BD470SZ1/BLM18BD470SH1



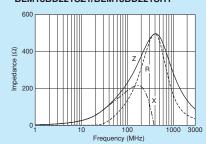
BLM18BD121SZ1/BLM18BD121SH1



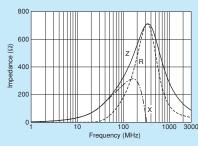
BLM18BD151SZ1/BLM18BD151SH1



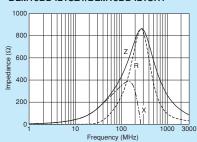




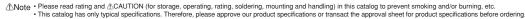
### BLM18BD331SZ1/BLM18BD331SH1



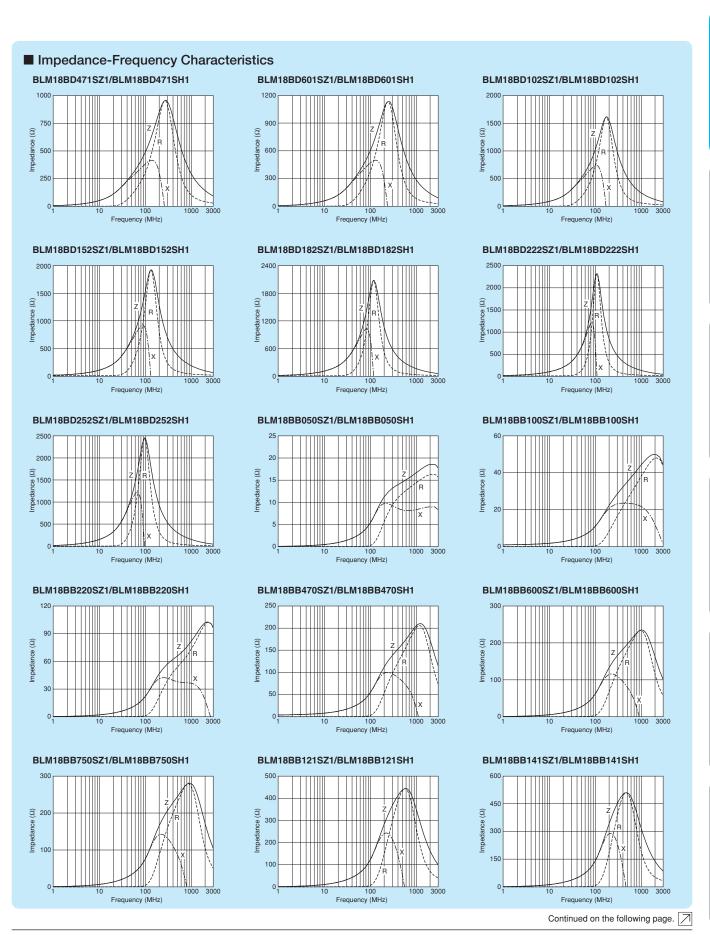
### BLM18BD421SZ1/BLM18BD421SH1









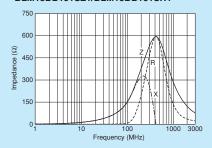




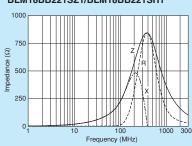


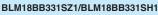
### ■ Impedance-Frequency Characteristics

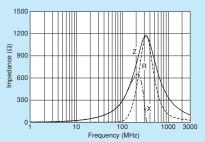
#### BLM18BB151SZ1/BLM18BB151SH1



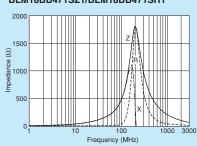




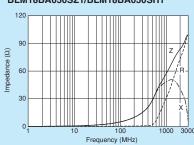




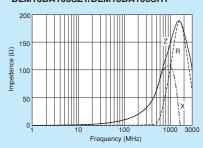
### BLM18BB471SZ1/BLM18BB471SH1



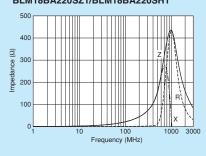
#### BLM18BA050SZ1/BLM18BA050SH1



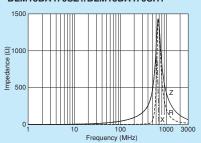
BLM18BA100SZ1/BLM18BA100SH1



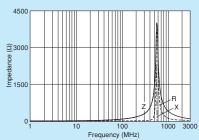
### BLM18BA220SZ1/BLM18BA220SH1



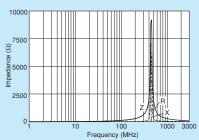
#### BLM18BA470SZ1/BLM18BA470SH1

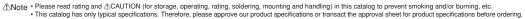


BLM18BA750SZ1/BLM18BA750SH1



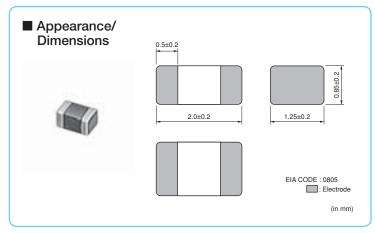
### BLM18BA121SZ1/BLM18BA121SH1





## BLM21PG<sub>Series</sub> 0805/2012 (inch/mm)

## 0805 size for power lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

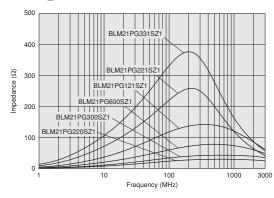
### ■ Rated Value (□: packaging code)

- that a take (= passing seas)						
Part Number		Impedance	Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riated Garrent	Do nesistance	Temperature Range	
BLM21PG220SZ1□	BLM21PG220SH1□	22Ω ±25%	6000mA	$0.009\Omega$ max.	-55°C∼+125°C	
BLM21PG300SZ1□	BLM21PG300SH1□	30Ω (Typ.)	4000mA	0.014Ω max.	-55°C∼+125°C	
BLM21PG600SZ1□	BLM21PG600SH1□	60Ω ±25%	3500mA	$0.02\Omega$ max.	-55°C∼+125°C	
BLM21PG121SZ1□	BLM21PG121SH1□	120Ω ±25%	3000mA	0.03Ω max.	-55°C∼+125°C	
BLM21PG221SZ1□	BLM21PG221SH1□	220Ω ±25%	2000mA	$0.045\Omega$ max.	-55°C∼+125°C	
BLM21PG331SZ1□	BLM21PG331SH1□	330Ω ±25%	1500mA	0.07Ω max.	-55°C∼+125°C	

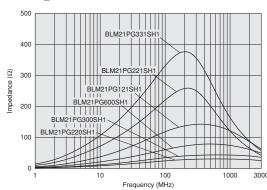
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

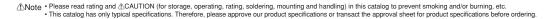
### BLM21PG\_SZ Series



### BLM21PG\_SH Series





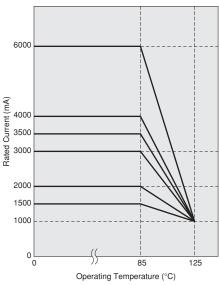


### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM21PG series.

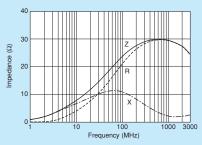
Please apply the derating curve shown in chart according to the operating temperature.

Derating of Rated Current

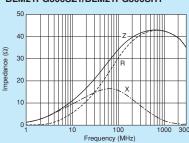


### ■ Impedance-Frequency Characteristics

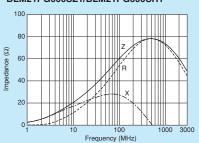




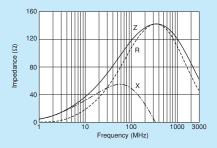
### BLM21PG300SZ1/BLM21PG300SH1



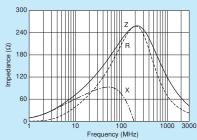
### BLM21PG600SZ1/BLM21PG600SH1



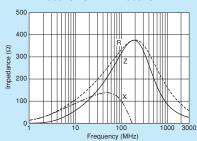
### BLM21PG121SZ1/BLM21PG121SH1



### BLM21PG221SZ1/BLM21PG221SH1



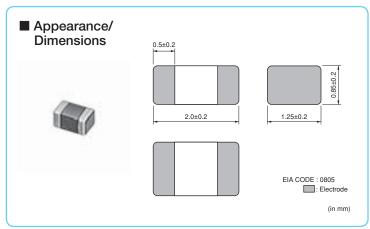
### BLM21PG331SZ1/BLM21PG331SH1



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## BLM21AG<sub>Series 0805/2012 (inch/mm)</sub>

### 0805 size for general signal lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

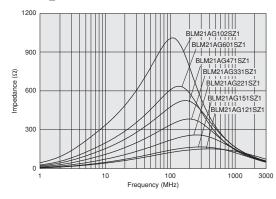
### ■ Rated Value (□: packaging code)

■ Hatea Value (□. paokaging code)						
Part Number		Impedance	Rated Current	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riated Sairent	DO NESISTANOS	Temperature Range	
BLM21AG121SZ1□	BLM21AG121SH1□	120Ω ±25%	800mA	0.10Ω max.	-55℃~+125℃	
BLM21AG151SZ1□	BLM21AG151SH1□	150Ω ±25%	800mA	0.10 Ω max.	-55°C∼+125°C	
BLM21AG221SZ1□	BLM21AG221SH1□	220Ω ±25%	800mA	0.13Ω max.	-55°C∼+125°C	
BLM21AG331SZ1□	BLM21AG331SH1□	330Ω ±25%	700mA	0.16Ω max.	-55°C∼+125°C	
BLM21AG471SZ1□	BLM21AG471SH1□	470Ω ±25%	700mA	0.19Ω max.	-55°C∼+125°C	
BLM21AG601SZ1□	BLM21AG601SH1□	600Ω ±25%	600mA	0.21 Ω max.	-55℃~+125℃	
BLM21AG102SZ1□	BLM21AG102SH1□	1000Ω ±25%	500mA	0.28Ω max.	-55℃~+125℃	

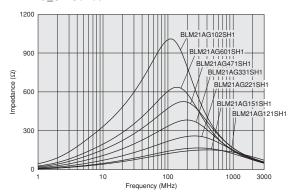
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

### BLM21AG\_SZ Series

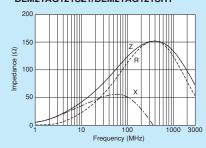


### **BLM21AG\_SH Series**

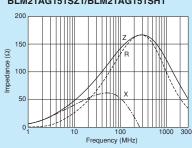


### ■ Impedance-Frequency Characteristics

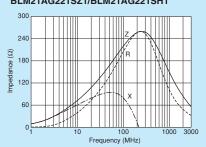
### BLM21AG121SZ1/BLM21AG121SH1



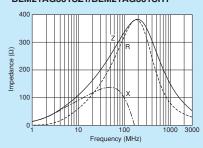
### BLM21AG151SZ1/BLM21AG151SH1



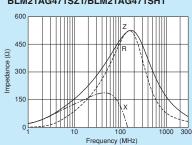
BLM21AG221SZ1/BLM21AG221SH1



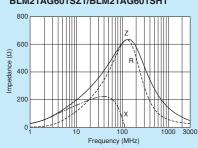
### BLM21AG331SZ1/BLM21AG331SH1



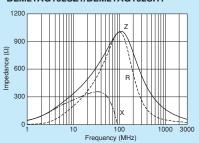
#### BLM21AG471SZ1/BLM21AG471SH1



#### BLM21AG601SZ1/BLM21AG601SH1



#### BLM21AG102SZ1/BLM21AG102SH1

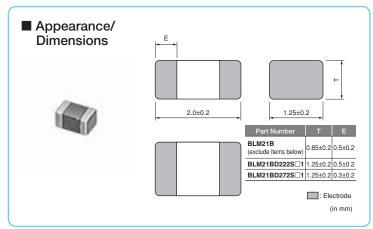




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# BLM21B<sub>Series</sub> 0805/2012 (inch/mm)

### 0805 size for high speed signal lines.



### Packaging

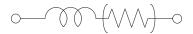
All except for BLM21BD222SZ1/21BD272SZ1

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000

### • BLM21BD222SZ1/21BD272SZ1 only

Code	Packaging	Minimum Quantity
L	180mm Plastic Tape	3000
K	330mm Plastic Tape	10000
В	Bulk(Bag)	1000

### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

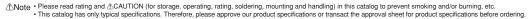
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

Part Number		Impedance			Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Rated Current	DC Resistance	Temperature Range
BLM21BD121SZ1□	BLM21BD121SH1□	120Ω ±25%	200mA	0.25Ω max.	-55°C∼+125°C
BLM21BD151SZ1□	BLM21BD151SH1□	150Ω ±25%	200mA	0.25Ω max.	-55°C∼+125°C
BLM21BD221SZ1□	BLM21BD221SH1□	220Ω ±25%	200mA	0.25Ω max.	-55°C∼+125°C
BLM21BD331SZ1□	BLM21BD331SH1□	330Ω ±25%	200mA	0.30Ω max.	-55°C∼+125°C
BLM21BD421SZ1□	BLM21BD421SH1□	420Ω ±25%	200mA	0.30Ω max.	-55°C∼+125°C
BLM21BD471SZ1□	BLM21BD471SH1□	470Ω ±25%	200mA	0.35Ω max.	-55°C∼+125°C
BLM21BD601SZ1□	BLM21BD601SH1□	600Ω ±25%	200mA	0.35Ω max.	-55°C∼+125°C
BLM21BD751SZ1□	BLM21BD751SH1□	750Ω ±25%	200mA	0.40Ω max.	-55°C∼+125°C
BLM21BD102SZ1□	BLM21BD102SH1□	1000Ω ±25%	200mA	0.40Ω max.	-55°C∼+125°C
BLM21BD152SZ1□	BLM21BD152SH1□	1500Ω ±25%	200mA	0.45Ω max.	-55°C∼+125°C
BLM21BD182SZ1□	BLM21BD182SH1□	1800Ω ±25%	200mA	$0.50\Omega$ max.	-55°C∼+125°C
BLM21BD222TZ1	BLM21BD222TH1□	2200Ω ±25%	200mA	0.60Ω max.	-55°C∼+125°C
BLM21BD222SZ1□	BLM21BD222SH1□	2250Ω (Typ.)	200mA	0.60Ω max.	-55°C∼+125°C
BLM21BD272SZ1□	BLM21BD272SH1□	2700Ω ±25%	200mA	0.80Ω max.	-55°C∼+125°C
BLM21BB050SZ1□	BLM21BB050SH1□	5Ω ±25%	1000mA	0.02Ω max.	-55°C∼+125°C
BLM21BB600SZ1□	BLM21BB600SH1□	60Ω ±25%	800mA	0.13Ω max.	-55°C∼+125°C
BLM21BB750SZ1□	BLM21BB750SH1□	75Ω ±25%	700mA	0.16Ω max.	-55°C∼+125°C
BLM21BB121SZ1□	BLM21BB121SH1□	120Ω ±25%	600mA	0.19Ω max.	-55°C∼+125°C
BLM21BB151SZ1□	BLM21BB151SH1□	150Ω ±25%	600mA	0.21 Ω max.	-55°C∼+125°C
BLM21BB201SZ1□	BLM21BB201SH1□	200Ω ±25%	500mA	0.26Ω max.	-55°C∼+125°C
BLM21BB221SZ1□	BLM21BB221SH1□	220Ω ±25%	500mA	0.26Ω max.	-55°C∼+125°C
BLM21BB331SZ1□	BLM21BB331SH1□	330Ω ±25%	400mA	0.33Ω max.	-55°C∼+125°C
BLM21BB471SZ1□	BLM21BB471SH1□	470Ω ±25%	400mA	0.40Ω max.	-55°C∼+125°C

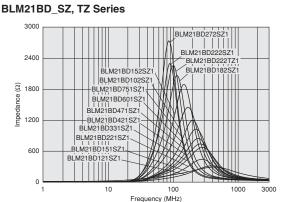
Number of Circuits: 1



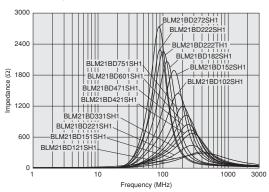




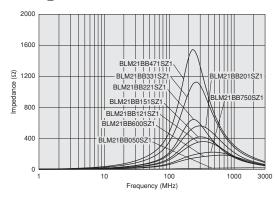
### ■ Impedance-Frequency Characteristics (Main Items)



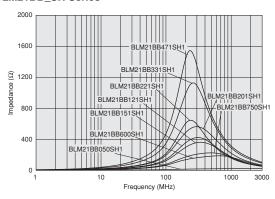
### BLM21BD\_SH, TH Series



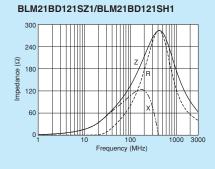
#### **BLM21BB SZ Series**



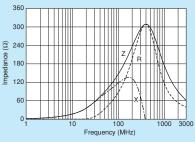
### BLM21BB\_SH Series



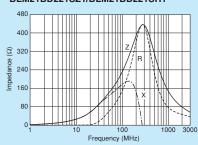
### ■ Impedance-Frequency Characteristics



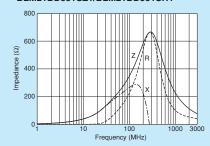




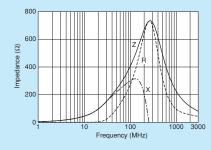




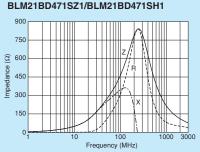




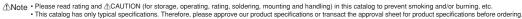
### BLM21BD421SZ1/BLM21BD421SH1

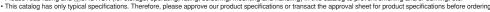


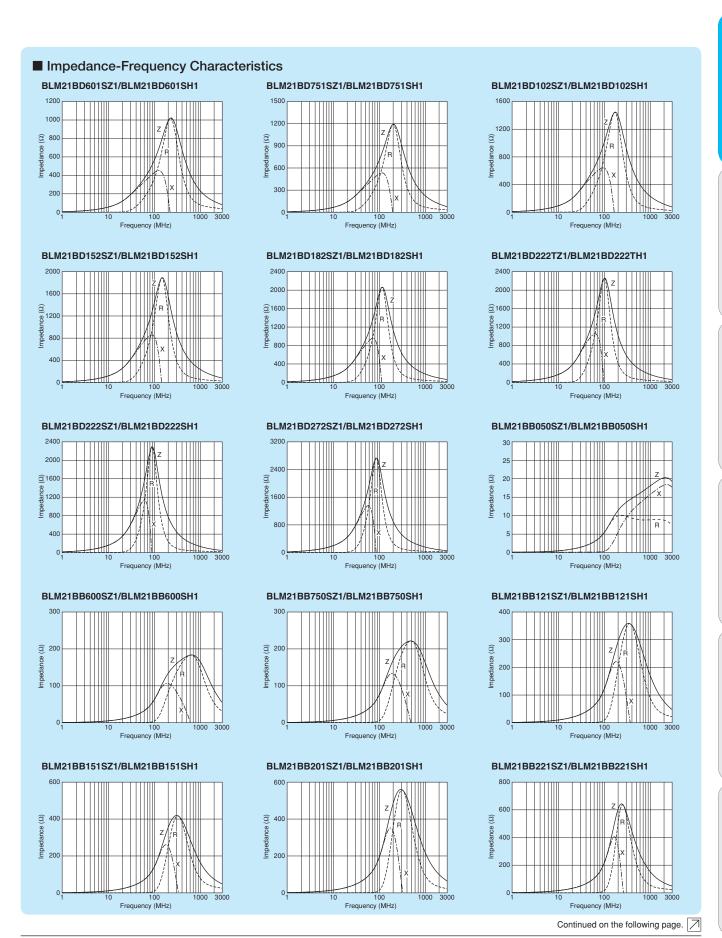
### BLM21BD471SZ1/BLM21BD471SH1

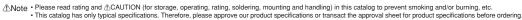








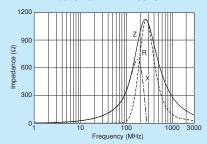




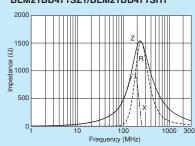


### ■ Impedance-Frequency Characteristics

### BLM21BB331SZ1/BLM21BB331SH1



### BLM21BB471SZ1/BLM21BB471SH1

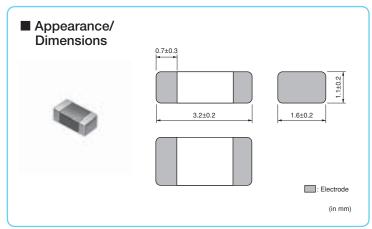




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# BLM31PG Series 1206/3216 (inch/mm)

### 1206 size for power lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
K	ø330mm Embossed Taping	10000
В	Packing in Bulk	1000



### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

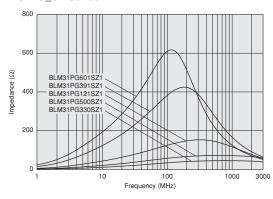
### ■ Rated Value (□: packaging code)

Part Number		Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nateu Current	DO NESISTANCE	Temperature Range
BLM31PG330SZ1□	BLM31PG330SH1□	33Ω ±25%	6000mA	$0.009\Omega$ max.	-55°C∼+125°C
BLM31PG500SZ1□	BLM31PG500SH1□	50Ω (Typ.)	3500mA	$0.015\Omega$ max.	-55°C∼+125°C
BLM31PG121SZ1□	BLM31PG121SH1□	120Ω ±25%	3500mA	$0.02\Omega$ max.	-55°C∼+125°C
BLM31PG391SZ1□	BLM31PG391SH1□	390Ω ±25%	2000mA	$0.05\Omega$ max.	-55°C∼+125°C
BLM31PG601SZ1□	BLM31PG601SH1□	600Ω ±25%	1500mA	$0.08\Omega$ max.	-55°C∼+125°C

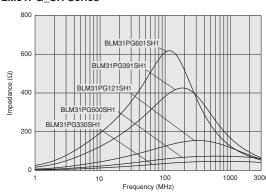
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

### BLM31PG\_SZ Series



### BLM31PG\_SH Series



Continued on the following page.

⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

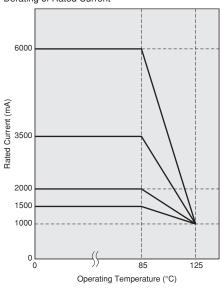


### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM31PG series.

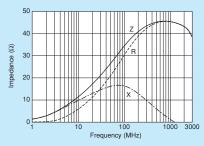
Please apply the derating curve shown in chart according to the operating temperature.

**Derating of Rated Current** 

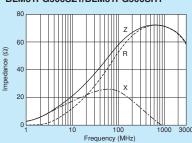


### ■ Impedance-Frequency Characteristics

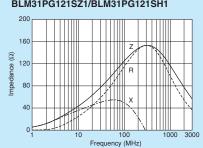
### BLM31PG330SZ1/BLM31PG330SH1



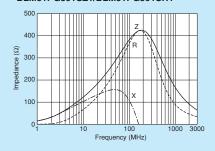
### BLM31PG500SZ1/BLM31PG500SH1



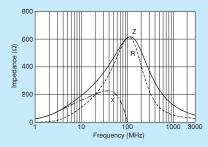
### BLM31PG121SZ1/BLM31PG121SH1



### BLM31PG391SZ1/BLM31PG391SH1



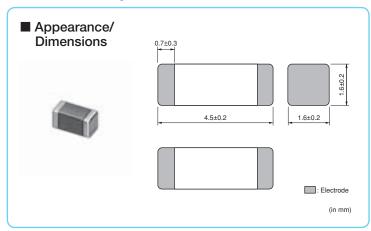
### BLM31PG601SZ1/BLM31PG601SH1



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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## BLM41PG<sub>Series 1806/4516</sub> (inch/mm)

## 1806 size for power lines.



### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2500
K	ø330mm Embossed Taping	8000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

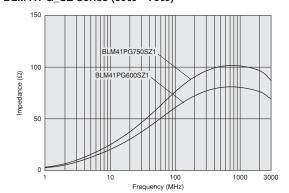
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

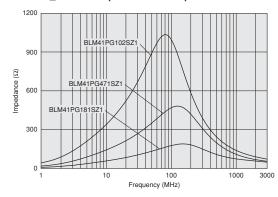
Thatea value (E. pashaging seas)					
Part Number		Impedance	Rated Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	riated Current	DO Resistance	Temperature Range
BLM41PG600SZ1□	BLM41PG600SH1□	60Ω (Typ.)	6000mA	$0.009\Omega$ max.	-55°C∼+125°C
BLM41PG750SZ1□	BLM41PG750SH1□	75Ω (Typ.)	3500mA	$0.015\Omega$ max.	-55°C∼+125°C
BLM41PG181SZ1□	BLM41PG181SH1□	180Ω ±25%	3500mA	$0.02\Omega$ max.	-55°C∼+125°C
BLM41PG471SZ1□	BLM41PG471SH1□	470Ω ±25%	2000mA	0.05Ω max.	-55°C∼+125°C
BLM41PG102SZ1□	BLM41PG102SH1□	1000Ω ±25%	1500mA	0.09Ω max.	-55°C∼+125°C

Number of Circuits: 1

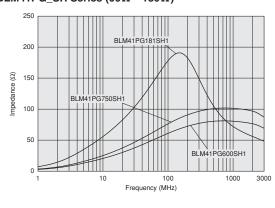
### ■ Impedance-Frequency Characteristics (Main Items) BLM41PG\_SZ Series ( $60\Omega \sim 75\Omega$ )



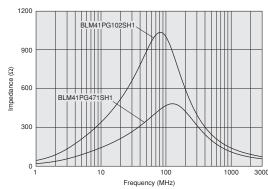
### BLM41PG\_SZ Series (180 $\Omega$ ~1000 $\Omega$ )

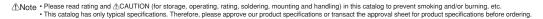


### BLM41PG\_SH Series ( $60\Omega \sim 180\Omega$ )



### BLM41PG\_SH Series (470 $\Omega$ ~1000 $\Omega$ )



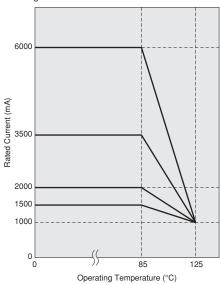


### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM41PG series.

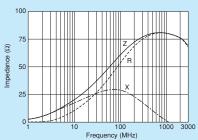
Please apply the derating curve shown in chart according to the operating temperature.

Derating of Rated Current

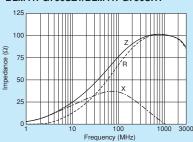


### ■ Impedance-Frequency Characteristics

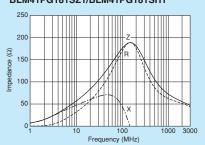




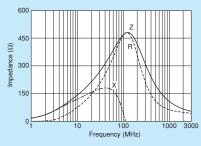
### BLM41PG750SZ1/BLM41PG750SH1



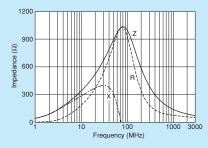
### BLM41PG181SZ1/BLM41PG181SH1



### BLM41PG471SZ1/BLM41PG471SH1



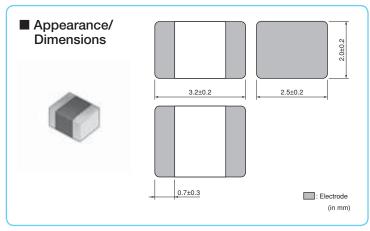
### BLM41PG102SZ1/BLM41PG102SH1



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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## BLE32PN Series 1210/3225 (inch/mm)

## 10A max., large current chip ferrite bead inductor.



### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	1500
K	ø330mm Embossed Taping	7000
В	Packing in Bulk	1000



### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

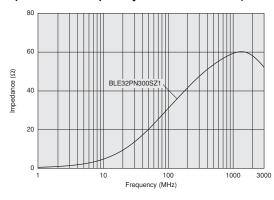
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

Part N	lumber	Impedance	Impedance Rated Current		Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	nated Current	DC Resistance	Temperature Range	
BLE32PN300SZ1□	_	30Ω ±10Ω	10000mA	1.6mΩ max.	-55°C∼+125°C	

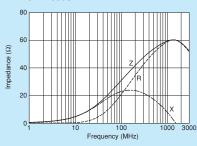
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)



### ■ Impedance-Frequency Characteristics

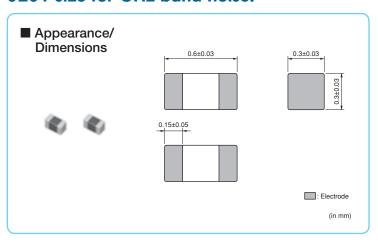
### BLE32PN300SZ1



⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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### 0201 size for GHz band noise.



### Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000







■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

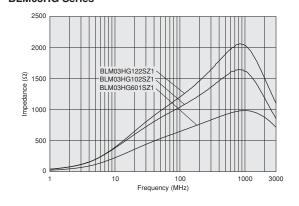
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

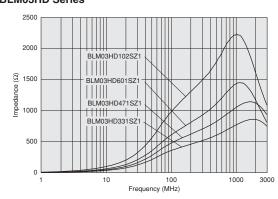
Part N	umber	Impedance	Impedance Rated Current		DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	nated Current	unent Do nesistance	Temperature Range
BLM03HG601SZ1□	_	600Ω ±25%	1000Ω ±40%	150mA	1.6Ω max.	-55°C∼+125°C
BLM03HG102SZ1□	_	1000Ω ±25%	1800Ω ±40%	125mA	2.6Ω max.	-55°C∼+125°C
BLM03HG122SZ1□	_	1200Ω ±25%	2000Ω ±40%	100mA	3.5Ω max.	-55°C∼+125°C
BLM03HD331SZ1□	_	330Ω ±25%	750Ω ±40%	200mA	1.0Ω max.	-55°C∼+125°C
BLM03HD471SZ1□	_	470Ω ±25%	1000Ω ±40%	175mA	1.3Ω max.	-55°C∼+125°C
BLM03HD601SZ1□	_	600Ω ±25%	1500Ω ±40%	150mA	1.7Ω max.	-55°C∼+125°C
BLM03HD102SZ1□	_	1000Ω ±25%	2300Ω ±40%	120mA	2.9Ω max.	-55°C∼+125°C
BLM03HB191SZ1□	_	190Ω ±25%	1150Ω ±40%	150mA	2.0Ω max.	-55°C∼+125°C

Number of Circuits: 1

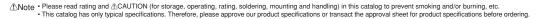
### ■ Impedance-Frequency Characteristics (Main Items) **BLM03HG Series**



### **BLM03HD Series**



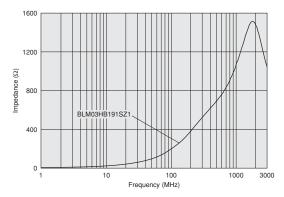






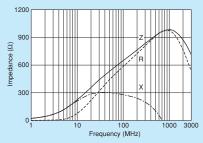
### ■ Impedance-Frequency Characteristics (Main Items)

### **BLM03HB Series**

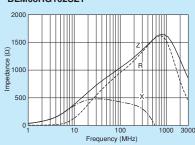


### ■ Impedance-Frequency Characteristics

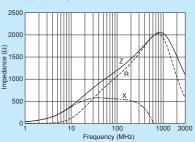
### BLM03HG601SZ1



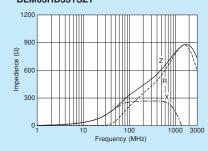
### BLM03HG102SZ1



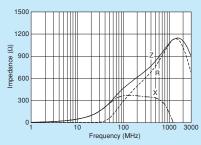
### BLM03HG122SZ1



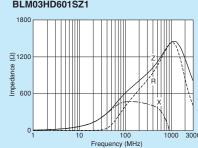
### BLM03HD331SZ1



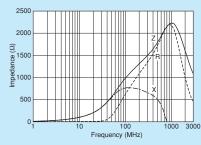
### BLM03HD471SZ1



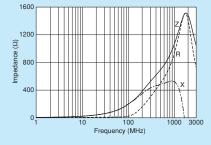
### BLM03HD601SZ1



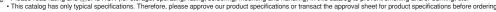
### BLM03HD102SZ1



### BLM03HB191SZ1



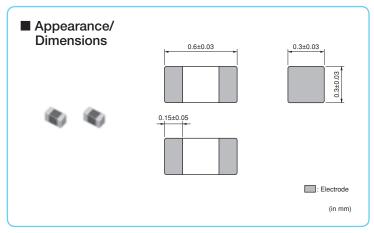
♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.





## **Power lines · Signal lines Universal Type** LM03 E Series 0201/0603 (inch/mm)

### For GHz band noise and capable of large current.



### ■ Packaging

<u></u>					
Code	Packaging	Minimum Quantity			
D	ø180mm Paper Taping	15000			
J	ø330mm Paper Taping	50000			
В	Packing in Bulk	1000			
	1 doming in bank	.000			



### ■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

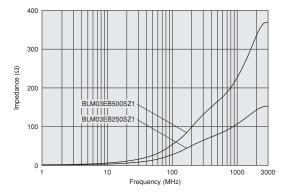
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

Part Number		Impedance	Impedance	Poted Current	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	nateu Current	DC nesistance	Temperature Range
BLM03EB250SZ1□	_	25Ω ±25%	105Ω ±40%	600mA	0.26Ω max.	-55°C∼+125°C
BLM03EB500SZ1□	_	50Ω ±25%	255Ω ±40%	400mA	0.58Ω max.	-55°C∼+125°C

Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

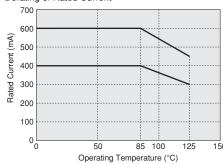


### ■ Derating of Rated Current

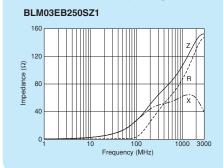
In operating temperature exceeding +85°C, derating of current is necessary for BLM03E series.

Please apply the derating curve shown in chart according to the operating temperature.

### **Derating of Rated Current**



### ■ Impedance-Frequency Characteristics



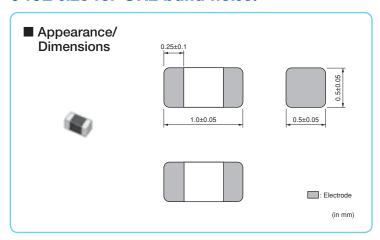
## 300 200 100

BLM03EB500SZ1

<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## BLM15H<sub>Series</sub> 0402/1005 (inch/mm)

### 0402 size for GHz band noise.

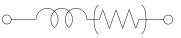


### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000







(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

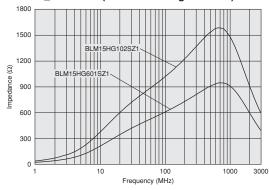
### ■ Rated Value (□: packaging code)

Trated Value (□. packaging code)						
Part Number		Impedance	Impedance	Rated	DC	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	Current	Resistance	Temperature Range
BLM15HG601SZ1□	BLM15HG601SH1□	600Ω ±25%	1000Ω ±40%	300mA	0.7Ω max.	-55°C∼+125°C
BLM15HG102SZ1□	BLM15HG102SH1□	$1000\Omega$ $\pm 25\%$	1400Ω ±40%	250mA	1.1Ω max.	-55°C∼+125°C
BLM15HD601SZ1□	BLM15HD601SH1□	$600\Omega \pm 25\%$	1400Ω ±40%	300mA	0.85Ω max.	-55°C∼+125°C
BLM15HD102SZ1□	BLM15HD102SH1□	$1000\Omega$ $\pm 25\%$	2000Ω ±40%	250mA	1.25Ω max.	-55°C∼+125°C
BLM15HD182SZ1□	BLM15HD182SH1□	$1800\Omega \pm 25\%$	2700Ω ±40%	200mA	2.2Ω max.	-55°C∼+125°C
BLM15HB121SZ1□	_	120Ω ±25%	500Ω ±40%	300mA	0.7Ω max.	-55°C∼+125°C
BLM15HB221SZ1□	_	220Ω ±25%	900Ω ±40%	250mA	1.0Ω max.	-55°C∼+125°C

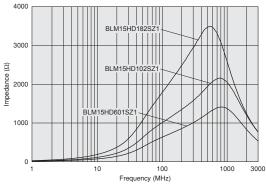
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

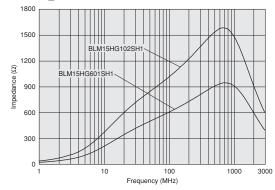
### BLM15HG\_SZ Series (For General Signal Lines)



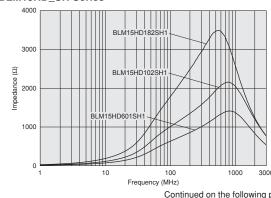
### BLM15HD\_SZ Series (For High Speed Signal Lines)



### **BLM15HG\_SH Series**

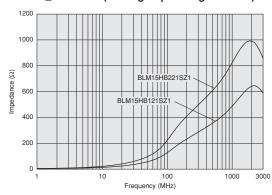


### BLM15HD\_SH Series



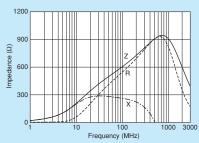
<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

### ■ Impedance-Frequency Characteristics (Main Items) BLM15HB\_SZ Series (For High Speed Signal Lines)

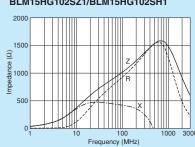


### **■** Impedance-Frequency Characteristics

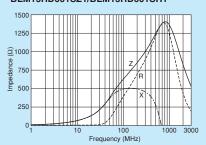
### BLM15HG601SZ1/BLM15HG601SH1



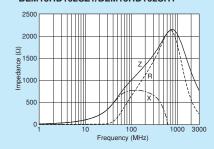
### BLM15HG102SZ1/BLM15HG102SH1



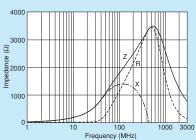
#### BLM15HD601SZ1/BLM15HD601SH1



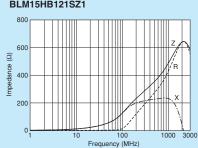
### BLM15HD102SZ1/BLM15HD102SH1



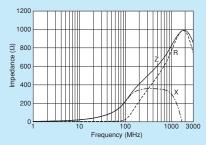
### BLM15HD182SZ1/BLM15HD182SH1



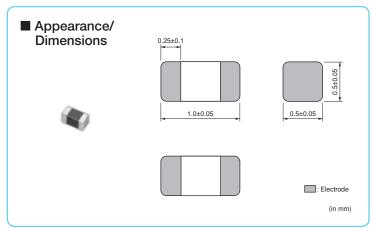
BLM15HB121SZ1



#### BLM15HB221SZ1



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

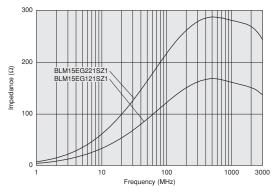
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

Part Number		Impedance Imp	Impedance	Rated	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	Current	DO NESISTANCE	Temperature Range
BLM15EG121SZ1□	_	120Ω ±25%	145Ω (Typ.)	1500mA	0.095Ω max.	-55°C∼+125°C
BLM15EG221SZ1□	_	220Ω ±25%	270Ω (Typ.)	700mA	0.28Ω max.	-55°C∼+125°C

Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

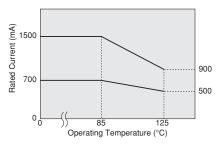


### ■ Derating of Rated Current

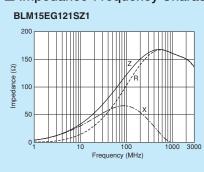
In operating temperature exceeding +85°C, derating of current is necessary for BLM15E series.

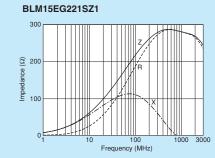
Please apply the derating curve shown in chart according to the operating temperature.

### **Derating of Rated Current**



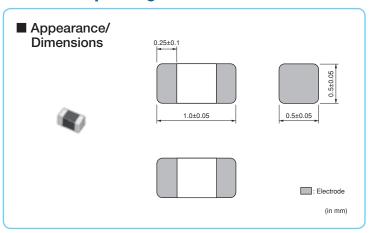
### ■ Impedance-Frequency Characteristics





⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

### Available up to high-GHz band noise.



### ■ Packaging

	~ ~	
Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000









(Resistance element becomes dominant at high frequencies.)

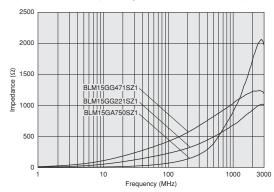
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

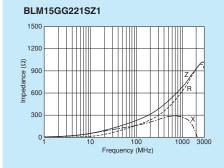
Part N	umber	lmpedance Impedance Rated		DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	Current	DC nesistance	Temperature Range
BLM15GG221SZ1□	_	220Ω ±25%	600Ω ±40%	300mA	0.7Ω max.	-55°C∼+125°C
BLM15GG471SZ1□	_	470Ω ±25%	1200Ω ±40%	200mA	1.3Ω max.	-55°C∼+125°C
BLM15GA750SZ1□	_	75Ω ±25%	1000Ω ±40%	200mA	1.3Ω max.	-55°C∼+125°C

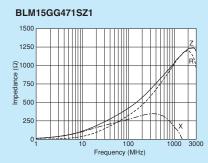
Number of Circuits: 1

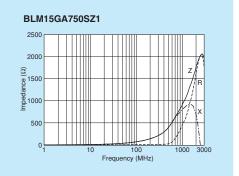
### ■ Impedance-Frequency Characteristics (Main Items)



### ■ Impedance-Frequency Characteristics



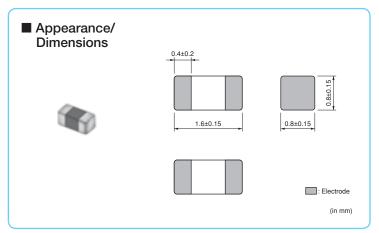




<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
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## BLM 18H Series 0603/1608 (inch/mm)

### 0603 size for GHz band noise. BLM18HE also supports power lines.



### Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

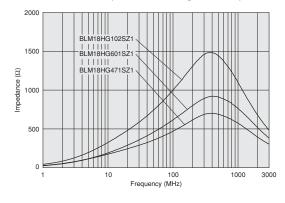
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

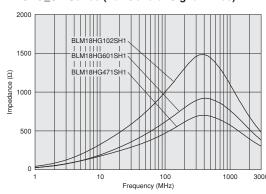
■ Rated value (□: packaging code)						
Part Number		Impedance	Impedance	Rated	DC Resistance	Operating
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	Current		Temperature Range
BLM18HG471SZ1□	BLM18HG471SH1□	470Ω ±25%	600Ω (Typ.)	200mA	0.85Ω max.	-55°C∼+125°C
BLM18HG601SZ1□	BLM18HG601SH1□	600Ω ±25%	700Ω (Typ.)	200mA	1.00 Ω max.	-55°C∼+125°C
BLM18HG102SZ1□	BLM18HG102SH1□	1000Ω ±25%	1000Ω (Typ.)	100mA	1.60 Ω max.	-55°C∼+125°C
BLM18HE601SZ1□	_	600Ω ±25%	600Ω (Typ.)	800mA	0.25Ω max.	-55°C∼+125°C
BLM18HE102SZ1□	_	1000Ω ±25%	1000Ω (Typ.)	600mA	0.35Ω max.	-55°C∼+125°C
BLM18HE152SZ1□	_	1500Ω ±25%	1500Ω (Typ.)	500mA	0.50 Ω max.	-55°C∼+125°C
BLM18HD471SZ1□	BLM18HD471SH1□	470Ω ±25%	1000Ω (Typ.)	100mA	1.20 Ω max.	-55°C∼+125°C
BLM18HD601SZ1□	BLM18HD601SH1□	600Ω ±25%	1200Ω (Typ.)	100mA	1.50Ω max.	-55°C∼+125°C
BLM18HD102SZ1□	BLM18HD102SH1□	1000Ω ±25%	1700Ω (Typ.)	50mA	1.80Ω max.	-55°C∼+125°C
BLM18HB121SZ1□	_	120Ω ±25%	500Ω ±40%	200mA	0.50Ω max.	-55°C∼+125°C
BLM18HB221SZ1□	_	220Ω ±25%	1100Ω ±40%	100mA	0.80Ω max.	-55°C∼+125°C
BLM18HB331SZ1□	_	330Ω ±25%	1600Ω ±40%	50mA	1.20Ω max.	-55°C∼+125°C

Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items) BLM18HG\_SZ Series (For General Signal Lines)

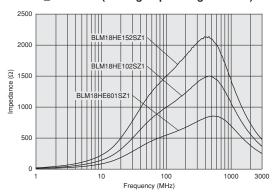


### BLM18HG\_SH Series (For General Signal Lines)

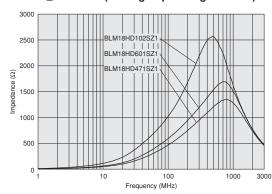




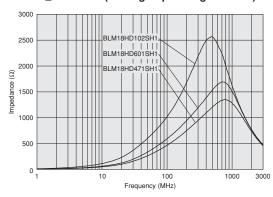
### ■ Impedance-Frequency Characteristics (Main Items) BLM18HE\_SZ Series (For High Speed Signal Lines)



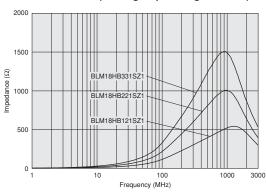
### BLM18HD\_SZ Series (For High Speed Signal Lines)



### BLM18HD\_SH Series (For High Speed Signal Lines)



### BLM18HB\_SZ Series (For High Speed Signal Lines)

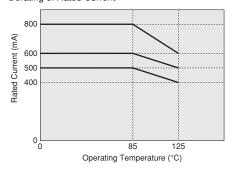


### ■ Derating of Rated Current

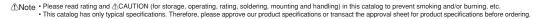
In operating temperature exceeding +85°C, derating of current is necessary for BLM18HE series.

Please apply the derating curve shown in chart according to the operating temperature.

**Derating of Rated Current** 



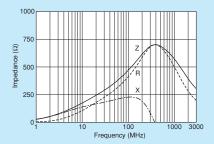




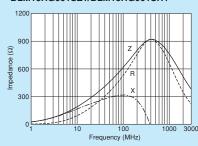


#### ■ Impedance-Frequency Characteristics

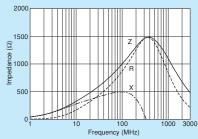
#### BLM18HG471SZ1/BLM18HG471SH1



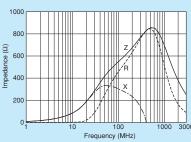
#### BLM18HG601SZ1/BLM18HG601SH1



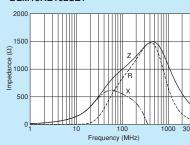
#### BLM18HG102SZ1/BLM18HG102SH1



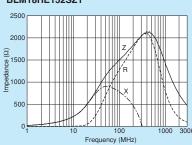




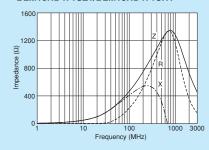
#### BLM18HE102SZ1



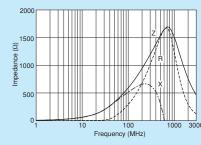
#### BLM18HE152SZ1



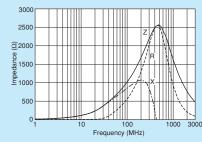
#### BLM18HD471SZ1/BLM18HD471SH1



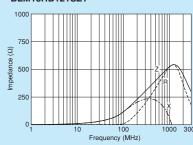
#### BLM18HD601SZ1/BLM18HD601SH1



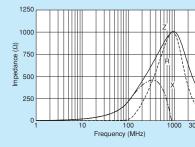
#### BLM18HD102SZ1/BLM18HD102SH1



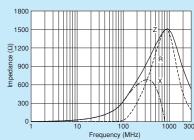
#### BLM18HB121SZ1



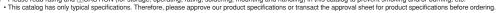
#### BLM18HB221SZ1



#### BLM18HB331SZ1

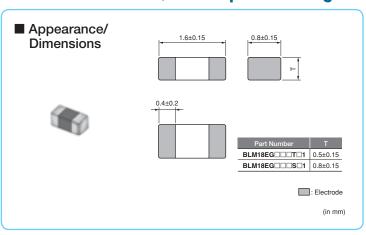


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.





### For GHz band noise, also capable to large current.



■ Packaging

Packaging	Minimum Quantity
ø180mm Paper Taping	4000
ø330mm Paper Taping	10000
Packing in Bulk	1000
	ø180mm Paper Taping ø330mm Paper Taping



■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.77 to p.80 for mounting information.

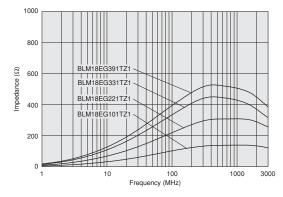
#### ■ Rated Value (□: packaging code)

= riated value (E. packaging edde)											
Part N For Infotainment	Part Number  For Infotainment For Powertrain/Safety		Impedance (at 1GHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range					
BLM18EG101TZ1□	BLM18EG101TH1□	100Ω ±25%	140Ω (Typ.)	2000mA	0.045Ω max.	-55°C∼+125°C					
BLM18EG121SZ1□	BLM18EG121SH1□	120Ω ±25%	145Ω (Typ.)	2000mA	0.04Ω max.	-55°C∼+125°C					
_	BLM18EG181SH1□	180Ω ±25%	260Ω (Typ.)	2000mA	0.05Ω max.	-55°C∼+125°C					
BLM18EG221SZ1□	_	220Ω ±25%	260 Ω (Typ.)	2000mA	0.05Ω max.	-55°C∼+125°C					
BLM18EG221TZ1□	BLM18EG221TH1□	220Ω ±25%	300Ω (Typ.)	1000mA	0.15Ω max.	-55°C∼+125°C					
BLM18EG331TZ1□	BLM18EG331TH1□	330Ω ±25%	450Ω (Typ.)	500mA	0.21 Ω max.	-55°C∼+125°C					
BLM18EG391TZ1□	BLM18EG391TH1□	390Ω ±25%	520Ω (Typ.)	500mA	0.30 Ω max.	-55°C∼+125°C					
BLM18EG471SZ1□	BLM18EG471SH1□	470Ω ±25%	550Ω (Typ.)	500mA	0.21 Ω max.	-55°C∼+125°C					
BLM18EG601SZ1□	BLM18EG601SH1□	600Ω ±25%	700Ω (Typ.)	500mA	0.35Ω max.	-55°C∼+125°C					

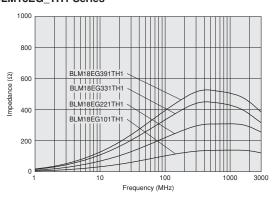
Number of Circuits: 1

### ■ Impedance-Frequency Characteristics (Main Items)

#### BLM18EG\_TZ1 Series



#### BLM18EG\_TH1 Series



Continued on the following page.

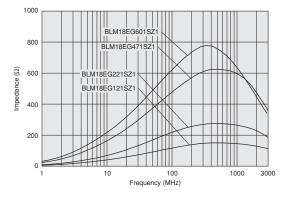




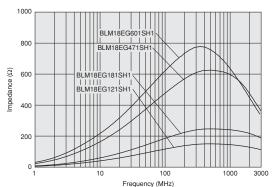
<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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### ■ Impedance-Frequency Characteristics (Main Items)

#### BLM18EG\_SZ1 Series



#### BLM18EG\_SH1 Series

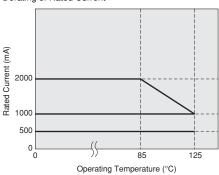


#### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for BLM18EG series.

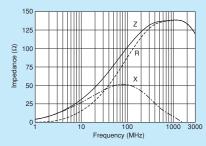
Please apply the derating curve shown in chart according to the operating temperature.

#### Derating of Rated Current

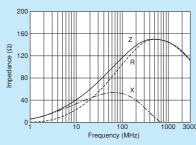


#### ■ Impedance-Frequency Characteristics

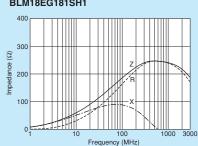
#### BLM18EG101TZ1/BLM18EG101TH1



#### BLM18EG121SZ1/BLM18EG121SH1

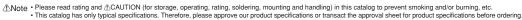


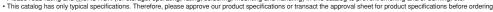
### BLM18EG181SH1



Continued on the following page.





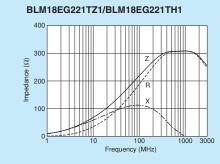


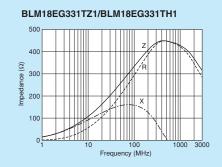


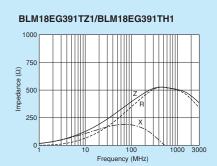
#### ■ Impedance-Frequency Characteristics

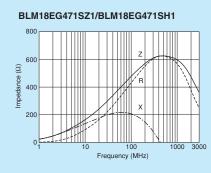


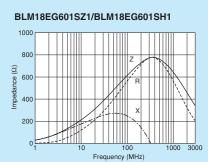
Frequency (MHz)









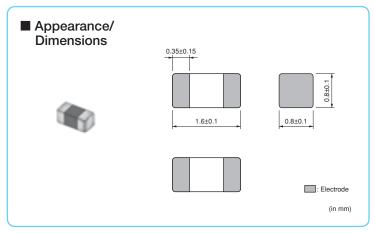




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# BLM18GG Series 0603/1608 (inch/mm)

## Available up to high-GHz band noise.



#### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000



■ Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

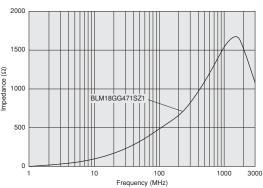
Refer to pages from p.77 to p.80 for mounting information.

### ■ Rated Value (□: packaging code)

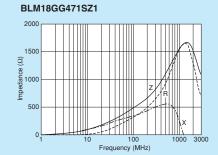
Part N	lumber	Impedance	Impedance	Rated	DC Resistance	Operating	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1GHz/20°C)	Current	DC nesistance	Temperature Range	
BLM18GG471SZ1□	_	470Ω ±25%	1800Ω ±30%	200mA	$1.0\Omega\pm0.3\Omega$	-55°C∼+125°C	

Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)



#### **■** Impedance-Frequency Characteristics



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### Rating

#### 1. About the Rated Current

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

2. About the Excessive Surge Current Excessive surge current ( pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.Please contact us in advance in case of applying the surge current.

#### Soldering and Mounting

#### Self-heating

Please pay special attention when mounting chip ferrite beads BLM\_AX/P/K/S series bead inductor BLE series in close proximity to other products that radiate heat

The heat generated by other products may deteriorate the insulation resistance and cause excessive heat in this component.

#### **Notice**

#### Storage and Operating Conditions

<Operating Environment>

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

Do not use products in the environment close to the organic solvent.

<Storage and Handling Requirements>

1. Storage Period

BLM15E/15H/15G series should be used within 12 months, the other series should be used within 6 months

Solderability should be checked if this period is exceeded.

- 2. Storage Conditions
  - Storage temperature: -10 to +40°C Relative humidity: 15 to 85%

Avoid sudden changes in temperature and humidity.

(2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

#### Notice (Soldering and Mounting)

1. Cleaning

Failure and degradation of a product are caused by the cleaning method. When you clean in conditions that are not in mounting information, please contact Murata engineering.

2. Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.

 Mounting on-boad with Conductive Glue BLM18AG\_WH is designed for conductive glue mounting method. Please refer to Mounting infomation.

#### 4 Other

Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.

#### Handling

1. Resin Coating

Using resin for coating/molding products may affect the products performance.

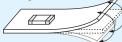
So please pay careful attention in selecting resin. Prior to use, please make the reliability evaluation with the product mounted in your application set.

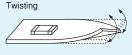
2. Handling of a Substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the Product.

Bending





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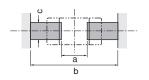
#### 1. Standard Land Pattern Dimensions

Land Pattern + Solder Resist Land Pattern

(in mm) ☐ Solder Resist

BLE32 BLM03 **BLM15 BLM18 BLM21** BLM31 **BLM41** 

#### Reflow and Flow **BLM Series**

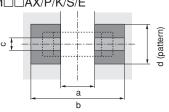


Type	Soldering	а	b	С
BLM03	Reflow	0.2-0.3	0.6-0.9	0.3
BLM15	Reflow	0.4	1.2-1.4	0.5
BLM18	Flow (except 18G)	0.7	2.2-2.6	0.7
	Reflow		1.8-2.0	
BLM21	Flow/ Reflow	1.2	3.0-4.0	1.0

- Except for BLM03PG·PX·EB/15AX·PD·PG·PX/ 18PG·KG·SG/21PG. And BLM03/15/18G is specially adapted for reflow soldering.
- BLM18A\_WH series is designed for conductive glue mounting method, not for normal soldering method.

Please contact us for applicable mounting method for BLM18A\_WH series.

#### BLE32PN·BLM AX/P/K/S/E



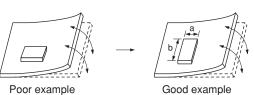
Type	Rated Current	Soldering	а	b	С	Laı	nd Pad Thickne nd Dimension	ess d		
Турс	(A)	ooldering	а	Ь	C	18µm	35µm	70µm		
BLE32PN	10	Flow/	1.9	3.6	2.7	-	4.0 (Temperature 85°C or less)	-		
DELOZI N	Reflow	2.7	-	8.0 (Temperature 125°C or less)	-					
BLM03AX BLM03P□	0.9max.	Reflow	0.2-0.3	0.6-0.9	0.3	0.3	0.3	0.3		
BLM03EB	1.8max.	TICHOW	0.2-0.3	0.0-0.9	0.3	1.2	0.7	0.3		
BLM15AX	1.5max.					0.5	0.5	0.5		
BLM15PD BLM15PG	2.2max.	Reflow	0.4	0.4	1.2-1.4	0.5	1.2	0.7	0.5	
BLM15PX	3.0max.					2.4	1.2	0.5		
	0.5-1.5			Flow		0.7	0.7	0.7		
BLM18PG BLM18KG	1.7-2.5		0.7	0.7	0.7	2.2-2.6	0.7	1.2	0.7	0.7
BLM18SG	3-4					0.7	0.7	Reflow 1.8-2.0	0.7	2.4
	5-6			1.0-2.0		6.4	3.3	1.65		
	1.5					1.0	1.0	1.0		
BLM21PG	2		1.0	3.0-4.0	1.0	1.2	1.0	1.0		
BLIVIZ IPG	3-4	Flow/	1.2	1.2	1.2	3.0-4.0	1.0	2.4	1.2	1.0
	6	Reflow				6.4	3.3	1.65		
	1.5-2					1.2	1.2	1.2		
BLM31PG	3.5		2.0	4.2-5.2		2.4	1.2	1.2		
	6				1 0	6.4	3.3	1.65		
	1.5-2				1.2	1.2	1.2	1.2		
BLM41PG	3.5		3.0	5.5-6.5		2.4	1.2	1.2		
	6					6.4	3.3	1.65		

- About land pad thickness of BLE32PN, please note the upper limit of the temperature.
- Do not apply narrower pattern than listed above to BLM□□AX/P/K/S. Narrow pattern can cause excessive heat or open circuit.

#### PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.

Products should be located in the sideways direction (Length: a<b) to the mechanical stress.



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#### 2. Solder Paste Printing and Adhesive Application

When reflow soldering the chip ferrite beads and bead inductor the printing must be conducted in accordance with the following cream solder printing conditions.

If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack.

Standard land dimensions should be used for resist and copper foil patterns.

When flow soldering the chip ferrite beads and bead inductor apply the adhesive in accordance with the following conditions.

If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering process.

(in mm)

Series	Solder Paste Printing	Adhesive Application
BLM BLE	<ul> <li>●Ensure that solder is applied smoothly to a minimum height of 0.2mm to 0.3mm at the end surface of the part.</li> <li>●Guideline of solder paste thickness: 100-150µm: BLM03 100-200µm: BLM15/18/21/31/41/BLE32</li> </ul>	BLM18/21/31/41 Series (Except for BLM18G Series) Coating amount is illustrated in the following diagram.  a: 20-70μm b: 30-35μm c: 50-105μm  Chip Solid Inductor  Chip Solid Inductor  Bonding agent Land

#### 3. Standard Soldering Conditions

#### (1) Soldering Methods

Use flow and reflow soldering methods only.
Use standard soldering conditions when soldering chip ferrite beads and bead inductor.

In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder. Use of Sn-Zn based solder will deteriorate performance of products.

If using BLA series with Sn-Zn based solder, please contact Murata in advance.

#### Flux:

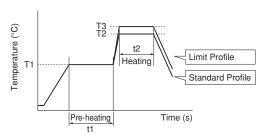
- Use Rosin-based flux.
   In case of using RA type solder, products should be cleaned completely with no residual flux.
- Do not use strong acidic flux (with chlorine content exceeding 0.20wt%)
- Do not use water-soluble flux.

For additional mounting methods, please contact Murata.



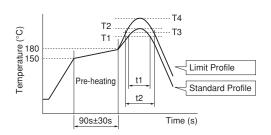
#### (2) Soldering Profile

●Flow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



	Dro b	natina	St	andard Profile	)		Limit Profile		
Series	Pre-heating		Pre-neating Heating		ting	Cycle	Heating		Cycle
	Temp. (T1)	Time. (t1)	Temp. (T2)	Time. (t2)	of Flow	Temp. (T3)	Time. (t2)	of Flow	
BLM (Except for BLM03/15/18G/18AG_W) BLE	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.	

#### Reflow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



		Standar	d Profile		Limit Profile				
Series	Heating		Peak Temperature	Cycle	Heating		Peak Temperature	Cycle	
	Temp. (T1)	Time. (t1)	(T2)	of Reflow	Temp. (T3)	Time. (t2)	(T4)	of Reflow	
BLM (Except for BLM18AG_W) BLE	220°C min.	30 to 60s	245±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.	

#### (3) Reworking with Solder Iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating: 150°C 60s min.

Soldering iron power output / Tip diameter:

80W max. / ø3mm max.

Temperature of soldering iron tip / Soldering time / Times:  $350^{\circ}$ C max. / 3-4s / 2 times

Do not allow the tip of the soldering iron to directly contact the chip.

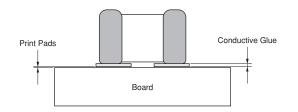
For additional methods of reworking with a soldering iron, please contact Murata engineering.

#### 4. Mounting on-board with Conductive Glue of BLM18AG\_WH1

Please adhere rigidly to the condition below which shows the method of mounting with conductive glue.

Please coat print pads with conductive glue using metal mask and metal squeegee, and then mount our products on the substrates with a mount machine or human hand. Please put the substrates into an oven (140 to 150°C) for 30 minutes in order to cure the adhesive.

Please check whether the chips and the substrates are connected with the conductive glue or not and there is no electrical short of the conductive glue.



1. Board	Ceramic Board or Alumina Board
2. Thickness of Glue	30 to 50µm
3. Recommended Conductive	PC3000
Glue	(Manufactured by Heraeus)

#### 5. Cleaning

Following conditions should be observed when cleaning chip ferrite beads.

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol type cleaner)
- (2) Ultrasonic

Output: 20W/liter max. Duration: 5 minutes max. Frequency: 28 to 40kHz

(3) Cleaning Agent

The following list of cleaning agents have been tested on the individual components. Evaluation of final assembly should be completed prior to production.

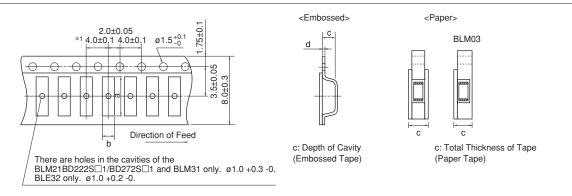
Do not clean BLM18AG□□□WH1 series. Before cleaning, please contact Murata engineering.

- (a) Alcohol cleaning agent Isopropyl alcohol (IPA)
- (b) Aqueous cleaning agent Pine Alpha ST-100S

- (4) Ensure that flux residue is completely removed. Component should be thoroughly dried after aqueous agent has been removed with deionized water.
- (5) BLM\_G type is processed with resin. On rinsing the product, using water for ultrasonic cleaning may affect the resin quality used for the product by water element. In case of set cleaning conditions, please make sure the reliability according to the cleaning conditions.

For additional cleaning methods, please contact Murata engineering.

#### ■ Minimum Quantity and Dimensions of 8mm Width Paper / Embossed Tape



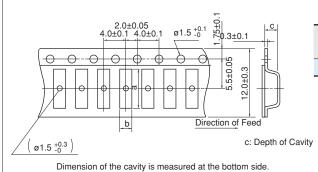
<sup>\*1</sup> BLM03/15: 2.0±0.05 BLM18S/18T/BLA2A: 2.0±0.1

Dimension of the cavity of embossed tape is measured at the bottom side.

		Dim	anaiana		Minimum Qty. (pcs.)						
Part Number	Dimensions				ø180m	ım Reel	ø330m	D. II.			
	а	b	С	d	Paper Tape	Embossed Tape	Paper Tape	Embossed Tape	Bulk		
BLM03	0.70	0.40	0.55 max.	-	15000	-	50000	-	1000		
BLM15	1.15	0.65	0.8 max.	-	10000	-	50000	-	1000		
BLM18A/B/P/H/G	1.85	1.05	1.1 max.	-	4000	-	10000	-	1000		
BLM18EG/KG_T□	1.85	1.05	0.85 max.	_	4000	_	10000	-	1000		
BLM18EG/KG_S□	1.05	1.05	1.1 max.	-		-					
BLM18S	1.85	1.05	0.90 max.	-	10000	-	30000	-	1000		
BLM21	2.25	1.45	1.1 max.	-	4000	-	10000	-	1000		
BLM31	3.5	1.9	1.3	0.2	-	3000	-	10000	1000		
BLM21BD222S□1/272S□1	2.25	1.45	1.3	0.2	-	3000	-	10000	1000		
BLE32	3.2	2.8	2.3	0.25	-	1500	-	7000	1000		

(in mm)

#### ■ Minimum Quantity and Dimensions of 12mm Width Embossed Tape



Dort Number	Dir	nensic	ns	Minimum Qty. (pcs.)				
Part Number	а	b	С	ø180mm Reel ø330mm Reel Bul				
BLM41	4.8	1.9	1.75	2500	8000	1000		

(in mm)



<sup>&</sup>quot;Minimum Quantity" means the number of units of each delivery or order. The quantity should be an integral multiple of the "Minimum Quantity."

### Capacitor

(Part Number)

















Product ID

Product ID	
NF	Chip EMIFIL®

2Structure

Gottactare	
Code	Structure
M	Capacitor Type

3Dimensions (LXW)

Code	Dimensions (L×W)	EIA
21	2.0×1.25mm	0805
31	3.2×1.6mm	1206

4 Features

Code	Features		
HC	For Automotive	Powertrain, Safety	
нк			

#### 6 Capacitance

Expressed by three figures. The unit is in pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

**6**Characteristics

Code	Capacitance Temperature Characteristics	
R	±15%, +15/-18%	
U	-750 ±120ppm/°C	

Rated Voltage

Code	Rated Voltage	
1A	10V	
1C	16V	
1H	50V	
2A	100V	

8 Electrode/Others

Code	Electrode	Series
3	Sn Plating	NFM

or adiaging				
Code Packaging		Series		
L	Embossed Taping (ø180mm Reel)	NFM31		
В	Bulk	All series		
D	Paper Taping (ø180mm Reel)	NFM21		

#### **LC Combined**

(Part Number)



#### Product ID

<b>O</b> 10000112		
Product ID		
NF	Chip EMIFIL®	

#### 2Structure

Code	Structure	
L	Multilayer, LC Combined Type	
E	Block, LC Combined Type	

#### 3Dimensions (LXW)

<u> </u>		
Code	Dimensions (L×W)	EIA
18	1.6×0.8mm	0603
31	31 3.2×1.6mm	
61	6.8×1.6mm	2706

#### 4 Features

Code	Features	
HT	For Automotive	Powertrain, Safety, T Circuit
ZT		Infotainment, T Circuit

#### **5**Cut-off Frequency (**NFL** Series)

Expressed by three figures. The unit is in hertz (Hz). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

#### **6**Capacitance (**NFE** Series)

Expressed by three figures. The unit is in pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

#### **6**Characteristics (NFL Series)

Code	Characteristics
н	Cut-off Frequency

#### **6**Characteristics (NFE Series)

Code	Capacitance Temperature Characteristics
С	±20%, ±22%
D	+20/-30%, +22/-33%
F	+30/-80%, +22/-82%
R	±15%
U	-750 ±120ppm/ °C
Z	Other

#### Rated Voltage

Code	Rated Voltage
1A	10V
1E	25V
2A	100V

#### 8 Electrode

Code	Electrode	Series
3	Sn Plating	NFL
9	Others	NFE

Code	Packaging	Series
К	Embossed Taping (ø330mm Reel)	NFE
L	Embossed Taping (ø180mm Reel)	NFE
В	Bulk	NFL18/NFE
D	Paper Taping (ø180mm Reel)	NFL18



### **Inductor Type**

(Part Number)















Product ID

Product ID	
NF	Chip EMIFIL®

2Structure

Condition	
Code	Structure
Z	Inductor Type

3Dimensions (LXW)

	,	
Code	Dimensions (L×W)	EIA
32	3.2×2.5mm	1210

4 Features

Code	Features
BW	Special Feature Classification

6 Impedance

Expressed by three figures. The unit is in ohm  $(\Omega)$ . The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

6 Inductance Tolerance

Code	Features
Н	For General Use (LF Solder)

Category

Code		Category
Z	For Automotive	Infotainment

8 Number of Circuits

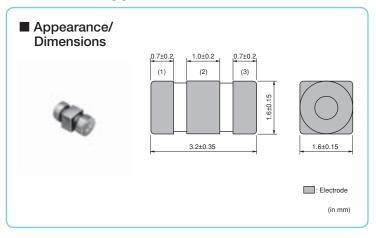
Code	Number of Circuits
1	1 Circuit

Specification

Code	Specification
0	Standard Type
1	Low Rdc Type

Code	Packaging
K	Embossed Taping (ø330mm Reel)
L	Embossed Taping (ø180mm Reel)
В	Bulk

## Meets 6A, T-type filter with built-in ferrite bead.



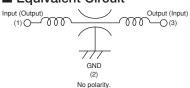
#### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	8000
В	Packing in Bulk	500





**■** Equivalent Circuit



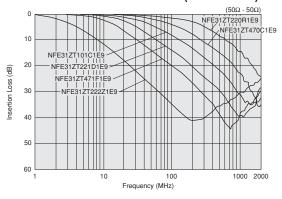
Refer to pages from p.96 to p.100 for mounting information.

### ■ Rated Value (□: packaging code)

Part N	umber	Canacitanas	Capacitance Rated Current R		Insulation	Operating
For Infotainment	For Powertrain/Safety	Сараспансе	nateu Current	Rated Voltage	Resistance (min.)	Temperature Range
NFE31ZT220R1E9□	_	22pF ±30%	6A	25Vdc	1000ΜΩ	-40°C∼+85°C
NFE31ZT470C1E9□	_	47pF 50/-20%	6A	25Vdc	1000ΜΩ	-40°C∼+85°C
NFE31ZT101C1E9□	_	100pF 80/-20%	6A	25Vdc	1000ΜΩ	-40°C∼+85°C
NFE31ZT221D1E9□	_	220pF 50/-20%	6A	25Vdc	1000ΜΩ	-40°C∼+85°C
NFE31ZT471F1E9	_	470pF 50/-20%	6A	25Vdc	1000MΩ	-40°C∼+85°C
NFE31ZT222Z1E9	_	2200pF ±50%	6A	25Vdc	1000ΜΩ	-40°C∼+85°C

Number of Circuit: 1

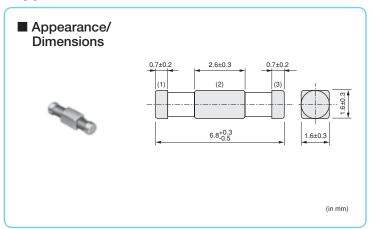
#### ■ Insertion Loss Characteristics (Main Items)



#### **Power lines · Signal lines Universal Type**

# FE61 H | Series 2706/6816 (inch/mm)

## T-type filter with built-in ferrite bead.

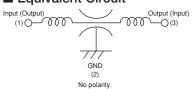


#### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2500
K	ø330mm Embossed Taping	8000
В	Packing in Bulk	500



#### **■** Equivalent Circuit



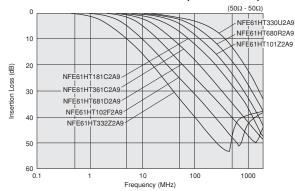
Refer to pages from p.96 to p.100 for mounting information.

#### ■ Rated Value (□: packaging code)

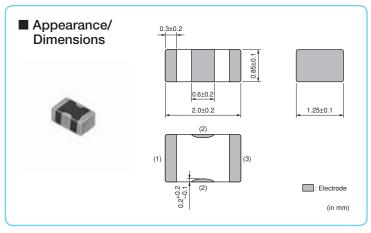
<b>=</b> 1.000 70.00 (⊏	Triated value ( packaging code)							
Part N	Part Number		Rated Current	Rated Voltage	Insulation	Operating		
For Infotainment	For Powertrain/Safety	Capacitance	riated Carrent	riated voltage	Resistance (min.)	Temperature Range		
_	NFE61HT330U2A9□	33pF ±30%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT680R2A9□	68pF ±30%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT101Z2A9□	100pF ±30%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT181C2A9□	180pF ±30%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT361C2A9□	360pF ±20%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT681D2A9□	680pF ±30%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT102F2A9□	1000pF 80/-20%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		
_	NFE61HT332Z2A9□	3300pF 80/-20%	2A	100Vdc	1000ΜΩ	-55°C∼+125°C		

Number of Circuit: 1

#### ■ Insertion Loss Characteristics (Main Items)



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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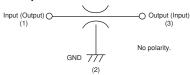


### ■ Packaging Packaging





#### ■ Equivalent Circuit



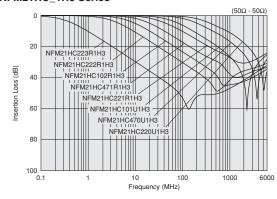
Refer to pages from p.96 to p.100 for mounting information.

■ Rated Value (□: packaging code)

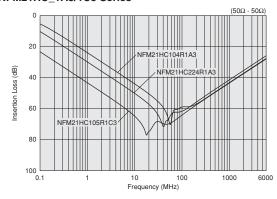
Part N	lumber	Capacitance	Rated Current	Rated Voltage	Insulation	Operating
For Infotainment	For Powertrain/Safety	Сараспансе	nated Current	nateu voitage	Resistance (min.)	Temperature Range
_	NFM21HC220U1H3□	22pF ±20%	700mA	50Vdc	$1000 M\Omega$	-55°C∼+125°C
_	NFM21HC470U1H3	47pF ±20%	700mA	50Vdc	1000MΩ	-55°C∼+125°C
_	NFM21HC101U1H3	100pF ±20%	700mA	50Vdc	$1000 M\Omega$	-55°C∼+125°C
_	NFM21HC221R1H3□	220pF ±20%	700mA	50Vdc	1000MΩ	-55°C∼+125°C
_	NFM21HC471R1H3□	470pF ±20%	1000mA	50Vdc	$1000M\Omega$	-55°C∼+125°C
_	NFM21HC102R1H3□	1000pF ±20%	1000mA	50Vdc	1000MΩ	-55°C∼+125°C
_	NFM21HC222R1H3□	2200pF ±20%	1000mA	50Vdc	$1000 M\Omega$	-55°C∼+125°C
_	NFM21HC223R1H3□	22000pF ±20%	2000mA	50Vdc	1000MΩ	-55°C∼+125°C
_	NFM21HC104R1A3	100000pF ±20%	2000mA	10Vdc	1000MΩ	-55°C∼+125°C
_	NFM21HC224R1A3	220000pF ±20%	2000mA	10Vdc	1000ΜΩ	-55°C∼+125°C
_	NFM21HC105R1C3□	1000000pF ±20%	4000mA	16Vdc	500MΩ	-55°C∼+125°C

Number of Circuit: 1

#### ■ Insertion Loss Characteristics (Main Items) NFM21HC\_1H3 Series



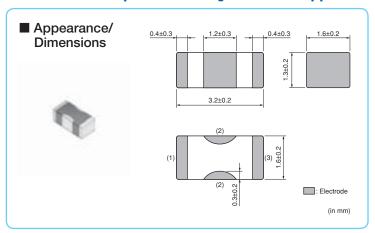
#### NFM21HC\_1A3/1C3 Series



#### **Power lines · Signal lines Universal Type**

# NFM31HK Series 1206/3216 (inch/mm)

### The 3-terminal capacitor has a good noise suppression effect at a high frequency range, meets 10A.

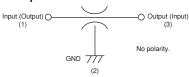


### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
В	Packing in Bulk	500



#### **■** Equivalent Circuit



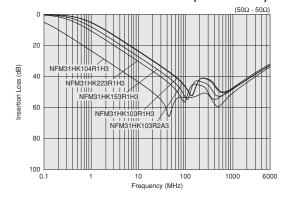
Refer to pages from p.96 to p.100 for mounting information.

#### ■ Rated Value (□: packaging code)

Part I	Part Number		Potod Current	Rated Voltage	Insulation	Operating	
For Infotainment	For Powertrain/Safety	Capacitance	nated Current	nateu voitage	Resistance (min.)	Temperature Range	
_	NFM31HK103R1H3□	10000pF ±20%	10A	50Vdc	1000MΩ	-55°C∼+125°C	
_	NFM31HK103R2A3□	10000pF ±20%	10A	100Vdc	1000ΜΩ	-55°C∼+125°C	
_	NFM31HK153R1H3□	15000pF ±20%	10A	50Vdc	1000MΩ	-55°C∼+125°C	
_	NFM31HK223R1H3□	22000pF ±20%	10A	50Vdc	1000ΜΩ	-55°C∼+125°C	
_	NFM31HK104R1H3□	100000pF ±20%	6A	50Vdc	1000ΜΩ	-55°C∼+125°C	

Number of Circuit: 1

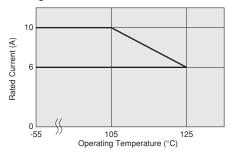
#### ■ Insertion Loss Characteristics (Main Items)



#### ■ Derating of Rated Current

When NFM31HK series is used in operating temperatures exceeding +105°C, derating of current is necessary. Please apply the derating curve shown in chart according to the operating temperature.

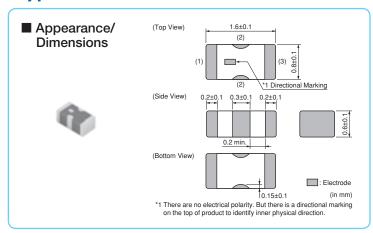
#### **Derating of Rated Current**



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# NFL18ZT Series 0603/1608 (inch/mm)

## T-type LC filter. Reduces waveform distortion of high speed signal.

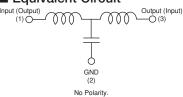


### ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
В	Packing in Bulk	1000



#### ■ Equivalent Circuit



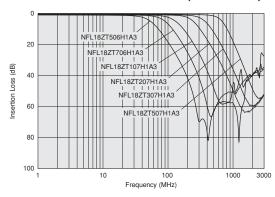
Refer to pages from p.96 to p.100 for mounting information.

### ■ Rated Value (□: packaging code)

= Hatou Value (E. paekaging code)								
Part Number		Nominal Cut-off Capa	Capacitance	Inductance	Rated	Rated	Insulation Resistance	Withstand
For Infotainment	For Powertrain/Safety	Frequency			Current	Voltage	(min.)	Voltage
NFL18ZT506H1A3	_	50MHz	110pF (Typ.)	350nH (Typ.)	75mA	10Vdc	1000ΜΩ	30Vdc
NFL18ZT706H1A3	_	70MHz	70pF (Typ.)	230nH (Typ.)	75mA	10Vdc	1000ΜΩ	30Vdc
NFL18ZT107H1A3	_	100MHz	50pF (Typ.)	150nH (Typ.)	75mA	10Vdc	$1000M\Omega$	30Vdc
NFL18ZT207H1A3	_	200MHz	22pF (Typ.)	110nH (Typ.)	100mA	10Vdc	1000MΩ	30Vdc
NFL18ZT307H1A3	_	300MHz	16pF (Typ.)	74nH (Typ.)	100mA	10Vdc	1000MΩ	30Vdc
NFL18ZT507H1A3	_	500MHz	10pF (Typ.)	42nH (Typ.)	100mA	10Vdc	1000MΩ	30Vdc

Operating Temperature Range: -55°C~+125°C Number of Circuits: 1

#### ■ Insertion Loss Characteristics (Main Items)



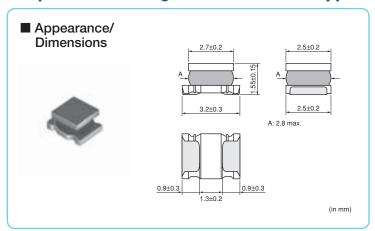
⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



#### **Power lines · Signal lines Universal Type**

# NFZ32BW\_10<sub>Series 1210/3225 (inch/mm)</sub>

## For power lines · signal lines universal type, 1210 size, noise suppression filters.



#### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500



#### **■** Equivalent Circuit



(Resistance element becomes dominant at high frequencies.)

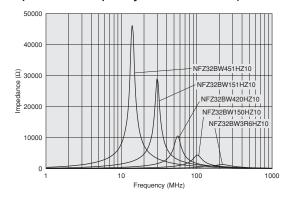
Refer to pages from p.96 to p.100 for mounting information.

#### ■ Rated Value (□: packaging code)

■ hated value (□.	packaging code)						
Part No		Impedance	Impedance	Rated *	DC	Operating Temperature Range	Operating Temperature
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1MHz/20°C)	Current	Resistance	(Self-temperature rise is included)	Range
NFZ32BW3R6HZ10□	_	-	3.6Ω ±30%	2550mA	$0.03\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW7R4HZ10□	_	-	7.4Ω ±30%	2050mA	$0.045\Omega{\pm}20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW9R0HZ10□	_	-	9.0Ω ±30%	1750mA	$0.057 \Omega \pm 20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW150HZ10□	_	-	15Ω ±30%	1600mA	$0.076\Omega \pm 20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW210HZ10□	_	-	21Ω ±30%	1200mA	$0.12\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW320HZ10□	_	-	32Ω ±30%	1000mA	0.18Ω±20%	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW420HZ10□	_	-	42Ω ±30%	850mA	$0.24\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW700HZ10□	_	-	70Ω ±30%	700mA	$0.38\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW111HZ10□	_	-	110Ω ±30%	520mA	$0.57\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW151HZ10□	_	-	150Ω ±30%	450mA	$0.81\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW221HZ10□	_	-	220Ω ±30%	390mA	1.15Ω±20%	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW291HZ10□	_	-	290Ω ±30%	310mA	1.78Ω±20%	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW451HZ10□	_	-	450Ω ±30%	275mA	$2.28\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW621HZ10□	_	-	620Ω ±30%	250mA	2.7Ω±20%	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW881HZ10□	_	-	880Ω ±30%	200mA	$4.38\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C

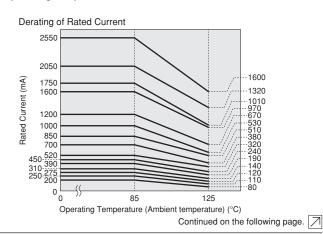
Number of Circuits: 1

#### ■ Impedance-Frequency Characteristics (Main Items)



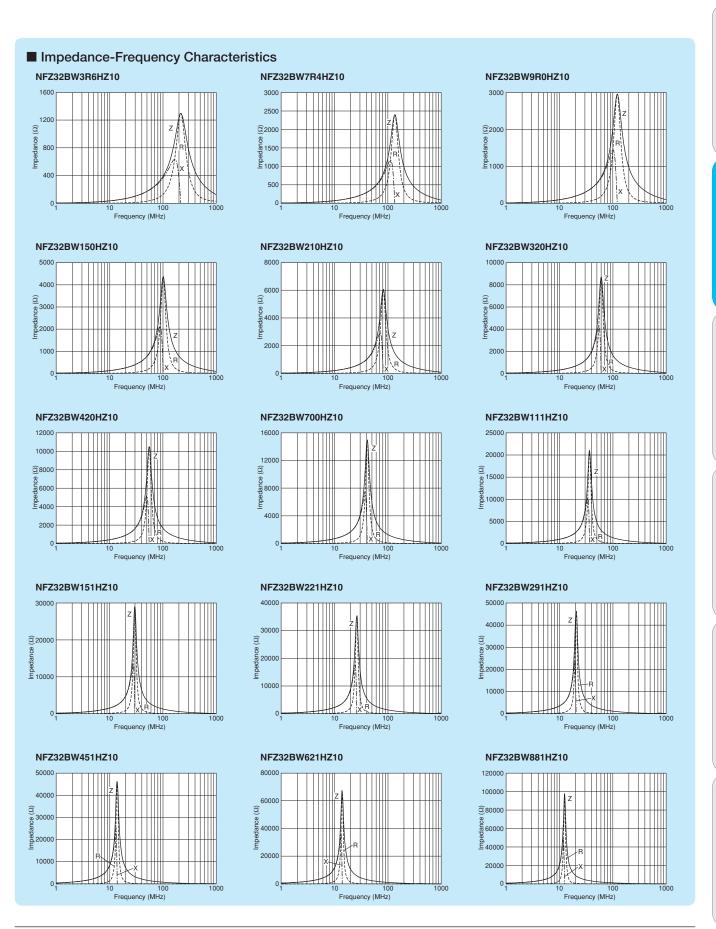
#### ■ Derating of Rated Current

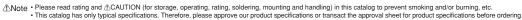
In operating temperature exceeding +85°C, derating of current is necessary for NFZ32BW\_H□10 series. Please apply the derating curve shown in chart according to the operating temperature.



<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

When Rated Current is applied to the Products, self-generation of heat will rise to 40°C or less.



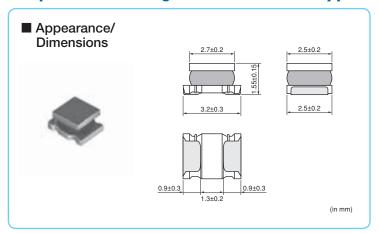




#### **Power lines · Signal lines Universal Type**

## Series 1210/3225 (inch/mm)

## For power lines · signal lines universal type, 1210 size, noise suppression filters.



#### ■ Packaging

Code	Packaging	Minimum Quantity	
L	ø180mm Embossed Taping	2000	
K	ø330mm Embossed Taping	7500	



#### **■** Equivalent Circuit



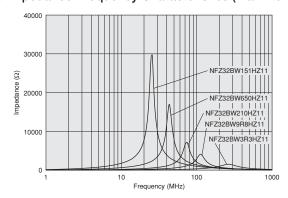
(Resistance element becomes dominant at high frequencies.)

Refer to pages from p.96 to p.100 for mounting information.

### ■ Rated Value (□: packaging code)

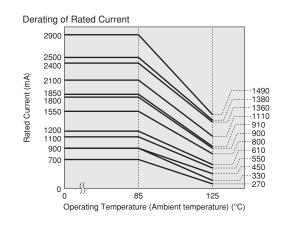
Part N	Part Number		Impedance	Rated *	DC	Operating Temperature Range	Operating Temperature
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	(at 1MHz/20°C)	Current	Resistance	(Self-temperature rise is included)	Range
NFZ32BW3R3HZ11□	_	-	3.3Ω ±30%	2900mA	$0.024\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW6R8HZ11□	_	-	6.8Ω ±30%	2500mA	$0.036\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW8R4HZ11□	_	-	8.4Ω ±30%	2400mA	$0.048\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW9R8HZ11□	_	-	9.8Ω ±30%	2100mA	$0.053\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW120HZ11□	_	-	12Ω ±30%	1850mA	$0.064\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW190HZ11□	_	-	19Ω ±30%	1800mA	$0.089\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW210HZ11□	_	-	21Ω ±30%	1550mA	$0.100\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW310HZ11□	_	-	31Ω ±30%	1200mA	$0.155\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW520HZ11□	_	-	52Ω ±30%	1100mA	$0.220\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW650HZ11□	_	-	65Ω ±30%	900mA	$0.295\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW101HZ11□	_	-	100Ω ±30%	900mA	$0.475\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C
NFZ32BW151HZ11□	_	-	150Ω ±30%	700mA	$0.685\Omega\pm20\%$	-40°C∼+125°C	-40°C∼+105°C

#### ■ Impedance-Frequency Characteristics (Main Items)



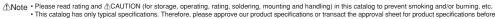
#### ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for NFZ32BW\_H□11 series. Please apply the derating curve shown in chart according to the operating temperature.



Continued on the following page.



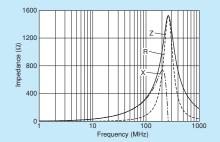




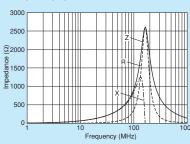
<sup>\*</sup> When Rated Current is applied to the Products, self-generation of heat will rise to 40°C or less.

#### **■** Impedance-Frequency Characteristics

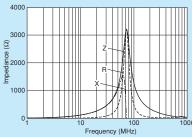
#### NFZ32BW3R3HZ11



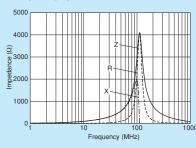
#### NFZ32BW6R8HZ11



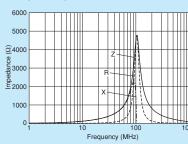
### NFZ32BW8R4HZ11



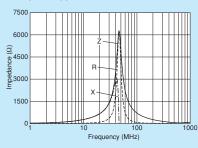
#### NFZ32BW9R8HZ11



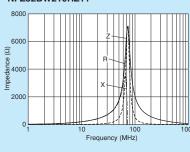
#### NFZ32BW120HZ11



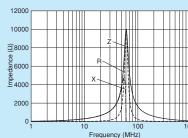
#### NFZ32BW190HZ11



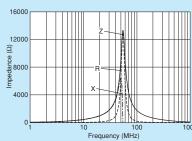
#### NFZ32BW210HZ11



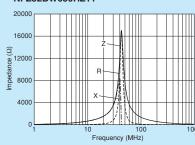
#### NFZ32BW310HZ11



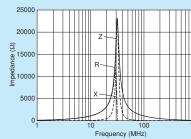
#### NFZ32BW520HZ11



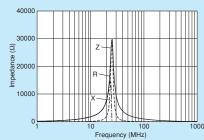
#### NFZ32BW650HZ11



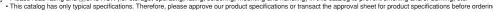
#### NFZ32BW101HZ11



#### NFZ32BW151HZ11



<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.





### **<b>∆**Caution

#### Rating

- 1. About the Rated Current
  - Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.
- 2. About the Excessive Surge Current (NFZ Series) Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

#### Soldering and Mounting

1. Self-heating

Please provide special attention when mounting chip EMIFIL® NFM□□H series in close proximity to other products that radiate heat.

The heat generated by other products may deteriorate the insulation resistance and cause excessive heat in this component.

Worst case, results to a short circuit which causes fuming or partial dispersion when the product is used.

2. Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure our product.

#### **Notice**

#### Storage and Operating Conditions

<Operating Environment>

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

Do not use products in the environment close to the organic solvent.

<Storage and Handling Requirements>

- 1. Storage Period The NF series should be used within 12 months. Products to be used after this period should be checked for solderability or bondability with glue.
- 2. Storage Conditions
- (1) Storage temperature: -10 to +40°C Relative humidity: 15 to 85% Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

#### Notice (Soldering and Mounting)

1. Cleaning

Failure and degradation of a product are caused by the cleaning method. When you clean in conditions that are not in mounting information, please contact Murata engineering.

2. Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.

- 3. Points of Attention about NFM Pattern Forms The loaded stresses are different to a chip depend on PCB materials and structures. When the chip will be mounted on the metal PCB contained alumina material. PCB heat expansion/contraction will be a cause of chip cracks because the coefficients of thermal expressions are different between metal PCB and the chip itself.
- 4. Other

Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.





#### Handling

1. Resin Coating (Except for NFZ Series) Using resin for coating/molding products may affect the products performance.

So please pay careful attention in selecting resin. Prior to use, please make the reliability evaluation with the product mounted in your application set. Resin Coating (NFZ\_W Series)

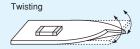
To prevent breaking the wire, avoid touching with sharp material, such as tweezers or other material such as bristles of cleaning brush, to the wire wound portion of this product. To prevent breaking the core, avoid applying excessive mechanical shock to products mounted on the board. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resins containing impurities or chloride may possibly.

2. Handling of a Substrate After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the Product.







# Chip EMIFIL® Soldering and Mounting

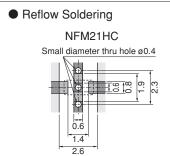
#### 1. Standard Land Pattern Dimensions

NF series suppress noise by conducting the high-frequency noise element to ground. Therefore, to obtain maximum performance from these filters, the ground pattern should be made as large as possible during the PCB design stage. As shown below, one side of the PCB is used for chip mounting, and the other is used for grounding.

Small diameter feedthrough holes are then used to connect the grounds on each side of the PCB. This reduces the high-frequency impedance of the grounding and maximizes the filter's performance.



NFM21HC



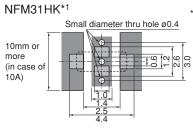
The chip EMI filter suppresses noise by conducting the high-frequency noise to ground. Therefore, to get enough noise reduction, feed through holes which are connected to ground-plane should be arranged according to the figure to reinforce the ground pattern. NFM21HC is specially adapted for reflow soldering.

Please contact us if using thinner land pad than 18µm.

NFM31HK

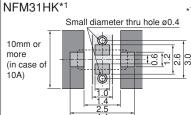
#### Reflow Soldering

Chip mounting side



\*1 For large current design, width of signal land pattern should be wider not less than 1mm per 1A (1mm/A). For example, in case of 10A, signal land pattern width should be 10mm or more. (1mm/A\*10A=10mm)

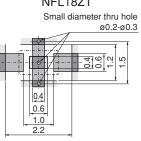
#### Flow Soldering Chip mounting side



\*1 For large current design, width of signal land pattern should be wider not less than 1mm per 1A (1mm/A). For example, in case of 10A, signal land pattern width should be 10mm or more. (1mm/A\*10A=10mm)

NFL18ZT

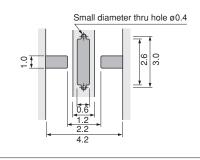
#### Reflow Soldering NFL18ZT



Please contact us if using thinner land pad than  $18\mu m$ .

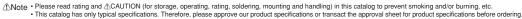
NFE31ZT

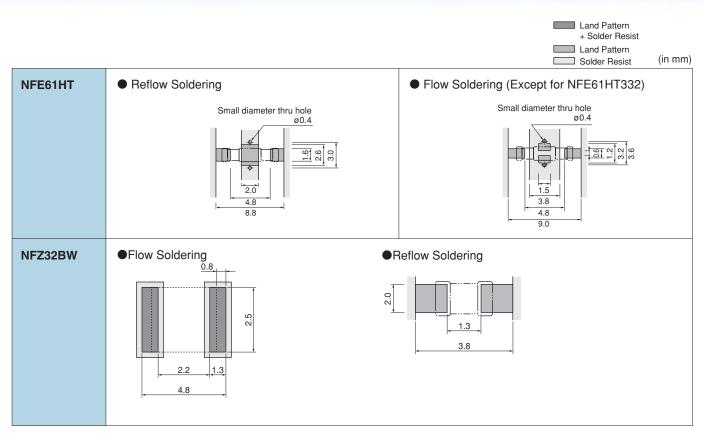
#### Reflow Soldering NFE31ZT



Continued on the following page.





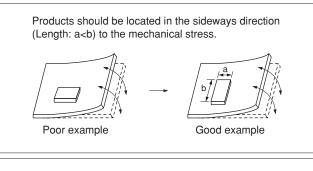


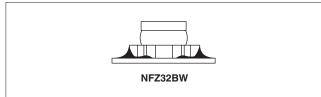
(1) PCB Warping PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.

#### (2) Amount of Solder Paste

Excessive solder causes electrode corrosion, while insufficient solder causes low electrode bonding strength. Adjust the amount of solder paste as shown on the right so that solder is applied.

- Guideline of solder paste thickness
- · NFZ32BW: 100 to 150µm





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#### 2. Solder Paste Printing and Adhesive Application

When reflow soldering the chip EMI suppression filter, the printing must be conducted in accordance with the following cream solder printing conditions.

If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack.

Standard land dimensions should be used for resist and copper foil patterns.

When flow soldering the EMI suppression filter, apply the adhesive in accordance with the following conditions. If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering process.

(in mm)

Series	Solder Paste Printing	Adhesive Application
NFM21HC NFM31HK	●Guideline of solder paste thickness: 100-150µm: NFM21HC/31HK	■ NFM31HK Series Apply 0.06mg of bonding agent at each chip. Do not cover electrodes.
	NFM21HC NFM31HK	Bonding agent  Coating position of bonding agent
NFL18ZT	●Guideline of solder paste thickness: 100-150µm	
NFE31ZT	•Guideline of solder paste thickness: 150-200μm	
NFE61HT	•Guideline of solder paste thickness: 150-200μm	Apply 1.0mg of bonding agent at each chip.  Bonding agent  * Except for NFE61HT332

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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

#### 3. Standard Soldering Conditions

#### (1) Soldering Methods

Use flow and reflow soldering methods only. Use standard soldering conditions when soldering chip EMI suppression filters.

In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder. Use of Sn-Zn based solder will deteriorate performance of products. If using NFM series with Sn-Zn based solder, please contact Murata in advance.

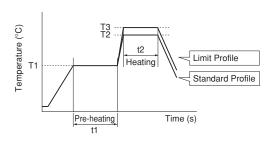
#### Flux:

- Use Rosin-based flux. In case of using RA type solder, products should be cleaned completely with no residual flux.
- Do not use strong acidic flux (with chlorine content exceeding 0.20wt%)
- Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

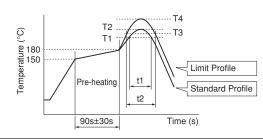
#### (2) Soldering Profile

Flow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



	Pre-heating -		Sta	andard Profile	•	Limit Profile		
Series			Heating		Cycle	Heating		Cycle
	Temp. (T1)	Time. (t1)	Temp. (T2)	Time. (t2)	of Flow	Temp. (T3)	Time. (t2)	of Flow
NFM31HK	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.
NFE61HT (Except for NFE61HT332)	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.
NFZ32BW	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	1 time

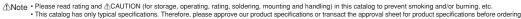
 Reflow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)

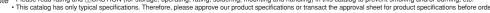


		Standar	d Profile		Limit Profile			
Series	Heating		Peak Temperature	Cycle	Heating		Peak Temperature	Cycle
	Temp. (T1)	Time. (t1)	(T2)	of Reflow	Temp. (T3)	Time. (t2)	(T4)	of Reflow
NFM21HC NFM31HK	220°C min.	30 to 60s	245±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.
NFE31ZT NFE61HT NFL18ZT	220°C min.	30 to 60s	245±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.
NFZ32BW	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.

Continued on the following page.









(3) Reworking with Solder Iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating: 150°C 60s min.

Soldering iron power output / Tip diameter:

30W max. / ø3mm max.\*1

\*1 NFZ32: 80W max. / ø3mm max.

Temperature of soldering iron tip / Soldering time / Times:

350°C max. / 3-4s / 2 times

Do not allow the tip of the soldering iron to directly contact the chip.

For additional methods of reworking with a soldering iron, please contact Murata engineering.

#### 4. Cleaning

Following conditions should be observed when cleaning chip EMI filter.

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol type cleaner)
- (2) Ultrasonic

Output: 20W/liter max. Duration: 5 minutes max. Frequency: 28 to 40kHz

Care should be taken not to cause resonance of the PCB and mounted products.

(3) Cleaning Agent

The following list of cleaning agents have been tested on the individual components. Evaluation of final assembly should be completed prior to production.

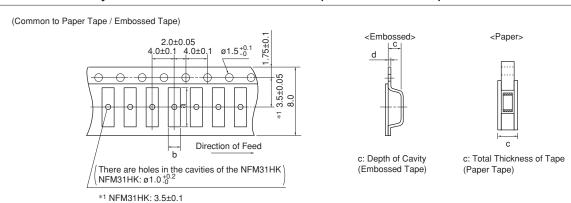
- (a) Alcohol cleaning agent Isopropyl alcohol (IPA)
- (b) Aqueous cleaning agent Pine Alpha ST-100S

(4) Ensure that flux residue is completely removed.

Component should be thoroughly dried after aqueous agent has been removed with deionized water.



#### ■ Minimum Quantity and Dimensions of 8mm Width Paper / Embossed Tape

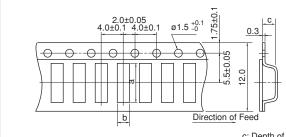


Dimension of the cavity of embossed tape is measured at the bottom side.

	Dimensions				Minimum Qty. (pcs.)					
Part Number					ø180mm Reel		ø330mm Reel			
	а	b	С	d	Paper Tape	Embossed Tape	Paper Tape	Embossed Tape	Bulk	
NFL18ZT	1.85	1.05	0.9 max.	-	4000	-	-	-	1000	
NFM21HC	2.3	1.55	1.1 max.	-	4000	-	-	-	500	
NFM31HK	3.5	1.9	1.5	0.25	-	3000	-	-	500	
NFE31ZT	3.6	1.8	1.85	0.2	-	2000	-	8000	500	
NFZ32BW	2.9	3.6	1.7	0.2	-	2000	-	7500	-	

(in mm)

#### ■ Minimum Quantity and Dimensions of 12mm Width Embossed Tape



Part Number	Dir	nensic	ns	ns Minimum Qty. (pcs.)			
Part Number	а	b	С	ø180mm Reel	ø330mm Reel	Bulk	
NFE61HT	7.2	1.9	1.75	2500	8000	500	

c: Depth of Cavity

Dimension of the cavity is measured at the bottom side.

(in mm)



<sup>&</sup>quot;Minimum Quantity" means the number of units of each delivery or order. The quantity should be an integral multiple of the "Minimum Quantity."

### (Part Number) Z

## Product ID

Product ID	
DL	Chip Common Mode Choke Coils

#### 2Structure

Code	Structure
W	Wire Wound Type
M	Multilayer Type

#### 3Dimensions (LXW)

Code	Dimensions (L×W)	EIA
11	1.25×1.0mm	0504
21	2.0×1.2mm	0805
31	3.2×1.6mm	1206
43	4.5×3.2mm	1812
5A	5.0×3.6mm	2014
5B	5.0×5.0mm	2020

#### 4 Features (1)

Code	Туре
S	Magnetically Shielded One Circuit Type
Т	One Circuit Low Profile Type

#### **5**Category (**DLW** Series)

Code	Category	
Z	For Automotive	Infotainment
Н		Powertrain, Safety

#### **5**Category (**DLM** Series)

Code	Category
N	For General

Typical impedance at 100MHz is expressed by three figures. The unit is in ohm  $(\Omega)$ . The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

#### 6 Inductance (DLW43SH)

Expressed by three figures. The unit is micro-henry ( $\mu H$ ). The first and second figures are significant digits, and the third figure expresses the number of zeros which follow the two figures.

#### Circuit

Code	Circuit
s	
M	
Н	Expressed by a letter.
Т	
Х	

#### 8 Features (2) (DLW Series)

Code	Features	
K		
Р	Expressed by a letter.	
Q		

#### 8 Features (2) (DLM Series)

	, , , , , , , , , , , , , , , , , , ,	
Code	Features	
Z	For Automotive	Infotainment

#### Number of Signal Lines

Code	Number of Signal Lines
2	Two Lines

<b>U</b> uokaging				
Code Packaging		Packaging	Series	
	K	Embossed Taping (ø330mm Reel)	DLW43S/DLW5AT/DLW5BS/DLW5BT	
	L	Embossed Taping (ø180mm Reel)	All Series	
	В	Bulk	All Series	



(Part Number) PL T 10H H 102 6R0 P N B

# Product ID Product ID PL Common Mode Choke Coils

# ☑Type Code Type T DC Type

3 Applications	
Code	Applications
10H	For DC Line High-frequency Type
5BP	5.0×5.0mm Size, for DC Lines

4Features (1)			
Code	Features		
Н	For Automotive	Powertrain, Safety	

#### 6 Impedance

Expressed by three figures. The unit is ohm  $(\Omega)$ . The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

#### **6**Rated Current

Expressed by three figures. The unit is ampere (A). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures. A decimal point is expressed by the capital letter "R." In this case, all figures are significant digits.

#### **7** Features (2)

Code	Features	
Р	Expressed by a letter.	
S		

#### **8**Lead Dimensions

Code	Lead Dimensions
N	No Lead Terminal (SMD)

#### Packaging

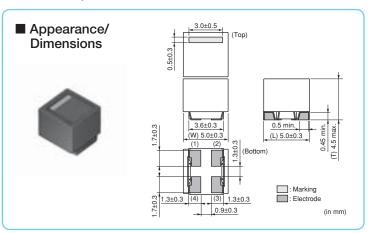
Code Packaging		Series
В	Bulk	PLT10H, PLT5BP
L	Embossed Taping (ø178mm/ø180mm Reel)	PLT10H, PLT5BP
K	Embossed Taping (ø330mm Reel)	PLT10H

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### 2020 size, wire-wound common mode choke coil for power lines.



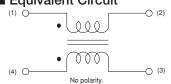
■ Packaging

Code	Packaging	Minimum Quantity		
L	ø180mm Embossed Taping	400		
K	ø330mm Embossed Taping	1500		
В	Packing in Bulk	100		

AEC-Q200



■ Equivalent Circuit



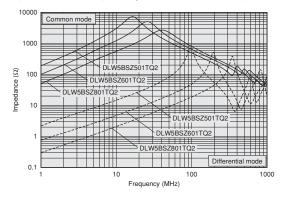
Refer to pages from p.117 to p.120 for mounting information.

■ Rated Value (□: packaging code)

Part Number		Common Mode Impedance	Common Mode Impedance	Rated	Rated	Insulation Resistance	Withstand	DC
For Infotainment	For Powertrain/Safety	(at 10MHz/20°C)	(at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance
DLW5BSZ501TQ2□	_	2800Ω ±40%	500Ω (Typ.)	0.7A	50Vdc	10ΜΩ	125Vdc	0.23 Ω max.
DLW5BSZ601TQ2□	_	1200Ω ±40%	600Ω (Typ.)	1.0A	50Vdc	10ΜΩ	125Vdc	0.12Ω max.
DLW5BSZ801TQ2□	_	550Ω ±40%	800Ω (Typ.)	1.5A	50Vdc	10ΜΩ	125Vdc	$0.056\Omega$ max.

Operating Temperature Range: -40°C~+105°C Number of Circuit: 1

#### ■ Impedance-Frequency Characteristics (Main Items)





■ Appearance/

**Dimensions** 

DLW5AT\_TQ2

■ Appearance/

**Dimensions** 

DLW5BT\_TQ2

# DLW5BT<sub>Series</sub> (105°C available type)

### Low profile wire-wound common mode choke coil for power lines.

0.5 min.

0.5 min.

(L) 5.0±0.3

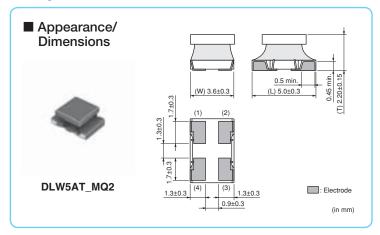
: Marking

: Electrode

(in mm)

: Electrode

(in mm)



(W) 3.6±0.3

1.3±0.3

0.5±0.3

1.3±0.3 (4)

3.6±0.3

1.3±0.3

0.9±0.3

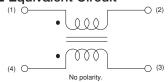
### ■ Packaging

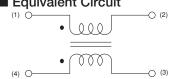
Code	Packaging	Minimum Quantity		
L	ø180mm Embossed Taping	700		
K	ø330mm Embossed Taping	2500		
В	Packing in Bulk	100		





■ Equivalent Circuit



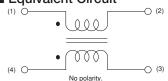


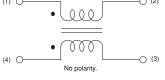


Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	700
K	ø330mm Embossed Taping	2500
В	Packing in Bulk	100









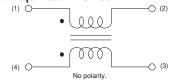
#### ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	700
K	ø330mm Embossed Taping	2500
В	Packing in Bulk	100





### ■ Equivalent Circuit



Refer to pages from p.117 to p.120 for mounting information.

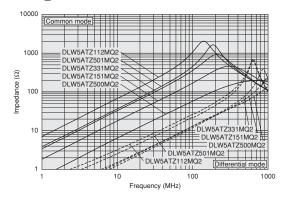
■ Rated Value (□: packaging code)

Part Number		Common Mode	Rated	Rated	Insulation Resistance	Withstand	DC
For Infotainment	For Powertrain/Safety	Impedance (at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance
DLW5ATZ500MQ2	_	50Ω (Typ.)	4A	50Vdc	10ΜΩ	125Vdc	0.013Ω max.
DLW5ATZ151MQ2	_	150Ω (Typ.)	3A	50Vdc	10ΜΩ	125Vdc	0.020 Ω max.
DLW5ATZ331MQ2□	_	330Ω (Typ.)	2.5A	50Vdc	10ΜΩ	125Vdc	0.027Ω max.
DLW5ATZ501MQ2	_	500Ω (Typ.)	2A	50Vdc	10ΜΩ	125Vdc	0.034Ω max.
DLW5ATZ112MQ2	_	1100Ω (Typ.)	1.5A	50Vdc	10ΜΩ	125Vdc	0.056Ω max.
DLW5ATZ450TQ2	_	45Ω (Typ.)	4A	50Vdc	10ΜΩ	125Vdc	0.013Ω max.
DLW5ATZ111TQ2	_	110Ω (Typ.)	3A	50Vdc	10ΜΩ	125Vdc	0.020 Ω max.
DLW5ATZ231TQ2	_	230Ω (Typ.)	2.5A	50Vdc	10ΜΩ	125Vdc	0.027Ω max.
DLW5ATZ401TQ2	_	400Ω (Typ.)	2A	50Vdc	10ΜΩ	125Vdc	0.034Ω max.
DLW5ATZ501TQ2	_	500Ω (Typ.)	1.5A	50Vdc	10ΜΩ	125Vdc	0.056Ω max.
DLW5BTZ101TQ2	_	100Ω (Typ.)	4A	50Vdc	10ΜΩ	125Vdc	0.013Ω max.
DLW5BTZ251TQ2□	_	250Ω (Typ.)	3A	50Vdc	10ΜΩ	125Vdc	0.020 Ω max.
DLW5BTZ501TQ2□	_	500Ω (Typ.)	2.5A	50Vdc	10ΜΩ	125Vdc	0.027Ω max.
DLW5BTZ102TQ2□	_	1000Ω (Typ.)	2A	50Vdc	10ΜΩ	125Vdc	0.034Ω max.
DLW5BTZ142TQ2□		1400Ω (Typ.)	1.5A	50Vdc	10ΜΩ	125Vdc	0.056Ω max.

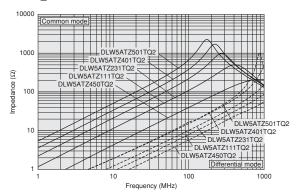
Operating Temperature Range: -40°C~+105°C Number of Circuit: 1

#### ■ Impedance-Frequency Characteristics (Main Items)

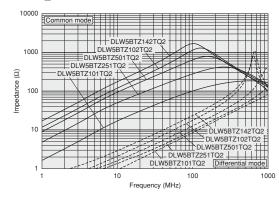
#### DLW5AT\_MQ2 Series



#### DLW5AT\_TQ2 Series

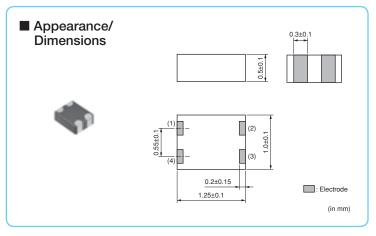


#### DLW5BT\_TQ2 Series



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## 0504 size multilayer type chip common mode choke coil.

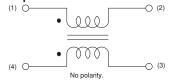


## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	4000
В	Packing in Bulk	500



## ■ Equivalent Circuit



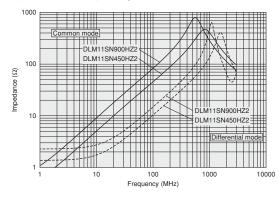
Refer to pages from p.117 to p.120 for mounting information.

## ■ Rated Value (□: packaging code)

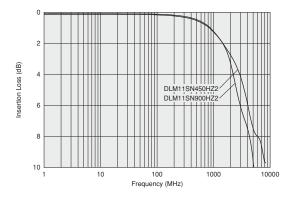
Part Number		Common Mode	Rated	Rated	Insulation Resistance	Withstand	DC
For Infotainment	For Powertrain/Safety	Impedance (at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance
DLM11SN450HZ2	_	45Ω ±25%	100mA	5Vdc	100ΜΩ	12.5Vdc	0.7Ω±25%
DLM11SN900HZ2	_	90Ω ±25%	100mA	5Vdc	100ΜΩ	12.5Vdc	1.1Ω±25%

Operating Temperature Range: -55°C~+125°C Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items)



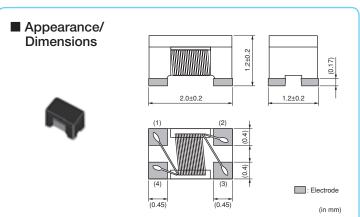
## ■ Differential Mode Transmission Characteristics (Typ.)



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# DLW215 Series 0805/2012 (inch/mm)

## 0805 size, wire-wound common mode choke coil for high speed signal line.



■ Packaging								
	Code	Packaging	Mir Qu					
	L	ø180mm Embossed Taping	2					

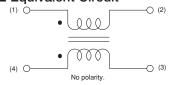
Packing in Bulk



500



■ Equivalent Circuit



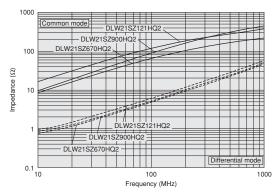
Refer to pages from p.117 to p.120 for mounting information.

## ■ Rated Value (□: packaging code)

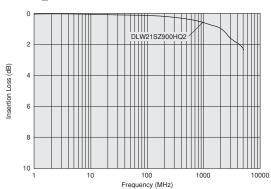
Part Number		Common Mode Impedance	Rated	Rated	Insulation Resistance	Withstand	DC	
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance	
DLW21SZ670HQ2□	_	67Ω ±25%	320mA	20Vdc	10ΜΩ	50Vdc	0.31 Ω max.	
DLW21SZ900HQ2□	_	90Ω ±25%	280mA	20Vdc	10ΜΩ	50Vdc	0.41 Ω max.	
DLW21SZ121HQ2	_	120Ω ±25%	280mA	20Vdc	10ΜΩ	50Vdc	0.41 Ω max.	

Operating Temperature Range: -40°C~+105°C Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items) DLW21SZ\_HQ2 Series



## ■ Differential Mode Transmission Characteristics (Typ.) DLW21SZ\_HQ2 Series



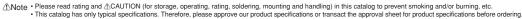
## ■ Rated Value (□: packaging code)

Part Number		Common Mode Impedance	Rated	Rated	Insulation Resistance	Withstand	DC
For Infotainment	For Powertrain/Safety	(at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance
DLW21SZ181XQ2	_	180Ω ±25%	240mA	20Vdc	10ΜΩ	50Vdc	0.39 Ω max.
DLW21SZ261XQ2	_	260Ω ±25%	220mA	20Vdc	10ΜΩ	50Vdc	0.59 Ω max.
DLW21SZ491XQ2	_	490Ω ±25%	190mA	20Vdc	10ΜΩ	50Vdc	0.77Ω max.

Operating Temperature Range: -40°C~+105°C Number of Circuit: 1

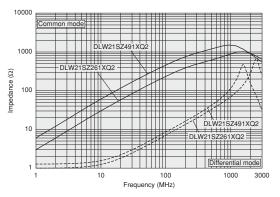
Continued on the following page.  $\begin{tabular}{|c|c|c|c|} \hline \end{tabular}$ 



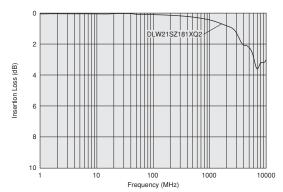




## ■ Impedance-Frequency Characteristics (Main Items) DLW21SZ\_XQ2 Series

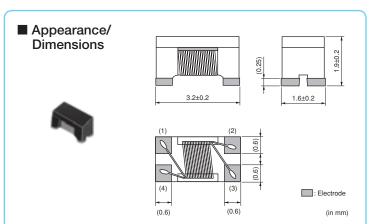


## ■ Differential Mode Transmission Characteristics (Typ.) DLW21SZ\_XQ2 Series



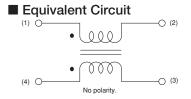
# DLW315<sub>Series 1206/3216 (inch/mm)</sub>

## 1206 size wire-wound common mode choke coil.



■ Packaging							
Code	Packaging	Minimum Quantity					
L	ø180mm Embossed Taping	2000					
В	De elsie er im Deelle	F00					





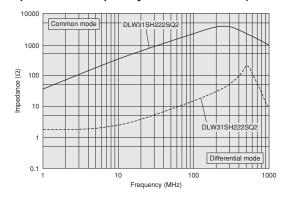
Refer to pages from p.117 to p.120 for mounting information.

## ■ Rated Value (□: packaging code)

	Part Number		Common Mode	Rated	Rated	Insulation Resistance	Withstand	DC
	For Infotainment	For Powertrain/Safety	Impedance (at 100MHz/20°C)	Current	Voltage	(min.)	Voltage	Resistance
Ī	_	DLW31SH222SQ2□	2200Ω ±25%	80mA	32Vdc	10ΜΩ	80Vdc	1.6Ω ±20%

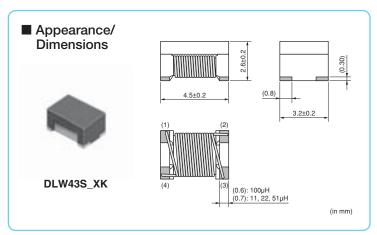
Operating Temperature Range: -40  $^{\circ}$ C  $\sim$ +125  $^{\circ}$ C Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items)





<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

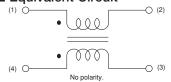


## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	500
K	ø330mm Embossed Taping	2500
В	Packing in Bulk	100



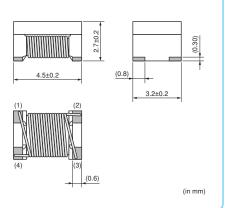




## ■ Appearance/ **Dimensions**



DLW43S\_XP

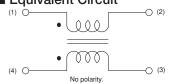


## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	500
K	ø330mm Embossed Taping	2500
В	Packing in Bulk	100



■ Equivalent Circuit



Refer to pages from p.117 to p.120 for mounting information.

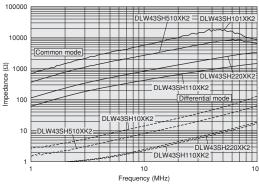
## ■ Rated Value (□: packaging code)

Part Number  For Infotainment For Powertrain/Safety		Common Mode Inductance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Withstand Voltage	DC Resistance
—	DLW43SH110XK2	11µH -30%/+50% (at 0.1MHz)	360mA	50Vdc 10MΩ		125Vdc	0.5Ω max.
_	DLW43SH220XK2	22µH -30%/+50% (at 0.1MHz)	310mA	50Vdc	10ΜΩ	125Vdc	0.6Ω max.
_	DLW43SH510XK2	51µH -30%/+50% (at 1MHz)	230mA	50Vdc	10ΜΩ	125Vdc	1.0Ω max.
_	DLW43SH101XK2	100µH -30%/+50% (at 1MHz)	200mA	50Vdc	10ΜΩ	125Vdc	2.0Ω max.
— DLW43SH101XP2□		100µH -30%/+80% (at 0.1MHz)	170mA	50Vdc	10ΜΩ	125Vdc	2.0Ω max.

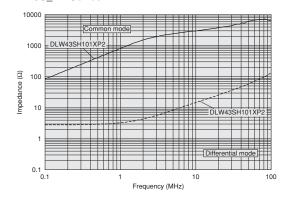
Operating Temperature Range: -40°C~+125°C Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items)

## DLW43S\_XK Series

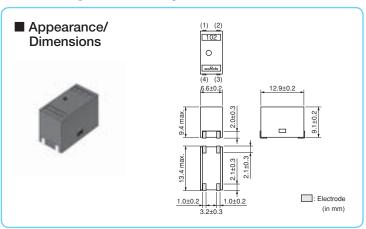


## DLW43S\_XP Series



# PLT10H<sub>Series</sub> (12.9x6.6mm)

## Meets large current up to 18A max.



## Packaging

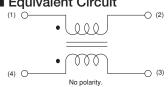
Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	125
K	ø330mm Embossed Taping	500
В	Packing in Bulk	50







■ Equivalent Circuit



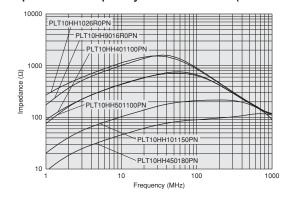
Refer to pages from p.121 to p.122 for mounting information.

## ■ Rated Value (□: packaging code)

Part Number		Common Mode Impedance	Rated	Rated	Insulation Resistance	Withstand	DC Resistance	Inductance
For Infotainment	For Powertrain/Safety	(at 10MHz/20°C)	Current	Voltage	(min.)	Voltage	DO NESISTANCE	muuctance
_	PLT10HH450180PN□	45Ω (Typ.)	18A	300Vdc	10ΜΩ	750Vdc	$1.3 \text{m}\Omega{\pm}0.5 \text{m}\Omega$	0.8µH min.
_	PLT10HH101150PN□	100Ω (Typ.)	15A	300Vdc	10ΜΩ	750Vdc	$1.8 m\Omega\pm0.5 m\Omega$	2.0µH min.
_	PLT10HH401100PN□	400Ω (Typ.)	10A	100Vdc	10ΜΩ	250Vdc	$3.6 m\Omega\pm0.5 m\Omega$	6μH min.
_	PLT10HH501100PN□	500Ω (Typ.)	10A	100Vdc	10ΜΩ	250Vdc	$3.6 m\Omega \pm 0.5 m\Omega$	9μH min.
_	PLT10HH9016R0PN□	900Ω (Typ.)	6A	100Vdc	10ΜΩ	250Vdc	$8.0$ m $\Omega\pm0.5$ m $\Omega$	14µH min.
_	PLT10HH1026R0PN□	1000Ω (Typ.)	6A	100Vdc	10ΜΩ	250Vdc	$8.0 \text{m}\Omega \pm 0.5 \text{m}\Omega$	20μH min.

Operating Temperature Range (Self-temperature rise is included): -55°C~+105°C (PLT10HH 501100/1026R0 PN), -55°C~+125°C (PLT10HH 450180/101150/401100/9016R0 PN) Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items)

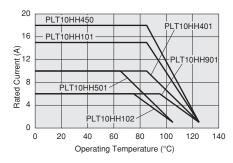


## Derating of Rated Current

In operating temperature exceeding +65°C, derating of current is necessary for PLT10H series.

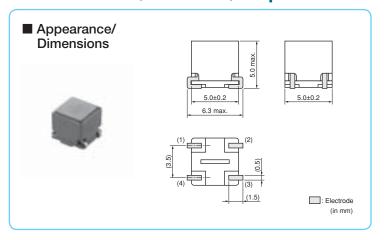
Please apply the derating curve shown in chart according to the operating temperature.

### **Derating of Rated Current**



<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## 150°C available, 2020 size, for power lines.



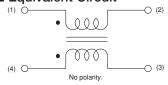
## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	300
В	Packing in Bulk	50





■ Equivalent Circuit



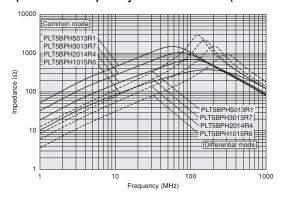
Refer to pages from p.121 to p.122 for mounting information.

## ■ Rated Value (□: packaging code)

	( 1 0 0 7									
Part Number		Common Mode Impedance	Rated	Rated	Insulation Resistance	Withstand	DC Resistance			
For Infotainment	For Powertrain/Safety	(at 10MHz/20°C)	Current	Voltage	(min.)	Voltage				
_	PLT5BPH1015R6SN□	100Ω (Typ.)	5.6A	80Vdc	10ΜΩ	200Vdc	$4m\Omega\pm30\%$			
_	PLT5BPH2014R4SN□	200Ω (Typ.)	4.4A	80Vdc	10ΜΩ	200Vdc	$7m\Omega\pm30\%$			
-	PLT5BPH3013R7SN□	300Ω (Typ.)	3.7A	80Vdc	10ΜΩ	200Vdc	$11m\Omega\pm30\%$			
_	PLT5BPH5013R1SN□	500Ω (Typ.)	3.1A	80Vdc	10ΜΩ	200Vdc	$17m\Omega \pm 30\%$			

Operating Temperature Range: -55°C~+150°C Number of Circuit: 1

## ■ Impedance-Frequency Characteristics (Main Items)

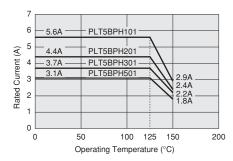


## ■ Derating of Rated Current

In operating temperature exceeding +125°C, derating of current is necessary for PLT5BP series.

Please apply the derating curve shown in chart according to the operating temperature.

## Derating of Rated Current



⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering



#### **DL** Chip Common Mode Choke Coil **⚠** Caution/Notice

## **<b>∴**Caution

## Rating

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance. Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure our product.

## Soldering and Mounting

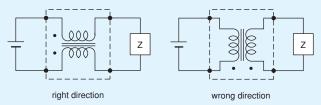
1. Self-heating

Please provide special attention when mounting chip common mode choke coils DLW5 series in close proximity to other products that radiate heat. The heat generated by other products may deteriorate

the insulation resistance and cause excessive heat in

## 2. Mounting Direction

Mount Chip Common Mode Choke Coils in right direction. Wrong direction, which is 90 degrees rotated from right direction, causes not only open or short circuit but also flames or other serious trouble.



## **Notice**

## Storage and Operating Conditions

<Operating Environment>

this component.

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

Do not use products in the environment close to the organic solvent.

<Storage and Handling Requirements>

- 1. Storage Period The DL series should be used within 12 months. Solderability should be checked if this period is exceeded.
- 2. Storage Conditions
- (1) Storage temperature: -10 to +40°C Relative humidity: 15 to 85% Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

## Notice (Soldering and Mounting)

1. Cleaning

Failure and degradation of a product are caused by the cleaning method. When you clean in conditions that are not in mounting information, please contact Murata engineering.

Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.

3. Other

Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercialpurpose equipment design.

## Handling

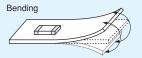
- 1. Resin Coating (Except for DLW Series.) Using resin for coating/molding products may affect the products performance. So please pay careful attention in selecting resin. Prior to use, please make the reliability evaluation with the product mounted in your application set.
- 2. Resin Coating (DLW31S Series) Do not make any resin coating DLW31S series. The impedance value may change due to high cure-stress of resin to be used for coating/molding products.
  - An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit. So, please pay your careful attention in selecting resin in case of coating/molding the products with the resin.
- 3. Resin Coating (Except DLW31S Series) The impedance value may change due to high curestress of resin to be used for coating/molding products. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit. So, please pay your careful attention in selecting resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

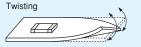
Continued on the following page.





- 4. Caution for Use (DLW Series) When you hold products with a tweezer, please hold by the sides. Sharp materials, such as a pair of tweezers, should not touch the winding portion to prevent breaking the wire. Mechanical shock should not be applied to the products mounted on the board to prevent breaking the core.
- 5. Brushing (DLW21S/DLW31S/DLW43S Series) When you clean the neighborhood of products such as connector pins, bristles of cleaning brush shall not be touched to the winding portion of this product to prevent the breaking of wire.
- 6. Handling of a Substrate After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate. Excessive mechanical stress may cause cracking in the Product.





115

## **∴**Caution

## Rating

- 1. Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.
- Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure our product.

## Soldering and Mounting

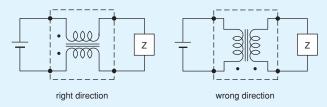
Self-heating

Please provide special attention when mounting chip common mode choke coils in close proximity to other products that radiate heat.

The heat generated by other products may deteriorate the insulation resistance and cause excessive heat in this component.

#### 2. Mounting Direction

Mount Chip Common Mode Choke Coils in right direction. Wrong direction, which is 90 degrees rotated from right direction, causes not only open or short circuit but also flames or other serious trouble.



## **Notice**

## Storage and Operating Conditions

<Operating Environment>

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

Do not use products in the environment close to the organic solvent.

<Storage and Handling Requirements>

1. Storage Period

PLT10H series, PLT5BP series should be used within 12 months.

Solderability should be checked if this period is exceeded.

- 2. Storage Conditions
  - (1) Storage temperature: -10 to +40°C
    Relative humidity: 15 to 85%
    Avaid auddon changes in temperature or

Avoid sudden changes in temperature and humidity.

(2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

## Notice (Soldering and Mounting)

1. Cleaning

Failure and degradation of a product are caused by the cleaning method. When you clean in conditions that are not in mounting information, please contact Murata engineering.

2. Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.

3. Other

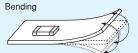
Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.

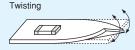
## Handling

1. Handling of a Substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the Product.





 <sup>⚠</sup>Note
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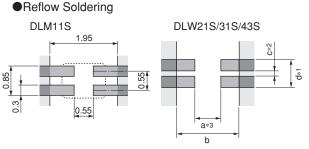
## 1. Standard Land Pattern Dimensions

Land Pattern + Solder Resist Land Pattern

☐ Solder Resist

(in mm)

DLM11S **DLW21S DLW31S DLW43S** DLW5A DLW5B



3.3

4.7

Series а b С d DLW21S/H 8.0 2.6 0.4 1.2 DLW31S 3.7 0.4 1.6 1.6 DLW43SH110/220/510 3.0 5.9 1.6 3.4 DLW43SH101 3.2 5.9 1.6 3.4

- \*1: If the pattern is made with wider than 1.2mm (DLW21) / 1.6mm (DLW31S) it may result in components turning around, because melting speed is different. In the worst case, short circuit between lines may occur.
- \*2: If the pattern is made with less than specified dimensions, in the worst case, short circuit between lines may occur due to spread of soldering paste or mount placing
- \*3: If the pattern is made with wider than 0.8mm (DLW21) / 1.6mm (DLW31SN), the bending strength will be reduced. Moreover, if the pattern is made with less than "a" dimension, in the worst case short circuit may be occurred. (DLW43S)

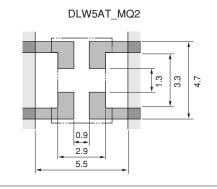
Do not use gild pattern; excess soldering heat may dissolve metal of a copper wire.

## DLW5AT\_MQ2

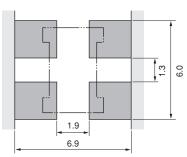
Reflow Soldering Chip Mounting Side

DLW5A/5B (Except for DLW5AT\_MQ2)

0.9 2.9 5.5



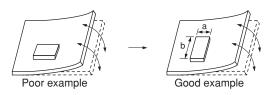
## ●Flow Soldering Chip Mounting Side DLW5AT\_MQ2



## PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.

Products should be located in the sideways direction (Length: a<b) to the mechanical stress.



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EM

## 2. Solder Paste Printing and Adhesive Application

When reflow soldering the chip common mode choke coils, the printing must be conducted in accordance with the following cream solder printing conditions.

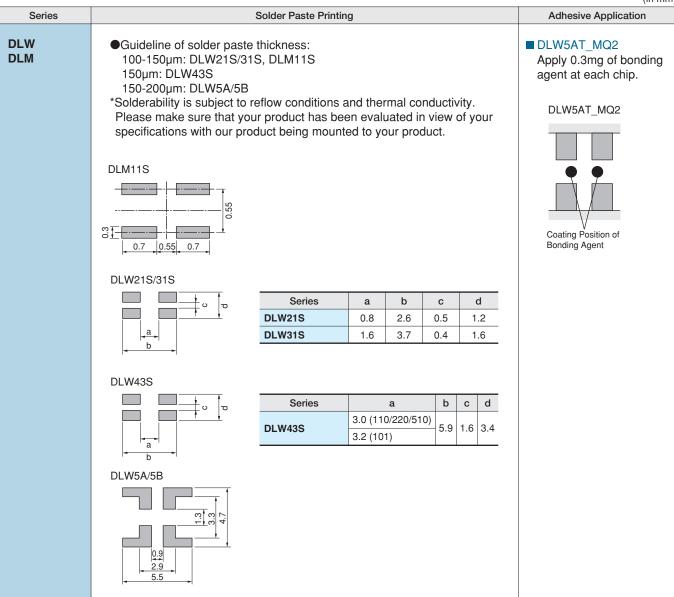
If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack.

Standard land dimensions should be used for resist and copper foil patterns.

When flow soldering the chip common mode choke coils, apply the adhesive in accordance with the following conditions.

If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering process.

(in mm)



<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

## 3. Standard Soldering Conditions

## (1) Soldering Methods

Use flow and reflow soldering methods only.

Use standard soldering conditions when soldering chip common mode choke coils.

In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder. Use of Sn-Zn based solder will deteriorate performance of products. If using DLM series with Sn-Zn based solder, please contact Murata in advance.

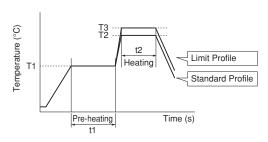
#### Flux:

- Use Rosin-based flux.
  - In case of DLW21/31/43 series, use Rosin-based flux with converting chlorine content of 0.06 to 0.1wt%. In case of using RA type solder, products should be cleaned completely with no residual flux.
- Do not use strong acidic flux (with chlorine content exceeding 0.20wt%)
- Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

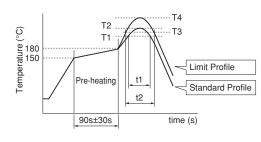
## (2) Soldering Profile

Flow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



	Due le		Sta	andard Profile	)	Limit Profile			
Series	Pre-heating		Hea	Heating Cyc		Heating		Cycle	
	Temp. (T1)	Time. (t1)	Temp. (T2)	Time. (t2)	of Flow	Temp. (T3)	Time. (t2)	of Flow	
DLW5AT_MQ2	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.	

## Reflow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



		Standar	d Profile		Limit Profile				
Series	Hea	ting	Peak Temperature	Cycle	Hea	ting	Peak Temperature	Cycle of Reflow	
	Temp. (T1)	Time. (t1)	(T2)	of Reflow	Temp. (T3)	Time. (t2)	(T4)		
DLM/ DLW21S/31S	220°C min.	30 to 60s	245±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.	
DLW43S	220°C min.	30 to 60s	245±3°C	2 times max.	240°C min.	30s max.	260°C/10s	2 times max.	
DLW5A/5B	220°C min.	30 to 60s	250±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.	



(3) Reworking with Solder Iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating: 150°C 60s min.

Soldering iron power output / Tip diameter:

30W max. / ø3mm max.

Temperature of soldering iron tip / Soldering time / Times:

350°C max. / 3-4s / 2 times\*1

\*1 DLW31S/DLW43S: 350°C max. / 3s / 2 times

Do not allow the tip of the soldering iron to directly contact the chip.

For additional methods of reworking with a soldering iron, please contact Murata engineering.

## 4. Cleaning

Following conditions should be observed when cleaning chip EMI filter.

Do not clean DLW series.

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol type cleaner)
- (2) Ultrasonic

Output: 20W/liter max. Duration: 5 minutes max. Frequency: 28 to 40kHz

(3) Cleaning agent

The following list of cleaning agents have been tested on the individual components. Evaluation of final assembly should be completed prior to production. Before cleaning, please contact Murata engineering.

- (a) Alcohol cleaning agent Isopropyl alcohol (IPA)
- (b) Aqueous cleaning agent Pine Alpha ST-100S

(4) Ensure that flux residue is completely removed.

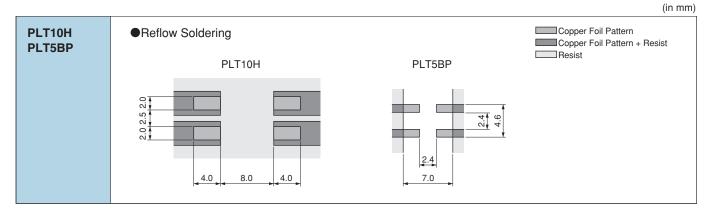
Component should be thoroughly dried after aqueous agent has been removed with deionized water.



## Chip Common Mode Choke Coil

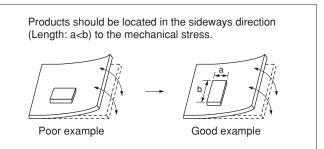
## Soldering and Mounting

## 1. Standard Land Pattern Dimensions



## PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.



## 2. Solder Paste Printing and Adhesive Application

When reflow soldering the chip common mode choke coils, the printing must be conducted in accordance with the following cream solder printing conditions.

If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack.

Standard land dimensions should be used for resist and copper foil patterns.

When flow soldering the chip common mode choke coils, apply the adhesive in accordance with the following conditions.

If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering process.

Series	Solder Paste Printing
PLT10H PLT5BP	<ul> <li>Guideline of solder paste thickness:         150-200µm: PLT10H         150µm: PLT5BP         For the solder paste printing pattern, use standard land dimensions.</li> <li>*Solderability is subject to reflow conditions and thermal conductivity. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.</li> </ul>

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## 3. Standard Soldering Conditions

## (1) Soldering Methods

Use reflow soldering methods only.

Use standard soldering conditions when soldering chip common mode choke coils.

In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder. Use of Sn-Zn based solder will deteriorate performance of products.

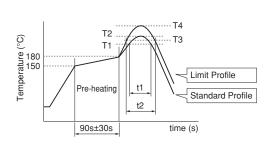
## Flux:

- Use Rosin-based flux.
- Do not use strong acidic flux (with chlorine content exceeding 0.20wt%)
- Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

## (2) Soldering Profile

●Reflow Soldering Profile (Sn-3.0Ag-0.5Cu Solder)



		Standar	d Profile		Limit Profile			
Series	Heating		Peak	Cycle	Hea	ting	Peak Temperature	Cycle
		of Reflow	Temp. (T3)	Time. (t2)	(T4)	of Reflow		
PLT10H	220°C min.	30 to 60s	250±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.
PLT5BP	220°C min.	30 to 60s	245±3°C	2 times max.	240°C min.	30s max.	260°C/10s	2 times max.

## (3) Reworking with Solder Iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating: 150°C 60s min.

Soldering iron power output / Tip diameter: 80W max. / ø3mm max.: PLT10HH 30W max. / ø3mm max.: PLT5BP

Temperature of soldering iron tip / Soldering time / Times:

400°C max. / 5s / 2 times: PLT10HH 350°C max. / 3 to 4s / 2 times: PLT5BP Do not allow the tip of the soldering iron to directly contact the chip.

For additional methods of reworking with a soldering iron, please contact Murata engineering.

## 4. Cleaning

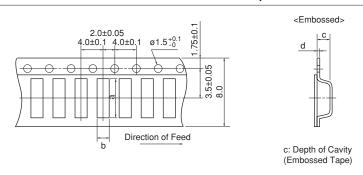
Do not clean after soldering.

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## Chip Common Mode Choke Coil Packaging

## ■ Minimum Quantity and Dimensions of 8mm Width Embossed Tape

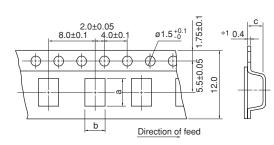


Dimension of the cavity of embossed tape is measured at the bottom side.

	Minimum Qty. (pcs.)									
Part Number		וווט	nensions		ø180m	ım Reel	ø330mm Reel		D. II.	
	а	b	С	d	Paper Tape	Embossed Tape	Paper Tape	Embossed Tape	Bulk	
DLM11S	1.4	1.15	0.65	0.25	-	4000	-	-	500	
DLW21S	2.25	1.45	1.4	0.3	-	2000	-	-	500	
DLW31S	3.6	2.0	2.1	0.3	-	2000	-	-	500	

(in mm)

## ■ Minimum Quantity and Dimensions of 12mm Width Embossed Tape



 $$^{*1}$$  DLW43/DLW5AT: 0.3  $\,$  c: Depth of Cavity Dimension of the cavity is measured at the bottom side.

Part Number	Dir	nensic	ns	Minimum Qty. (pcs.)				
Part Number	а	b	С	ø180mm Reel	ø330mm Reel	Bulk		
DLW43SH_XK	4.9	3.6	2.7	500	2500	100		
DLW43SH_XP	4.9	3.6	2.9	500	2500	100		
DLW5AT	5.4	4.1	2.7	700	2500	100		
DLW5BS	5.5	5.4	4.7	400	1500	100		
DLW5BT	5.5	5.5	2.7	700	2500	100		

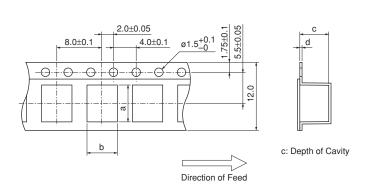
(in mm)

"Minimum Quantity" means the number of units of each delivery or order. The quantity should be an integral multiple of the "Minimum Quantity."





## ■ Minimum Quantity and Dimensions of 12mm Width Embossed Tape

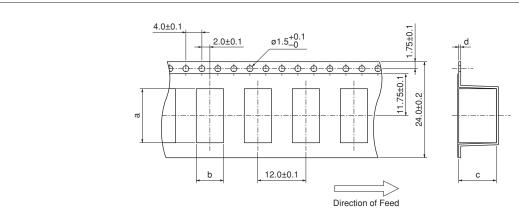


Dimension of the cavity is measured at the bottom side.

Part Number		Dimer	nsions		Minimum Qty. (pcs.)				
Part Number	а	b	С	d	ø180mm Reel	ø330mm Reel	Bulk		
PLT5BP	6.5	5.35	5.1	0.4	300	-	50		

(in mm)

## ■ Minimum Quantity and Dimensions of 24mm Width Embossed Tape



Dimension of the cavity is measured at the bottom side.

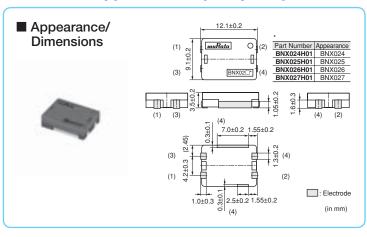
Part Number		Dimer	nsions		Minimum Qty. (pcs.)			
Part Number	а	b	С	d	ø180mm Reel	ø330mm Reel	Bulk	
PLT10H	13.5	6.8	9.4	0.5	125	500	50	

(in mm)



## BNX02 Series

## Wide noise suppression frequency range from 100kHz to several GHz is available. (SMD type)



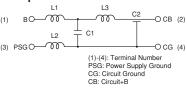
## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	400
K	ø330mm Embossed Taping	1500
В	Packing in Bulk	100





## ■ Equivalent Circuit



Refer to pages from p.128 to p.129 for mounting information.

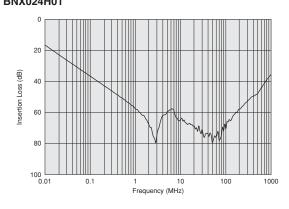
■ Rated Value (□: packaging code)

	= : lates t sales (=:   pastaging esta)										
Part	Part Number		Withstand	Rated	Insulation	Insertion Loss					
For Infotainment	For Powertrain/Safety	Voltage	Voltage	Current	Resistance (min.)	moordon 2000					
_	BNX024H01□	50Vdc	125Vdc	15A	100ΜΩ	100kHz to 1GHz:35dB min. (Line impedance=50 $\Omega$ )					
_	BNX025H01□	25Vdc	62.5Vdc	15A	50MΩ	50kHz to 1GHz:35dB min. (Line impedance=50 $\Omega$ )					
_	BNX026H01□	50Vdc	125Vdc	15A	10ΜΩ	50kHz to 1GHz:35dB min. (Line impedance=50 $\Omega$ )					
_	BNX027H01□	16Vdc	40Vdc	15A	1ΜΩ	40kHz to 1GHz:35dB min. (Line impedance=50 Ω)					

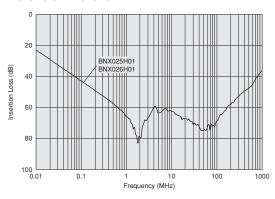
Operating Temperature Range: -55°C~+125°C

In operating temperatures exceeding +85°C, derating of current is necessary.

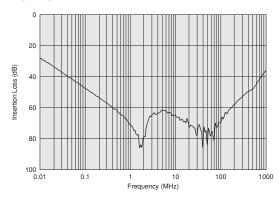
## ■ Insertion Loss Characteristics (Main Items) BNX024H01



#### BNX025H01/BNX026H01



## BNX027H01



Continued on the following page.



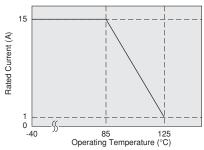




## ■ Derating of Rated current

In operating temperature exceeding +85°C, derating of current is necessary for BNX024H/025H/026H/027H series. Please apply the derating curve shown in chart according to the operating temperature.

Derating of Rated Current





## 

## **Caution**

## Rating

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

## **Notice**

## Storage and Operating Conditions

<Operating Environment>

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

Do not use products in the environment close to the organic solvent.

- <Storage and Handling Requirements>
- Storage Period
   BNX series should be used within 12 months.
   Solderability should be checked if this period is exceeded.
- 2. Storage Conditions
- Storage temperature: -10 to +40°C
   Relative humidity: 15 to 85%
   Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

## Notice (Soldering and Mounting)

1. Cleaning

Do not clean BNX series (SMD Type).

2. Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.

3. Other

Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.

## Handling

1. Resin Coating

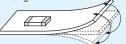
Using resin for coating/molding products may affect the products performance.

So please pay careful attention in selecting resin. Prior to use, please make the reliability evaluation with the product mounted in your application set.

2. Handling of a Substrate (for BNX02□) After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the Product.

Bending





♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before order



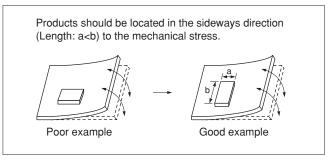
## Block Type EMIFIL® SMD Type Soldering and Mounting

## 1. Standard Land Pattern Dimensions



BNX02□ O 125 CG. CB PSG CG OCG 0 13.2

- (1) A double-sided print board (or multilayer board) as shown in the left figure is designed, and please apply a soldering Cu electrode with a product electrode to a "Land Pattern", apply resist to a "Land Pattern + Solder Resist" at Cu electrode.
- (2) This product is designed to meet large current. Please design PCB pattern which is connected to this product not to become too hot by applied large current.
- (3) Please drop CG on a ground electrode on the back layer (the same also in a multilayer case) by the through hole. And a surface to ground electrode layer may also take a large area as much as possible.
- (4) It is recommended to use a double-sided printed circuit board with BNX mounting on one side and the ground pattern on the other in order to maximize filtering performance, multiple feed through holes are required to maximize the BNX's connection to ground.
- (5) The ground pattern should be designed to be as large as possible to achieve maximum filtering performance.
- PCB Warping (for BNX02□) PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.

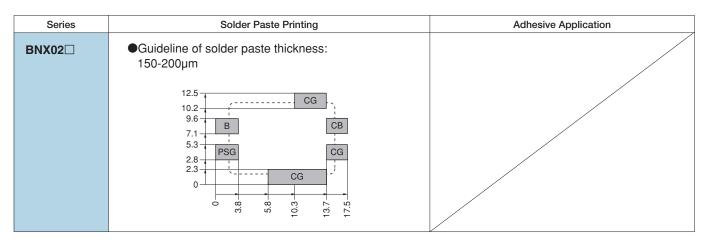


## 2. Solder Paste Printing and Adhesive Application

When reflow soldering the block type EMIFIL®, the printing must be conducted in accordance with the following cream solder printing conditions.

If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack.

Standard land dimensions should be used for resist and copper foil patterns.



♠Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

## 3. Standard Soldering Conditions

## (1) Soldering Methods

Use reflow soldering methods only.

Use standard soldering conditions when soldering block type EMIFIL® SMD type.

In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder. Use of Sn-Zn based solder will deteriorate performance of products.

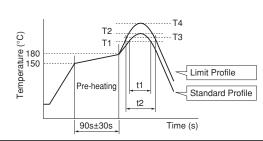
#### Flux:

- Use Rosin-based flux.
  - In case of using RA type solder, products should be cleaned completely with no residual flux.
- Do not use strong acidic flux (with chlorine content exceeding 0.20wt%)
- Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

## (2) Soldering Profile

●Reflow Soldering Profile (Sn-3.0Ag-0.5Cu solder)



	Standard Profile			Limit Profile				
Series	Heating		Peak Temperature Cycle	Heating		Peak Temperature	Cycle	
	Temp. (T1)	Time. (t1)	(T2)	of Reflow	Temp. (T3)	Time. (t2)	(T4)	of Reflow
BNX02□	220°C min.	30 to 60s	250±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.

## (3) Reworking with Solder Iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating: 150°C 60s min.

Soldering iron power output: 100W max.

Temperature of soldering iron tip / Soldering time / Times:

450°C max. / 5s max. / 2 time

Do not allow the tip of the soldering iron to directly contact the chip.

For additional methods of reworking with a soldering iron, please contact Murata engineering.

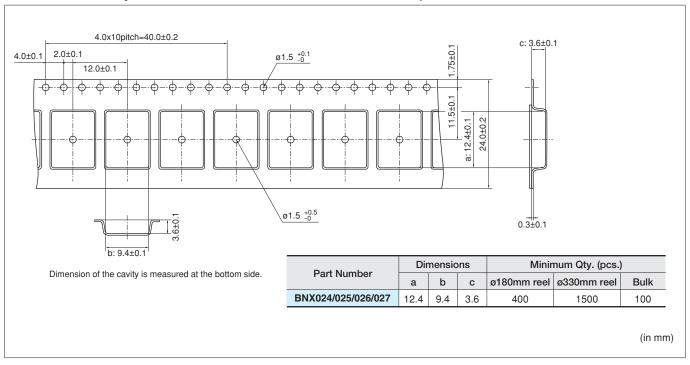
## 4. Cleaning

Do not clean BNX02□ series, or inner humidity protect material will be damaged, results product's insulation resistance getting worse.



# Block Type EMIFIL® SMD Type Packaging

## ■ Minimum Quantity and Dimensions of 24mm Width Embossed Tape



"Minimum Quantity" means the number of units of each delivery or order. The quantity should be an integral multiple of the "Minimum Quantity."

# M DS Disc Type EMIFIL® Part Numbering

(Part Number)



## ●Product ID

Product ID	
DS	Three-terminal Capacitor

#### 2Structure

Code	Structure
S	Built-in Ferrite Beads Type

## Style

Code	Style	
1	Expressed by a letter.	

## 4 Category

Code	Category		
Z	For Automotive	Infotainment	

#### **5**Temperature Characteristics

Code	Capacitance Change	
В3	±10% (Temperature Range: -25°C to +85°C)	

#### 6 Rated Voltage

Code	Rated Voltage
1H	50V
2A	100V

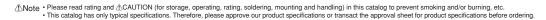
## Capacitance

Expressed by three alphanumerics. The unit is in pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

## 8Lead Type/9Packaging

Code	Lead Type	Lead Length* (mm)	Packaging	Series
Q55B		25.0 min.	Bulk	
Q91J	Straight	00.011.0	Paper Reel (ø320mm)	DSS1
Q91A		20.0±1.0	Ammo Pack	

<sup>\*</sup>Lead Distance between Reference and Bottom Planes Except for Bulk.





(Part Number) VF C 2 H R7 1D 105 K 2 K1 B

2 3 4 5 6 7 8 9 10 10

## 1Product ID

Product ID	
VF	EMIGUARD® Lead Type

#### **2**Structure

Code	Structure
С	Built-in Capacitor

## Style

Code	Style
2	Size is expressed by a digit

### 4 Features

Code	Features		
Н	For Automotive	Powertrain, Safety	

#### **5**Temperature Characteristics

Code	Capacitance Change	
R7	±15% (Temperature Range: -55°C to +125°C)	

## 

Code	Lead Type	Lead Length* Packaging		Series
K1B		26.0±1.0mm	Bulk	
M1A	Inside Crimp	18.0±1.0mm	Ammo Pack	VFC2
M1J		10.U±1.UIIIII	Paper Reel (ø320mm)	

<sup>\*</sup>From bottom of the crimp.

### 6 Rated Voltage

Code	Rated Voltage
1D	22V

#### Capacitance

Expressed by three alphanumerics. The unit is in pico-farad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

## 8 Capacitance

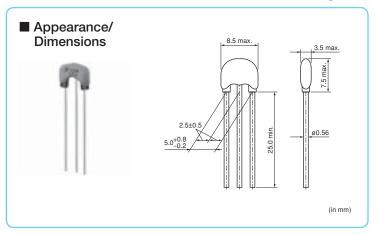
Code	Capacitance
K	±10%

## 

Code	Varistor Voltage
2	27V



## 3 terminal structure enables excellent high frequency characteristics.



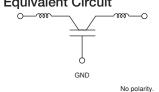
## ■ Packaging

Code	Packaging	Minimum Quantity
В	Packing in Bulk	250
Α	Ammo Pack	1500
R	ø320mm Reel	1500





■ Equivalent Circuit



Refer to p.140 for mounting information.

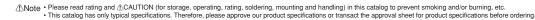
■ Rated Value (□: packaging code)

■ Rated Value (⊔: pa					
Part N		Capacitance	Rated Current	Rated Voltage	Operating Temperature Range
For Infotainment	For Powertrain/Safety				
DSS1ZB32A220Q55B	_	22pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A220Q91A□	_	22pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A220Q91J□	_	22pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A330Q55B□	_	33pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A330Q91A□	_	33pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A330Q91J□	_	33pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A470Q55B□	_	47pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A470Q91A□	_	47pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A470Q91J□	_	47pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A680Q55B□	_	68pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A680Q91A□	_	68pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A680Q91J□	_	68pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A101Q55B□	_	100pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A101Q91A□	_	100pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A101Q91J□	_	100pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A121Q55B□	_	120pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A121Q91A□	_	120pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A121Q91J□	_	120pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A151Q55B	_	150pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A151Q91A	_	150pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A151Q91J□	_	150pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A221Q55B	_	220pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A221Q91A□	_	220pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A221Q91J□	_	220pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A271Q55B□	_	270pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A271Q91A	_	270pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A271Q91J□	_	270pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A331Q55B□	_	330pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A331Q91A	_	330pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A331Q91J□	_	330pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A471Q55B	_	470pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A471Q91A□	_	470pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A471Q91J□	_	470pF ±10%	6A	100Vdc	-40°C∼+85°C

Number of Circuit: 1

Continued on the following page.







DSS<sub>1</sub>

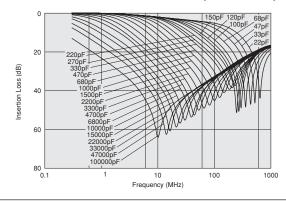
Bead	TVND
Ferrite	OMU
Chip	

Chip EMIFIL® SMD Type

Part N	umher				Operating
For Infotainment	For Powertrain/Safety	Capacitance	Rated Current	Rated Voltage	Temperature Range
DSS1ZB32A681Q55B	—	680pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A681Q91A	_	680pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A681Q91J	_	680pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A102Q55B□	_	1000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A102Q91A	_	1000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A102Q91J□	_	1000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A152Q55B	_	1500pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A152Q91A□	_	1500pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A152Q91J□	_	1500pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A222Q55B□	_	2200pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A222Q91A□	_	2200pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A222Q91J□	_	2200pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A332Q55B□	_	3300pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A332Q91A□	_	3300pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A332Q91J□	_	3300pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A472Q55B□	_	4700pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A472Q91A□	_	4700pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A472Q91J□	_	4700pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A682Q55B□	_	6800pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A682Q91A□	_	6800pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A682Q91J□	_	6800pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A103Q55B□	_	10000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A103Q91A□	_	10000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A103Q91J□	_	10000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A153Q55B□	_	15000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A153Q91A□	_	15000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A153Q91J□	_	15000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A223Q55B□	_	22000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A223Q91A□	_	22000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB32A223Q91J□	_	22000pF ±10%	6A	100Vdc	-40°C∼+85°C
DSS1ZB31H333Q55B□	_	33000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H333Q91A□	_	33000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H333Q91J□	_	33000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H473Q55B□	_	47000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H473Q91A□	_	47000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H473Q91J□	_	47000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H104Q55B□	_	100000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H104Q91A	_	100000pF ±10%	6A	50Vdc	-40°C∼+85°C
DSS1ZB31H104Q91J□	_	100000pF ±10%	6A	50Vdc	-40°C∼+85°C

Number of Circuit: 1

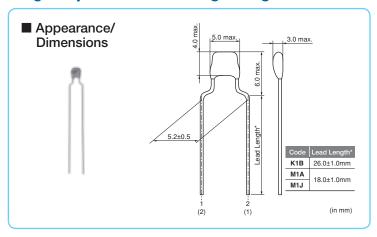
## ■ Insertion Loss Characteristics (Main Items)



⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



## Large capacitance and high surge current of 200A.



## ■ Packaging

Code	Packaging	Minimum Quantity
В	Packing in Bulk	500
Α	Ammo Pack	2000
J	ø320mm Paper Reel	2000



■ Equivalent Circuit



Refer to p.140 for mounting information.

■ Rated Value (□: packaging code)

Part Number		Varistor	Capacitance	Temperature	Rated	Insulation
For Infotainment	For Powertrain/Safety	Voltage	Сараспансе	Characteistics	Voltage	Resistance (min.)
_	VFC2HR71D105K2M1□	27Vdc +5/-3V	1.0µF ±10%	R7 (±15%)	22Vdc	1ΜΩ

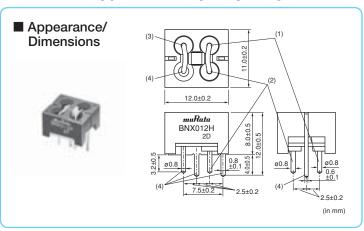
Operating Temperature Range: -55°C ~+125°C

Block Type EMIFIL<sup>®</sup>

SMD Type

# BNX012<sub>Series</sub>

## Wide noise suppression frequency range from 100kHz to several GHz is available. (Lead type)



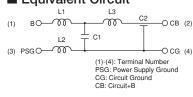
## ■ Packaging

Code	Packaging	Minimum Quantity
-	Box	150





■ Equivalent Circuit



Refer to pages from p.141 to p.142 for mounting information.

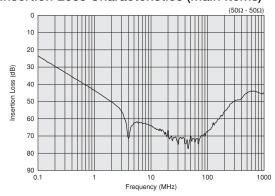
## ■ Rated Value (□: packaging code)

	Part N	lumber	Rated Withstand Rated		Rated	Insulation Insertion Loss	
	For Infotainment	For Powertrain/Safety	Voltage	Voltage	Current	Resistance (min.)	ilisertion Loss
Ī	_	BNX012H0	50Vdc	125Vdc	15A	500MΩ	1MHz to 1GHz:40dB min. (Line impedance=50Ω)

Operating Temperature Range: -55°C~+125°C

In operating temperatures exceeding +85°C, derating of current is necessary.

## ■ Insertion Loss Characteristics (Main Items)



Continued on the following page.

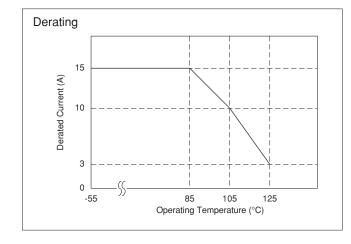




## ■ Derating of Rated current

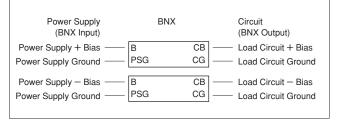
## Rating

In operating temperatures exceeding +85°C, derating of current is necessary for BNX012H series. Please apply the derating curve shown in chart according to the operating temperature.



## Connecting ± Power Line

In case of using  $\pm$  power line, please connect to each terminal as shown.



137

## **⚠** Caution

## Rating

- 1. Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.
- Products should not be applied for the absorption of surge which have large energy (ex. Included lighting surge, switching surges) because it is designed for the absorption of electrostatic surges, or it results cracks in ceramics which may lead to smoking / firing.

## Soldering and Mounting

- Mounting holes should be designed as specified in these specifications. Other designs than those shown in these specifications may cause cracks in ceramics that may lead to smoking or firing.
- 2. Take care not to apply any mechanical stress to product body at the lead terminal bending process for product angle adjustment after insertion.

## **Notice**

## Storage and Operating Conditions

<Operating Environment>

- 1. Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.
- Do not use products near water, oil or organic solvents. Avoid environments where dust or dirt may adhere to the product.
- Do not adhere any resin to products, coat nor mold products with any resin (including adhesive) to prevent mechanical and chemical stress on products.
- <Storage and Handling Requirements>
- Storage Period
   Use the products within 12 months after delivery.
   Solderability should be checked if this period is
   exceeded.
- 2. Storage Conditions
- Storage temperature: -10 to 40 degrees C
   Relative humidity: 15 to 85%
   Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.
- <Using EMIGUARD® effectively>
- 1. Products should be used at rated voltage or less and rated current or less.

## Soldering and Mounting

1. Washing

Failure and degradation of a product are causedby the washing method. When you wash in conditions that are not in the mounting information, please contact Murata engineering.

2. Soldering

Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in the mounting information.

3. Other

Noise suppression levels resulting from Murata's EMI suppression filters EMIFIL® may vary, depending on the circuits and ICs used, type of noise, mounting pattern, lead wire length, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.



## 

## **Caution**

## Rating

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

## **Notice**

## Storage and Operating Conditions

<Operating Environment>

- 1. Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.
- Do not use products near water, oil or organic solvents.
- <Storage and Handling Requirements>
- Storage Period
   BNX Series should be used within 12 months.
   Solderability should be checked if this period is exceeded.
- 2. Storage Conditions
- (1) Storage temperature: -10 to +40°C Relative humidity: 15 to 85% Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

#### Notice (Soldering and Mounting)

1. Cleaning

Failure and degradation of a product are caused by the cleaning method. When you clean in conditions that are not in mounting information, please contact Murata engineering.

- 2. Soldering
  - Reliability decreases with improper soldering methods. Please solder by the standard soldering conditions shown in mounting information.
- 3. Other

Noise suppression levels resulting from Murata's EMI suppression filters "EMIFIL" may vary, depending on the circuits and ICs used, type of noise, mounting pattern, lead wire length, mounting location, and other operating conditions. Be sure to check and confirm in advance the noise suppression effect of each filter, in actual circuits, etc. before applying the filter in a commercial-purpose equipment design.

## Notice (Appearance)

Although some part of the product surface seems to be white in some cases, do not care because it is the result of waxing process for humidity resistance improvement. This wax does not make bad affection to mechanical or electrical performance, reliability of the product.

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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



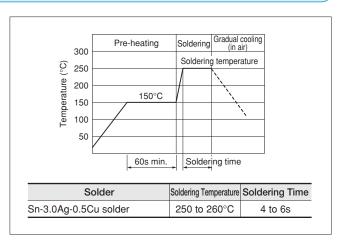
## 1. Mounting Hole

Mounting holes should be designed as specified below.

Part Number	Bulk Type (in mm)	Taping Type (in mm)		
DSS1	2.5±0.2 2.5±0.2	Ø1.0-3  2.5±0.2  2.5±0.2		
VFC2H	Ø0.8-2 5.2±0.4	61.0-2 5.2±0.4		

## 2. Soldering

- (1) Use Sn-3.0Ag-0.5Cu solder.
- (2) Use Rosin-based flux. Do not use strong acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).
- (3) Products and the leads should not be subjected to any mechanical stress during the soldering process, or while subjected to the equivalent high temperatures.
- (4) Standard flow soldering profile.



## 3. Cleaning Conditions

Clean other parts in the following conditions.

- (1) Cleaning temperature should be limited to 60°C max. (40°C max for alcohol type cleaner).
- (2) Ultrasonic cleaning should comply with the following conditions, avoiding the resonance phenomenon at the mounted products and PCB.

Power: 20 W /  $\ell$  max. Frequency: 28 to 40kHz Time: 5 min. max.

- (3) Cleaner
  - (a) Alcohol type cleaner Isopropyl alcohol (IPA)
  - (b) Aqueous agent (PLT series cannot be cleaned) PINE ALPHA ST-100S

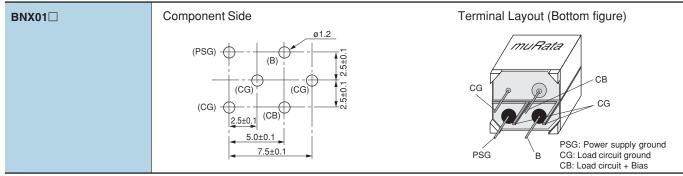
- (4) There should be no residual flux or residual cleaner left after cleaning.
  - In the case of using aqueous agent, products should be dried completely after rinsing with de-ionized water in order to remove the cleaner.
- (5) The surface of products may become dirty after cleaning, but there is no deterioration on mechanical, electrical characteristics and reliability.
- (6) Other cleaning: Please contact us.



# Block Type EMIFIL® Lead Type Soldering and Mounting

## 1. Mounting Hole

Mounting holes should be designed as specified below.



## 2. Using the Block Type EMIFIL® (Lead Type) Effectively

## (1) How to use effectively

This product effectively prevents undesired radiation and external noise from going out / entering the circuit by grounding the high frequency components which cause noise problems. Therefore, grounding conditions may affect the performance of the filter and attention should be paid to the following for effective use.

- (a) Design maximized grounding area in the P.C. board, and grounding pattern for all the grounding terminals of the product to be connected. (Please follow the specified recommendations.)
- (b) Minimize the distance between ground of the P.C. board and the ground plate of the product. (Recommend using the through hole connection between grounding area both of component side and bottom side.)
- (c) Insert the terminals into the holes on P.C. board completely.
- (d) Don't connect PSG terminal with CG terminal directly. (See the item 1. Terminal Layout)

## (2) Self-heating

Though this product has a large rated current, localized selfheating may be caused depending on soldering conditions. To avoid this, attention should be paid to the following:

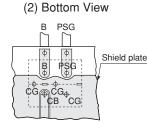
- (a) Use P.C. board with our recommendation on hole diameter / land pattern dimensions, mentioned in the right hand drawing, especially for 4 terminals which pass current.
- (b) Solder the terminals to the P.C. board with soldercover area at least 90%. Otherwise, excess self-heating at connection between terminals and P.C. board may lead to smoke and / or fire of the product even when operating at rated current.
- (c) After installing this product in your product, please make sure the self-heating is within the rated current recommended.

## P. C. Board Patterns

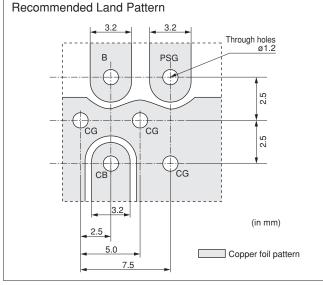
Use a bilateral P.C. board. Insert the BNX into the P.C.board until the root of the terminal is secured, then solder.

(1) Component Side View





Copper foil pattern

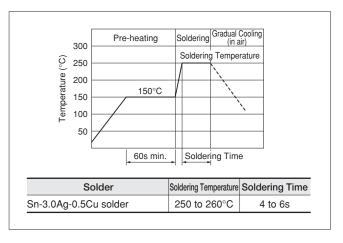


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## 3. Soldering

- (1) Use Sn-3.0Ag-0.5Cu solder.
- (2) Use Rosin-based flux. Do not use strong acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).
- (3) Products and the leads should not be subjected to any mechanical stress during the soldering process, or while subjected to the equivalent high temperatures.
- (4) Standard flow soldering profile



## 4. Cleaning

Clean the block Type  $\mathsf{EMIFIL}^{\circledR}(\mathsf{Lead}\ \mathsf{Type})$  in the following conditions.

- (1) Cleaning temperature should be limited to 60°C max. (40°C max for alcohol type cleaner).
- (2) Ultrasonic cleaning should comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20W/liter max. Frequency: 28 to 40kHz Time: 5 min. max.

- (3) Cleaner
  - (a) Alcohol type cleaner Isopropyl alcohol (IPA)
  - (b) Aqueous agent Pine Alpha ST-100S

- (4) There should be no residual flux or residual cleaner left after cleaning.
  - In the case of using aqueous agent, products should be dried completely after rinsing with de-ionized water in order to remove the cleaner.
- (5) The surface of products may become dirty after cleaning, but there is no deterioration on mechanical, electrical characteristics and reliability.
- (6) Other cleaning: Please contact us.



■ Minimum Quantity

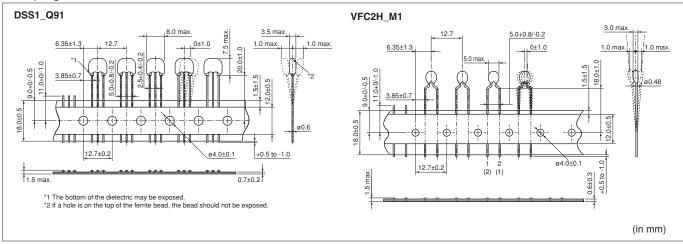
Part Number	Minimum Order Quantity (order in sets only) (pcs.)		
	Ammo Pack	ø320mm Paper Reel	Bulk (Bag)
VFC2H Series	2000	2000	500
DSS1 Series	1500	1500	250

■ Lead Type Code

Lead Type Code	Lead Length (H)	
Straight Type		
Q55B	25.0mm min.	
Q91A	20.0±1.0mm	
Q91J	20.0±1.0mm	

Lead Type Code	Lead Length (from bottom of the crimp)	
Inside Crimp		
K1B	26.0±1.0mm	
M1A		
M1J	18.0±1.0mm	

## ■ Taping Dimensions



muRata

(Part Number) В **75** 

## 1 Product ID

Product ID	
DX	Micro Chip Transformer

#### 2Structure

Code	Structure
W	Winding Type

#### 3Dimensions (LXW)

Code	Dimensions (LXW)	EIA
21	2.0×1.2mm	0805

#### Type of Transformer

Code	Type of Transformer
В	Balun

### **5**Category

Code	Category	
Z	For Automotive	Infotainment

#### **6**Port Impedance

Code	Port Impedance
75	75Ω

#### Characteristics

Code	Impedance Ratio
11	one to one

### 8 Rough Frequency Range

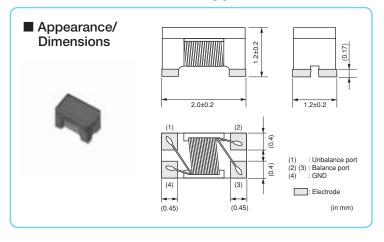
Code	Rough Frequency Range	
Т	50MHz to 870MHz	
S	950MHz to 2150MHz	

#### Packaging

Code	Packaging	
K	Embossed Taping (ø330mm Reel)	
L	Embossed Taping (ø180mm Reel)	
В	Bulk	

# DXW21B<sub>Series</sub> 0805/2012 (inch/mm)

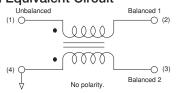
## 0805 size, wire-wound type. (Balun)



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	10000
В	Packing in Bulk	500

■ Equivalent Circuit



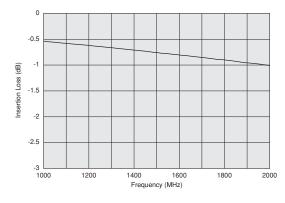
Refer to pages from p.147 to p.148 for mounting information.

■ Rated Value (□: packaging code)

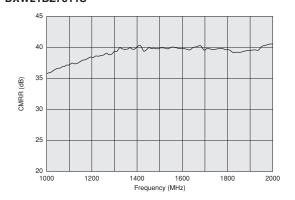
Part Number		Eroguanay Banga	Dort Impedance	Insertion Loss	CMRR	Rated Power
For Infotainment	For Powertrain/Safety	Frequency Range	Port impedance	at Freq. Range (max.)	at Freq. Range (min.)	nated Power
DXW21BZ7511S	_	1 to 1.5GHz	75Ω - 75Ω	1.4dB	20dB	27dBm
DXW21BZ7511T	_	50 to 870MHz	75Ω - 75Ω	1.0dB	20dB	27dBm

Operating Temperature Range: -40°C~+85°C Only for reflow soldering.

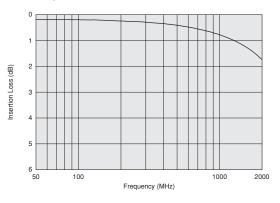
## ■ Insertion Loss Characteristics DXW21BZ7511S



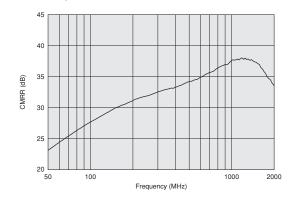
## ■ CMRR Characteristics DXW21BZ7511S



## ■ Insertion Loss Characteristics DXW21BZ7511T



## ■ CMRR Characteristics DXW21BZ7511T



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M

## Rating

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

## Soldering and Mounting

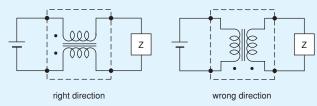
1. Self-heating

Please provide special attention when mounting chip Micro Chip Transformer (DXW) series in close proximity to other products that radiate heat. The heat generated by other products may deteriorate

The heat generated by other products may deteriorate the insulation resistance and cause excessive heat in this component.

#### 2. Mounting Direction

Mount Micro Chip Transformer in right direction. Wrong direction, which is 90 degree rotated from right direction, the characteristics does not come out as Micro Chip Transformer or causes not only open or short circuit but also flames or other serious trouble.



## **Notice**

### Storage and Operating Conditions

<Operating Environment>

Do not use products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

<Storage and Handling Requirements>

- Storage Period
   DXW series should be used within 12 months.
   Solderability should be checked if this period is exceeded.
- 2. Storage Conditions
- Storage temperature: -10 to +40 degree C Relative humidity: 15 to 85% Avoid sudden changes in temperature and humidity.
- (2) Do not store products in a chemical atmosphere such as chlorine gas, acid or sulfide gas.

## Handling

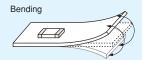
1. Resin Coating

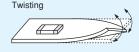
The impedance value may change due to high curestress of resin to be used for coating/molding products. An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc. Some resin contains some impurities or chloride possible to generate chlorine by hydrolysis under some operating condition may cause corrosion of wire of coil, leading to open circuit. So, please pay your careful attention in selecting resin in case of coating/molding the products with the resin. Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

2. Handling of a Substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

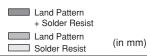
Excessive mechanical stress may cause cracking in the Product.

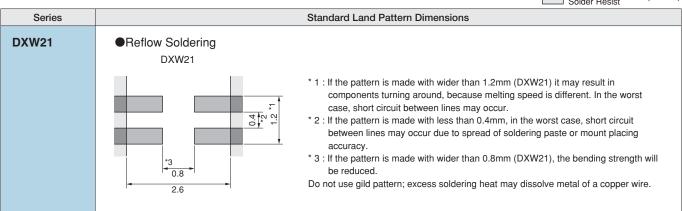






#### 1. Standard Land Pattern Dimensions





## 2. Solder Paste Printing and Adhesive Application

When reflow soldering the Micro Chip Transformer, the printing must be conducted in accordance with the following cream solder printing conditions.

If too much solder is applied, the chip will be prone to damage by mechanical and thermal stress from the PCB and may crack. In contrast, if too little solder is applied, there is the potential that the termination strength will be insufficient, creating the potential for detachment. Standard land dimensions should be used for resist and copper foil patterns.

(in mm)

Series	Solder Paste Printing
DXW21	●Coat the solder paste a thickness: 100-150μm

### 3. Standard Soldering Conditions

#### (1) Soldering Methods

Use reflow soldering methods only.

Use standard soldering conditions when soldering Micro Chip Transformer.

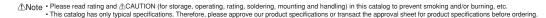
In cases where several different parts are soldered, each having different soldering conditions, use those conditions requiring the least heat and minimum time.

Solder: Use Sn-3.0Ag-0.5Cu solder.

- Use Rosin-based flux, (with converting chlorine content 0.06 to 0.1(wt)%.), but not highly acidic flux (with Halogen content exceeding 0.2(wt)% conversion to chlorine).
- Do not use water-soluble flux.

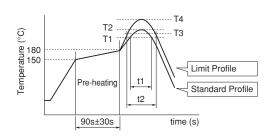
Continued on the following page.







- (2) Soldering profile
  - ●Reflow Soldering profile (Sn-3.0Ag-0.5Cu)



	Standard Profile					Limit Profile			
Series	Hea	ting	Peak temperature		Heating		Peak temperature	0 1 6 6	
	Temp. (T1)	Time. (t1)	(T2)	Cycle of reflow	Temp. (T3)	Time. (t2)	(T4)	Cycle of reflow	
DXW	220°C min.	30 to 60s	245±3°C	2 times max.	230°C min.	60s max.	260°C/10s	2 times max.	

(3) Reworking with Solder Iron

The following conditions must be strictly followed when

using a soldering iron.

Pre-heating : 150°C 60s min.
Soldering iron power output : 30W max.
Temperature of soldering iron tip / Soldering time :

280°C max./10s max. or 350°C max./3s max.

For additional methods of reworking with a soldering iron, please contact Murata engineering.

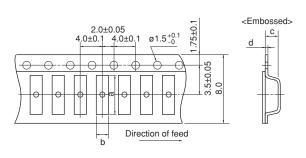
## 4. Cleaning

Do not clean.



## Microchip Transformer (Balun) Packaging

## ■ Minimum Quantity and Dimensions of 8mm Width Embossed Tape



Dimension of the cavity is measured at the bottom side.

		Dimor	noiono			Minimum Qty. (pcs.)	
Part Number	Dimensions		ø180mm reel	ø330mm reel	D. II.		
	а	b	С	d	Embossed Tape	Embossed Tape	Bulk
DXW21B	2.25	1.45	1.40	0.30	2000	10000	500

(in mm)

## Memo

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## Chip Inductors



## Contents

Classification and Structure of Chip Inductors	··· 152
Product Guide ·····	··· 154
•Inductors for Power Lines	
Part Numbering	156
Product Detail ·····	158
	··· 189
Soldering and Mounting	··· 191
Packaging	··· 195
•Inductors for General Circuits	
Part Numbering	··· 197
Product Detail	··· 198
<b>∆</b> Caution/Notice ······	202
Soldering and Mounting	203
Packaging	206
•RF Inductors	
Part Numbering	207
Product Detail	208
<b>∆</b> Caution/Notice ·····	228
Soldering and Mounting	230
Packaging ·····	233





## Classification and Structure of Chip Inductors

## ●Line Up and Applications for Chip Inductors

	Line Up	Applications
For Power Lines / For Low Frequency	Wire Wound Type Ferrite Core  LQH Series (With some exceptions.)	For Voltage Conversion For Choke
Circuits (Under 100MHz)	Multilayer Type Ferrite Core  LQM Series	For Resonance Circuits For Low Frequency Filter Circuits
	Wire Wound Type Non-magnetic Core  LQW_A Series	
RF Inductors (Greater than 100MHz)	Multilayer Type Non-magnetic Material LQG Series	For Impedance Matching For High Frequency Filter Circuits For RF Choke
	Film Type Non-magnetic Material  LQP Series	

152



## ● Construction and Features of Chip Inductors

	Construction	Features
For Power Lines / For General Circuits	Wire Wound Type  Wire Some products are coated with magnetic resin. Electrode	Wide inductance range Good DC bias current characteristics
(Under 100MHz)	Multilayer Type Coil pattern  Electrode Ferrite	Small and lightweight Low DC resistance
	Wire Wound Type For Radio Frequency Wire  Electrode  Resin coating on the top Non-magnetic ceramic core	High Q Large inductance
RF Inductors (Greater than 100MHz)	Multilayer Type Coil pattern Outer electrode Non-magnetic ceramic	Industrial standard design
	Film Type  Inner electrode, which is produced using photolithography process  Outer electrode	Small size, but high Q





## Chip Inductors Product Guide

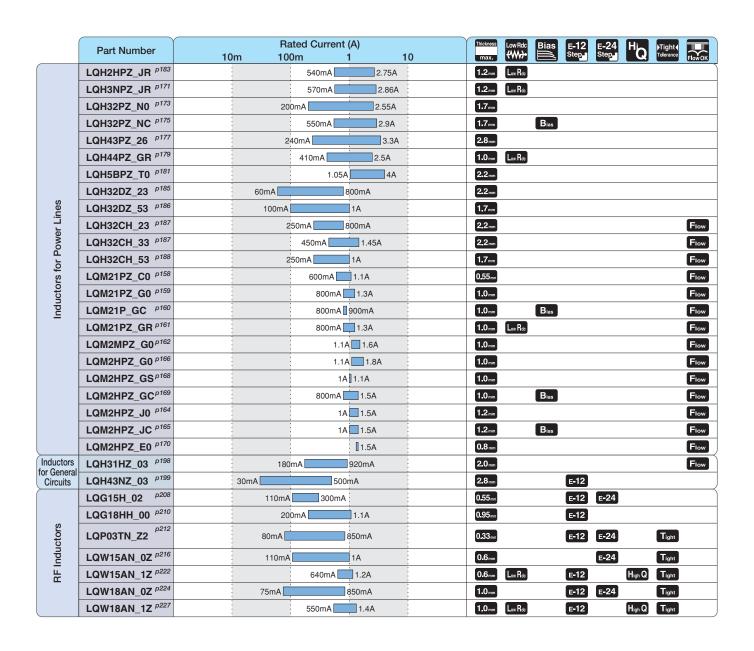
Murata's LQ series of chip inductors (chip coils) consists of compact, high-performance inductors. Their innovative coil and case structures mean low DC resistance and outstanding high-frequency characteristics. The series is designed for a variety of applications, facilitating component selection for individual circuit requirements.

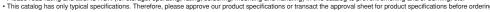
LOH2HPZ_UR_PI75		Part Number	Ctrusture	Size Code			Inducta	ance Range	e (H)			
CH3NPZ_JR_PTT    LOH32PZ_ND_PTT    LOH32PZ_ND_PTT    LOH32PZ_ND_PTT    LOH32PZ_ND_PTT    LOH32PZ_ND_PTT    LOH32PZ_ND_PTT    LOH32PZ_SD_PTT    LOM21PZ_SD_PTT    LOM21PZ_SD_			Structure	in inch (in mm)	1n	10n		1μ 10	μ 10	)0μ 1	m 1	I0m
CH32PZ_NO_P175    LOH32PZ_NO_P175    LOH32PZ_NO_P175    LOH32PZ_NO_P175    LOH43PZ_GR_P175    LOH43PZ_GR_P175    LOH43PZ_GR_P175    LOH43PZ_GR_P175    LOH43PZ_GR_P175    LOH32DZ_3R_P185    LOH32DZ_3R_P185    LOH32DZ_3R_P185    LOH32CH_3R_P185    LOM21PZ_GR_P185    LOM21PZ_GR_P				1008 (2520)			0.47µH		22µH			
CH32PZ_NC_PITS   LOH43PZ_G6_PITS   LOH43PZ_G6_PITS   LOH43PZ_G6_PITS   LOH43PZ_G6_PITS   LOH43PZ_G6_PITS   LOH43PZ_G6_PITS   LOH43PZ_G7_PITS   LOH43PZ_G6_PITS   LOM21PZ_G6_PITS   LOM21PZ_G6_PITS   LOM21PZ_G6_PITS   LOM21PZ_G6_PITS   LOM21PZ_G8_PITS   LOM21PZ_G8_		LQH3NPZ_JR P171		1212 (3030)			0.68µH		47	μH		
Character   Company   Co		LQH32PZ_N0 P173		1210 (3225)			0.47µH			120µH		
CH44PZ_GR   P179		LQH32PZ_NC p175		1210 (3225)			0.47µH		22µH			
CHSBPZ_TO   P187		LQH43PZ_26 p177		1812 (4532)			1.0µ	н		220µH		
CH32DZ 23 p185   1210 (3225)   1.0µH   330µH   100µH   100µH   120µH   100µH   120µH   100µH   120µH   100µH   120µH   100µH   120µH   100µH   120µH   120µH   100µH   120µH		LQH44PZ_GR p179	Wire Wound Type	1515 (4040)			0.68µH	Ċ.	47	μH		
LQH32DZ_53 p186   LQH32CH_23 p187   LQH32CH_23 p187   LQH32CH_23 p187   LQH32CH_33 p187   LQH32CH_53 p188   LQH32CH_53		LQH5BPZ_T0 p181	(Ferrite Core)	2020 (5050)			0.47µH		22µH			
LQM21PZ_GD_p165		LQH32DZ_23 p185		1210 (3225)			1.0µ	н		330	iΗ	
LQM21PZ_GD_p165	nes	LQH32DZ_53 p186		1210 (3225)			1.0µ	н		]100µH		
LQM21PZ_GD_p165	ř :	LQH32CH_23 p187		1210 (3225)			1.0µ	н	22µH			
LQM21PZ_GD_p165	owe	LQH32CH_33 P187		1210 (3225)		0.1	15µН		10µH			
LQM21PZ_GD_p165	or P	LQH32CH_53 P188		1210 (3225)			1.0µ	н	22µH			
LQM21PZ_GD_p165	rs fc	LQM21PZ_C0 p158		0805 (2012)			0.47µH	2.2µH				
LQM21PZ_GD_p165	ıcto	LQM21PZ_G0 P159		0805 (2012)			0.47µH	3.3µl	1		:	
LQM21PZ_GD_p165	Indu	LQM21P_GC P160		0805 (2012)			1.0µ	H 2.2µH				
LQM2HPZ_GS p168	_	LQM21PZ_GR P161		0805 (2012)			1.0µ	H4.7	ıΗ			
LQM2HPZ_GS_p168		LQM2MPZ_G0 <sup>p162</sup>		0806 (2016)			0.47µH	4.7	ıΗ			
LQM2HPZ_GC <sup>p169</sup> LQM2HPZ_JO <sup>p164</sup> LQM2HPZ_JO <sup>p165</sup> LQM2HPZ_DO <sup>p164</sup> LQM2HPZ_DO <sup>p165</sup> LQM2HPZ_EO <sup>p170</sup> Inductors for General Circuits  LQH31HZ_03 <sup>p199</sup> LQH3NZ_03 <sup>p199</sup> LQH43NZ_03 <sup>p199</sup> LQG15H_02 <sup>p208</sup> LQG15H_02 <sup>p208</sup> LQG15H_02 <sup>p208</sup> LQH21Z_p21 LQH21Z_p2		LQM2HPZ_G0 P166		1008 (2520)			0.47µH	4.7	ıΗ	:		
LQM2HPZ_JC   p165   1008 (2520)   1.0µH   2.2µH   1008 (2520)   1.0µH   10.56µH   10.56µH   10.0µH   10.56µH   10.0µH   10.0		LQM2HPZ_GS <sup>p168</sup>	(1 0.11.10 00.10)	1008 (2520)				2.2μH 4.7	ıΗ			
LQM2HPZ_E0 p170		LQM2HPZ_GC <sup>p169</sup>		1008 (2520)			1.0µ	H4.7	ιH			
LQM2HPZ_E0 p170		LQM2HPZ_J0 P164		1008 (2520)			1.0µ	Н 3.3µН	1			
LQH31HZ_03   p199   Ferrite Core   1206 (3216)   54nH   880nH   880nH   2200μH		LQM2HPZ_JC P165		1008 (2520)			1.0µ	H2.2µH			:	
Circuits   LQH43NZ_03   p199   (Ferrite Core)   1812 (4532)   1.0µH   270nH		LQM2HPZ_E0 P170		1008 (2520)			0	0.56µH				
Circuits   LQH43NZ_03   p799   Ferrite Core   1812 (4532)   1.0µH   2200µH		LQH31HZ_03 p198	Wire Wound Type	1206 (3216)		54nl	н	880nH				
LQG18HH_00   p210   (Non-Magnetic Core)   0603 (1608)   1.2nH   270nH   270nH   Inductance Lineup   E-24 or Higher   E-24 or Higher   E-12   LQW15AN_0Z   p216   LQW15AN_1Z   p222   Vire Wound Type   0402 (1005)   1.5nH   120nH		LQH43NZ_03 p199	(Ferrite Core)	1812 (4532)			1.0µ	н			2200	μĤ
LQP03TN_Z2		LQG15H_02 p208	Multilayer Type	0402 (1005)	1.0nH		270	nH				
LQP03TN_Z2   P212   FIIm Type (Non-Magnetic Core)   0201 (0603)   0.6nH   120nH   120n		LQG18HH_00 p210	(Non-Magnetic Core)	0603 (1608)	1.2nH		270	nH			:	
I QW18AN 07 P224 (Non-Magnetic Core) 0603 (1608) 2 2nH 470nH *There are some items that	ıctors	LQP03TN_Z2 p212		0201 (0603)	0.6nH		120nH		In	: E-2	4 or Highe	r
I QW18AN 07 P224 (Non-Magnetic Core) 0603 (1608) 2 2nH 470nH *There are some items that	Indt	LQW15AN_0Z p216		0402 (1005)	1.5nH		120nH					
	RF	LQW15AN_1Z p222		0402 (1005)	1.3nH	8.4nH						
do not match to E step.		LQW18AN_0Z p224	(Non-Magnetic Core)	0603 (1608)	2.2nH		4	70nH				
LQW18AN_1Z p227 0603 (1608) 2.2nH 33nH		LQW18AN_1Z p227		0603 (1608)	2.2nH		33nH			:	:	

CAUTION: Use rosin-based flux, but not strong acidic flux (with chlorine content exceeding 0.2wt%) when soldering chip inductors (chip coils). Do not use water-soluble flux.

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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.











## Inductors for Power Lines Part Numbering

(Part Number)





























#### Product ID

Product ID	
LQ	Chip Inductors (Chip Coils)

#### 2Structure

Code	Structure		
Н	Wire Wound Type (Ferrite Core)		
M	Multilayer Type (Ferrite Core)		

### 3Dimensions (LXW)

Code	Dimensions (L×W)	Size Code (in inch)
21	2.0×1.25mm	0805
2M	2.0×1.6mm	0806
2H	2.5×2.0mm	1008
3N	3.0×3.0mm	1212
32	3.2×2.5mm	1210
43	4.5×3.2mm	1812
44	4.0×4.0mm	1515
5B	5.0×5.0mm	2020

#### 4 Applications and Characteristics

Code	Series Applications and Characteristics	
D	LQH	for Choke
С	LQH for Choke (Coating Type)	
Р	LQM/LQH for Power Line	

### 6 Category

Code	Category		
Z	A ta ma a tir . a	Infotainment	
Н	Automotive	Powertrain/Safety	

#### **6**Inductance

Expressed by three-digit alphanumerics. The unit is micro-henry  $(\mu H)$ . The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures. If there is a decimal point, it is expressed by the capital letter "R." In this case, all figures are significant digits. If inductance is less than  $0.1\mu H$ , the inductance code is expressed by a combination of two figures and the capital letter "N," and the unit of inductance is nano-henry (nH).

The capital letter "N" indicates the unit of "nH," and also expresses a decimal point. In this case, all figures are significant digits.

#### Inductance Tolerance

Code	Inductance Tolerance		
K	±10%		
M	±20%		
N	±30%		

### **3**Features (Except for LQH□□P/LQM□□P)

Code	Features	Series
2	Standard Type	
3	Low DC Resistance	LQH32C/32D
5	Low Profile Type	

### 8Thickness

#### (LQH□□P/LQM□□P Only • Except for LQH43P)

Code	Dimensions (T)			
С	0.5mm			
E	0.7mm			
G	0.9mm			
J	1.1mm			
N	1.55mm			
Т	2.0mm			

### 9 Electrode (Except for LQH□□P/LQM□□P)

### ·Lead (Pb) Free

Code	Electrode	Series
0	Sn	LQM/LQW
3	LF Solder	LQH

### Specification

## (LQH P/LQM P Only • Except for LQH43P)

,	/ / /		
Code	Specification		
0/S	Standard Type		
С	Good Bias Current Characteristics Type		
R	Low DC Resistance Type		

Continued on the following page.





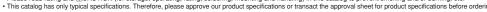
## **39**Thickness (**LQH43P** Only)

Code	Dimensions (T)
26	2.6mm

### Packaging

Code	Packaging	Series	
K Embossed Taping (ø330mm Reel)		LQH*1	
L	Embossed Taping (ø180mm Reel)	LQH/LQM2HP/LQM2MP	
В	Bulk	LQM	
D	Paper Taping (ø180mm Reel)	LQM21P	

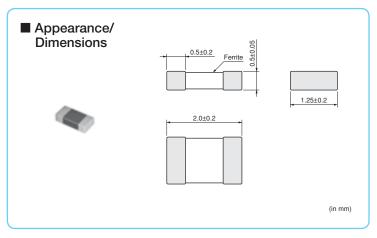
<sup>\*1</sup> Except for LQH2HP\_JR/LQH3NP\_JR





## 121PZ\_CO<sub>Series 0805/2012 (inch/mm)</sub>

## Size Code 0805 (2012) in inch (in mm), 0.55mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
В	Packing in Bulk	1000

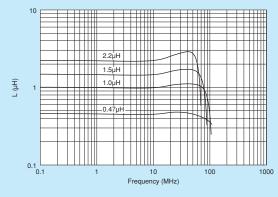


Refer to pages from p.191 to p.194 for mounting information.

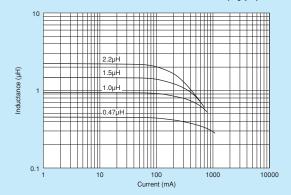
## ■ Rated Value (□: packaging code)

Part Number		Inductance	Inductance	Rated	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Test Frequency	Current	Resistance	Frequency (min.)
LQM21PZR47MC0□	_	$0.47 \mu H \pm 20\%$	1MHz	1100mA	$0.12\Omega\pm25\%$	100MHz
LQM21PZ1R0MC0□	_	$1.0 \mu H \pm 20\%$	1MHz	800mA	$0.19\Omega\pm25\%$	90MHz
LQM21PZ1R5MC0□	_	$1.5 \mu H \pm 20\%$	1MHz	700mA	$0.26\Omega{\pm}25\%$	70MHz
LQM21PZ2R2MC0□	_	2.2µH ±20%	1MHz	600mA	$0.34 \Omega \pm 25\%$	50MHz

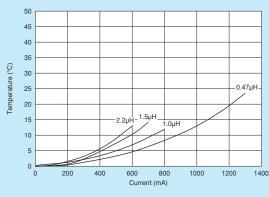
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



## ■ Temperature Rise Characteristics (Typ.)

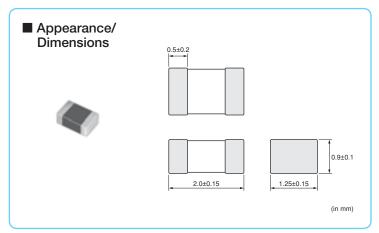


158

<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## 21PZ\_GO<sub>Series</sub> 0805/2012 (inch/mm)

## Size Code 0805 (2012) in inch (in mm), 1.0mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
В	Packing in Bulk	1000



Refer to pages from p.191 to p.194 for mounting information.

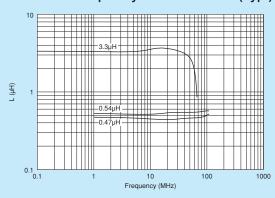
## ■ Rated Value (□: packaging code)

Part N	umber	Inductance	Rated	DC	Self-Resonance		
For Infotainment	For Powertrain/Safety	inductance	Ambient Temperature 85°C	Ambient Temperature 125°C	Resistance	Frequency (min.)	
LQM21PZR47MG0□	_	0.47µH ±20%	1.3A	0.95A	$0.094\Omega$ (max.) / $0.075\Omega$ (typ.)	100MHz	
LQM21PZR54MG0□	_	0.54µH ±20%	1.3A	0.95A	$0.094\Omega$ (max.) / $0.075\Omega$ (typ.)	100MHz	
LQM21PZ3R3MG0□	_	3.3µH ±20%	0.8A	0.55A	$0.207\Omega$ (max.) / $0.165\Omega$ (typ.)	30MHz	
LQM21PZ3R3NG0□	_	3.3µH ±30%	0.8A	0.55A	$0.207\Omega$ (max.) / $0.165\Omega$ (typ.)	30MHz	

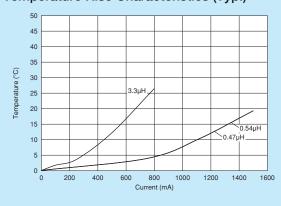
Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of ferrite

Operating Temperature Range: -55°C~+125°C

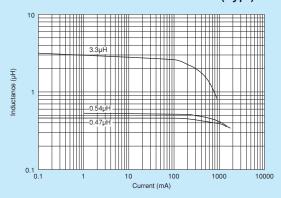
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Temperature Rise Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)

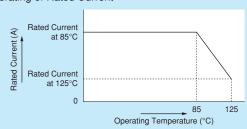


## ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for LQM21P G0 series.

Please apply the derating curve shown in chart according to the operating temperature.

**Derating of Rated Current** 

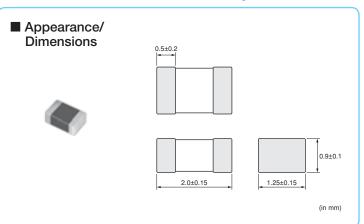


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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<sup>1</sup> When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.

# LQM21P\_GC Series 0805/2012 (inch/mm)

## **Bias Current Characteristics Improved**



## ■ Packaging

Code	ode Packaging	
D	ø180mm Paper Taping	2000
В	Packing in Bulk	1000

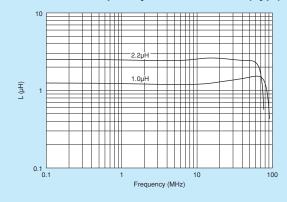


Refer to pages from p.191 to p.194 for mounting information.

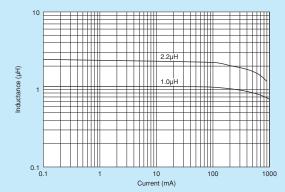
## ■ Rated Value (□: packaging code)

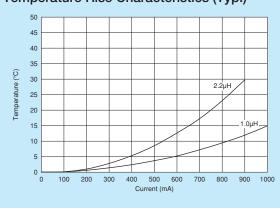
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	Frequency (min.)
LQM21PZ1R0NGC□	_	1.0µH ±30%	1MHz	900mA	$0.10\Omega \pm 25\%$	50MHz
_	LQM21PH2R2MGC□	2.2µH ±20%	1MHz	800mA	$0.23\Omega \pm 25\%$	40MHz
LQM21PZ2R2NGC□	_	2.2µH ±30%	1MHz	800mA	$0.23\Omega \pm 25\%$	40MHz

## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)

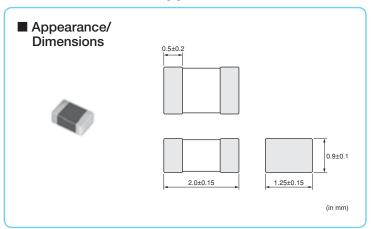




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# 21PZ\_GR<sub>Series</sub> 0805/2012 (inch/mm)

## **Low DC Resistance Type**



## Packaging

1	Code	Packaging	Minimum Quantity			
	D	ø180mm Paper Taping	4000			
	В	Packing in Bulk	1000			

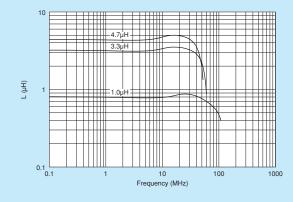


Refer to pages from p.191 to p.194 for mounting information.

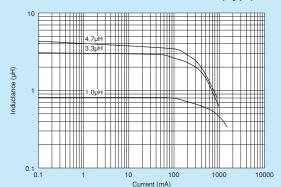
## ■ Rated Value (□: packaging code)

Part N	Part Number		Inductance	Rated	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	Frequency (min.)
LQM21PZ1R0NGR□	_	1.0µH ±30%	1MHz	1300mA	$0.066\Omega \pm 25\%$	50MHz
LQM21PZ3R3MGR□	_	3.3µH ±20%	1MHz	1000mA	$0.150\Omega \pm 25\%$	30MHz
LQM21PZ3R3NGR□	_	3.3µH ±30%	1MHz	1000mA	$0.150\Omega \pm 25\%$	30MHz
LQM21PZ4R7MGR□	_	4.7µH ±20%	1MHz	800mA	$0.23\Omega \pm 25\%$	30MHz
LQM21PZ4R7NGR□	_	4.7µH ±30%	1MHz	800mA	$0.23\Omega \pm 25\%$	30MHz

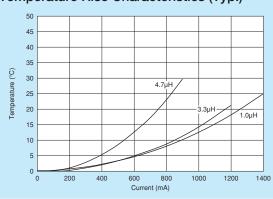
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



## ■ Temperature Rise Characteristics (Typ.)

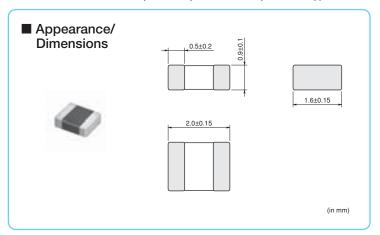


⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# 12MPZ\_G0<sub>Series</sub> 0806/2016 (inch/mm)

## Size Code 0806 (2016) in inch (in mm), 1.0mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
В	B Packing in Bulk	



Refer to pages from p.191 to p.194 for mounting information.

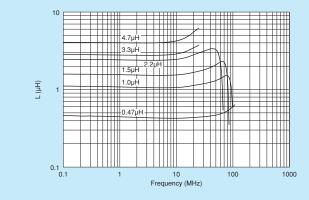
■ Rated Value (□: packaging code)

	paonaging coac,					
Part N	Part Number		Rated (	DC	Self-Resonance	
For Infotainment	For Powertrain/Safety	Inductance	Ambient Temperature 85°C	Ambient Temperature 125°C	Resistance	Frequency (min.)
LQM2MPZR47MG0□	_	0.47µH ±20%	1.6A	1.2A	$0.075\Omega(\text{max.})/0.060\Omega(\text{typ.})$	100MHz
LQM2MPZR47NG0□	_	0.47µH ±30%	1.6A	1.2A	$0.075\Omega(\text{max.})/0.060\Omega(\text{typ.})$	100MHz
LQM2MPZ1R0NG0□	_	1.0µH ±30%	1.4A	1.0A	$0.107\Omega(\text{max.})/0.085\Omega(\text{typ.})$	60MHz
LQM2MPZ1R5MG0□	_	1.5µH ±20%	1.2A	0.9A	0.138 Ω (max.) / 0.11 Ω (typ.)	50MHz
LQM2MPZ1R5NG0□	_	1.5µH ±30%	1.2A	0.9A	$0.138\Omega(max.)$ / $0.11\Omega(typ.)$	50MHz
LQM2MPZ2R2MG0□	_	2.2µH ±20%	1.2A	0.9A	0.138 Ω (max.) / 0.11 Ω (typ.)	40MHz
LQM2MPZ2R2NG0□	_	2.2µH ±30%	1.2A	0.9A	$0.138\Omega(max.)$ / $0.11\Omega(typ.)$	40MHz
LQM2MPZ3R3NG0□	_	3.3µH ±30%	1.2A	0.9A	0.15Ω(max.) / 0.12Ω(typ.)	30MHz
LQM2MPZ4R7MG0□	_	4.7µH ±20%	1.1A	0.8A	$0.175\Omega(max.)$ / $0.14\Omega(typ.)$	20MHz
LQM2MPZ4R7NG0□	_	4.7µH ±30%	1.1A	0.8A	0.175 Ω (max.) / 0.14 Ω (typ.)	20MHz

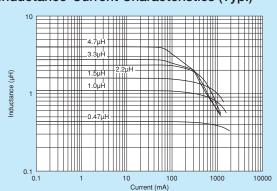
Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of ferrite

Operating Temperature Range: -55°C  $\sim$ +125°C

## ■ Inductance-Frequency Characteristics (Typ.)

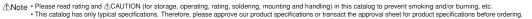


## ■ Inductance-Current Characteristics (Typ.)



Continued on the following page.

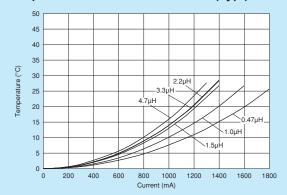






<sup>\*1</sup> When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.

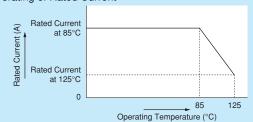
## ■ Temperature Rise Characteristics (Typ.)



## ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for LQM2MP\_G0 series. Please apply the derating curve shown in chart according to the operating temperature.

**Derating of Rated Current** 

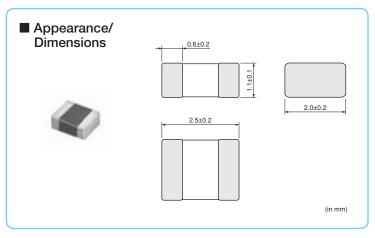


General

## **Multilayer Type (Ferrite Core)**

## LQM2HPZ\_JO<sub>Series</sub> 1008/2520 (inch/mm)

## Size Code 1008 (2520) in inch (in mm), 1.2mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
В	Packing in Bulk	1000



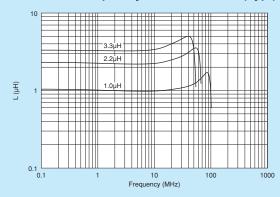
Refer to pages from p.191 to p.194 for mounting information.

## ■ Rated Value (□: packaging code)

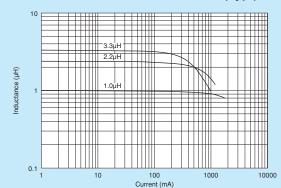
— : : a : a : a : a : a : a : a : a : a	= riates raise (=: paeriaging ecoe)						
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance	
For Infotainment	For Powertrain/Safety	Test Fred	Test Frequency	Current	Resistance	Frequency (min.)	
LQM2HPZ1R0MJ0□	_	1.0µH ±20%	1MHz	1500mA	0.09Ω±25%	70MHz	
LQM2HPZ2R2MJ0□	_	2.2µH ±20%	1MHz	1000mA	$0.12 \Omega \pm 25\%$	40MHz	
LQM2HPZ3R3MJ0□	_	3.3µH ±20%	1MHz	1000mA	$0.12\Omega \pm 25\%$	30MHz	

Class of Magnetic Shield: Magnetic shield of ferrite Operating Temperature Range: -55°C~+125°C

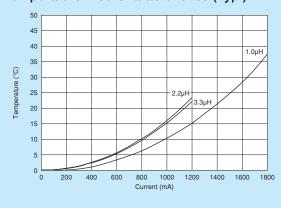
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



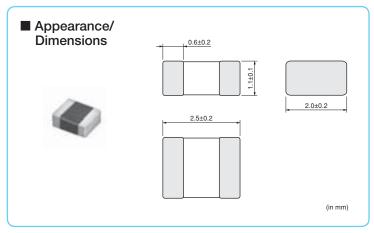
### ■ Temperature Rise Characteristics (Typ.)



## ⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc. • This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# 12HPZ\_JC<sub>Series</sub> 1008/2520 (inch/mm)

## **Bias Current Characteristics Improved**



## Packaging

	Code	Packaging	Minimum Quantity
	L	ø180mm Embossed Taping	3000
I	В	Packing in Bulk	1000



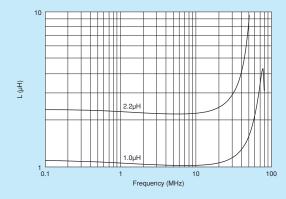
Refer to pages from p.191 to p.194 for mounting information.

## ■ Rated Value (□: packaging code)

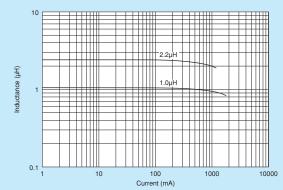
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance
For Infotainment	For Powertrain/Safety		Current	Resistance	Frequency (min.)	
LQM2HPZ1R0MJC□	_	1.0µH ±20%	1MHz	1500mA	$0.086\Omega \pm 25\%$	50MHz
LQM2HPZ2R2NJC□	_	$2.2 \mu H \pm 30\%$	1MHz	1000mA	$0.175\Omega\pm25\%$	30MHz

Class of Magnetic Shield: Magnetic shield of ferrite Operating Temperature Range: -55°C ~+125°C

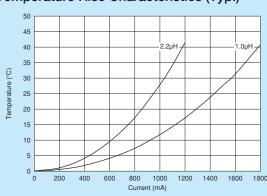
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



## ■ Temperature Rise Characteristics (Typ.)

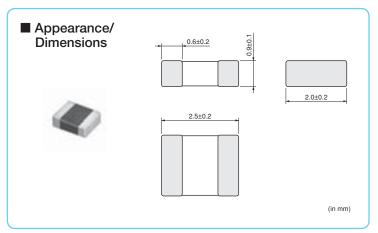


## ⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc. • This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



## 1008/2520 (inch/mm)

## Size Code 1008 (2520) in inch (in mm), 1.0mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
В	B Packing in Bulk	



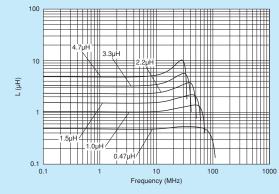
Refer to pages from p.191 to p.194 for mounting information.

## ■ Rated Value (□: packaging code)

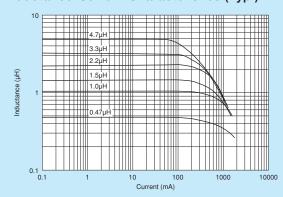
Part Number		Inductance	DC	Rated	Self-Resonance	
For Infotainment	For Powertrain/Safety	inductance	Resistance	Ambient Temperature 85°C	Ambient Temperature 125°C	Frequency (min.)
LQM2HPZR47MG0□	_	0.47µH ±20%	$0.050\Omega(\text{max.})/0.040\Omega(\text{typ.})$	1.8A	1.3A	100MHz
LQM2HPZ1R0MG0□	_	1.0µH ±20%	$0.069\Omega(\text{max.})/0.055\Omega(\text{typ.})$	1.6A	1.2A	60MHz
LQM2HPZ1R5MG0□	_	1.5µH ±20%	$0.088\Omega(\text{max.})/0.070\Omega(\text{typ.})$	1.5A	1.1A	50MHz
LQM2HPZ2R2MG0□	_	2.2µH ±20%	0.10 Ω (max.)/0.080 Ω (typ.)	1.3A	0.97A	40MHz
LQM2HPZ3R3MG0□	_	3.3µH ±20%	0.125Ω (max.)/0.10Ω (typ.)	1.2A	0.9A	30MHz
LQM2HPZ4R7MG0□	_	4.7μH ±20%	0.138Ω (max.)/0.11Ω (typ.)	1.1A	0.82A	25MHz

 $\label{eq:local_$ 

## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



Continued on the following page.

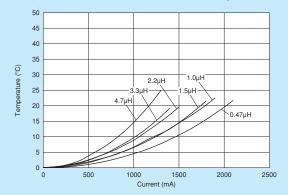






<sup>\*1</sup> When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.

## ■ Temperature Rise Characteristics (Typ.)

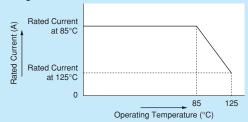


## ■ Derating of Rated Current

In operating temperature exceeding +85°C, derating of current is necessary for LQM2HP\_G0 series.

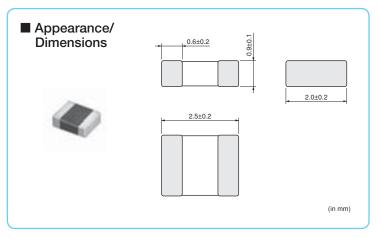
Please apply the derating curve shown in chart according to the operating temperature.

## **Derating of Rated Current**



## 1008/2520 (inch/mm)

## Size Code 1008 (2520) in inch (in mm), 1.0mm max. Thickness



■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	3000
В	Packing in Bulk	1000



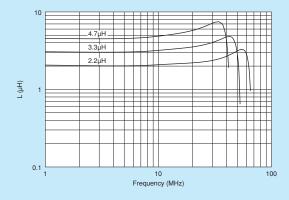
Refer to pages from p.191 to p.194 for mounting information.

## ■ Rated Value (□: packaging code)

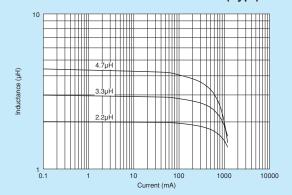
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance	
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	Frequency (min.)	
LQM2HPZ2R2MGS□	_	2.2µH ±20%	1MHz	1100mA	$0.18\Omega\pm25\%$	40MHz	
LQM2HPZ3R3MGS□	_	3.3µH ±20%	1MHz	1050mA	$0.21\Omega\pm25\%$	20MHz	
LQM2HPZ4R7MGS□	_	4.7µH ±20%	1MHz	1000mA	$0.25\Omega{\pm}25\%$	20MHz	

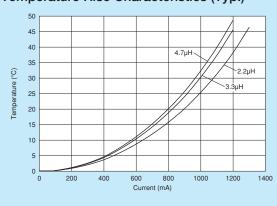
Class of Magnetic Shield: Magnetic shield of ferrite Operating Temperature Range: -40°C~+85°C

## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)

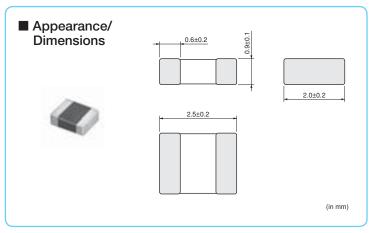




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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## 2HPZ\_GC<sub>Series</sub> 1008/2520 (inch/mm)

## **Bias Current Characteristics Improved**



## ■ Packaging

	Code	Packaging	Minimum Quantity
	L	ø180mm Embossed Taping	3000
Ī	В	Packing in Bulk	1000



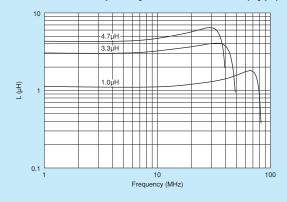
Refer to pages from p.191 to p.194 for mounting information.

## ■ Rated Value (□: packaging code)

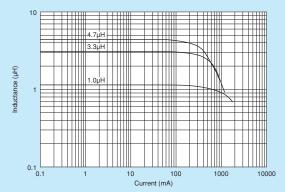
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance	Operating Temperature Range	
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency (		Resistance	Frequency (min.)		
LQM2HPZ1R0MGC□	_	1.0µH ±20%	1MHz	1500mA	$0.08\Omega \pm 25\%$	50MHz	-30°C∼+85°C	
LQM2HPZ3R3MGC□	_	3.3µH ±20%	1MHz	1000mA	0.16Ω±25%	30MHz	-55°C∼+125°C	
LQM2HPZ4R7MGC□	_	4.7μH ±20%	1MHz	800mA	0.18Ω±25%	25MHz	-55°C∼+125°C	

Class of Magnetic Shield: Magnetic shield of ferrite

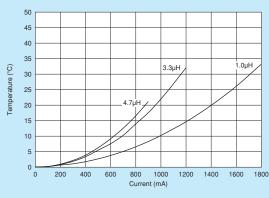
## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



## ■ Temperature Rise Characteristics (Typ.)



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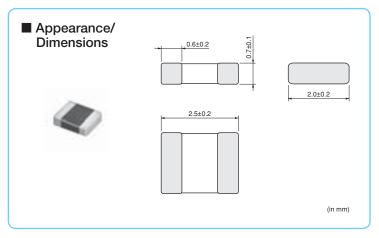


General

## **Multilayer Type (Ferrite Core)**

## 1008/2520 (inch/mm)

## Size Code 1008 (2520) in inch (in mm), 0.8mm max. Thickness



#### ■ Packaging Packaging Quantity ø180mm Embossed Taping 3000

Packing in Bulk

В



Refer to pages from p.191 to p.194 for mounting information.

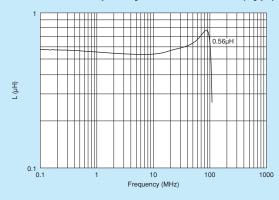
1000

■ Rated Value (□: packaging code)

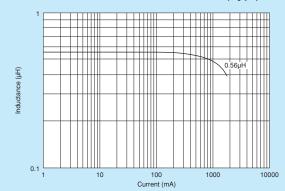
Part Number		Inductance	Inductance	Rated	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	Frequency (min.)
LQM2HPZR56ME0□	_	0.56µH ±20%	1MHz	1500mA	$0.06\Omega \pm 25\%$	70MHz

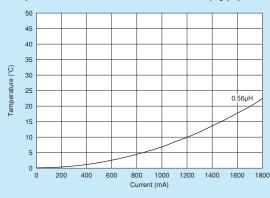
Class of Magnetic Shield: Magnetic shield of ferrite Operating Temperature Range: -55  $^{\circ}$ C  $^{\sim}$ +125  $^{\circ}$ C

## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



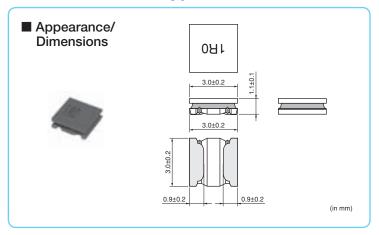


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**Wire Wound Type (Ferrite Core)** 

# 3NPZ\_JR Series 1212/3030 (inch/mm)

## Low DC Resistance Type, 1.2mm max. Thickness



■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000





Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: nackaging code)

■ nated value (□. packaging code)									
Part N	umber	Inductance	Rated Current *1 (Based on Inductance	Rated Current (Based	on Temperature Rise) *2	DC	Self-Resonance		
For Infotainment	For Powertrain/Safety	inductance	Change)	Ambient Temperature 85°C*3	Ambient Temperature 105°C*4	Resistance	Frequency (min.)		
LQH3NPZR68NJR□	_	0.68µH ±30%	2700mA	2860mA	1280mA	$0.032\Omega\pm20\%$	130MHz		
LQH3NPZ1R0MJR□	_	1.0µH ±20%	2250mA	2780mA	1230mA	0.040 Ω ±20%	100MHz		
LQH3NPZ1R5MJR□	_	1.5µH ±20%	1950mA	2510mA	1100mA	$0.049\Omega\pm20\%$	60MHz		
LQH3NPZ2R2MJR□	_	2.2µH ±20%	1800mA	2200mA	980mA	$0.068\Omega\pm20\%$	45MHz		
LQH3NPZ3R3MJR□	_	3.3µH ±20%	1350mA	1700mA	750mA	$0.095\Omega\pm20\%$	45MHz		
LQH3NPZ4R7MJR□	_	4.7µH ±20%	1180mA	1580mA	710mA	0.12Ω±20%	40MHz		
LQH3NPZ6R8MJR□	_	6.8µH ±20%	970mA	1360mA	610mA	0.18Ω±20%	35MHz		
LQH3NPZ100MJR□	_	10µH ±20%	810mA	1200mA	530mA	0.24Ω±20%	30MHz		
LQH3NPZ150MJR□	_	15µH ±20%	650mA	870mA	370mA	0.38Ω±20%	25MHz		
LQH3NPZ220MJR□	_	22µH ±20%	520mA	800mA	350mA	0.50Ω±20%	20MHz		
LQH3NPZ330MJR□	_	33µH ±20%	420mA	630mA	280mA	0.79Ω±20%	15MHz		
LQH3NPZ470MJR□	_	47μH ±20%	360mA	570mA	240mA	1.0Ω±20%	10MHz		

Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

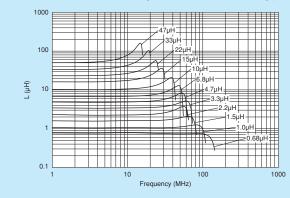
Operating Temperature Range (Self-temperature rise is included): -40  $^{\circ}\text{C} \sim +125 ^{\circ}\text{C}$ 

Operating Temperature Range (Self-temperature rise is not included): -40°C~+105°C

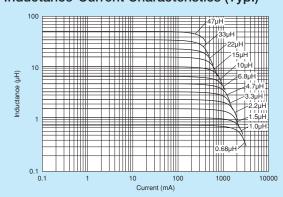
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within ±30% of initial inductance value range.
- \*2 Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.
- \*3 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max. (Ambient temperature 85°C).
- \*4 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 20°C max. (Ambient temperature 85°C to 105°C)





## ■ Inductance-Current Characteristics (Typ.)



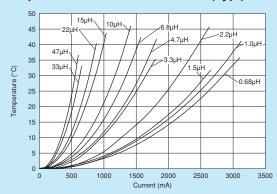
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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before



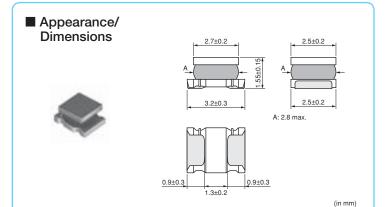




**Wire Wound Type (Ferrite Core)** 

# 132PZ\_NO<sub>Series 1210/3225 (inch/mm)</sub>

## 1.7mm max. Thickness



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500



Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: nackaging code)

■ nateu value (∟	: packaging code	=)					
Part N	umber	Inductance	Rated Current *1*3 (Based on Inductance	Rated Current (Based	on Temperature Rise) *2*3	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Change)	Ambient Temperature 85°C	Ambient Temperature 105°C	Resistance	Frequency (min.)
LQH32PZR47NN0□	_	0.47µH ±30%	3400mA	2550mA	1600mA	0.030 Ω ±20%	100MHz
LQH32PZ1R0NN0□	_	1.0µH ±30%	2300mA	2050mA	1320mA	0.045Ω±20%	100MHz
LQH32PZ1R5NN0□	_	1.5µH ±30%	1750mA	1750mA	1010mA	0.057Ω±20%	70MHz
LQH32PZ2R2NN0□	_	2.2µH ±30%	1550mA	1600mA	970mA	0.076Ω±20%	70MHz
LQH32PZ3R3NN0□	_	3.3µH ±30%	1250mA	1200mA	670mA	0.12Ω±20%	50MHz
LQH32PZ4R7NN0□	_	4.7µH ±30%	1000mA	1000mA	530mA	0.18Ω±20%	40MHz
LQH32PZ6R8NN0□	_	6.8µH ±30%	850mA	850mA	510mA	0.24Ω±20%	40MHz
LQH32PZ100MN0□	_	10μH ±20%	750mA	700mA	380mA	0.38Ω±20%	30MHz
LQH32PZ150MN0□	_	15µH ±20%	600mA	520mA	320mA	0.57Ω±20%	20MHz
LQH32PZ220MN0□	_	22μH ±20%	500mA	450mA	240mA	0.81Ω±20%	20MHz
LQH32PZ330MN0□	_	33μH ±20%	380mA	390mA	190mA	1.15Ω±20%	13MHz
LQH32PZ470MN0□	_	47μH ±20%	330mA	310mA	140mA	1.78Ω±20%	11MHz
LQH32PZ680MN0□	_	68µH ±20%	280mA	275mA	120mA	2.28Ω±20%	11MHz
LQH32PZ101MN0□	_	100μH ±20%	180mA	250mA	110mA	2.70Ω±20%	8MHz
LQH32PZ121MN0□	_	120µH ±20%	170mA	200mA	80mA	4.38Ω±20%	8MHz

Inductance Test Frequency: 1MHz

Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

Operating Temperature Range (Self-temperature rise is included): -40°C~+125°C

Operating Temperature Range (Self-temperature rise is not included): -40°C~+105°C

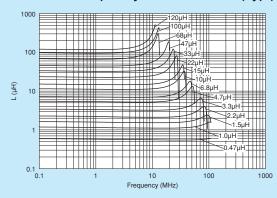
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within  $\pm 30\%$  of nomonal inductance value.
- \*2 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.
- \*3 Keep the temperature (ambient temperature plus self-generation of heat) under 125  $^{\circ}$ C.

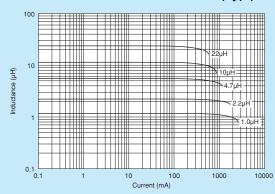
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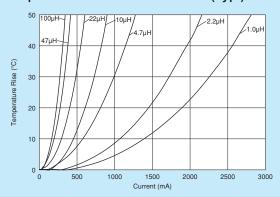


## ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)





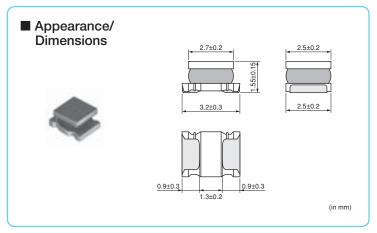


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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## **Wire Wound Type (Ferrite Core)**

# 32PZ\_NCSeries 1210/3225 (inch/mm)

## 1.7mm max. Thickness, Bias Current Characteristics Improved



## Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500





Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

■ Flated Value (□. paokaging oode)								
Part N	umber	Inductance	Rated Current *1*3 (Based on Inductance		on Temperature Rise) *2*3	DC	Self-Resonance Frequency	
For Infotainment	For Powertrain/Safety	inductance	Change)	Ambient Temperature 85°C	Ambient Temperature 105°C	Resistance	(min.)	
LQH32PZR47NNC□	_	0.47µH ±30%	4400mA	2900mA	1490mA	0.024Ω±20%	100MHz	
LQH32PZ1R0NNC□	_	1.0µH ±30%	3000mA	2500mA	1380mA	0.036Ω±20%	100MHz	
LQH32PZ1R5NNC□	_	1.5µH ±30%	2600mA	2100mA	1110mA	0.053Ω±20%	70MHz	
LQH32PZ2R2NNC□	_	2.2µH ±30%	2000mA	1850mA	910mA	0.064Ω±20%	70MHz	
LQH32PZ3R3NNC□	_	3.3µH ±30%	1900mA	1550mA	800mA	0.100Ω±20%	50MHz	
LQH32PZ4R7NNC□	_	4.7µH ±30%	1600mA	1200mA	610mA	0.155Ω±20%	40MHz	
LQH32PZ6R8NNC□	_	6.8µH ±30%	1300mA	1100mA	550mA	0.220 Ω ±20%	40MHz	
LQH32PZ100MNC□		10µH ±20%	1000mA	900mA	450mA	$0.295 \Omega \pm 20\%$	30MHz	
LQH32PZ150MNC□	_	15µH ±20%	800mA	700mA	330mA	0.475Ω±20%	20MHz	
LQH32PZ220MNC□	_	22µH ±20%	650mA	550mA	270mA	0.685Ω±20%	20MHz	

Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

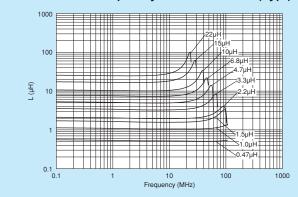
Operating Temperature Range (Self-temperature rise is included): -40  $^{\circ}\text{C} \sim +125 ^{\circ}\text{C}$ 

Operating Temperature Range (Self-temperature rise is not included): -40  $^{\circ}$ C $^{\sim}$ +105  $^{\circ}$ C

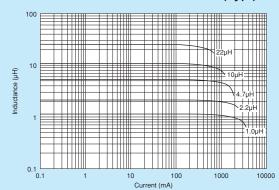
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within  $\pm 30\%$  of nomonal inductance value.
- \*2 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.
- $^{*}3$  Keep the temperature (ambient temperature plus self-generation of heat) under 125  $^{\circ}$ C.

## ■ Inductance-Frequency Characteristics (Typ.)



### ■ Inductance-Current Characteristics (Typ.)



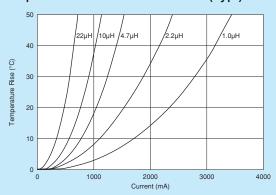
Continued on the following page.





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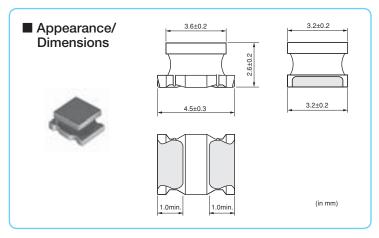




## **Wire Wound Type (Ferrite Core)**

# 43PZ\_26<sub>Series</sub> 1812/4532 (inch/mm)

## Size Code 1812 (4532) in inch (in mm)



## ■ Packaging

Code	Packaging	Minimum Quantity		
L	ø180mm Embossed Taping	500		
K	ø330mm Embossed Taping	2500		



Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

Trated value ( packaging code)											
Part N	Part Number		Rated Current *1*3 (Based on Inductance			DC	Self-Resonance				
For Infotainment	For Powertrain/Safety	Inductance	Change)	Ambient Temperature 85°C	Ambient Temperature 105°C	Resistance	Frequency (min.)				
LQH43PZ1R0N26□	_	1.0µH ±30%	3400mA	3300mA	1410mA	0.026Ω±20%	100MHz				
LQH43PZ2R2M26□	_	2.2µH ±20%	2300mA	2500mA	1120mA	0.042Ω±20%	45MHz				
LQH43PZ3R3M26□	_	3.3µH ±20%	1800mA	2100mA	1000mA	0.052Ω±20%	40MHz				
LQH43PZ4R7M26□	_	4.7µH ±20%	1400mA	1600mA	780mA	0.075Ω±20%	35MHz				
LQH43PZ6R8M26□	_	6.8µH ±20%	1200mA	1400mA	760mA	0.098Ω±20%	30MHz				
LQH43PZ8R2M26□	_	8.2µH ±20%	1100mA	1300mA	670mA	0.128Ω±20%	25MHz				
LQH43PZ100M26□	_	10μH ±20%	1050mA	1170mA	620mA	0.147Ω±20%	20MHz				
LQH43PZ220M26□	_	22μH ±20%	700mA	780mA	400mA	0.327Ω±20%	15MHz				
LQH43PZ470M26□	_	47μH ±20%	470mA	520mA	280mA	0.718Ω±20%	8MHz				
LQH43PZ101M26□	_	100μH ±20%	320mA	320mA	180mA	1.538Ω±20%	4MHz				
LQH43PZ151M26□	_	150µH ±20%	280mA	260mA	140mA	2.362Ω±20%	3MHz				
LQH43PZ221M26□	_	220µH ±20%	220mA	240mA	130mA	2.900 Ω ±20%	2MHz				

Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

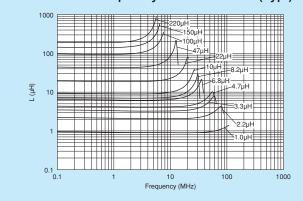
Operating Temperature Range (Self-temperature rise is included): -40  $^{\circ}\text{C} \sim +125 ^{\circ}\text{C}$ 

Operating Temperature Range (Self-temperature rise is not included): -40°C ~+105°C

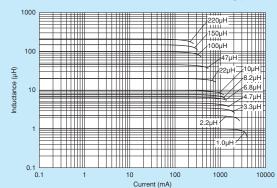
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within ±30% of nomonal inductance value.
- \*2 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.
- \*3 Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.

## ■ Inductance-Frequency Characteristics (Typ.)



### ■ Inductance-Current Characteristics (Typ.)



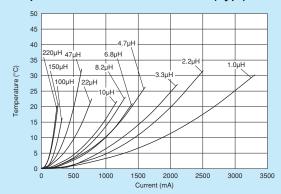
Continued on the following page.





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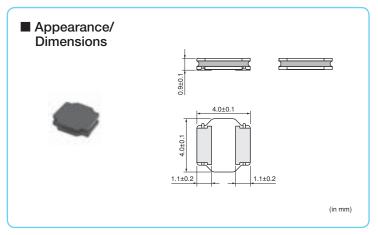




# **Wire Wound Type (Ferrite Core)**

# 44PZ\_GR Series 1515/4040 (inch/mm)

# Size Code 4040 (1515) in mm (in inch), 1.0mm max. Thickness. Low DC Resistance



# ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	1000
K	ø330mm Embossed Taping	4500







Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

■ Hated Value (□							
Part N	umber	Inductance	Rated Current *1 (Based on Inductance		DC	Self-Resonance Frequency	
For Infotainment	For Powertrain/Safety	muuotanoe	Change)	Ambient Temperature 85°C*3	Ambient Temperature 105°C*4	Resistance	(min.)
LQH44PZR68NGR□	_	0.68µH ±30%	2.4A	2.5A	1.5A	0.043Ω±20%	54MHz
LQH44PZ1R0NGR□	_	1.0µH ±30%	2.0A	2.4A	1.4A	0.043Ω±20%	50MHz
LQH44PZ2R2NGR□	_	2.2µH ±30%	1.6A	2.0A	1.2A	0.074Ω±20%	45MHz
LQH44PZ3R3NGR□	_	3.3µH ±30%	1.5A	1.7A	1.0A	0.11Ω±20%	25MHz
LQH44PZ4R7MGR□	_	4.7µH ±20%	1.2A	1.6A	0.96A	0.13Ω±20%	17MHz
LQH44PZ6R8MGR□	_	6.8µH ±20%	0.85A	1.4A	0.84A	0.17Ω±20%	15MHz
LQH44PZ100MGR□	_	10µH ±20%	0.80A	1.1A	0.66A	0.27Ω±20%	13MHz
LQH44PZ150MGR□	_	15µH ±20%	0.64A	0.9A	0.54A	0.42Ω±20%	10MHz
LQH44PZ220MGR□	_	22µH ±20%	0.50A	0.75A	0.45A	0.57Ω±20%	8MHz
LQH44PZ330MGR□	_	33µH ±20%	0.40A	0.48A	0.28A	1.4Ω±20%	6MHz
LQH44PZ470MGR□	_	47µH ±20%	0.36A	0.41A	0.24A	1.7Ω±20%	6MHz

Class of Magnetic Shield: Magnetic shield of magnetic powder in resin Inductance Test Frequency: 1MHz

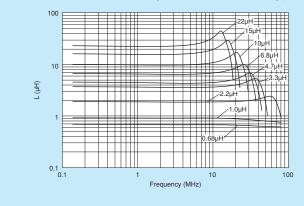
Operating Temperature Range (Self-temperature rise is included): -40°C~+125°C

Operating Temperature Range (Self-temperature rise is not included): -40°C~+105°C

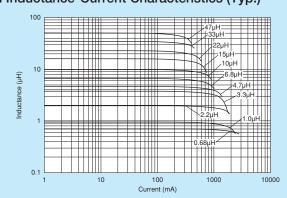
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within  $\pm 30\%$  of initial inductance value range.
- \*2 Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.
- \*3 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max. (Ambient temperature 85°C).
- \*4 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 20°C max. (Ambient temperature 85°C to 105°C).

# ■ Inductance-Frequency Characteristics (Typ.)



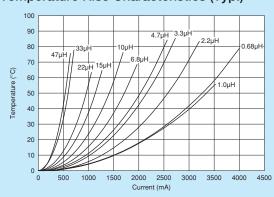
# ■ Inductance-Current Characteristics (Typ.)









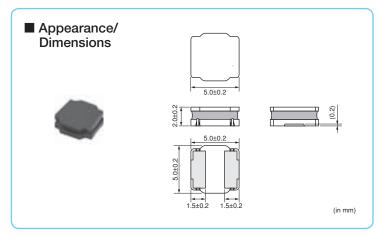




# **Wire Wound Type (Ferrite Core)**

# 5BPZ\_TO<sub>Series 2020/5050 (inch/mm)</sub>

# Size Code 2020 (5050) in inch (in mm)



### Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	500
K	ø330mm Embossed Taping	3000



Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

■ Rated value (□: packaging code)								
Part N	umber	Inductance	Rated Current *1*3 (Based on Inductance		DC	Self-Resonance Frequency		
For Infotainment	For Powertrain/Safety	muuctance	Change)	Ambient Temperature 85°C	Ambient Temperature 105°C	Resistance	(min.)	
LQH5BPZR47NT0□	_	$0.47 \mu H \pm 30\%$	7.7A	4.0A	2.05A	0.012Ω±20%	220MHz	
LQH5BPZ1R0NT0□	_	1.0µH ±30%	5.8A	3.1A	1.68A	0.019Ω±20%	90MHz	
LQH5BPZ1R2NT0□	_	1.2µH ±30%	5.4A	3.1A	1.68A	0.019Ω±20%	90MHz	
LQH5BPZ1R5NT0□	_	1.5µH ±30%	5.0A	3.0A	1.63A	0.024Ω±20%	70MHz	
LQH5BPZ2R2NT0□	_	2.2µH ±30%	4.0A	2.6A	1.37A	$0.030\Omega\pm20\%$	55MHz	
LQH5BPZ2R7NT0□	_	2.7µH ±30%	3.8A	2.5A	1.23A	0.035Ω±20%	50MHz	
LQH5BPZ3R3NT0□	_	3.3µH ±30%	3.5A	2.3A	1.21A	$0.044\Omega\pm20\%$	40MHz	
LQH5BPZ4R7NT0□	_	4.7µH ±30%	3.0A	2.0A	1.09A	$0.058\Omega\pm20\%$	40MHz	
LQH5BPZ6R8NT0□		$6.8 \mu H \pm 30\%$	2.5A	1.65A	0.96A	$0.083\Omega\pm20\%$	30MHz	
LQH5BPZ100MT0□	_	10µH ±20%	2.0A	1.60A	0.87A	0.106Ω±20%	25MHz	
LQH5BPZ150MT0□	_	15µH ±20%	1.6A	1.20A	0.62A	0.187Ω±20%	18MHz	
LQH5BPZ220MT0□	_	22µH ±20%	1.4A	1.05A	0.55A	0.259Ω±20%	15MHz	

Inductance Test Frequency: 100kHz Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

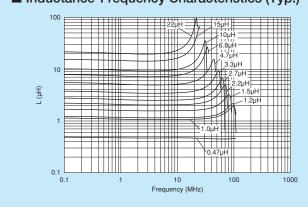
Operating Temperature Range (Self-temperature rise is included): -40  $^{\circ}\text{C} \sim +125 ^{\circ}\text{C}$ 

Operating Temperature Range (Self-temperature rise is not included): -40°C ~+105°C

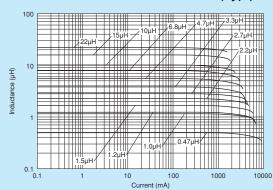
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within ±30% of nomonal inductance value.
- \*2 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max.
- \*3 Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.

# ■ Inductance-Frequency Characteristics (Typ.)



## ■ Inductance-Current Characteristics (Typ.)



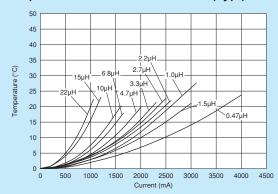




<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
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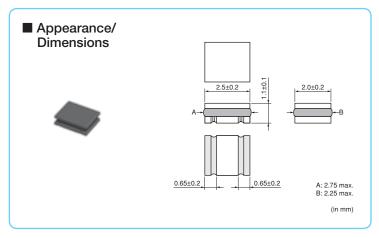
# ■ Temperature Rise Characteristics (Typ.)





# 2HPZ\_JR Series 1008/2520 (inch/mm)

# Size Code 1008 (2520) in inch (in mm), 1.2mm max. Thickness. Low DC Resistance



■ Packaging							
Code	Packaging	Mi Qı					

ø180mm Embossed Taping









Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: nackaging code)

■ hated value (□. packaging code)									
Part No	umber	Inductance	Rated Current *1 (Based on Inductance		DC	Self-Resonance			
For Infotainment	For Powertrain/Safety	inductance	Change)	Ambient Temperature 85°C*3	Ambient Temperature 105°C*4	Resistance	Frequency (min.)		
LQH2HPZR47NJR□	_	0.47µH ±30%	3.50A	2.75A	1.65A	0.031 Ω ±20%	190MHz		
LQH2HPZ1R0NJR□	_	1.0µH ±30%	2.60A	2.40A	1.44A	0.048Ω±20%	120MHz		
LQH2HPZ1R2NJR□	_	1.2µH ±30%	2.45A	2.07A	1.24A	$0.055\Omega\pm20\%$	100MHz		
LQH2HPZ1R5NJR□	_	1.5µH ±30%	2.20A	1.81A	1.08A	$0.075\Omega\pm20\%$	95MHz		
LQH2HPZ2R2MJR□	_	2.2µH ±20%	1.70A	1.65A	0.99A	$0.092\Omega\pm20\%$	50MHz		
LQH2HPZ3R3MJR□	_	3.3µH ±20%	1.45A	1.42A	0.85A	0.13Ω±20%	45MHz		
LQH2HPZ4R7MJR□	_	4.7µH ±20%	1.23A	1.29A	0.77A	0.17Ω±20%	40MHz		
LQH2HPZ6R8MJR□	_	6.8µH ±20%	1.05A	1.00A	0.60A	0.26Ω±20%	35MHz		
LQH2HPZ100MJR□	_	10μH ±20%	0.83A	0.83A	0.49A	0.38Ω±20%	30MHz		
LQH2HPZ150MJR□	_	15µH ±20%	0.69A	0.71A	0.42A	0.55Ω±20%	20MHz		
LQH2HPZ220MJR□	_	22µH ±20%	0.53A	0.54A	0.32A	0.84Ω±20%	20MHz		

Inductance Test Frequency: 1MHz Class of Magnetic Shield: Magnetic shield of magnetic powder in resin

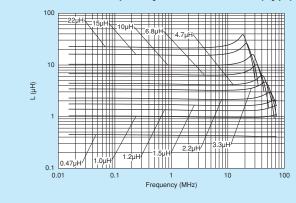
Operating Temperature Range (Self-temperature rise is included): -40°C~+125°C

Operating Temperature Range (Self-temperature rise is not included): -40°C ~+105°C

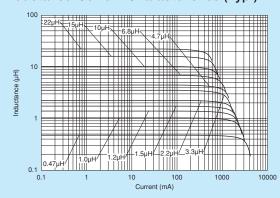
For reflow soldering only.

- \*1 When applied rated current to the products, inductance will be within  $\pm 30\%$  of intial inductance value range.
- \*2 Keep the temperature (ambient temperature plus self-generation of heat) under 125°C.
- \*3 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 40°C max. (Ambient temperature 85°C).
- \*4 When applied rated current to the products, temperature rise caused by self-generated heat shall be limited to 20°C max. (Ambient temperature 85°C to 105°C).

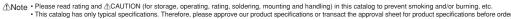
# ■ Inductance-Frequency Characteristics (Typ.)



### ■ Inductance-Current Characteristics (Typ.)



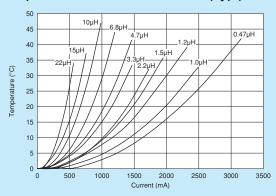








# ■ Temperature Rise Characteristics (Typ.)

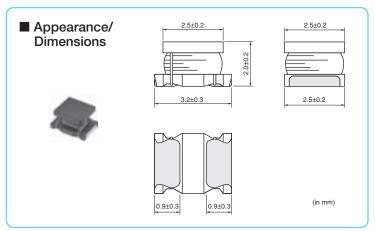




# **Wire Wound Type (Ferrite Core)**

# 32DZ\_23 Series 1210/3225 (inch/mm)

# Size Code 1210 (3225) in inch (in mm)



## ■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500



Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

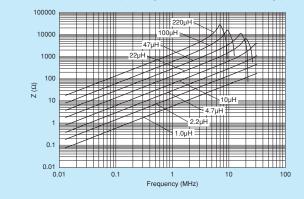
■ Rated Value (□: packaging code)								
	lumber	Inductance	Rated Current *1 (Based on Inductance	Rated Current *1 (Based on Temperature	DC	Self-Resonance		
For Infotainment	For Powertrain/Safety		Change)	Rise)	Resistance	Frequency (min.)		
LQH32DZ1R0M23□	_	$1.0 \mu H \pm 20\%$	800mA	800mA	$0.09\Omega{\pm}30\%$	96MHz		
LQH32DZ2R2M23□	_	$2.2\mu H \pm 20\%$	600mA	600mA	$0.13\Omega\pm30\%$	64MHz		
LQH32DZ3R3M23□	_	$3.3 \mu H \pm 20\%$	530mA	530mA	$0.20\Omega{\pm}30\%$	50MHz		
LQH32DZ4R7M23□	_	$4.7\mu H \pm 20\%$	450mA	450mA	$0.20\Omega{\pm}30\%$	43MHz		
LQH32DZ100K23□	_	$10\mu H \pm 10\%$	300mA	300mA	$0.44\Omega{\pm}30\%$	26MHz		
LQH32DZ220K23□	_	$22\mu H \pm 10\%$	250mA	250mA	$0.71\Omega{\pm}30\%$	19MHz		
LQH32DZ390K23□	_	$39\mu H \pm 10\%$	200mA	200mA	$1.2\Omega \pm 30\%$	16MHz		
LQH32DZ470K23□	_	$47\mu H \pm 10\%$	170mA	170mA	$1.3\Omega\pm30\%$	15MHz		
LQH32DZ680K23□	_	$68\mu H \pm 10\%$	130mA	130mA	$2.2\Omega{\pm}30\%$	12MHz		
LQH32DZ101K23□	_	$100\mu H \pm 10\%$	100mA	100mA	$3.5\Omega\pm30\%$	10MHz		
LQH32DZ151K23□	_	150µH ±10%	80mA	80mA	$5.1\Omega\pm30\%$	8.0MHz		
LQH32DZ221K23□	_	220µH ±10%	70mA	70mA	$8.4\Omega\pm30\%$	6.8MHz		
LQH32DZ331K23□		$330 \mu H \pm 10\%$	60mA	60mA	$10.0\Omega\pm30\%$	5.6MHz		

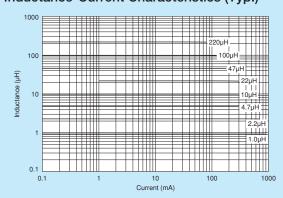
Inductance Test Frequency: 1MHz Class of Magnetic Shield: No magnetic shield

Operating Temperature Range: -40°C~+105°C

For reflow soldering only.

# Impedance-Frequency Characteristics (Typ.)



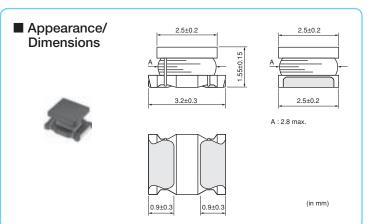


<sup>\*1</sup> When applied rated current to the products, self temperature rise shall be limited to 20°C max. and inductance will be within ±10% of initial inductance value.

<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
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# 32DZ\_53 Series 1210/3225 (inch/mm)

# Size Code 1210 (3225) in inch (in mm), 1.7mm max. Thickness.



# ■ Packaging

Co	ode	Packaging	Minimum Quantity
- 1	L	ø180mm Embossed Taping	2000
١	K	ø330mm Embossed Taping	7500



Refer to pages from p.191 to p.194 for mounting information.

■ Rated Value (□: packaging code)

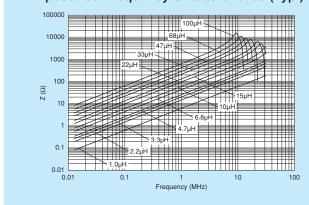
Part Number		Inductance	Rated Current *1 (Based on Inductance	Rated Current *1	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Change)	(Based on Temperature Rise)	Resistance	Frequency (min.)
LQH32DZ1R0M53□	_	$1.0 \mu H \pm 20\%$	1000mA	1000mA	$0.060\Omega{\pm}30\%$	100MHz
LQH32DZ2R2M53□	_	$2.2\mu H \pm 20\%$	790mA	790mA	$0.097\Omega\pm30\%$	64MHz
LQH32DZ3R3M53□	_	$3.3\mu H \pm 20\%$	710mA	710mA	$0.12\Omega\pm30\%$	50MHz
LQH32DZ4R7M53□	_	$4.7\mu H \pm 20\%$	650mA	650mA	$0.15\Omega\pm30\%$	43MHz
LQH32DZ6R8M53□	_	$6.8 \mu H \pm 20\%$	540mA	540mA	$0.25\Omega{\pm}30\%$	32MHz
LQH32DZ100K53□	_	$10\mu H \pm 10\%$	450mA	450mA	$0.30\Omega\pm30\%$	26MHz
LQH32DZ150K53□	_	$15\mu H \pm 10\%$	300mA	300mA	$0.58\Omega\pm30\%$	26MHz
LQH32DZ220K53□	_	$22\mu H \pm 10\%$	250mA	250mA	$0.71\Omega\pm30\%$	19MHz
LQH32DZ330K53□	_	$33\mu H \pm 10\%$	200mA	200mA	$1.1\Omega\pm30\%$	17MHz
LQH32DZ470K53□	_	$47\mu H \pm 10\%$	170mA	170mA	$1.3\Omega\pm30\%$	15MHz
LQH32DZ680K53□	_	$68 \mu H \pm 10\%$	130mA	130mA	$2.2\Omega\pm30\%$	12MHz
LQH32DZ101K53□	_	100µH ±10%	100mA	100mA	$3.5\Omega\pm30\%$	10MHz

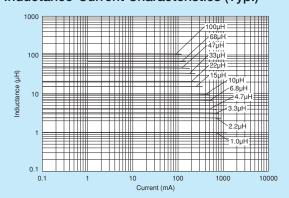
Inductance Test Frequency: 1MHz Class of Magnetic Shield: No magnetic shield

Operating Temperature Range: -40°C∼+105°C

For reflow soldering only.

# ■ Impedance-Frequency Characteristics (Typ.)



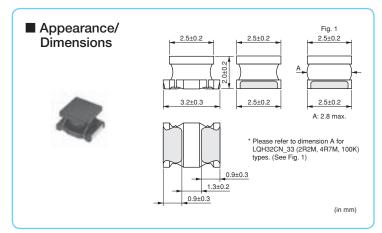


<sup>\*1</sup> When applied rated current to the products, self temperature rise shall be limited to 20°C max, and inductance will be within ±10% of initial inductance value.

<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before

# H\_23/LQH32CH\_33<sub>Series</sub> 1210/3225 (inch/mm)

# Size Code 1210 (3225) in inch (in mm)



### Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500



Refer to pages from p.191 to p.194 for mounting information.

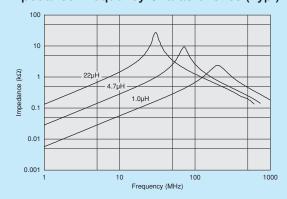
# ■ Rated Value (□: packaging code)

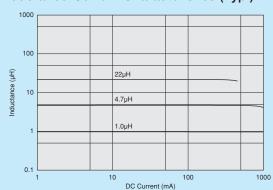
,	lumber		Rated Current *1	Rated Current *1	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	(Based on Inductance Change)	(Based on Temperature Rise)	Resistance	Frequency (min.)
_	LQH32CH1R0M23	$1.0 \mu H \pm 20\%$	800mA	800mA	$0.09\Omega{\pm}30\%$	96MHz
_	LQH32CH2R2M23□	$2.2\mu H \pm 20\%$	600mA	600mA	$0.13\Omega\pm30\%$	64MHz
_	LQH32CH4R7M23□	$4.7\mu H \pm 20\%$	450mA	450mA	$0.20\Omega{\pm}30\%$	43MHz
_	LQH32CH100K23	$10\mu H \pm 10\%$	300mA	300mA	$0.44\Omega{\pm}30\%$	26MHz
_	LQH32CH220K23□	$22\mu H \pm 10\%$	250mA	250mA	$0.71\Omega{\pm}30\%$	19MHz
_	LQH32CHR15M33□	$0.15\mu H \pm 20\%$	1450mA	1450mA	$0.028\Omega{\pm}30\%$	400MHz
_	LQH32CHR27M33□	$0.27 \mu H \pm 20\%$	1250mA	1250mA	$0.034\Omega{\pm}30\%$	250MHz
_	LQH32CHR47M33□	$0.47 \mu H \pm 20\%$	1100mA	1100mA	$0.042\Omega\pm30\%$	150MHz
_	LQH32CH1R0M33□	$1.0 \mu H \pm 20\%$	1000mA	1000mA	$0.060\Omega{\pm}30\%$	100MHz
_	LQH32CH2R2M33	$2.2 \mu H \pm 20\%$	790mA	790mA	$0.097\Omega\pm30\%$	64MHz
_	LQH32CH4R7M33□	$4.7\mu H \pm 20\%$	650mA	650mA	$0.15\Omega{\pm}30\%$	43MHz
_	LQH32CH100K33	10µH ±10%	450mA	450mA	$0.30\Omega\pm30\%$	26MHz

Inductance Test Frequency: 1MHz Class of Magnetic Shield: No magnetic shield

Operating Temperature Range (Self-temperature rise is not included): -40  $^{\circ}$ C  $\sim$ +85  $^{\circ}$ C

#### ■ Impedance-Frequency Characteristics (Typ.)



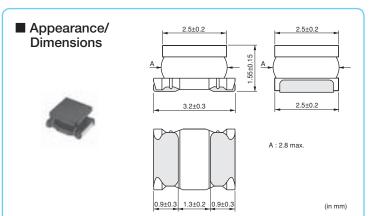


<sup>\*1</sup> When applied rated current to the products, self temperature rise shall be limited to 20°C max. and inductance will be within ±10% of initial inductance value.

<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc
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# 132CH\_53 Series 1210/3225 (inch/mm)

# Size Code 1210 (3225) in inch (in mm), 1.7mm max. Thickness



#### ■ Packaging **Packaging** Quantity ø180mm Embossed Taping 2000 ø330mm Embossed Taping 7500



Refer to pages from p.191 to p.194 for mounting information.

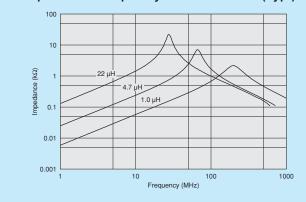
■ Rated Value (□: packaging code)

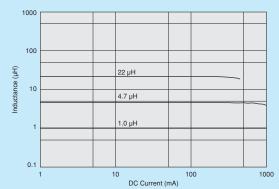
Part N	lumber	Inductance	Rated Current *1 (Based on Inductance	Rated Current *1 (Based on Temperature	DC	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Change)	Rise)	Resistance	Frequency (min.)
_	LQH32CH1R0M53□	$1.0\mu H \pm 20\%$	1000mA	1000mA	$0.060\Omega\pm30\%$	100MHz
_	LQH32CH2R2M53□	$2.2\mu H \pm 20\%$	790mA	790mA	$0.097\Omega\pm30\%$	64MHz
_	LQH32CH3R3M53□	$3.3\mu H \pm 20\%$	710mA	710mA	$0.12\Omega\pm30\%$	50MHz
_	LQH32CH4R7M53□	$4.7\mu H \pm 20\%$	650mA	650mA	$0.15\Omega{\pm}30\%$	43MHz
_	LQH32CH6R8M53□	$6.8 \mu H \pm 20\%$	540mA	540mA	$0.25\Omega{\pm}30\%$	32MHz
_	LQH32CH100K53	$10\mu H \pm 10\%$	450mA	450mA	$0.30\Omega{\pm}30\%$	26MHz
_	LQH32CH150K53□	$15\mu H \pm 10\%$	300mA	300mA	$0.58\Omega{\pm}30\%$	26MHz
_	LQH32CH220K53□	$22\mu H \pm 10\%$	250mA	250mA	$0.71\Omega \pm 30\%$	19MHz

Inductance Test Frequency: 1MHz Class of Magnetic Shield: No magnetic shield

Operating Temperature Range (Self-temperature rise is not included): -40  $^{\circ}$ C  $\sim$ +85  $^{\circ}$ C

# ■ Impedance-Frequency Characteristics (Typ.)





<sup>\*1</sup> When applied rated current to the products, self temperature rise shall be limited to 20°C max. and inductance will be within ±10% of initial inductance value.

<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# Inductors for Power Lines (Caution/Notice

# **<b>∆**Caution

#### Rating

1. About the Rated Current

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

#### 2. About Excessive Surge Current

Surge current (pulse current or rush current) greater than the specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

## **Notice**

## Storage and Operating Condition

<Operating Environment>

Do not use products in chemical atmosphere such as chlorine gas, acid or sulfide gas.

<Storage Requirements>

1. Storage Period

LQM series should be used within 6 months; the other products should be used within 12 months. Check solderability if this period is exceeded.

- 2. Storage Conditions
  - (1) Store products in a warehouse in compliance with the following conditions:

Temperature: -10 to +40°C.

Humidity: 15 to 85% (relative humidity) Do not subject products to rapid changes in

temperature and humidity.

Do not store them in chemical atmosphere such as one containing sulfurous acid gas or alkaline

This will prevent electrode oxidation, which causes poor solderability and possible corrosion of inductors.

- (2) Do not store products in bulk packaging to prevent collision among inductors, which causes core chipping and wire breakage.
- (3) Store products on pallets to protect from humidity, dust. etc.
- (4) Avoid heat shock, vibration, direct sunlight, etc.

#### Handling

This item is designed to have sufficient strength, but handle with care to avoid chipping or breaking its ceramic structure.

LQH C/D/P series

- · To prevent breaking the wire, avoid touching with sharp material, such as tweezers or the bristles of a cleaning brush, to the wire wound portion of this
- To prevent breaking the core, avoid applying excessive mechanical shock to products mounted on the board.
- Temperature may rise up to max. 40°C when applying the rated current to Inductors for Power Lines. Be careful of the temperature rating of the circuit board and components around the chip Inductors.

#### LQM series

- · There is the possibility that magnetism may change the inductance value. Do not use a magnet or tweezers with magnetism when handling chip inductors. (The tip of the tweezers should be molded with resin or pottery.)
- · When the excessive current over rated current is applied, it may cause the inductance value to change due to magnetism.

#### <Handling>

- 1. Avoid applying excessive stress to products to prevent damage.
- 2. Do not touch wire wound with sharp objects such as tweezers to prevent wire breakage.
- 3. Do not apply excessive force to products mounted on boards to prevent core breakage.

### <Transportation>

Do not apply excessive vibration or mechanical shock to products.

#### <Resin Coating>

When coating products with resin, the relatively high resin curing stress may change inductance values. For exterior coating, select resin carefully so that electrical and mechanical performance of the product is not affected. Prior to use, please evaluate reliability with the product mounted in your application set. (LQH series)

An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating conditions, etc. Some resins containing impurities or chloride may possibly generate chlorine by hydrolysis under some operating conditions, causing corrosion of the inductor wire and leading to an open circuit.

#### <Rated Current>

(LQH2HP JR Series·LQH44P GR Series) Inductance will be more than the value, which is 30% down from minimum rated Inductance value.

(Other LQH P Series)

Inductance will be within ±30% of nominal Inductance value.

 Based on Temperature Rise For LQH P series, rated current is set to keep temperature rise caused by self heating 40°C or less. For other Inductors for Power Lines, please refer to individual specifications.

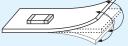




<Handling of a Substrate>

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting the substrate when cropping the substrate, inserting and removing a connector from the substrate, or tightening a screw to the substrate. Excessive mechanical stress may cause cracking in the Product.

Bending







# **Inductors for Power Lines**

# **Soldering and Mounting**

#### 1. Standard Land Pattern Dimensions

A high Q value is achieved when the PCB electrode land pattern is designed so that it does not project beyond the chip Inductors (chip coils) electrode.

Land Pattern + Solder Resist Land Pattern Solder Resist Solder Resist

		0			(in mm)
Series		Standard Land Dimensio	ns		
LQM21P		Part Number	а	b	С
LQM2MP LQM2HP		LQM21P	1.2	3.0-4.0	1.0
LQM2PP	<u> </u>	LQM2MP	0.8	2.4	1.8
LQH44P_GR	٥	LQM2HP	1.6	3.0	1.5
LQH5BP		LQH32P	1.3	3.8	2.0
	a	LQH44P_GR	1.5	4.4	2.7
	b	LQH5BP	1.8	5.5	4.1
LQH2HP	1.25				
LQH32C LQH32D	5.5				
LQH3NP_JR	1.4 3.0				
LQH43P  Attention should be paid to potential magnet	7.5				

Attention should be paid to potential magnetic coupling effects when using the Inductors (coils) as a resonator.

## 2. Standard Soldering Conditions

#### (1) Soldering method

Chip Inductors (Chip coils) can be flow or reflow soldered. Please contact Murata regarding other soldering methods.

As for LQH2HP/3NP/32P/44P/5BP series, please use reflow soldering.

Solder: Use Sn-3.0Ag-0.5Cu solder.

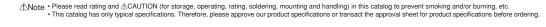
Flux: Use rosin-based flux, but not strongly acidic flux (with chlorine content exceeding 0.2wt%).

Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

Continued on the following page.

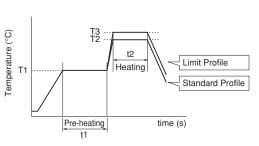




muRata

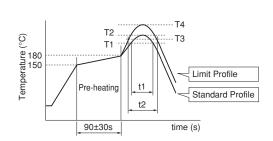
## (2) Soldering profile

● Flow Soldering profile (Sn-3.0Ag-0.5Cu solder)



	Due h	Pre-heating		andard Profile	•	Limit Profile		
Series	Pre-no			Heating		Heating		Cycle
	Temp. (T1)	Time. (t1)	Temp. (T2)	Time. (t2)	of flow	Temp. (T3)	Time. (t2)	of flow
LQM21P/2MP/2HP	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.
LQH32C LQH43P	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	1 time

 Reflow Soldering profile (Sn-3.0Ag-0.5Cu solder)



		Standar	rd Profile		Limit Profile				
Series	Heating		Peak temperature	Cycle	Heating		Peak temperature	Cycle	
	Temp. (T1) Time. (t1) (T2) of reflow		Temp. (T3)	Time. (t2)	(T4)	of reflow			
LQM21P/2MP/2HP LQH2HP LQH32D LQH3NP/32P/43P/44P/5BP	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.	
LQH32C	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	1 time	

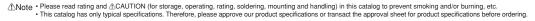
# (3) Reworking with Soldering Iron Preheating at 150°C for 1 minute is required. Do not directly touch the ceramic element with the tip of the soldering iron. The reworking soldering conditions are as

Soldering iron power output: 80W max. Temperature of soldering iron tip: 350°C Diameter of soldering iron end: 3.0mm max.

Soldering time: within 3 s

Continued on the following page.





follows:



# 3. Mounting Instructions

#### (1) Land Pattern Dimensions

Large lands reduce Q of the mounted chip. Also, large protruding land areas (bordered by lines having dimensions 'c' and 'd' shown) cause floating and electrode leaching.

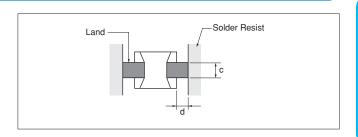
(2) Land Pattern Designing (LQH series) Please follow the recommended patterns. Otherwise, their performance, which includes electrical performance or solderability, may be affected, or result in "position shift" in the soldering process.

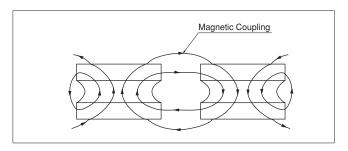


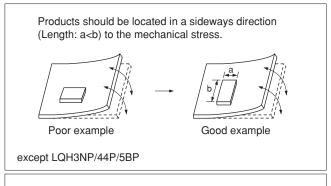
Since some chip inductors (chip coils) are constructed like an open magnetic circuit, narrow spacing between inductors (coils) may cause magnetic coupling. LQM and LQH P series have a magnetically shielded structure. The structure makes their coupling coefficient smaller than that of conventional chip inductors (chip coils).

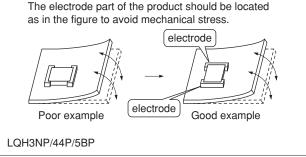
#### (4) PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.





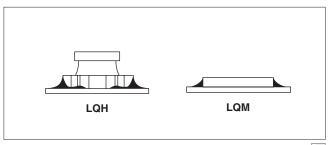




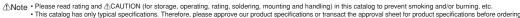
### (5) Amount of Solder Paste

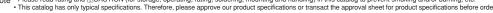
Excessive solder causes electrode corrosion, while insufficient solder causes low electrode bonding strength. Adjust the amount of solder paste as shown on the right so that solder is applied.

- Guideline of solder paste thickness
  - · LQM, LQH2HP/3NP/32P/44P/5BP: 100 to 150µm
  - · LQH32C/32D, LQH43P: 200 to 300µm





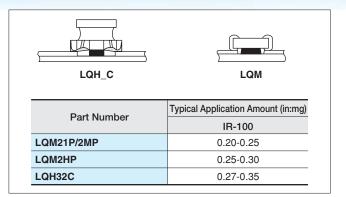






(6) Amount of Adhesive

If too much adhesive is applied, then it may overflow into the land or termination areas and yield poor solderability. In contrast, if insufficient adhesive is applied, or if the adhesive is not sufficiently hardened, then the chip may become detached during flow soldering. Apply the adhesive in accordance with the conditions shown in the chart.



### 4. Cleaning

The following conditions should be observed when cleaning chip inductors (chip coils):

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol cleaning agents)
- (2) Ultrasonic

Output: 20W/I max.

Duration: 5 minutes max. Frequency: 28 to 40kHz

Care should be taken not to cause resonance of the PCB and mounted products.

- (3) Cleaning agent
  - The following cleaning agents have been tested on individual components. Evaluation in complete assembly should be done prior to production.
  - (a) Alcohol cleaning agents Isopropyl alcohol (IPA)
  - (b) Aqueous cleaning agents Pine Alpha ST-100S

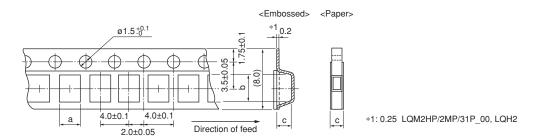
(4) Ensure that flux residue is completely removed.

Component should be thoroughly dried after aqueous agents have been removed with deionized water.

For additional cleaning methods, please contact Murata.



## ■ Minimum Quantity and 8mm Width Taping Dimensions



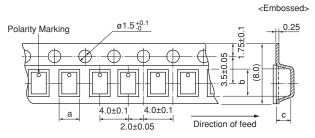
Dimension of the cavity of embossed tape is measured at the bottom side.

#### Paper Tape

Part Number	Dimer	nsions	Total Thickness of Tape	Packaging	Code (Minimum	Qty. [pcs.])
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
LQM21P_C0	1.45	2.25	0.8 max.	<b>D</b> [4000]	-	<b>B</b> [1000]
LQM21P_G	1.45	2.25	1.1 max.	<b>D</b> [4000]	-	<b>B</b> [1000]

#### **Embossed Tape**

Part Number	Dimensions		Depth of Cavity	Packaging Code (Minimum Qty. [pcs.		
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
LQM2HP_J0/JC	2.25	2.75	1.3	L [3000]	-	<b>B</b> [1000]
LQM2HP_G	2.3	2.8	1.1	L [3000]	-	<b>B</b> [1000]
LQM2MP_G0	1.85	2.25	1.1	L [3000]	-	<b>B</b> [1000]
LQH32C_33/23, LQH32D_23/53	2.9	3.6	2.1	<b>L</b> [2000]	<b>K</b> [7500]	-
LQH32C_53	2.9	3.6	1.7	<b>L</b> [2000]	<b>K</b> [7500]	-
LQH32P	2.9	3.6	1.7	<b>L</b> [2000]	<b>K</b> [7500]	-



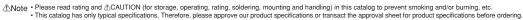
Dimension of the cavity of embossed tape is measured at the bottom side.

## **Embossed Tape**

Part Number	Dimer	nsions	Depth of Cavity	Packaging	Code (Minimum	Qty. [pcs.])
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
LQH2HP_JR	2.3	2.8	1.3	<b>L</b> [2000]	-	-

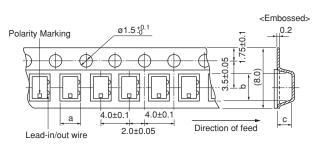
(in mm)







# ■ Minimum Quantity and 8mm Width Taping Dimensions



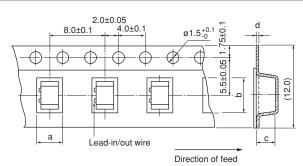
Dimension of the cavity of embossed tape is measured at the bottom side.

#### **Embossed Tape**

Part Number	Dimer	nsions	Depth of Cavity	Packaging	Code (Minimum	Qty. [pcs.])
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
LQH3NP JR	3.3	3.3	1.6	<b>L</b> [2000]	-	-

(in mm)

# ■ Minimum Quantity and 12mm Width Embossed Taping Dimensions



Dimension of the cavity of embossed tape is measured at the bottom side.

#### **Embossed Tape**

Part Number	Dir	nensions (c:	Depth of Cav	rity)	Packaging Code (Minimum Qty. [pcs.])			
Part Number	а	b	С	d	ø180mm reel	ø330mm reel	Bulk	
LQH43P	3.6	4.9	2.7	0.3	<b>L</b> [500]	<b>K</b> [2500]	-	
LQH44P_GR	4.3	4.3	1.4	0.3	<b>L</b> [1000]	<b>K</b> [4500]	-	
LQH5BP	5.3	5.3	2.4	0.3	<b>L</b> [500]	<b>K</b> [3000]	-	

(in mm)

 <sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
 • This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# Inductors for General Circuits Part Numbering

(Part Number)



























#### Product ID

Product ID	
LQ	Chip Inductors (Chip Coils)

#### 2Structure

Code	Structure
Н	Wire Wound Type (Ferrite Core)

### 3Dimensions (LXW)

Code	Dimensions (L×W)	Size Code (in inch)
31	3.2×1.6mm	1206
43	4.5×3.2mm	1812

#### 4 Applications and Characteristics

Code Applications and Characteristics			
N for Resonant Circuit			
Н	for High-frequency Resonant Circuit		

#### 6 Category

Code	Category				
Z	Automotive Infotainment				

#### **6**Inductance

Expressed by three-digit alphanumerics. The unit is micro-henry (μH). The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures. If there is a decimal point, it is expressed by the capital letter "R". In this case, all figures are significant digits. If inductance is less than  $0.1\mu H$ , the inductance code is expressed by a combination of two figures and the capital letter "N", and the unit of inductance is nano-henry (nH).

The capital letter "N" indicates the unit of "nH", and also expresses a decimal point. In this case, all figures are significant digits.

#### Inductance Tolerance

Code	Inductance Tolerance					
J	±5%					
K	±10%					
M	±20%					

#### 8 Features

Code	Features
0	Standard Type

#### 9Electrode

#### •Lead (Pb) Free

Code	Electrode
3	LF Solder

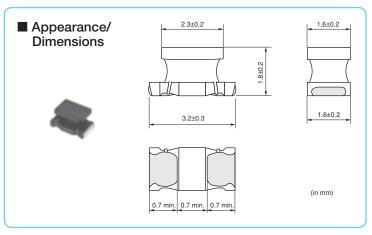
#### Packaging

	Code	Packaging			
	K Embossed Taping (ø330mm Reel)				
L Embossed Taping (ø180mm Reel					

**Wire Wound Type (Ferrite Core)** 

# 131HZ\_03 Series 1206/3216 (inch/mm)

# Size Code 1206 (3216) in inch (in mm), Ferrite Core High Frequency Wound Type



■ Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	2000
K	ø330mm Embossed Taping	7500



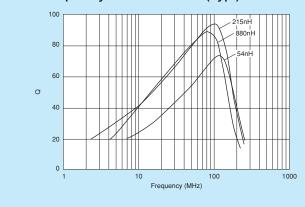
Refer to pages from p.203 to p.205 for mounting information.

■ Rated Value (□: nackaging code)

■ Rated value (□: packaging code)								
Part N	umber	Inductance	Inductance	Rated	DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQH31HZ54NK03□	_	54nH ±10%	1MHz	920mA	$0.035\Omega\pm30\%$	50	100MHz	800MHz
LQH31HZ95NK03□	_	95nH ±10%	1MHz	790mA	0.047Ω±30%	60	100MHz	650MHz
LQH31HZR14J03□	_	145nH ±5%	1MHz	700mA	$0.061\Omega\pm30\%$	60	100MHz	500MHz
LQH31HZR14K03□	_	145nH ±10%	1MHz	700mA	0.061 Ω ±30%	60	100MHz	500MHz
LQH31HZR21J03□	_	215nH ±5%	1MHz	520mA	0.11Ω±30%	60	100MHz	430MHz
LQH31HZR21K03□	_	215nH ±10%	1MHz	520mA	0.11Ω±30%	60	100MHz	430MHz
LQH31HZR29J03□	_	290nH ±5%	1MHz	420mA	0.17Ω±30%	60	100MHz	360MHz
LQH31HZR29K03□	_	290nH ±10%	1MHz	420mA	0.17Ω±30%	60	100MHz	360MHz
LQH31HZR39J03□	_	390nH ±5%	1MHz	330mA	$0.26\Omega \pm 30\%$	60	100MHz	300MHz
LQH31HZR39K03□	_	390nH ±10%	1MHz	330mA	$0.26\Omega \pm 30\%$	60	100MHz	300MHz
LQH31HZR50J03□	_	500nH ±5%	1MHz	260mA	$0.44\Omega \pm 30\%$	60	100MHz	270MHz
LQH31HZR50K03□	_	500nH ±10%	1MHz	260mA	0.44Ω±30%	60	100MHz	270MHz
LQH31HZR61J03□	_	610nH ±5%	1MHz	250mA	$0.48\Omega \pm 30\%$	60	100MHz	240MHz
LQH31HZR61K03□	_	610nH ±10%	1MHz	250mA	$0.48\Omega \pm 30\%$	60	100MHz	240MHz
LQH31HZR75J03□	_	750nH ±5%	1MHz	190mA	$0.79\Omega \pm 30\%$	60	100MHz	220MHz
LQH31HZR75K03□	_	750nH ±10%	1MHz	190mA	0.79Ω±30%	60	100MHz	220MHz
LQH31HZR88J03□	_	880nH ±5%	1MHz	180mA	$0.86\Omega\pm30\%$	60	100MHz	200MHz
LQH31HZR88K03□	_	880nH ±10%	1MHz	180mA	$0.86\Omega \pm 30\%$	60	100MHz	200MHz

Operating Temperature Range (Self-temperature rise is not included): -40°C~+85°C

## ■ Q-Frequency Characteristics (Typ.)



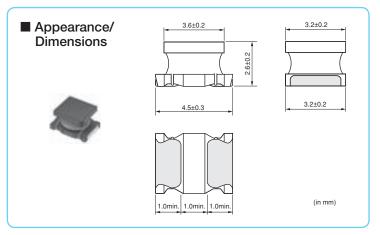
⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



**Wire Wound Type (Ferrite Core)** 

# 3NZ\_03 Series 1812/4532 (inch/mm)

# Size Code 1812 (4532) in inch (in mm)



Packaging

Code	Packaging	Minimum Quantity
L	ø180mm Embossed Taping	500
K	ø330mm Embossed Taping	2500



Refer to pages from p.203 to p.205 for mounting information.

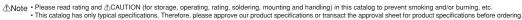
■ Rated Value (□: nackaging code)

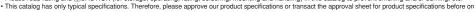
■ Rated Value (☐: packaging code)								
Part N	lumber	Inductance	Inductance	Rated *1	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQH43NZ1R0M03□	_	1.0µH ±20%	1MHz	500mA	0.20Ω	20	1MHz	120MHz
LQH43NZ1R2M03□	_	1.2µH ±20%	1MHz	500mA	0.20Ω	20	1MHz	100MHz
LQH43NZ1R5M03□	_	1.5µH ±20%	1MHz	500mA	0.30Ω	20	1MHz	85MHz
LQH43NZ1R8M03□	_	1.8µH ±20%	1MHz	500mA	0.30Ω	20	1MHz	75MHz
LQH43NZ2R2M03□	_	2.2μH ±20%	1MHz	500mA	0.30Ω	20	1MHz	62MHz
LQH43NZ2R7M03□	_	2.7μH ±20%	1MHz	500mA	0.32Ω	20	1MHz	53MHz
LQH43NZ3R3M03□	_	$3.3 \mu H \pm 20\%$	1MHz	500mA	$0.35\Omega$	20	1MHz	47MHz
LQH43NZ3R9M03□	_	3.9µH ±20%	1MHz	500mA	0.38Ω	20	1MHz	41MHz
LQH43NZ4R7K03□	_	4.7μH ±10%	1MHz	500mA	0.40Ω	30	1MHz	38MHz
LQH43NZ4R7M03□	_	4.7µH ±20%	1MHz	500mA	0.40Ω	30	1MHz	38MHz
LQH43NZ5R6K03□	_	5.6µH ±10%	1MHz	500mA	0.47Ω	30	1MHz	33MHz
LQH43NZ5R6M03□	_	5.6µH ±20%	1MHz	500mA	0.47Ω	30	1MHz	33MHz
LQH43NZ6R8K03□	_	6.8µH ±10%	1MHz	450mA	0.50Ω	30	1MHz	31MHz
LQH43NZ6R8M03□	_	6.8µH ±20%	1MHz	450mA	0.50Ω	30	1MHz	31MHz
LQH43NZ8R2K03□	_	$8.2 \mu H \pm 10\%$	1MHz	450mA	0.56Ω	30	1MHz	27MHz
LQH43NZ8R2M03□	_	8.2µH ±20%	1MHz	450mA	0.56Ω	30	1MHz	27MHz
LQH43NZ100J03□	_	10µH ±5%	1MHz	400mA	0.56Ω	35	1MHz	23MHz
LQH43NZ100K03□	_	10µH ±10%	1MHz	400mA	0.56Ω	35	1MHz	23MHz
LQH43NZ120J03□	_	12µH ±5%	1MHz	380mA	0.62Ω	35	1MHz	21MHz
LQH43NZ120K03□	_	12µH ±10%	1MHz	380mA	0.62Ω	35	1MHz	21MHz
LQH43NZ150J03□	_	15µH ±5%	1MHz	360mA	0.73Ω	35	1MHz	19MHz
LQH43NZ150K03□	_	15µH ±10%	1MHz	360mA	0.73Ω	35	1MHz	19MHz
LQH43NZ180J03□	_	18µH ±5%	1MHz	340mA	0.82Ω	35	1MHz	17MHz
LQH43NZ180K03□	_	18µH ±10%	1MHz	340mA	0.82Ω	35	1MHz	17MHz
LQH43NZ220J03□	_	22µH ±5%	1MHz	320mA	0.94Ω	35	1MHz	15MHz
LQH43NZ220K03□	_	22µH ±10%	1MHz	320mA	0.94Ω	35	1MHz	15MHz
LQH43NZ270J03□	_	27µH ±5%	1MHz	300mA	1.1Ω	35	1MHz	14MHz
LQH43NZ270K03□	_	27µH ±10%	1MHz	300mA	1.1Ω	35	1MHz	14MHz
LQH43NZ330J03□	_	33µH ±5%	1MHz	270mA	1.2Ω	35	1MHz	12MHz
LQH43NZ330K03□	_	33µH ±10%	1MHz	270mA	1.2Ω	35	1MHz	12MHz
LQH43NZ390J03□	_	39µH ±5%	1MHz	240mA	1.4Ω	35	1MHz	11MHz
	•						•	

Class of Magnetic Shield: No magnetic shield Operating Temperature Range: -40°C~+105°C

For reflow soldering only.





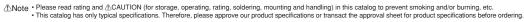




<sup>\*1</sup> When applied rated current to the products, self temperature rise shall be limited to 20°C max. and inductance will be within ±10% of initial inductance value.

Part Number			Inductance	Rated *1	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQH43NZ390K03□		39µH ±10%	1MHz	240mA	1.4Ω	35	1MHz	11MHz
LQH43NZ470J03□	_	47µH ±5%	1MHz	220mA	1.5Ω	35	1MHz	10MHz
LQH43NZ470K03□	_	47µH ±10%	1MHz	220mA	1.5Ω	35	1MHz	10MHz
LQH43NZ560J03□	_	56µH ±5%	1MHz	200mA	1.7Ω	35	1MHz	9.3MHz
LQH43NZ560K03□	_	56μH ±10%	1MHz	200mA	1.7Ω	35	1MHz	9.3MHz
LQH43NZ680J03□	_	68µH ±5%	1MHz	180mA	1.9Ω	35	1MHz	8.4MHz
LQH43NZ680K03□	_	68µH ±10%	1MHz	180mA	1.9Ω	35	1MHz	8.4MHz
LQH43NZ820J03□	_	82µH ±5%	1MHz	170mA	2.2Ω	35	1MHz	7.5MHz
LQH43NZ820K03□	_	82µH ±10%	1MHz	170mA	2.2Ω	35	1MHz	7.5MHz
LQH43NZ101J03□	_	100µH ±5%	1MHz	160mA	2.5Ω	40	796kHz	6.8MHz
LQH43NZ101K03□	_	100µH ±10%	1MHz	160mA	2.5Ω	40	796kHz	6.8MHz
LQH43NZ121J03□	_	$120\mu H \pm 5\%$	1MHz	150mA	3.0Ω	40	796kHz	6.2MHz
LQH43NZ121K03□	_	120µH ±10%	1MHz	150mA	3.0Ω	40	796kHz	6.2MHz
LQH43NZ151J03□	_	150µH ±5%	1MHz	130mA	3.7Ω	40	796kHz	5.5MHz
LQH43NZ151K03□	_	150µH ±10%	1MHz	130mA	3.7Ω	40	796kHz	5.5MHz
LQH43NZ181J03□	_	180µH ±5%	1MHz	120mA	4.5 Ω	40	796kHz	5.0MHz
LQH43NZ181K03□	_	180µH ±10%	1MHz	120mA	4.5 Ω	40	796kHz	5.0MHz
LQH43NZ221J03□	_	220µH ±5%	1MHz	110mA	5.4Ω	40	796kHz	4.5MHz
LQH43NZ221K03□	_	220μH ±10%	1MHz	110mA	5.4Ω	40	796kHz	4.5MHz
LQH43NZ271J03□	_	270µH ±5%	1MHz	100mA	6.8Ω	40	796kHz	4.0MHz
LQH43NZ271K03□	_	270μH ±10%	1MHz	100mA	6.8Ω	40	796kHz	4.0MHz
LQH43NZ331J03□	_	330µH ±5%	1MHz	95mA	8.2Ω	40	796kHz	3.6MHz
LQH43NZ331K03□	_	330µH ±10%	1MHz	95mA	8.2Ω	40	796kHz	3.6MHz
LQH43NZ391J03□	_	390µH ±5%	1MHz	90mA	9.7Ω	40	796kHz	3.3MHz
LQH43NZ391K03□	_	390µH ±10%	1MHz	90mA	9.7Ω	40	796kHz	3.3MHz
LQH43NZ471J03□	_	470µH ±5%	1kHz	80mA	11.8Ω	40	796kHz	3.0MHz
LQH43NZ471K03	_	470µH ±10%	1kHz	80mA	11.8Ω	40	796kHz	3.0MHz
LQH43NZ561J03	_	560µH ±5%	1kHz	70mA	14.5Ω	40	796kHz	2.7MHz
LQH43NZ561K03	_	560µH ±10%	1kHz	70mA	14.5Ω	40	796kHz	2.7MHz
LQH43NZ681J03	_	680µH ±5%	1kHz	65mA	17.0Ω	40	796kHz	2.5MHz
LQH43NZ681K03	_	680µH ±10%	1kHz	65mA	17.0Ω	40	796kHz	2.5MHz
LQH43NZ821J03	_	820µH ±5%	1kHz	60mA	20.5Ω	40	796kHz	2.2MHz
LQH43NZ821K03	_	820µH ±10%	1kHz	60mA	20.5Ω	40	796kHz	2.2MHz
LQH43NZ102J03	_	1000µH ±5%	1kHz	50mA	25.0Ω	40	252kHz	2.0MHz
LQH43NZ102K03□ LQH43NZ122J03□	_	1000µH ±10%	1kHz	50mA	25.0Ω	40	252kHz	2.0MHz
	_	1200µH ±5%	1kHz	45mA	30.0Ω	40	252kHz	1.8MHz
LQH43NZ122K03□ LQH43NZ152J03□		1200µH ±10%	1kHz 1kHz	45mA 40mA	30.0Ω 37.0Ω	40	252kHz 252kHz	1.8MHz 1.6MHz
LQH43NZ152K03		1500µH ±5%		40mA		40	252kHz	1.6MHz
LQH43NZ182J03	_	1500µH ±10% 1800µH ±5%	1kHz 1kHz	35mA	37.0Ω 45.0Ω	40	252kHz	1.5MHz
LQH43NZ182K03		1800μH ±10%	1kHz	35mA	45.0Ω	40	252kHz	1.5MHz
LQH43NZ222J03	_	2200μH ±5%	1kHz	30mA	50.0Ω	40	252kHz	1.3MHz
LQH43NZ222K03	_	2200μH ±5% 2200μH ±10%	1kHz	30mA	50.0Ω	40	252kHz	1.3MHz
LGH HONZZZZKUO_		2200μ11 ± 10%	INFIZ	JUITA	30.012	40	ZUZNIZ	1.JIVIDZ

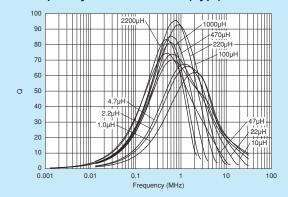


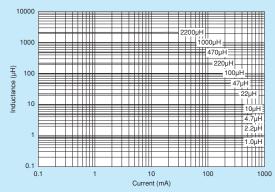




Class of Magnetic Shield: No magnetic shield
Operating Temperature Range: -40°C~+105°C
For reflow soldering only.
\*1 When applied rated current to the products, self temperature rise shall be limited to 20°C max. and inductance will be within ±10% of initial inductance value.

# ■ Q-Frequency Characteristics (Typ.)





# Inductors for General Circuits (Caution/Notice

## **1** Caution

#### Rating

1. About the Rated Current

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

2. About Excessive Surge Current

Surge current (pulse current or rush current) greater than the specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the surge current.

#### **Notice**

### Storage and Operating Condition

<Operating Environment>

Do not use products in chemical atmosphere such as chlorine gas, acid or sulfide gas.

- <Storage Requirements>
- 1. Storage Period

LQH series should be used within 12 months. Check solderability if this period is exceeded.

- 2. Storage Conditions
  - (1) Store products in a warehouse in compliance with the following conditions:

Temperature: -10 to +40 degrees C. Humidity: 15 to 85% (relative humidity) Do not subject products to rapid changes in temperature and humidity.

Do not store them in chemical atmosphere such as one containing sulfurous acid gas or alkaline gas.

This will prevent electrode oxidation, which causes poor solderability and possible corrosion of inductors.

- (2) Do not store products in bulk packaging to prevent collision among inductors, which causes core chipping and wire breakage.
- (3) Store products on pallets to protect from humidity, dust, etc.
- (4) Avoid heat shock, vibration, direct sunlight, etc.

#### Handling

This item is designed to have sufficient strength, but handle with care to avoid chipping or breaking its ceramic structure.

LQH series

- To prevent breaking the wire, avoid touching with sharp material, such as tweezers or the bristles of a cleaning brush, to the wire wound portion of this product.
- To prevent breaking the core, avoid applying excessive mechanical shock to products mounted on the board.

### <Handling>

- 1. Avoid applying excessive stress to products to prevent damage.
- 2. Do not touch wire wound with sharp objects such as tweezers to prevent wire breakage.
- 3. Do not apply excessive force to products mounted on boards to prevent core breakage.
- <Transportation>

Do not apply excessive vibration or mechanical shock to products.

<Resin Coating>

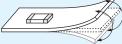
When coating products with resin, the relatively high resin curing stress may change inductance values. For exterior coating, select resin carefully so that electrical and mechanical performance of the product is not affected. Prior to use, please evaluate reliability with the product mounted in your application set. (LQH series)

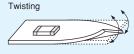
An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating conditions, etc. Some resins containing impurities or chloride may possibly generate chlorine by hydrolysis under some operating conditions, causing corrosion of the inductor wire and leading to an open circuit.

<Handling of a Substrate>

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting the substrate when cropping the substrate, inserting and removing a connector from the substrate, or tightening a screw to the substrate. Excessive mechanical stress may cause cracking in the Product.

Bending





<sup>♠</sup>Note • Please read rating and ♠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering

# **Inductors for General Circuits**

# **Soldering and Mounting**

#### 1. Standard Land Pattern Dimensions

A high Q value is achieved when the PCB electrode land pattern is designed so that it does not project beyond the chip Inductors (chip coils) electrode.



	(in mm)
Series	Standard Land Dimensions
LQH31H	1.0
LQH43N	4.5 0.3 1.2 1.5 1.5 1.5 1.5 1.5 7.5

Attention should be paid to potential magnetic coupling effects when using the Inductors (coils) as a resonator.

# 2. Standard Soldering Conditions

#### (1) Soldering method

Chip Inductors (Chip coils) can be flow or reflow soldered.

Please contact Murata regarding other soldering methods.

Solder: Use Sn-3.0Ag-0.5Cu solder.

Flux: Use rosin-based flux, but not strongly acidic flux (with

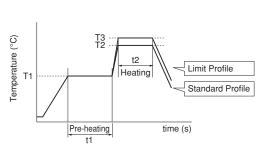
chlorine content exceeding 0.2wt%).

Do not use water-soluble flux.

For additional mounting methods, please contact Murata.

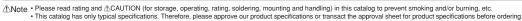
## (2) Soldering profile

 Flow Soldering profile (Sn-3.0Ag-0.5Cu solder)



	Pre-heating		St	andard Profile	)	Limit Profile		
Series			Hea	ting	Cycle	Heating		Cycle
	Temp. (T1)	Time. (t1)	Temp. (T2)	Time. (t2)	of flow	Temp. (T3)	Time. (t2)	of flow
LQH31H	150°C	60s min.	250°C	4 to 6s	2 times max.	265±3°C	5s max.	2 times max.

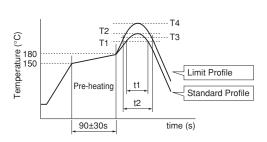








# Reflow Soldering profile (Sn-3.0Ag-0.5Cu solder)



		Standa	rd Profile		Limit Profile			
Series	Heating		Peak temperature	Cycle	Hea	ting	Peak temperature	Cycle
	Temp. (T1)	Time. (t1)	(T2)	of reflow	Temp. (T3)	Time. (t2)	(T4)	of reflow
LQH31H/43N	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.

#### (3) Reworking with Soldering Iron

Preheating at 150°C for 1 minute is required. Do not directly touch the ceramic element with the tip of the soldering iron. The reworking soldering conditions are as follows:

Soldering iron power output: 80W max. Temperature of soldering iron tip: 350°C Diameter of soldering iron end: 3.0mm max.

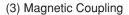
Soldering time: within 3 s

## 3. Mounting Instructions

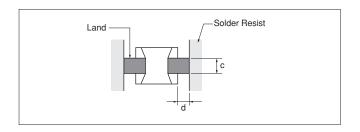
#### (1) Land Pattern Dimensions

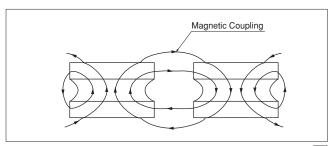
Large lands reduce Q of the mounted chip. Also, large protruding land areas (bordered by lines having dimensions 'c' and 'd' shown) cause floating and electrode leaching.

(2) Land Pattern Designing (LQH series) Please follow the recommended patterns. Otherwise, their performance, which includes electrical performance or solderability, may be affected, or result in "position shift" in the soldering process.



Since some chip inductors (chip coils) are constructed like an open magnetic circuit, narrow spacing between inductors (coils) may cause magnetic coupling.



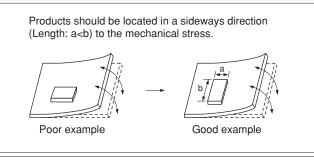


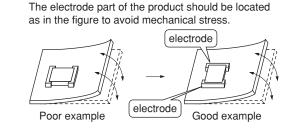
Continued on the following page.



### (4) PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.

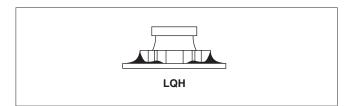




### (5) Amount of Solder Paste

Excessive solder causes electrode corrosion, while insufficient solder causes low electrode bonding strength. Adjust the amount of solder paste as shown on the right so that solder is applied.

 Guideline of solder paste thickness LQH: 200 to 300µm



# 4. Cleaning

The following conditions should be observed when cleaning chip inductors (chip coils):

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol cleaning agents)
- (2) Ultrasonic

Output: 20W/I max.

Duration: 5 minutes max. Frequency: 28 to 40kHz

Care should be taken not to cause resonance of the

PCB and mounted products.

(3) Cleaning agent

The following cleaning agents have been tested on individual components. Evaluation in complete assembly should be done prior to production.

- (a) Alcohol cleaning agents Isopropyl alcohol (IPA)
- (b) Aqueous cleaning agents Pine Alpha ST-100S
- (4) Ensure that flux residue is completely removed. Component should be thoroughly dried after aqueous agents have been removed with deionized water.

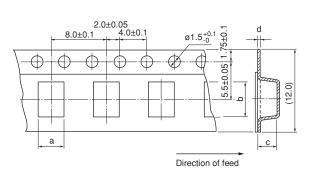
For additional cleaning methods, please contact Murata.



# **Inductors for General Circuits**

# **Packaging**

## ■ Minimum Quantity and 12mm Width Embossed Taping Dimensions



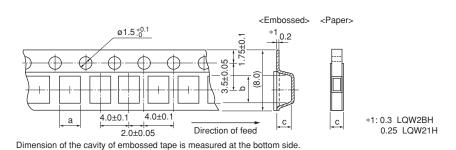
Dimension of the cavity of embossed tape is measured at the bottom side.

#### **Embossed Tape**

Part Number	Dir	nensions (c:	Depth of Cav	ity)	Packaging Code (Minimum Qty. [pcs.])			
Part Number	а	b	С	d	ø180mm reel	ø330mm reel	Bulk	
LQH43N	3.6	4.9	2.7	0.3	<b>L</b> [500]	<b>K</b> [2500]	-	

(in mm)

## ■ Minimum Quantity and 8mm Width Taping Dimensions



### **Embossed Tape**

Part Number	Dimer	nsions	Depth of Cavity	Packaging	Code (Minimum	Qty. [pcs.])
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
LQH31H	1.9	3.6	2.0	<b>L</b> [2000]	<b>K</b> [7500]	-

(in mm)



(Part Number)





























## 1 Product ID

Product ID	
LQ	Chip Inductors (Chip Coils)

#### 2Structure

Code	Structure
G	Multilayer Type (Air-core Inductors (Coils))
Р	Film Type
W	Wire Wound Type (Air-core Inductors (Coils))

#### 3Dimensions (LXW)

Code	Dimensions (L×W)	Size Code (in inch)
03	0.6×0.3mm	0201
15	1.0×0.5mm	0402
18	1.6×0.8mm	0603

#### 4 Applications and Characteristics

Code	Series	Applications and Characteristics
Н	LQG	Multilayer Air-core Inductors (Coils)
T	LQP	Film Type (Low DC Resistance Type)
Α	LQW	High Q Type (UHF-SHF)

# 6 Category

Code	Series	Category		
N	LQP/LQW	Standard Type		
Z	LQG	Ata ma atii .a	Infotainment	
Н	LG	Automotive	Powertrain/Safety	

#### **6**Inductance

Expressed by three-digit alphanumerics. The unit is micro-henry  $(\mu H)$ . The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures. If there is a decimal point, it is expressed by the capital letter "R." In this case, all figures are significant digits. If inductance is less than  $0.1 \mu H$ , the inductance code is expressed by a combination of two figures and the capital letter "N," and the unit of inductance is nano-henry (nH).

The capital letter "N" indicates the unit of "nH," and also expresses a decimal point. In this case, all figures are significant digits.

#### Inductance Tolerance

Code	Inductance Tolerance	
В	±0.1nH	
С	±0.2nH	
D	±0.5nH	
G	±2%	
Н	±3%	
J	±5%	
s	±0.3nH	
W	±0.05nH	

## 8 Features

Code	Features	Series
0	Standard Type	LQG/LQP/LQW
1	High-Q, Low DC Resistance	LQW15A/18A
Z	for Infotainment	LQP03T

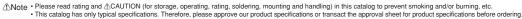
## Electrode

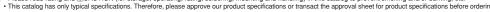
### ·Lead (Pb) Free

Code	Electrode	Series
0	Cn	LQG18H
2	Sn	LQG15H/LQP03T
Z	for Infotainment	LQW15A/LQW18W

#### Packaging

Code	Packaging	Series
В	Bulk	LQW/LQG/LQP
J	Paper Taping (ø330mm Reel)	LQW18A/LQG/LQP
D	Paper Taping (ø180mm Reel)	LQW/LQG/LQP



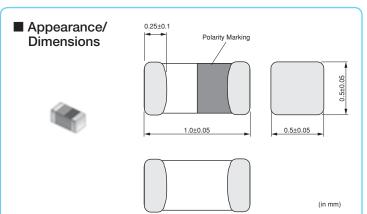




# Multilayer Type (Non-Magnetic Core)

# QG15H\_02Series 0402/1005 (inch/mm)

# Size Code 0402 (1005) in inch (in mm), Multilayer Type



■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	1000











Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□: packaging code)								
Part N	lumber	Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQG15HZ1N0S02□	LQG15HH1N0S0□	1.0nH ±0.3nH	100MHz	300mA	0.07Ω	8	100MHz	10000MHz
LQG15HZ1N1S02□	LQG15HH1N1S0□	1.1nH ±0.3nH	100MHz	300mA	0.09Ω	8	100MHz	6000MHz
LQG15HZ1N2S02□	LQG15HH1N2S0□	1.2nH ±0.3nH	100MHz	300mA	0.09Ω	8	100MHz	6000MHz
LQG15HZ1N3S02□	LQG15HH1N3S0□	1.3nH ±0.3nH	100MHz	300mA	0.09Ω	8	100MHz	6000MHz
LQG15HZ1N5S02□	LQG15HH1N5S0□	1.5nH ±0.3nH	100MHz	300mA	0.10Ω	8	100MHz	6000MHz
LQG15HZ1N6S02□	LQG15HH1N6S0□	1.6nH ±0.3nH	100MHz	300mA	0.10Ω	8	100MHz	6000MHz
LQG15HZ1N8S02□	LQG15HH1N8S0□	1.8nH ±0.3nH	100MHz	300mA	0.10Ω	8	100MHz	6000MHz
LQG15HZ2N0S02□	LQG15HH2N0S0□	2.0nH ±0.3nH	100MHz	300mA	0.10Ω	8	100MHz	6000MHz
LQG15HZ2N2S02□	LQG15HH2N2S0□	2.2nH ±0.3nH	100MHz	300mA	0.12Ω	8	100MHz	6000MHz
LQG15HZ2N4S02□	LQG15HH2N4S0□	2.4nH ±0.3nH	100MHz	300mA	0.15Ω	8	100MHz	6000MHz
LQG15HZ2N7S02□	LQG15HH2N7S0□	2.7nH ±0.3nH	100MHz	300mA	0.15Ω	8	100MHz	6000MHz
LQG15HZ3N0S02□	LQG15HH3N0S0□	3.0nH ±0.3nH	100MHz	300mA	0.17Ω	8	100MHz	6000MHz
LQG15HZ3N3S02□	LQG15HH3N3S0□	3.3nH ±0.3nH	100MHz	300mA	0.17Ω	8	100MHz	6000MHz
LQG15HZ3N6S02□	LQG15HH3N6S0□	3.6nH ±0.3nH	100MHz	300mA	0.18Ω	8	100MHz	6000MHz
LQG15HZ3N9S02□	LQG15HH3N9S0□	3.9nH ±0.3nH	100MHz	300mA	0.18Ω	8	100MHz	6000MHz
LQG15HZ4N3S02□	LQG15HH4N3S0□	4.3nH ±0.3nH	100MHz	300mA	0.18Ω	8	100MHz	6000MHz
LQG15HZ4N7S02□	LQG15HH4N7S0□	4.7nH ±0.3nH	100MHz	300mA	0.18Ω	8	100MHz	6000MHz
LQG15HZ5N1S02□	LQG15HH5N1S0□	5.1nH ±0.3nH	100MHz	300mA	0.20Ω	8	100MHz	5300MHz
LQG15HZ5N6S02□	LQG15HH5N6S0□	5.6nH ±0.3nH	100MHz	300mA	0.20Ω	8	100MHz	4500MHz
LQG15HZ6N2S02□	LQG15HH6N2S0□	6.2nH ±0.3nH	100MHz	300mA	0.22Ω	8	100MHz	4500MHz
LQG15HZ6N8J02□	LQG15HH6N8J0□	6.8nH ±5%	100MHz	300mA	0.24Ω	8	100MHz	4500MHz
LQG15HZ7N5J02□	LQG15HH7N5J0□	7.5nH ±5%	100MHz	300mA	0.24Ω	8	100MHz	4200MHz
LQG15HZ8N2J02□	LQG15HH8N2J0□	8.2nH ±5%	100MHz	300mA	0.24Ω	8	100MHz	3700MHz
LQG15HZ9N1J02□	LQG15HH9N1J0□	9.1nH ±5%	100MHz	300mA	0.26Ω	8	100MHz	3400MHz
LQG15HZ10NJ02□	LQG15HH10NJ0□	10nH ±5%	100MHz	300mA	0.26Ω	8	100MHz	3400MHz
LQG15HZ12NJ02□	LQG15HH12NJ0□	12nH ±5%	100MHz	300mA	0.28Ω	8	100MHz	3000MHz
LQG15HZ15NJ02□	LQG15HH15NJ0□	15nH ±5%	100MHz	300mA	0.32Ω	8	100MHz	2500MHz
LQG15HZ18NJ02□	LQG15HH18NJ0□	18nH ±5%	100MHz	300mA	0.36Ω	8	100MHz	2200MHz
LQG15HZ22NJ02□	LQG15HH22NJ0□	22nH ±5%	100MHz	300mA	0.42Ω	8	100MHz	1900MHz
LQG15HZ27NJ02□	LQG15HH27NJ0□	27nH ±5%	100MHz	300mA	0.46Ω	8	100MHz	1700MHz
LQG15HZ33NJ02□	LQG15HH33NJ0□	33nH ±5%	100MHz	200mA	0.58Ω	8	100MHz	1600MHz
LQG15HZ39NJ02□	LQG15HH39NJ0□	39nH ±5%	100MHz	200mA	0.65Ω	8	100MHz	1200MHz

muRata

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.



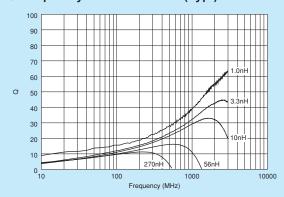




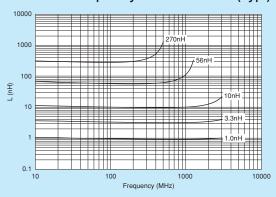
Part Number		Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQG15HZ47NJ02□	LQG15HH47NJ0□	47nH ±5%	100MHz	200mA	0.72Ω	8	100MHz	1000MHz
LQG15HZ56NJ02□	LQG15HH56NJ0□	56nH ±5%	100MHz	200mA	0.82Ω	8	100MHz	800MHz
LQG15HZ68NJ02□	LQG15HH68NJ0□	68nH ±5%	100MHz	180mA	0.92Ω	8	100MHz	800MHz
LQG15HZ82NJ02□	LQG15HH82NJ0□	82nH ±5%	100MHz	150mA	1.20 Ω	8	100MHz	700MHz
LQG15HZR10J02□	LQG15HHR10J0□	100nH ±5%	100MHz	150mA	1.25 Ω	8	100MHz	600MHz
LQG15HZR12J02□	LQG15HHR12J0□	120nH ±5%	100MHz	150mA	1.30 Ω	8	100MHz	600MHz
LQG15HZR15J02□	LQG15HHR15J0□	150nH ±5%	100MHz	140mA	2.99 Ω	8	100MHz	550MHz
LQG15HZR18J02□	LQG15HHR18J0□	180nH ±5%	100MHz	130mA	3.38Ω	8	100MHz	500MHz
LQG15HZR22J02□	LQG15HHR22J0□	220nH ±5%	100MHz	120mA	3.77Ω	8	100MHz	450MHz
LQG15HZR27J02□	LQG15HHR27J0□	270nH ±5%	100MHz	110mA	4.94Ω	8	100MHz	400MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.

# ■ Q-Frequency Characteristics (Typ.)



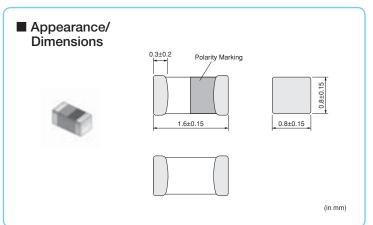
# ■ Inductance-Frequency Characteristics (Typ.)



# Multilayer Type (Non-Magnetic Core)

# QG18HH\_00<sub>Series 0603/1608 (inch/mm)</sub>

# Size Code 0603 (1608) in inch (in mm), Multilayer Type



Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	1000







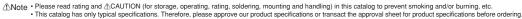
Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□: packaging code)

■ Rated Value (L	: packaging code)							
Part N	lumber	Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
_	LQG18HH1N2S00□	1.2nH ±0.3nH	100MHz	1100mA	0.10Ω	12	100MHz	6000MHz
_	LQG18HH1N5S00□	1.5nH ±0.3nH	100MHz	1100mA	0.10Ω	12	100MHz	6000MHz
_	LQG18HH1N8S00□	1.8nH ±0.3nH	100MHz	1100mA	0.10Ω	12	100MHz	5000MHz
_	LQG18HH2N2S00□	2.2nH ±0.3nH	100MHz	1100mA	0.10Ω	12	100MHz	5000MHz
_	LQG18HH2N7S00□	2.7nH ±0.3nH	100MHz	1000mA	0.13Ω	12	100MHz	4000MHz
_	LQG18HH3N3S00□	3.3nH ±0.3nH	100MHz	900mA	0.14Ω	12	100MHz	4000MHz
_	LQG18HH3N9S00□	3.9nH ±0.3nH	100MHz	900mA	0.15Ω	12	100MHz	3000MHz
_	LQG18HH4N7S00□	4.7nH ±0.3nH	100MHz	800mA	0.16Ω	12	100MHz	3000MHz
_	LQG18HH5N6S00□	5.6nH ±0.3nH	100MHz	800mA	0.17Ω	12	100MHz	3000MHz
_	LQG18HH6N2S00□	6.2nH ±0.3nH	100MHz	800mA	0.18Ω	12	100MHz	2800MHz
_	LQG18HH6N8J00□	6.8nH ±5%	100MHz	800mA	0.18Ω	12	100MHz	2800MHz
_	LQG18HH8N2J00□	8.2nH ±5%	100MHz	800mA	0.20Ω	12	100MHz	2600MHz
_	LQG18HH10NJ00□	10nH ±5%	100MHz	700mA	0.25 Ω	12	100MHz	2400MHz
_	LQG18HH12NJ00□	12nH ±5%	100MHz	600mA	0.30 Ω	12	100MHz	2200MHz
_	LQG18HH15NJ00□	15nH ±5%	100MHz	600mA	0.35 Ω	12	100MHz	1800MHz
_	LQG18HH18NJ00□	18nH ±5%	100MHz	600mA	0.35 Ω	12	100MHz	1800MHz
_	LQG18HH22NJ00□	22nH ±5%	100MHz	500mA	0.50 Ω	12	100MHz	1600MHz
_	LQG18HH27NJ00□	27nH ±5%	100MHz	500mA	0.54 Ω	12	100MHz	1400MHz
_	LQG18HH33NJ00□	33nH ±5%	100MHz	500mA	0.54 Ω	12	100MHz	1200MHz
_	LQG18HH39NJ00□	39nH ±5%	100MHz	400mA	0.60Ω	12	100MHz	1000MHz
_	LQG18HH47NJ00□	47nH ±5%	100MHz	400mA	0.70Ω	12	100MHz	900MHz
_	LQG18HH56NJ00□	56nH ±5%	100MHz	400mA	0.70Ω	12	100MHz	800MHz
_	LQG18HH68NJ00□	68nH ±5%	100MHz	400mA	0.80Ω	12	100MHz	800MHz
_	LQG18HH82NJ00□	82nH ±5%	100MHz	300mA	0.85Ω	12	100MHz	700MHz
_	LQG18HHR10J00□	100nH ±5%	100MHz	300mA	0.90Ω	12	100MHz	600MHz
_	LQG18HHR12J00□	120nH ±5%	100MHz	300mA	1.10Ω	14	100MHz	550MHz
_	LQG18HHR15J00□	150nH ±5%	100MHz	300mA	1.20 Ω	14	100MHz	550MHz
_	LQG18HHR18J00□	180nH ±5%	100MHz	300mA	1.30 Ω	14	100MHz	500MHz
_	LQG18HHR22J00□	220nH ±5%	100MHz	300mA	1.50 Ω	14	100MHz	450MHz
_	LQG18HHR27J00□	270nH ±5%	100MHz	200mA	1.90Ω	14	100MHz	400MHz

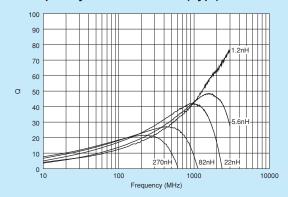
Operating Temperature Range (Self-temperature rise is not included): -55  $^{\circ}\text{C} \sim$  +125  $^{\circ}\text{C}$ For reflow soldering only.



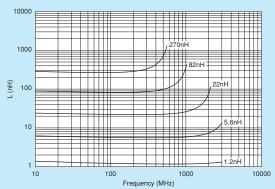




# ■ Q-Frequency Characteristics (Typ.)



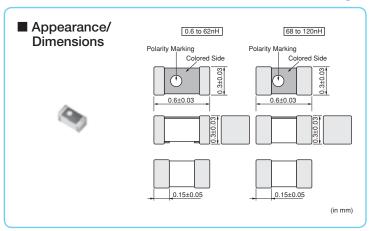
# ■ Inductance-Frequency Characteristics (Typ.)



# Film Type (Non-Magnetic Core)

# QP03TN\_Z2 Series 0201/0603 (inch/mm)

# Size Code 0201 (0603) in inch (in mm), High Q, Wide Variation



## ■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	15000
J	ø330mm Paper Taping	50000
В	Packing in Bulk	500











Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□:	: packaging code)							
Part N	umber	Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQP03TN0N6BZ2□	_	0.6nH ±0.1nH	500MHz	850mA	0.07Ω	14	500MHz	20000MHz
LQP03TN0N6CZ2□	_	0.6nH ±0.2nH	500MHz	850mA	0.07Ω	14	500MHz	20000MHz
LQP03TN0N7BZ2□	_	0.7nH ±0.1nH	500MHz	800mA	0.08Ω	14	500MHz	20000MHz
LQP03TN0N7CZ2□	_	0.7nH ±0.2nH	500MHz	800mA	0.08Ω	14	500MHz	20000MHz
LQP03TN0N8BZ2□	_	0.8nH ±0.1nH	500MHz	800mA	0.08Ω	14	500MHz	18000MHz
LQP03TN0N8CZ2□	_	0.8nH ±0.2nH	500MHz	800mA	0.08Ω	14	500MHz	18000MHz
LQP03TN0N9BZ2□	_	0.9nH ±0.1nH	500MHz	750mA	0.10Ω	14	500MHz	18000MHz
LQP03TN0N9CZ2□	_	0.9nH ±0.2nH	500MHz	750mA	0.10Ω	14	500MHz	18000MHz
LQP03TN1N0BZ2□	_	1.0nH ±0.1nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N0CZ2□	_	1.0nH ±0.2nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N1BZ2□	_	1.1nH ±0.1nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N1CZ2□	_	1.1nH ±0.2nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N2BZ2□	_	1.2nH ±0.1nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N2CZ2□	_	1.2nH ±0.2nH	500MHz	750mA	0.10Ω	14	500MHz	17000MHz
LQP03TN1N3BZ2□	_	1.3nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	17000MHz
LQP03TN1N3CZ2□	_	1.3nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	17000MHz
LQP03TN1N4BZ2□	_	1.4nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	16000MHz
LQP03TN1N4CZ2□	_	1.4nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	16000MHz
LQP03TN1N5BZ2□	_	1.5nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N5CZ2□	_	1.5nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N6BZ2□	_	1.6nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N6CZ2□	_	1.6nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N7BZ2□	_	1.7nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N7CZ2□	_	1.7nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N8BZ2□	_	1.8nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N8CZ2□	_	1.8nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	15000MHz
LQP03TN1N9BZ2□	_	1.9nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	12500MHz
LQP03TN1N9CZ2□	_	1.9nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	12500MHz
LQP03TN2N0BZ2	_	2.0nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	12500MHz
LQP03TN2N0CZ2	_	2.0nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	12500MHz
LQP03TN2N1BZ2	_	2.1nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	11000MHz
LQP03TN2N1CZ2□	_	2.1nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	11000MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.





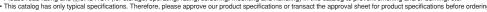


Part N	lumber		Industance	Dotod	May of DC	0	O Toot	Colf Decemens
For Infotainment	For Powertrain/Safety	Inductance	Inductance Test Frequency	Rated Current	Max. of DC Resistance	Q (min.)	Q Test Frequency	Self-Resonance Frequency (min.)
LQP03TN2N2BZ2	Tor Fowertrain/Salety	2.2nH ±0.1nH	500MHz	600mA	0.15Ω	14	500MHz	11000MHz
LQP03TN2N2CZ2		2.2nH ±0.1nH 2.2nH ±0.2nH	500MHz	600mA	0.15Ω	14	500MHz	11000MHz
LQP03TN2N3BZ2	_	2.3nH ±0.1nH	500MHz	500mA	0.13Ω	14	500MHz	1000MHz
LQP03TN2N3CZ2	_	2.3nH ±0.1nH 2.3nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N4BZ2	_	2.4nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N4CZ2	_		500MHz					
LQP03TN2N5BZ2	_	2.4nH ±0.2nH		500mA	0.20Ω	14	500MHz	10000MHz
	_	2.5nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N5CZ2	_	2.5nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N6BZ2	_	2.6nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N6CZ2	_	2.6nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N7BZ2	_	2.7nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N7CZ2	_	2.7nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	10000MHz
LQP03TN2N8BZ2	_	2.8nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	9500MHz
LQP03TN2N8CZ2	_	2.8nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	9500MHz
LQP03TN2N9BZ2	_	2.9nH ±0.1nH	500MHz	500mA	0.20Ω	14	500MHz	9500MHz
LQP03TN2N9CZ2	_	2.9nH ±0.2nH	500MHz	500mA	0.20Ω	14	500MHz	9500MHz
LQP03TN3N0BZ2	_	3.0nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	9500MHz
LQP03TN3N0CZ2	_	3.0nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	9500MHz
LQP03TN3N1BZ2	_	3.1nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N1CZ2	_	3.1nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N2BZ2	_	3.2nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N2CZ2	_	3.2nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N3BZ2	_	3.3nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N3CZ2	_	3.3nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	8000MHz
LQP03TN3N4BZ2	_	3.4nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	7000MHz
LQP03TN3N4CZ2	_	3.4nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	7000MHz
LQP03TN3N5BZ2	_	3.5nH ±0.1nH	500MHz	450mA	0.25Ω	14	500MHz	7000MHz
LQP03TN3N5CZ2	_	3.5nH ±0.2nH	500MHz	450mA	0.25Ω	14	500MHz	7000MHz
LQP03TN3N6BZ2	_	3.6nH ±0.1nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N6CZ2	_	3.6nH ±0.2nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N7BZ2	_	3.7nH ±0.1nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N7CZ2	_	3.7nH ±0.2nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N8BZ2	_	3.8nH ±0.1nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N8CZ2	_	3.8nH ±0.2nH	500MHz	400mA	0.30Ω	14	500MHz	6000MHz
LQP03TN3N9BZ2	_	3.9nH ±0.1nH	500MHz	400mA	0.30Ω	14	500MHz	5700MHz
LQP03TN3N9CZ2	_	3.9nH ±0.2nH	500MHz	400mA	0.30Ω	14	500MHz	5700MHz
LQP03TN4N0BZ2	_	4.0nH ±0.1nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N0CZ2	_	4.0nH ±0.2nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N1BZ2	_	4.1nH ±0.1nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N1CZ2	_	4.1nH ±0.2nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N2BZ2	_	4.2nH ±0.1nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N2CZ2	_	4.2nH ±0.2nH	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N3HZ2	_	4.3nH ±3%	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N3JZ2□	_	4.3nH ±5%	500MHz	350mA	0.40Ω	14	500MHz	5300MHz
LQP03TN4N7HZ2	_	4.7nH ±3%	500MHz	350mA	0.40Ω	14	500MHz	4400MHz
LQP03TN4N7JZ2□	_	4.7nH ±5%	500MHz	350mA	0.40Ω	14	500MHz	4400MHz
LQP03TN5N1HZ2	_	5.1nH ±3%	500MHz	350mA	0.40Ω	14	500MHz	4200MHz
LOCI OUTTAJIATITE		J. 11111 ± J /0	JUUIVII IZ	JJUIIA	0.7012	17	JUDIVII IZ	72001011 12

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.









Part N	lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQP03TN5N1JZ2		5.1nH ±5%	500MHz	350mA	0.40Ω	14	500MHz	4200MHz
LQP03TN5N6HZ2	_	5.6nH ±3%	500MHz	350mA	0.40 Ω	14	500MHz	4000MHz
LQP03TN5N6JZ2	_	5.6nH ±5%	500MHz	350mA	0.40Ω	14	500MHz	4000MHz
LQP03TN6N2HZ2	_	6.2nH ±3%	500MHz	300mA	0.40Ω	14	500MHz	4000MHz
LQP03TN6N2JZ2	_	6.2nH ±5%	500MHz	300mA	0.60 Ω	14	500MHz	4000MHz
LQP03TN6N8HZ2	_	6.8nH ±3%	500MHz	300mA	0.60Ω	14	500MHz	3900MHz
LQP03TN6N8JZ2	_	6.8nH ±5%	500MHz	300mA	0.60Ω	14	500MHz	3900MHz
LQP03TN7N5HZ2	_	7.5nH ±3%	500MHz	300mA	0.60Ω	14	500MHz	3700MHz
LQP03TN7N5JZ2	_	7.5nH ±5%	500MHz	300mA	0.60Ω	14	500MHz	3700MHz
LQP03TN8N2HZ2	_	8.2nH ±3%	500MHz	250mA	0.70Ω	14	500MHz	3600MHz
LQP03TN8N2JZ2	_	8.2nH ±5%	500MHz	250mA	0.70Ω	14	500MHz	3600MHz
LQP03TN9N1HZ2	_	9.1nH ±3%	500MHz	250mA	0.70Ω	14	500MHz	3300MHz
LQP03TN9N1JZ2	_	9.1nH ±5%	500MHz	250mA	0.70Ω	14	500MHz	3300MHz
LQP03TN10NHZ2	_	10nH ±3%	500MHz	250mA	0.70Ω	14	500MHz	3200MHz
LQP03TN10NJZ2	_	10nH ±5%	500MHz	250mA	0.70Ω	14	500MHz	3200MHz
LQP03TN11NHZ2	_	11nH ±3%	500MHz	250mA	0.80Ω	14	500MHz	2900MHz
LQP03TN11NJZ2	_	11nH ±5%	500MHz	250mA	0.80Ω	14	500MHz	2900MHz
LQP03TN12NHZ2	_	12nH ±3%	500MHz	250mA	0.70Ω	12	500MHz	2900MHz
LQP03TN12NJZ2	_	12nH ±5%	500MHz	250mA	0.70Ω	12	500MHz	2900MHz
LQP03TN13NHZ2	_	13nH ±3%	500MHz	250mA	0.80Ω	12	500MHz	2600MHz
LQP03TN13NJZ2□	_	13nH ±5%	500MHz	250mA	0.80Ω	12	500MHz	2600MHz
LQP03TN15NHZ2□	_	15nH ±3%	500MHz	250mA	0.70Ω	12	500MHz	2600MHz
LQP03TN15NJZ2□	_	15nH ±5%	500MHz	250mA	0.70Ω	12	500MHz	2600MHz
LQP03TN16NHZ2□	_	16nH ±3%	500MHz	200mA	0.95Ω	12	500MHz	2200MHz
LQP03TN16NJZ2□	_	16nH ±5%	500MHz	200mA	0.95Ω	12	500MHz	2200MHz
LQP03TN18NHZ2□	_	18nH ±3%	500MHz	200mA	0.80Ω	12	500MHz	2200MHz
LQP03TN18NJZ2□	_	18nH ±5%	500MHz	200mA	0.80Ω	12	500MHz	2200MHz
LQP03TN20NHZ2□	_	20nH ±3%	500MHz	150mA	2.30Ω	12	500MHz	2200MHz
LQP03TN20NJZ2□	_	20nH ±5%	500MHz	150mA	2.30Ω	12	500MHz	2200MHz
LQP03TN22NHZ2□	_	22nH ±3%	500MHz	150mA	1.90Ω	12	500MHz	2200MHz
LQP03TN22NJZ2□	_	22nH ±5%	500MHz	150mA	1.90Ω	12	500MHz	2200MHz
LQP03TN24NHZ2□	_	24nH ±3%	500MHz	140mA	2.30Ω	12	500MHz	2000MHz
LQP03TN24NJZ2□	_	24nH ±5%	500MHz	140mA	2.30Ω	12	500MHz	2000MHz
LQP03TN27NHZ2□	_	27nH ±3%	500MHz	140mA	2.30Ω	12	500MHz	2000MHz
LQP03TN27NJZ2□	_	27nH ±5%	500MHz	140mA	2.30 Ω	12	500MHz	2000MHz
LQP03TN30NHZ2	_	30nH ±3%	500MHz	120mA	2.95 Ω	9	500MHz	1700MHz
LQP03TN30NJZ2□	_	30nH ±5%	500MHz	120mA	2.95Ω	9	500MHz	1700MHz
LQP03TN33NHZ2□	_	$33$ nH $\pm 3\%$	300MHz	120mA	2.95Ω	9	300MHz	1700MHz
LQP03TN33NJZ2□	_	33nH ±5%	300MHz	120mA	2.95Ω	9	300MHz	1700MHz
LQP03TN36NHZ2□	_	36nH ±3%	300MHz	120mA	3.00Ω	9	300MHz	1500MHz
LQP03TN36NJZ2□	_	36nH ±5%	300MHz	120mA	3.00Ω	9	300MHz	1500MHz
LQP03TN39NHZ2	_	39nH ±3%	300MHz	120mA	3.00Ω	9	300MHz	1500MHz
LQP03TN39NJZ2□	_	39nH ±5%	300MHz	120mA	3.00Ω	9	300MHz	1500MHz
LQP03TN43NHZ2	_	43nH ±3%	300MHz	100mA	3.60Ω	9	300MHz	1300MHz
LQP03TN43NJZ2□	_	43nH ±5%	300MHz	100mA	3.60Ω	9	300MHz	1300MHz
LQP03TN47NHZ2	_	47nH ±3%	300MHz	100mA	3.60Ω	9	300MHz	1300MHz
LQP03TN47NJZ2□	_	47nH ±5%	300MHz	100mA	3.60Ω	9	300MHz	1300MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.



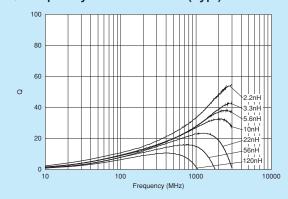




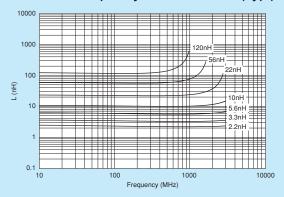
Part Number		Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQP03TN51NHZ2	_	51nH ±3%	300MHz	100mA	3.90 Ω	9	300MHz	1200MHz
LQP03TN51NJZ2□	_	51nH ±5%	300MHz	100mA	3.90 Ω	9	300MHz	1200MHz
LQP03TN56NHZ2	_	56nH ±3%	300MHz	100mA	3.90Ω	9	300MHz	1200MHz
LQP03TN56NJZ2□	_	56nH ±5%	300MHz	100mA	3.90Ω	9	300MHz	1200MHz
LQP03TN62NHZ2	_	62nH ±3%	300MHz	100mA	8Ω	8	300MHz	1100MHz
LQP03TN62NJZ2□	_	62nH ±5%	300MHz	100mA	8Ω	8	300MHz	1100MHz
LQP03TN68NHZ2	_	68nH ±3%	300MHz	100mA	8Ω	8	300MHz	1100MHz
LQP03TN68NJZ2□	_	68nH ±5%	300MHz	100mA	8Ω	8	300MHz	1100MHz
LQP03TN75NHZ2	_	75nH ±3%	300MHz	100mA	10Ω	8	300MHz	1000MHz
LQP03TN75NJZ2□	_	75nH ±5%	300MHz	100mA	10Ω	8	300MHz	1000MHz
LQP03TN82NHZ2	_	82nH ±3%	300MHz	100mA	10Ω	8	300MHz	1000MHz
LQP03TN82NJZ2□	_	82nH ±5%	300MHz	100mA	10Ω	8	300MHz	1000MHz
LQP03TN91NHZ2	_	91nH ±3%	300MHz	80mA	10Ω	8	300MHz	900MHz
LQP03TN91NJZ2□	_	91nH ±5%	300MHz	80mA	10Ω	8	300MHz	900MHz
LQP03TNR10HZ2□	_	100nH ±3%	300MHz	80mA	10Ω	8	300MHz	900MHz
LQP03TNR10JZ2□	_	100nH ±5%	300MHz	80mA	10Ω	8	300MHz	900MHz
LQP03TNR11HZ2□	_	110nH ±3%	300MHz	80mA	12Ω	8	300MHz	800MHz
LQP03TNR11JZ2	_	110nH ±5%	300MHz	80mA	12Ω	8	300MHz	800MHz
LQP03TNR12HZ2□	_	120nH ±3%	300MHz	80mA	12Ω	8	300MHz	800MHz
LQP03TNR12JZ2	_	120nH ±5%	300MHz	80mA	12Ω	8	300MHz	800MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C~+125°C For reflow soldering only.

## ■ Q-Frequency Characteristics (Typ.)



## ■ Inductance-Frequency Characteristics (Typ.)



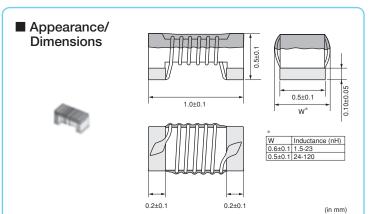


<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

## **Wire Wound Type (Non-Magnetic Core)**

# V15AN\_0Z<sub>Series</sub> 0402/1005 (inch/mm)

## Size Code 0402 (1005) in inch (in mm), Wound Type



■ Packaging

Code	Packaging	Minimum Quantity			
D	10000				
В	B Packing in Bulk				

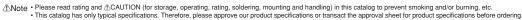


Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□: packaging code)								
Part N	lumber	Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	muutane	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN1N5B0Z□	_	1.5nH ±0.1nH	100MHz	1000mA	0.03Ω	10	250MHz	18.0GHz
LQW15AN1N5C0Z□	_	1.5nH ±0.2nH	100MHz	1000mA	0.03Ω	10	250MHz	18.0GHz
LQW15AN1N5D0Z□	_	1.5nH ±0.5nH	100MHz	1000mA	0.03Ω	10	250MHz	18.0GHz
LQW15AN1N6C0Z□	_	1.6nH ±0.2nH	100MHz	750mA	0.07Ω	10	250MHz	17.0GHz
LQW15AN1N6D0Z□	_	1.6nH ±0.5nH	100MHz	750mA	0.07Ω	10	250MHz	17.0GHz
LQW15AN1N7C0Z□	_	1.7nH ±0.2nH	100MHz	640mA	0.10Ω	10	250MHz	17.0GHz
LQW15AN1N7D0Z□	_	1.7nH ±0.5nH	100MHz	640mA	0.10Ω	10	250MHz	17.0GHz
LQW15AN1N8C0Z□	_	1.8nH ±0.2nH	100MHz	460mA	0.16Ω	10	250MHz	16.0GHz
LQW15AN1N8D0Z□	_	1.8nH ±0.5nH	100MHz	460mA	0.16Ω	10	250MHz	16.0GHz
LQW15AN2N4B0Z□	_	2.4nH ±0.1nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N4C0Z□	_	2.4nH ±0.2nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N4D0Z□	_	2.4nH ±0.5nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N5B0Z□	_	2.5nH ±0.1nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N5C0Z□	_	2.5nH ±0.2nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N5D0Z□	_	2.5nH ±0.5nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N6B0Z□	_	2.6nH ±0.1nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N6C0Z□	_	2.6nH ±0.2nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N6D0Z□	_	2.6nH ±0.5nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N7B0Z□	_	2.7nH ±0.1nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N7C0Z□	_	2.7nH ±0.2nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N7D0Z□	_	2.7nH ±0.5nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N8B0Z□	_	2.8nH ±0.1nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N8C0Z□	_	2.8nH ±0.2nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N8D0Z□	_	2.8nH ±0.5nH	100MHz	850mA	0.05Ω	20	250MHz	15.0GHz
LQW15AN2N9B0Z□	_	2.9nH ±0.1nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN2N9C0Z□	_	2.9nH ±0.2nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN2N9D0Z□	_	2.9nH ±0.5nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN3N0B0Z	_	3.0nH ±0.1nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN3N0C0Z	_	3.0nH ±0.2nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN3N0D0Z□	_	3.0nH ±0.5nH	100MHz	750mA	0.07Ω	20	250MHz	15.0GHz
LQW15AN3N1B0Z□	_	3.1nH ±0.1nH	100MHz	570mA	0.13Ω	20	250MHz	14.0GHz
LQW15AN3N1C0Z□	_	3.1nH ±0.2nH	100MHz	570mA	0.13Ω	20	250MHz	14.0GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.







Part N	lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN3N1D0Z	_	3.1nH ±0.5nH	100MHz	570mA	0.13Ω	20	250MHz	14.0GHz
LQW15AN3N2B0Z	_	3.2nH ±0.1nH	100MHz	500mA	0.17Ω	15	250MHz	14.0GHz
LQW15AN3N2C0Z	_	3.2nH ±0.2nH	100MHz	500mA	0.17Ω	15	250MHz	14.0GHz
LQW15AN3N2D0Z	_	3.2nH ±0.5nH	100MHz	500mA	0.17Ω	15	250MHz	14.0GHz
LQW15AN3N9B0Z	_	3.9nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN3N9C0Z	_	3.9nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN3N9D0Z	_	3.9nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N1B0Z	_	4.1nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N1C0Z	_	4.1nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N1D0Z	_	4.1nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N3B0Z□	_	4.3nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N3C0Z□	_	4.3nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N3D0Z□	_	4.3nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	10.0GHz
LQW15AN4N4B0Z□	_	4.4nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N4C0Z□	_	4.4nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N4D0Z□	_	4.4nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N5B0Z□	_	4.5nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N5C0Z□	_	4.5nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N5D0Z□	_	4.5nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N6B0Z□	_	4.6nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N6C0Z□	_	4.6nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N6D0Z□	_	4.6nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N7B0Z□	_	4.7nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N7C0Z□	_	4.7nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N7D0Z□	_	4.7nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N8B0Z□	_	4.8nH ±0.1nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N8C0Z□	_	4.8nH ±0.2nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N8D0Z□	_	4.8nH ±0.5nH	100MHz	750mA	0.07Ω	25	250MHz	8.0GHz
LQW15AN4N9B0Z□	_	4.9nH ±0.1nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN4N9C0Z□	_	4.9nH ±0.2nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN4N9D0Z□	_	4.9nH ±0.5nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N0B0Z□	_	5.0nH ±0.1nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N0C0Z□	_	5.0nH ±0.2nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N0D0Z□	_	5.0nH ±0.5nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N1B0Z	_	5.1nH ±0.1nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N1C0Z□	_	5.1nH ±0.2nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N1D0Z□	_	5.1nH ±0.5nH	100MHz	600mA	0.12Ω	25	250MHz	8.0GHz
LQW15AN5N8B0Z□	_	5.8nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN5N8C0Z□	_	5.8nH ±0.2nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN5N8D0Z□	_	5.8nH ±0.5nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN6N2B0Z□	_	6.2nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN6N2C0Z□	_	6.2nH ±0.2nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN6N2D0Z	_	6.2nH ±0.5nH	100MHz	700mA	0.09Ω	25	250MHz	8.0GHz
LQW15AN6N3B0Z	_	6.3nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N3C0Z	_	6.3nH ±0.2nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N3D0Z□	_	6.3nH ±0.5nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N4B0Z□	_	6.4nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz

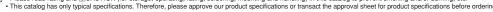
Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.

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217

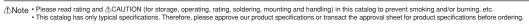




Part N	lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN6N4C0Z	Tor Fowertrain/Salety	6.4nH ±0.2nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N4D0Z		6.4nH ±0.5nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N5B0Z	<u> </u>	6.5nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N5C0Z	_	6.5nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N5D0Z	_	6.5nH ±0.5nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N6B0Z	_	6.6nH ±0.1nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N6C0Z	_	6.6nH ±0.2nH	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N6D0Z	_	6.6nH ±0.5nH			0.09Ω	25	250MHz	
LQW15AN6N7B0Z	_		100MHz	700mA		25		6.0GHz
LQW15AN6N7C0Z	_	$6.7 \text{nH} \pm 0.1 \text{nH}$ $6.7 \text{nH} \pm 0.2 \text{nH}$	100MHz 100MHz	700mA 700mA	0.09 Ω	25	250MHz 250MHz	6.0GHz
LQW15AN6N7D0Z	_		100MHz		0.09Ω	25	250MHz	6.0GHz 6.0GHz
LQW15AN6N8G0Z	_	6.7nH ±0.5nH		700mA				
_	_	6.8nH ±2%	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N8H0Z	_	6.8nH ±3%	100MHz	700mA	0.09Ω	25	250MHz	6.0GHz
LQW15AN6N8J0Z  LQW15AN6N9G0Z	_	6.8nH ±5%	100MHz	700mA	0.09 Ω	25 25	250MHz	6.0GHz
	_	6.9nH ±2%	100MHz	570mA			250MHz	6.0GHz
LQW15AN6N9H0Z	_	6.9nH ±3%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN6N9J0Z	_	6.9nH ±5%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N0G0Z	_	7.0nH ±2%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N0H0Z	_	7.0nH ±3%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N0J0Z	_	7.0nH ±5%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N1G0Z	_	7.1nH ±2%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N1H0Z	_	7.1nH ±3%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N1J0Z	_	7.1nH ±5%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N2G0Z	_	7.2nH ±2%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N2H0Z	_	7.2nH ±3%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N2J0Z	_	7.2nH ±5%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N3G0Z	_	7.3nH ±2%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N3H0Z	_	7.3nH ±3%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N3J0Z	_	7.3nH ±5%	100MHz	570mA	0.13Ω	25	250MHz	6.0GHz
LQW15AN7N5G0Z	_	7.5nH ±2%	100MHz	570mA	0.13Ω	30	250MHz	6.0GHz
LQW15AN7N5H0Z	_	7.5nH ±3%	100MHz	570mA	0.13Ω	30	250MHz	6.0GHz
LQW15AN7N5J0Z	_	7.5nH ±5%	100MHz	570mA	0.13Ω	30	250MHz	6.0GHz
LQW15AN8N2G0Z	_	8.2nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N2H0Z	_	8.2nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N2J0Z	_	8.2nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N6G0Z	_	8.6nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N6H0Z	_	8.6nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N6J0Z	_	8.6nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N7G0Z	_	8.7nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N7H0Z	_	8.7nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N7J0Z	_	8.7nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N8G0Z	_	8.8nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N8H0Z	_	8.8nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N8J0Z	_	8.8nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N9G0Z	_	8.9nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N9H0Z	_	8.9nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN8N9J0Z	_	8.9nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.







Part N	lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN9N0G0Z	For Fowertrain/Salety	9.0nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N0H0Z		9.0nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N0J0Z	_		100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N1G0Z	_	9.0nH ±5%	100MHz	540mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN9N1H0Z	_	9.1nH ±2%	100MHz	540mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN9N1J0Z	_	9.1nH ±3%	100MHz	540mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN9N2G0Z	_	9.1nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N2H0Z	_	9.2nH ±2%			0.14Ω	25	250MHz	
LQW15AN9N2J0Z	_	9.2nH ±3%	100MHz	540mA 540mA	-	25		5.5GHz
LQW15AN9N3G0Z	_	9.2nH ±5%	100MHz		0.14Ω	25	250MHz 250MHz	5.5GHz
LQW15AN9N3H0Z	_	9.3nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N3J0Z	_	9.3nH ±3%	100MHz	540mA	0.14Ω			5.5GHz
	_	9.3nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N4G0Z  LQW15AN9N4H0Z	_	9.4nH ±2%	100MHz	540mA	0.14Ω	25	250MHz 250MHz	5.5GHz
	_	9.4nH ±3%	100MHz	540mA	0.14Ω	25		5.5GHz
LQW15AN9N4J0Z	_	9.4nH ±5% 9.5nH ±2%	100MHz	540mA	0.14Ω	25 25	250MHz 250MHz	5.5GHz
LQW15AN9N5G0Z	_		100MHz	540mA	0.14Ω			5.5GHz
LQW15AN9N5H0Z	_	9.5nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N5J0Z	_	9.5nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N6G0Z	_	9.6nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N6H0Z	_	9.6nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N6J0Z	_	9.6nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N7G0Z	_	9.7nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N7H0Z	_	9.7nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N7J0Z	_	9.7nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N8G0Z	_	9.8nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N8H0Z	_	9.8nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N8J0Z	_	9.8nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N9G0Z	_	9.9nH ±2%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N9H0Z	_	9.9nH ±3%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN9N9J0Z	_	9.9nH ±5%	100MHz	540mA	0.14Ω	25	250MHz	5.5GHz
LQW15AN10NG0Z	_	10nH ±2%	100MHz	500mA	0.17Ω	25	250MHz	5.5GHz
LQW15AN10NH0Z	_	10nH ±3%	100MHz	500mA	0.17Ω	25	250MHz	5.5GHz
LQW15AN10NJ0Z	_	10nH ±5%	100MHz	500mA	0.17Ω	25	250MHz	5.5GHz
LQW15AN11NG0Z	_	11nH ±2%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN11NH0Z	_	11nH ±3%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN11NJ0Z	_	11nH ±5%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN12NG0Z	_	12nH ±2%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN12NH0Z	_	12nH ±3%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN12NJ0Z	_	12nH ±5%	100MHz	500mA	0.14Ω	30	250MHz	5.5GHz
LQW15AN13NG0Z	_	13nH ±2%	100MHz	430mA	0.21 Ω	25	250MHz	5.0GHz
LQW15AN13NH0Z	_	13nH ±3%	100MHz	430mA	0.21Ω	25	250MHz	5.0GHz
LQW15AN13NJ0Z	_	13nH ±5%	100MHz	430mA	0.21Ω	25	250MHz	5.0GHz
LQW15AN15NG0Z	_	15nH ±2%	100MHz	460mA	0.16Ω	30	250MHz	5.0GHz
LQW15AN15NH0Z	_	15nH ±3%	100MHz	460mA	0.16Ω	30	250MHz	5.0GHz
LQW15AN15NJ0Z	_	15nH ±5%	100MHz	460mA	0.16Ω	30	250MHz	5.0GHz
LQW15AN16NG0Z	_	16nH ±2%	100MHz	370mA	0.24Ω	25	250MHz	4.5GHz
LQW15AN16NH0Z	_	16nH ±3%	100MHz	370mA	0.24Ω	25	250MHz	4.5GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.









Part N	lumber		Inductance	Dotod	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Rated Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN16NJ0Z	Tor Fowertrain/Salety	16nH ±5%	100MHz	370mA	0.24Ω	25	250MHz	4.5GHz
LQW15AN18NG0Z		18nH ±2%	100MHz	370mA	0.24Ω	25	250MHz	4.5GHz
LQW15AN18NH0Z		18nH ±3%	100MHz	370mA	0.27 Ω	25	250MHz	4.5GHz
LQW15AN18NJ0Z	<u> </u>	18nH ±5%	100MHz	370mA	0.27 Ω	25	250MHz	4.5GHz
LQW15AN19NG0Z		19nH ±2%	100MHz	370mA	0.27 Ω	25	250MHz	4.5GHz
LQW15AN19NH0Z	<u> </u>	19nH ±3%	100MHz	370mA	0.27 Ω	25	250MHz	4.5GHz
LQW15AN19NJ0Z		19nH ±5%	100MHz	370mA	0.27 Ω	25	250MHz	4.5GHz
LQW15AN20NG0Z	_	20nH ±2%	100MHz	370mA	0.27 Ω	25	250MHz	4.0GHz
LQW15AN20NH0Z		20nH ±3%	100MHz	370mA	0.27 Ω	25	250MHz	4.0GHz
LQW15AN20NJ0Z		20nH ±5%	100MHz	370mA	0.27 Ω	25	250MHz	4.0GHz
LQW15AN22NG0Z		22nH ±2%	100MHz	310mA	0.30 Ω	25	250MHz	4.0GHz
LQW15AN22NH0Z	_	22nH ±3%	100MHz	310mA	0.30 Ω	25	250MHz	4.0GHz
LQW15AN22NJ0Z	_	22nH ±5%	100MHz	310mA	0.30 Ω	25	250MHz	4.0GHz
LQW15AN23NG0Z	_	23nH ±2%	100MHz	310mA	0.30 Ω	25	250MHz	3.8GHz
LQW15AN23NH0Z		23nH ±3%	100MHz	310mA	0.30Ω	25	250MHz	3.8GHz
LQW15AN23NJ0Z	_	23nH ±5%	100MHz	310mA	0.30Ω	25	250MHz	3.8GHz
LQW15AN24NG0Z	_	24nH ±2%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN24NH0Z		24nH ±3%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN24NJ0Z	_	24nH ±5%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN27NG0Z	_	27nH ±2%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN27NH0Z	_	27nH ±3%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN27NJ0Z	_	27nH ±5%	100MHz	280mA	0.52Ω	25	250MHz	3.5GHz
LQW15AN30NG0Z	_	30nH ±2%	100MHz	270mA	0.58Ω	25	250MHz	3.3GHz
LQW15AN30NH0Z	_	30nH ±3%	100MHz	270mA	0.58Ω	25	250MHz	3.3GHz
LQW15AN30NJ0Z	_	30nH ±5%	100MHz	270mA	0.58Ω	25	250MHz	3.3GHz
LQW15AN33NG0Z	_	33nH ±2%	100MHz	260mA	0.63Ω	25	250MHz	3.2GHz
LQW15AN33NH0Z□	_	33nH ±3%	100MHz	260mA	0.63Ω	25	250MHz	3.2GHz
LQW15AN33NJ0Z	_	33nH ±5%	100MHz	260mA	0.63Ω	25	250MHz	3.2GHz
LQW15AN36NG0Z	_	36nH ±2%	100MHz	260mA	0.63Ω	25	250MHz	3.1GHz
LQW15AN36NH0Z□	_	36nH ±3%	100MHz	260mA	0.63Ω	25	250MHz	3.1GHz
LQW15AN36NJ0Z□	_	36nH ±5%	100MHz	260mA	0.63Ω	25	250MHz	3.1GHz
LQW15AN39NG0Z□	_	39nH ±2%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN39NH0Z□	_	39nH ±3%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN39NJ0Z	_	39nH ±5%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN40NG0Z	_	40nH ±2%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN40NH0Z	_	40nH ±3%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN40NJ0Z	_	40nH ±5%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN43NG0Z□	_	43nH ±2%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN43NH0Z□	_	43nH ±3%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN43NJ0Z□		43nH ±5%	100MHz	250mA	0.70Ω	25	250MHz	3.0GHz
LQW15AN47NG0Z□	_	47nH ±2%	100MHz	210mA	1.08Ω	25	200MHz	2.9GHz
LQW15AN47NH0Z□	_	47nH ±3%	100MHz	210mA	1.08Ω	25	200MHz	2.9GHz
LQW15AN47NJ0Z□	_	47nH ±5%	100MHz	210mA	1.08Ω	25	200MHz	2.9GHz
LQW15AN51NG0Z	_	51nH ±2%	100MHz	210mA	1.08Ω	25	200MHz	2.85GHz
LQW15AN51NH0Z□	_	51nH ±3%	100MHz	210mA	1.08Ω	25	200MHz	2.85GHz
LQW15AN51NJ0Z	_	51nH ±5%	100MHz	210mA	1.08Ω	25	200MHz	2.85GHz
LQW15AN56NG0Z□	_	56nH ±2%	100MHz	200mA	1.17Ω	25	200MHz	2.8GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.



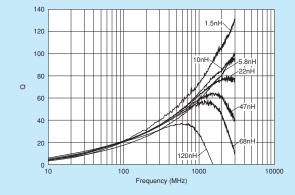




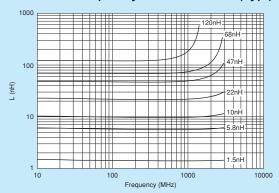
Part Number		Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN56NH0Z	_	56nH ±3%	100MHz	200mA	1.17Ω	25	200MHz	2.8GHz
LQW15AN56NJ0Z□	_	56nH ±5%	100MHz	200mA	1.17Ω	25	200MHz	2.8GHz
LQW15AN62NG0Z□	_	62nH ±2%	100MHz	145mA	1.82Ω	20	200MHz	2.6GHz
LQW15AN62NH0Z□	_	62nH ±3%	100MHz	145mA	1.82Ω	20	200MHz	2.6GHz
LQW15AN62NJ0Z□	_	62nH ±5%	100MHz	145mA	1.82Ω	20	200MHz	2.6GHz
LQW15AN68NG0Z□	_	68nH ±2%	100MHz	140mA	1.96Ω	20	200MHz	2.5GHz
LQW15AN68NJ0Z□	_	$68$ nH $\pm 5\%$	100MHz	140mA	1.96Ω	20	200MHz	2.5GHz
LQW15AN72NG0Z□	_	$72$ nH $\pm 2\%$	100MHz	135mA	2.10Ω	20	150MHz	2.5GHz
LQW15AN72NJ0Z□	_	$72$ nH $\pm 5\%$	100MHz	135mA	2.10Ω	20	150MHz	2.5GHz
LQW15AN75NG0Z□	_	75nH ±2%	100MHz	135mA	2.10Ω	20	150MHz	2.4GHz
LQW15AN75NJ0Z□	_	$75$ nH $\pm 5\%$	100MHz	135mA	2.10Ω	20	150MHz	2.4GHz
LQW15AN82NG0Z□	_	82nH ±2%	100MHz	130mA	2.24Ω	20	150MHz	2.3GHz
LQW15AN82NJ0Z□	_	82nH ±5%	100MHz	130mA	2.24Ω	20	150MHz	2.3GHz
LQW15AN91NG0Z□	_	91nH ±2%	100MHz	125mA	2.38Ω	20	150MHz	2.1GHz
LQW15AN91NJ0Z□	_	91nH ±5%	100MHz	125mA	2.38Ω	20	150MHz	2.1GHz
LQW15ANR10J0Z□	_	100nH ±5%	100MHz	120mA	2.52Ω	20	150MHz	1.5GHz
LQW15ANR12J0Z□	_	120nH ±5%	100MHz	110mA	2.66Ω	20	150MHz	1.0GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$ +125°C For reflow soldering only.

## ■ Q-Frequency Characteristics (Typ.)



## ■ Inductance-Frequency Characteristics (Typ.)



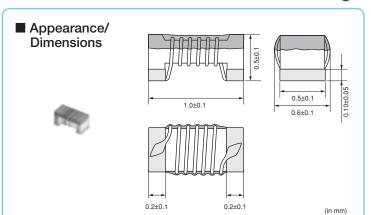




## **Wire Wound Type (Non-Magnetic Core)**

# 5AN\_1Z<sub>Series</sub> 0402/1005 (inch/mm)

# Size Code 0402 (1005) in inch (in mm), High Q, Low DC Resistance Type



■ Packaging

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	10000
В	500	





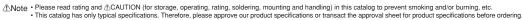
Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□: packaging code)

· ·	: packaging code) lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN1N3C1Z	_	1.3nH ±0.2nH	100MHz	1200mA	0.017Ω	20	250MHz	16GHz
LQW15AN1N3D1Z	_	1.3nH ±0.5nH	100MHz	1200mA	0.017Ω	20	250MHz	16GHz
LQW15AN1N4C1Z	_	1.4nH ±0.2nH	100MHz	1100mA	0.019Ω	25	250MHz	15GHz
LQW15AN1N4D1Z	_	1.4nH ±0.5nH	100MHz	1100mA	0.019Ω	25	250MHz	15GHz
LQW15AN2N2C1Z	_	2.2nH ±0.2nH	100MHz	1000mA	0.027Ω	25	250MHz	14GHz
LQW15AN2N2D1Z	_	2.2nH ±0.5nH	100MHz	1000mA	0.027Ω	25	250MHz	14GHz
LQW15AN2N3C1Z□	_	2.3nH ±0.2nH	100MHz	1000mA	0.027Ω	25	250MHz	14GHz
LQW15AN2N3D1Z□	_	2.3nH ±0.5nH	100MHz	1000mA	0.027Ω	25	250MHz	14GHz
LQW15AN2N4D1Z□	_	2.4nH ±0.5nH	100MHz	1000mA	$0.027\Omega$	25	250MHz	14GHz
LQW15AN3N3D1Z□	_	3.3nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	12GHz
LQW15AN3N4C1Z□	_	3.4nH ±0.2nH	100MHz	900mA	0.040Ω	30	250MHz	12GHz
LQW15AN3N4D1Z□	_	3.4nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	12GHz
LQW15AN3N5C1Z□	_	3.5nH ±0.2nH	100MHz	900mA	$0.040\Omega$	30	250MHz	9.5GHz
LQW15AN3N5D1Z□	_	3.5nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	9.5GHz
LQW15AN3N6C1Z□	_	3.6nH ±0.2nH	100MHz	900mA	0.040Ω	30	250MHz	9.5GHz
LQW15AN3N6D1Z□	_	3.6nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	9.5GHz
LQW15AN3N8C1Z□	_	3.8nH ±0.2nH	100MHz	900mA	0.040Ω	30	250MHz	7GHz
LQW15AN3N8D1Z□	_	3.8nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	7GHz
LQW15AN3N9D1Z	_	3.9nH ±0.5nH	100MHz	900mA	0.040Ω	30	250MHz	7GHz
LQW15AN4N0C1Z	_	4.0nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	6.5GHz
LQW15AN4N0D1Z	_	4.0nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	6.5GHz
LQW15AN4N2C1Z	_	4.2nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	6.5GHz
LQW15AN4N2D1Z□	_	4.2nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	6.5GHz
LQW15AN4N7D1Z□	_	4.7nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N1C1Z	_	5.1nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N1D1Z	_	5.1nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N2C1Z	_	5.2nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N2D1Z□	_	5.2nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N3C1Z	_	5.3nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N3D1Z□	_	5.3nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N4C1Z	_	5.4nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N4D1Z□	_	5.4nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz

Operating Temperature Range (Self-temperature rise is not included): -55 $^{\circ}$ C $^{\sim}$ +125 $^{\circ}$ C For reflow soldering only.

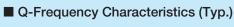


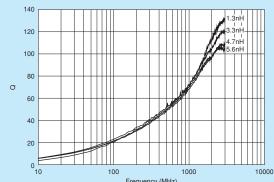




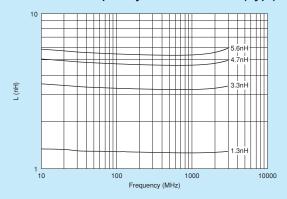
Part Number		Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW15AN5N5C1Z□	_	5.5nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N5D1Z	_	5.5nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N6C1Z	_	5.6nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N6D1Z	_	5.6nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N7C1Z	_	5.7nH ±0.2nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N7D1Z	_	5.7nH ±0.5nH	100MHz	800mA	0.051 Ω	30	250MHz	8GHz
LQW15AN5N9C1Z□	_	5.9nH ±0.2nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN5N9D1Z□	_	5.9nH ±0.5nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN6N0C1Z	_	6.0nH ±0.2nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN6N0D1Z	_	6.0nH ±0.5nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN6N1C1Z	_	6.1nH ±0.2nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN6N1D1Z	_	6.1nH ±0.5nH	100MHz	760mA	0.056Ω	30	250MHz	7.7GHz
LQW15AN7N4C1Z□	_	$7.4$ nH $\pm 0.2$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N4D1Z□	_	7.4nH ±0.5nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N6C1Z□	_	$7.6$ nH $\pm 0.2$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N6D1Z□	_	$7.6$ nH $\pm 0.5$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N7C1Z□	_	$7.7$ nH $\pm 0.2$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N7D1Z□	_	$7.7$ nH $\pm 0.5$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N8C1Z□	_	$7.8$ nH $\pm 0.2$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N8D1Z□	_	$7.8$ nH $\pm 0.5$ nH	100MHz	750mA	0.058Ω	30	250MHz	6.8GHz
LQW15AN7N9C1Z□	_	$7.9$ nH $\pm 0.2$ nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN7N9D1Z□	_	7.9nH ±0.5nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N0C1Z□	_	8.0nH ±0.2nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N0D1Z□	_	8.0nH ±0.5nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N1C1Z	_	8.1nH ±0.2nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N1D1Z	_	8.1nH ±0.5nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N3C1Z	_	8.3nH ±0.2nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N3D1Z□	_	8.3nH ±0.5nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N4C1Z	_	8.4nH ±0.2nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz
LQW15AN8N4D1Z	_	8.4nH ±0.5nH	100MHz	640mA	0.079Ω	30	250MHz	7.5GHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$ +125°C For reflow soldering only.

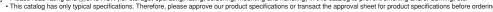




## ■ Inductance-Frequency Characteristics (Typ.)



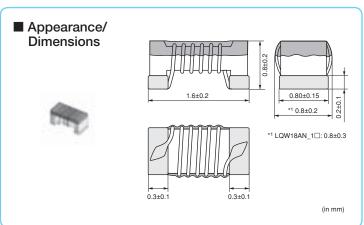
⚠Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.





# 8AN\_0Z<sub>Series</sub> 0603/1608 (inch/mm)

# Size Code 0603 (1608) in inch (in mm), Wound Type



■ Packaging

Code	Packaging	Minimum Quantity				
D	D ø180mm Paper Taping					
J	ø330mm Paper Taping	10000				
В	B Packing in Bulk					









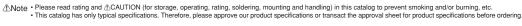


Refer to pages from p.230 to p.232 for mounting information.

■ Rated Value (□: packaging code)								
Part N	Part Number		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW18AN2N2D0Z□	_	2.2nH ±0.5nH	100MHz	700mA	0.042Ω	16	250MHz	6000MHz
LQW18AN3N6C0Z	_	3.6nH ±0.2nH	100MHz	850mA	0.059Ω	25	250MHz	6000MHz
LQW18AN3N6D0Z□	_	3.6nH ±0.5nH	100MHz	850mA	0.059Ω	25	250MHz	6000MHz
LQW18AN3N9C0Z□	_	3.9nH ±0.2nH	100MHz	850mA	0.059Ω	35	250MHz	6000MHz
LQW18AN3N9D0Z□	_	3.9nH ±0.5nH	100MHz	850mA	0.059Ω	35	250MHz	6000MHz
LQW18AN4N3C0Z□	_	4.3nH ±0.2nH	100MHz	850mA	0.059Ω	35	250MHz	6000MHz
LQW18AN4N3D0Z□	_	4.3nH ±0.5nH	100MHz	850mA	0.059Ω	35	250MHz	6000MHz
LQW18AN4N7D0Z□	_	4.7nH ±0.5nH	100MHz	850mA	0.059Ω	35	250MHz	6000MHz
LQW18AN5N6C0Z□	_	5.6nH ±0.2nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN5N6D0Z□	_	5.6nH ±0.5nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN6N2C0Z□	_	6.2nH ±0.2nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN6N2D0Z□	_	6.2nH ±0.5nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN6N8C0Z□	_	6.8nH ±0.2nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN6N8D0Z□	_	6.8nH ±0.5nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN7N5C0Z□	_	7.5nH ±0.2nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN7N5D0Z□	_	7.5nH ±0.5nH	100MHz	750mA	0.082Ω	35	250MHz	6000MHz
LQW18AN8N2C0Z□	_	8.2nH ±0.2nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN8N2D0Z□	_	8.2nH ±0.5nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN8N7C0Z□	_	8.7nH ±0.2nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN8N7D0Z□	_	8.7nH ±0.5nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN9N1C0Z	_	9.1nH ±0.2nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN9N1D0Z□	_	9.1nH ±0.5nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN9N5D0Z□	_	9.5nH ±0.5nH	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN10NG0Z□	_	10nH ±2%	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN10NJ0Z	_	10nH ±5%	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN11NG0Z□	_	11nH ±2%	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN11NJ0Z	_	11nH ±5%	100MHz	650mA	0.11Ω	35	250MHz	6000MHz
LQW18AN12NG0Z□	_	12nH ±2%	100MHz	600mA	0.13Ω	35	250MHz	6000MHz
LQW18AN12NJ0Z	_	12nH ±5%	100MHz	600mA	0.13Ω	35	250MHz	6000MHz
LQW18AN13NG0Z□	_	13nH ±2%	100MHz	600mA	0.13Ω	35	250MHz	6000MHz
LQW18AN13NJ0Z	_	13nH ±5%	100MHz	600mA	0.13Ω	35	250MHz	6000MHz
LQW18AN15NG0Z	_	15nH ±2%	100MHz	600mA	0.13Ω	40	250MHz	6000MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.





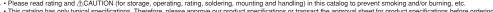


Part N	lumber		Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW18AN15NJ0Z	_	15nH ±5%	100MHz	600mA	0.13Ω	40	250MHz	6000MHz
LQW18AN16NG0Z	_	16nH ±2%	100MHz	550mA	0.16Ω	40	250MHz	5500MHz
LQW18AN16NJ0Z	_	16nH ±5%	100MHz	550mA	0.16Ω	40	250MHz	5500MHz
LQW18AN18NG0Z	_	18nH ±2%	100MHz	550mA	0.16Ω	40	250MHz	5500MHz
LQW18AN18NJ0Z	_	18nH ±5%	100MHz	550mA	0.16Ω	40	250MHz	5500MHz
LQW18AN20NG0Z	_	20nH ±2%	100MHz	550mA	0.16Ω	40	250MHz	4900MHz
LQW18AN20NJ0Z	_	20nH ±5%	100MHz	550mA	0.16Ω	40	250MHz	4900MHz
LQW18AN22NG0Z	_	22nH ±2%	100MHz	500mA	0.17Ω	40	250MHz	4600MHz
LQW18AN22NJ0Z□	_	22nH ±5%	100MHz	500mA	0.17Ω	40	250MHz	4600MHz
LQW18AN24NG0Z	_	24nH ±2%	100MHz	500mA	0.21Ω	40	250MHz	3800MHz
LQW18AN24NJ0Z	_	24nH ±5%	100MHz	500mA	0.21Ω	40	250MHz	3800MHz
LQW18AN27NG0Z	_	27nH ±2%	100MHz	440mA	0.21 Ω	40	250MHz	3700MHz
LQW18AN27NJ0Z	_	27nH ±5%	100MHz	440mA	0.21 Ω	40	250MHz	3700MHz
LQW18AN30NG0Z	_	30nH ±2%	100MHz	420mA	0.23Ω	40	250MHz	3300MHz
LQW18AN30NJ0Z□	_	30nH ±5%	100MHz	420mA	0.23Ω	40	250MHz	3300MHz
LQW18AN33NG0Z	_	33nH ±2%	100MHz	420mA	0.23Ω	40	250MHz	3200MHz
LQW18AN33NJ0Z□	_	33nH ±5%	100MHz	420mA	0.23Ω	40	250MHz	3200MHz
LQW18AN36NG0Z	_	36nH ±2%	100MHz	400mA	0.26Ω	40	250MHz	2900MHz
LQW18AN36NJ0Z□	_	36nH ±5%	100MHz	400mA	0.26Ω	40	250MHz	2900MHz
LQW18AN39NG0Z	_	39nH ±2%	100MHz	400mA	0.26Ω	40	250MHz	2800MHz
LQW18AN39NJ0Z□	_	39nH ±5%	100MHz	400mA	0.26Ω	40	250MHz	2800MHz
LQW18AN43NG0Z□	_	43nH ±2%	100MHz	380mA	0.29Ω	40	200MHz	2700MHz
LQW18AN43NJ0Z□	_	43nH ±5%	100MHz	380mA	0.29Ω	40	200MHz	2700MHz
LQW18AN47NG0Z□	_	47nH ±2%	100MHz	380mA	0.29Ω	38	200MHz	2600MHz
LQW18AN47NJ0Z□	_	47nH ±5%	100MHz	380mA	0.29Ω	38	200MHz	2600MHz
LQW18AN51NG0Z	_	51nH ±2%	100MHz	370mA	0.33Ω	38	200MHz	2500MHz
LQW18AN51NJ0Z□	_	51nH ±5%	100MHz	370mA	0.33Ω	38	200MHz	2500MHz
LQW18AN56NG0Z□	_	56nH ±2%	100MHz	360mA	0.35Ω	38	200MHz	2400MHz
LQW18AN56NJ0Z□	_	56nH ±5%	100MHz	360mA	0.35Ω	38	200MHz	2400MHz
LQW18AN62NG0Z□	_	62nH ±2%	100MHz	280mA	0.51Ω	38	200MHz	2300MHz
LQW18AN62NJ0Z□	_	62nH ±5%	100MHz	280mA	0.51Ω	38	200MHz	2300MHz
LQW18AN68NG0Z□	_	68nH ±2%	100MHz	340mA	0.38Ω	38	200MHz	2200MHz
LQW18AN68NJ0Z	_	68nH ±5%	100MHz	340mA	0.38Ω	38	200MHz	2200MHz
LQW18AN72NG0Z□	_	72nH ±2%	100MHz	270mA	0.56Ω	34	150MHz	2100MHz
LQW18AN72NJ0Z	_	72nH ±5%	100MHz	270mA	0.56Ω	34	150MHz	2100MHz
LQW18AN75NG0Z	_	75nH ±2%	100MHz	270mA	0.56Ω	34	150MHz	2050MHz
LQW18AN75NJ0Z	_	75nH ±5%	100MHz	270mA	0.56Ω	34	150MHz	2050MHz
LQW18AN82NG0Z	_	82nH ±2%	100MHz	250mA	0.60Ω	34	150MHz	2000MHz
LQW18AN82NJ0Z□	_	82nH ±5%	100MHz	250mA	0.60Ω	34	150MHz	2000MHz
LQW18AN91NG0Z	_	91nH ±2%	100MHz	230mA	0.64Ω	34	150MHz	1900MHz
LQW18AN91NJ0Z□	_	91nH ±5%	100MHz	230mA	0.64Ω	34	150MHz	1900MHz
LQW18ANR10G0Z	_	100nH ±2%	100MHz	220mA	0.68Ω	34	150MHz	1800MHz
LQW18ANR10J0Z□	_	100nH ±5%	100MHz	220mA	0.68Ω	34	150MHz	1800MHz
LQW18ANR11G0Z	_	110nH ±2%	100MHz	200mA	1.2Ω	32	150MHz	1700MHz
LQW18ANR11J0Z□	_	110nH ±5%	100MHz	200mA	1.2Ω	32	150MHz	1700MHz
LQW18ANR12G0Z	_	120nH ±2%	100MHz	180mA	1.3Ω	32	150MHz	1600MHz
LQW18ANR12J0Z□	_	120nH ±5%	100MHz	180mA	1.3Ω	32	150MHz	1600MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C  $\sim$  +125°C For reflow soldering only.



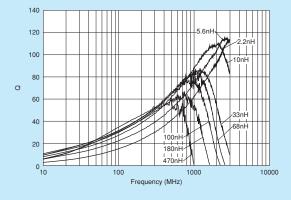




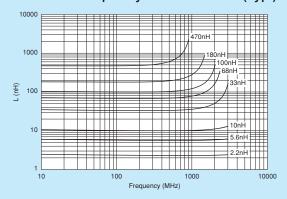
Part Number		Industria	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance
For Infotainment	For Powertrain/Safety	Inductance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)
LQW18ANR13G0Z	_	130nH ±2%	100MHz	170mA	1.4Ω	32	150MHz	1450MHz
LQW18ANR13J0Z□	_	130nH ±5%	100MHz	170mA	1.4Ω	32	150MHz	1450MHz
LQW18ANR15G0Z□	_	150nH ±2%	100MHz	160mA	1.5Ω	32	150MHz	1400MHz
LQW18ANR15J0Z	_	150nH ±5%	100MHz	160mA	1.5Ω	32	150MHz	1400MHz
LQW18ANR16G0Z□	_	160nH ±2%	100MHz	150mA	2.1 Ω	32	150MHz	1350MHz
LQW18ANR16J0Z□	_	160nH ±5%	100MHz	150mA	2.1 Ω	32	150MHz	1350MHz
LQW18ANR18G0Z□	_	180nH ±2%	100MHz	140mA	2.2Ω	25	100MHz	1300MHz
LQW18ANR18J0Z□	_	180nH ±5%	100MHz	140mA	2.2Ω	25	100MHz	1300MHz
LQW18ANR20G0Z□	_	200nH ±2%	100MHz	120mA	2.4Ω	25	100MHz	1250MHz
LQW18ANR20J0Z□	_	200nH ±5%	100MHz	120mA	2.4Ω	25	100MHz	1250MHz
LQW18ANR22G0Z□	_	220nH ±2%	100MHz	120mA	2.5Ω	25	100MHz	1200MHz
LQW18ANR22J0Z□	_	220nH ±5%	100MHz	120mA	2.5Ω	25	100MHz	1200MHz
LQW18ANR27G0Z□	_	270nH ±2%	100MHz	110mA	3.4Ω	30	100MHz	960MHz
LQW18ANR27J0Z□	_	270nH ±5%	100MHz	110mA	3.4Ω	30	100MHz	960MHz
LQW18ANR33G0Z□	_	330nH ±2%	100MHz	85mA	5.5Ω	30	100MHz	800MHz
LQW18ANR33J0Z□	_	330nH ±5%	100MHz	85mA	5.5Ω	30	100MHz	800MHz
LQW18ANR39G0Z□	_	390nH ±2%	100MHz	80mA	6.2Ω	30	100MHz	800MHz
LQW18ANR39J0Z□	_	390nH ±5%	100MHz	80mA	6.2Ω	30	100MHz	800MHz
LQW18ANR47G0Z□		470nH ±2%	100MHz	75mA	7.0Ω	30	100MHz	700MHz
LQW18ANR47J0Z□	_	470nH ±5%	100MHz	75mA	7.0Ω	30	100MHz	700MHz

Operating Temperature Range (Self-temperature rise is not included): -55°C~+125°C For reflow soldering only.

## ■ Q-Frequency Characteristics (Typ.)



## ■ Inductance-Frequency Characteristics (Typ.)

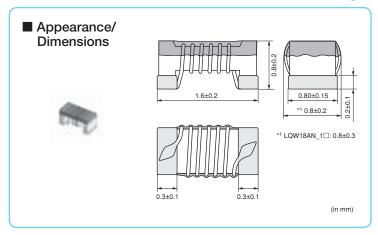




<sup>⚠</sup>Note • Please read rating and ⚠CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

# 

# Size Code 0603 (1608) in inch (in mm), High Q, Low DC Resistance Type



■ Pa	ckaging
Onde	D

Code	Packaging	Minimum Quantity
D	ø180mm Paper Taping	4000
J	ø330mm Paper Taping	10000
В	Packing in Bulk	500





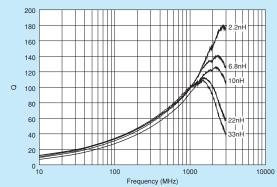
Refer to pages from p.230 to p.232 for mounting information.

## Rated Value (□: nackaging code)

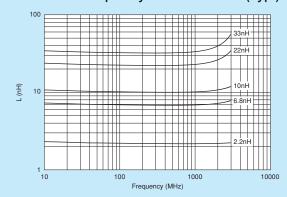
■ Rated Value (□: packaging code)  Part Number									
		Inductance	Inductance	Rated	Max. of DC	Q	Q Test	Self-Resonance	
For Infotainment	For Powertrain/Safety	muuctance	Test Frequency	Current	Resistance	(min.)	Frequency	Frequency (min.)	
LQW18AN2N2D1Z□	_	2.2nH ±0.5nH	100MHz	1400mA	0.018Ω	25	250MHz	18000MHz	
LQW18AN3N9C1Z	_	3.9nH ±0.2nH	100MHz	1000mA	0.032Ω	38	250MHz	11000MHz	
LQW18AN3N9D1Z□	_	3.9nH ±0.5nH	100MHz	1000mA	0.032Ω	38	250MHz	11000MHz	
LQW18AN5N6D1Z	_	5.6nH ±0.5nH	100MHz	900mA	0.045Ω	38	250MHz	10000MHz	
LQW18AN6N8C1Z	_	6.8nH ±0.2nH	100MHz	100MHz 900mA 0.045Ω 38 250MHz		7000MHz			
LQW18AN6N8D1Z	_	6.8nH ±0.5nH	100MHz	900mA	0.045Ω	38	250MHz	7000MHz	
LQW18AN8N2D1Z	_	8.2nH ±0.5nH	100MHz	800mA	0.058Ω	38	250MHz	7000MHz	
LQW18AN10NG1Z	_	10nH ±2%	100MHz	800mA	0.058Ω	38	250MHz	5000MHz	
LQW18AN10NJ1Z	_	10nH ±5%	100MHz	800mA	0.058Ω	38	250MHz	5000MHz	
LQW18AN12NG1Z	_	12nH ±2%	100MHz	750mA	0.071 Ω	38	250MHz	5000MHz	
LQW18AN12NJ1Z	_	12nH ±5%	100MHz	750mA	0.071 Ω	38	250MHz	5000MHz	
LQW18AN15NJ1Z	_	15nH ±5%	100MHz	700mA	0.085Ω	42	250MHz	4500MHz	
LQW18AN18NG1Z	_	18nH ±2%	100MHz	700mA	0.085Ω	42	250MHz	3500MHz	
LQW18AN18NJ1Z	_	18nH ±5%	100MHz	700mA	0.085Ω	42	250MHz	3500MHz	
LQW18AN22NG1Z	_	22nH ±2%	100MHz	640mA	0.099Ω	42	250MHz	3200MHz	
LQW18AN22NJ1Z□	_	22nH ±5%	100MHz	640mA	0.099Ω	42	250MHz	3200MHz	
LQW18AN27NG1Z	_	27nH ±2%	100MHz	590mA	0.116Ω	42	250MHz	2800MHz	
LQW18AN27NJ1Z	_	27nH ±5%	100MHz	590mA	0.116Ω	42	250MHz	2800MHz	
LQW18AN33NJ1Z	_	33nH ±5%	100MHz	550mA	0.132Ω	42	250MHz	2500MHz	

Operating Temperature Range (Self-temperature rise is not included): -55°C~+125°C





## ■ Inductance-Frequency Characteristics (Typ.)



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• This catalog has only typical specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



## RF Inductors / Caution/Notice

## **⚠**Caution

#### Rating

1. About the Rated Current

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

2. About Excessive Surge Current Surge current (pulse current or rush current) greater than the specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise. Please contact us in advance in case of applying the

### **Notice**

## Storage and Operating Condition

<Operating Environment>

Do not use products in chemical atmosphere such as chlorine gas, acid or sulfide gas.

- <Storage Requirements>
- 1. Storage Period

LQG series should be used within 6 months; the other products should be used within 12 months. Check solderability if this period is exceeded.

- 2. Storage Conditions
  - (1) Store products in a warehouse in compliance with the following conditions:

Temperature: -10 to +40 degrees C. Humidity: 15 to 85% (relative humidity) Do not subject products to rapid changes in temperature and humidity.

Do not store them in chemical atmosphere such as one containing sulfurous acid gas or alkaline

This will prevent electrode oxidation, which causes poor solderability and possible corrosion of inductors.

- (2) Do not store products in bulk packaging to prevent collision among inductors, which causes core chipping and wire breakage.
- (3) Store products on pallets to protect from humidity, dust. etc.
- (4) Avoid heat shock, vibration, direct sunlight, etc.

### Handling

This item is designed to have sufficient strength, but handle with care to avoid chipping or breaking its ceramic structure.

## LQW A series

- To prevent breaking the wire, avoid touching with sharp material, such as tweezers or the bristles of a cleaning brush, to the wire wound portion.
- To prevent breaking the core, avoid applying excessive mechanical shock to products mounted on the board.

- In some mounting machines, when picking up components, a support pin pushes the components up from the bottom of the base tape. In this case, please remove the support pin. The support pin may damage the components and break the wire.
- In rare cases, the laser recognition cannot recognize this component. Please contact us when you use laser recognizion. (There is no problem with the permeation and reflection type.)

#### LQP series

surge current.

• The pattern of the chip Inductors is covered with protective film. Take care to avoid damaging the chip Inductors when handling it with pick-up nozzles, sharp instruments, etc.

#### <Handling>

- 1. Avoid applying excessive stress to products to prevent damage.
- 2. Do not touch wire wound with sharp objects such as tweezers to prevent wire breakage.
- 3. Do not apply excessive force to products mounted on boards to prevent core breakage.

## <Transportation>

Do not apply excessive vibration or mechanical shock to products.

#### <Resin Coating>

When coating products with resin, the relatively high resin curing stress may change inductance values. For exterior coating, select resin carefully so that electrical and mechanical performance of the product is not affected. Prior to use, please evaluate reliability with the product mounted in your application set.

#### (LQW series)

An open circuit issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating conditions, etc. Some resins containing impurities or chloride may possibly generate chlorine by hydrolysis under some operating conditions, causing corrosion of the inductor wire and leading to an open circuit.

#### (LQP03 series)

When products are coated with resin, please contact us in advance.





### <Handling of a Substrate>

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting the substrate when cropping the substrate, inserting and removing a connector from the substrate, or tightening a screw to the substrate.

Excessive mechanical stress may cause cracking in the Product.





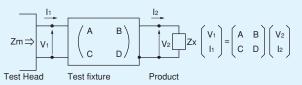




## Measuring Method

Measuring Method of Inductance/Q

1. Residual elements and stray elements of test fixtures can be described by F-parameter as shown in the following:



2. The impedance of chip Inductors (chip coils) Zx and measured value Zm can be described by input/output current/voltage.

$$Zm = \frac{V_1}{I_1} \quad , \quad Zx = \frac{V_2}{I_2}$$

3. Thus, the relation between Zx and Zm is shown in the following:

$$Zx = \alpha \, \frac{Zm - \beta}{1 - Zm\Gamma} \qquad \begin{array}{c} \text{where, } \alpha = D \ / \ A = 1 \\ \beta = B \ / \ D = Zsm - (1 - Yom \ Zsm) \ Zss \\ \Gamma = C \ / \ A = Yom \end{array}$$

Zsm: measured impedance of short chip

Zss: residual impedance of short chip\*

Yom: measured admittance when opening the fixture

\*Residual impedance of short chip

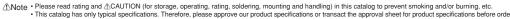
	er er er er er er p
Residual Impedance	Series
0nH	LQG15H, LQG18HH
0.480nH	LQP03TN
0.556nH	LQW15A
0.771nH	LQW18A

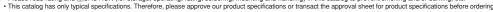
4. Lx and Qx should be calculated with the following equation.

$$Lx = \frac{Im (Zx)}{2\pi f}$$
,  $Qx = \frac{Im (Zx)}{Re (Zx)}$ 

Lx: Inductance of chip Inductors (chip coils) Qx: Q of chip Inductors (chip coils)

f: Measuring frequency







## **RF Inductors**

## **Soldering and Mounting**

#### 1. Standard Land Pattern Dimensions

A high Q value is achieved when the PCB electrode land pattern is designed so that it does not project beyond the chip Inductors (chip coils) electrode.

> Land Pattern + Solder Resist Land Pattern ☐ Solder Resist

Series	Standard Land Dimensions					
LQG15H LQG18H		Part Number	a	b	С	
LQP03	†	LQG15H	0.4	1.4-1.5	0.5-0.6	
LQW15A		LQG18H	0.6-0.8	1.8-2.2	0.6-0.8	
LQW18A		LQP03	0.2-0.3	0.8-0.9	0.2-0.3	
	a   b	LQW15A	0.5	1.2	0.65	
		LQW18A	0.6-0.8	1.9-2.0	0.7-1.0	

Attention should be paid to potential magnetic coupling effects when using the Inductors (coils) as a resonator.

#### 2. Standard Soldering Conditions

#### (1) Soldering method

Chip Inductors (Chip coils) can be flow or reflow soldered. Please contact Murata regarding other soldering methods.

As for LQG, LQP, LQW series, please use reflow soldering.

Solder: Use Sn-3.0Ag-0.5Cu solder.

Flux: Use rosin-based flux, but not strongly acidic flux (with chlorine content exceeding 0.2wt%).

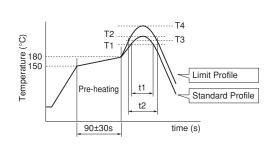
Do not use water-soluble flux.

The flux used for LQW series should use the rosin-based flux that includes middle activator equivalent to 0.06wt% to 0.1wt% chlorine.

For additional mounting methods, please contact Murata.

#### (2) Soldering profile

 Reflow Soldering profile (Sn-3.0Ag-0.5Cu solder)



		Standard Profile				Limit Profile				
Series	Heating		ting Peak temperature		Heating		Peak temperature	Cycle		
	Temp. (T1)	Time. (t1)	(T2)	of reflow	Temp. (T3)		(T4)	of reflow		
LQG15H/18H LQP03 LQW15A/18A	220°C	30 to 60s	245±3°C	2 times max.	230°C	60s max.	260°C/10s	2 times max.		

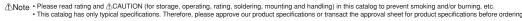
## (3) Reworking with Soldering Iron

Preheating at 150°C for 1 minute is required. Do not directly touch the ceramic element with the tip of the soldering iron. The reworking soldering conditions are as follows:

Soldering iron power output: 80W max. Temperature of soldering iron tip: 350°C Diameter of soldering iron end: 3.0mm max.

Soldering time: within 3 s







## 3. Mounting Instructions

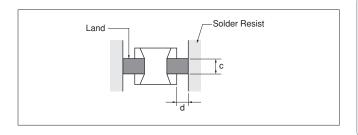
#### (1) Land Pattern Dimensions

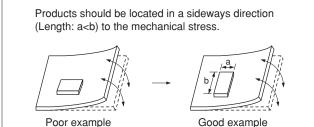
Large lands reduce Q of the mounted chip. Also, large protruding land areas (bordered by lines having dimensions 'c' and 'd' shown) cause floating and electrode leaching.

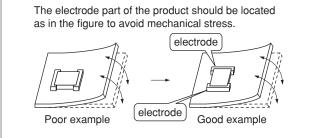
(2) Land Pattern Designing (LQW series) Please follow the recommended patterns. Otherwise, their performance, which includes electrical performance or solderability, may be affected, or result in "position shift" in the soldering process.

### (3) PCB Warping

PCB should be designed so that products are not subjected to the mechanical stress caused by warping the board.







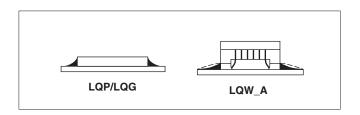
#### (4) Amount of Solder Paste

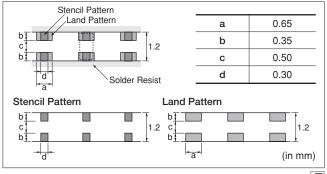
Excessive solder causes electrode corrosion, while insufficient solder causes low electrode bonding strength. Adjust the amount of solder paste as shown on the right so that solder is applied.

- Guideline of solder paste thickness
  - · LQG, LQW15A/LQW18A: 100 to 150µm
  - · LQP03TN: 100µm

### LQW15A Series:

Too much solder may cause slant or rotation of the chip at the time of solder melting. Please reduce the amount of solder by using a smaller solder area than the land pattern, as shown in the figure at right.









### 4. Cleaning

The following conditions should be observed when cleaning chip inductors (chip coils):

- (1) Cleaning Temperature: 60°C max. (40°C max. for alcohol cleaning agents)
- (2) Ultrasonic

Output: 20W/I max.

Duration: 5 minutes max. Frequency: 28 to 40kHz

Care should be taken not to cause resonance of the PCB and mounted products.

(3) Cleaning agent

The following cleaning agents have been tested on individual components. Evaluation in complete assembly should be done prior to production.

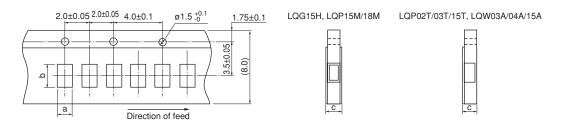
- (a) Alcohol cleaning agents Isopropyl alcohol (IPA)
- (b) Aqueous cleaning agents Pine Alpha ST-100S

(4) Ensure that flux residue is completely removed. Component should be thoroughly dried after aqueous agents have been removed with deionized water.

For additional cleaning methods, please contact Murata.



## ■ Minimum Quantity and 8mm Width Taping Dimensions



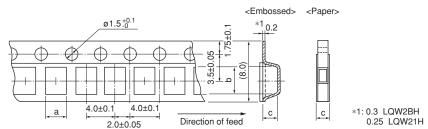
#### Paper Tape

Part Number	Dimensions		Total Thickness of Tape	Packaging Code (Minimum Qty. [pcs.])			
Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk	
LQG15H	0.62	1.12	0.8 max.	<b>D</b> [10000]	<b>J</b> [50000]	<b>B</b> [1000]	
LQP03T *1	0.35	0.65/0.67	0.55 max.	<b>D</b> [15000]	<b>J</b> [50000]	<b>B</b> [500]	
LQW15A_0Z *2	0.64/0.66/0.69	1.18	0.8 max.	<b>D</b> [10000]	-	<b>B</b> [500]	
LQW15A_1Z *3	0.66/0.69	1.18	0.8 max.	<b>D</b> [10000]	-	<b>B</b> [500]	

- \*1 0.67 (LQP03TN Z2; 0.6-62nH) 0.65 (LQP03TN\_Z2; 68-120nH)
- \*2 0.69 (1.5nH, 2.4-2.8nH, 3.9-4.8nH, 5.8-6.8nH, 8.2-9.9nH, 11nH, 12nH, 15nH) 0.66 (1.6-1.8nH, 2.9nH, 3.0nH, 3.1nH, 3.2nH, 4.9-5.1nH, 6.9-7.5nH, 10nH, 13nH, 16-23nH, 100nH, 120nH) 0.64 (24-91nH)
- \*3 0.69 (1.3nH, 1.4nH) 0.66 (2.2-8.4nH)

(in mm)

## ■ Minimum Quantity and 8mm Width Taping Dimensions



Dimension of the cavity of embossed tape is measured at the bottom side.

## Paper Tape

	<u> </u>						
Part Number		Dimensions		Total Thickness of Tape	Packaging Code (Minimum Qty. [pcs.]		
	Part Number	а	b	С	ø180mm reel	ø330mm reel	Bulk
	LQG18H	1.05	1.85	1.1 max.	<b>D</b> [4000]	<b>J</b> [10000]	<b>B</b> [1000]
	LQW18A_0Z	1.0	1.8	1.1 max.	<b>D</b> [4000]	<b>J</b> [10000]	<b>B</b> [500]
	LQW18A_1Z	1.1	1.9	1.1 max.	<b>D</b> [4000]	<b>J</b> [10000]	<b>B</b> [500]

(in mm)





# **EMI Suppression Filters (for DC)**

## **Chip Ferrite Bead** BLM03AG ..... p.17 BLM03AX ..... p.15 BLM03B ..... p.19 BLM03E .....p.64 BLM03H ..... p.62 BLM03PG ..... p.12 BLM03PX ..... p.13 BLM15AG .... p.27 BLM15AX .... p.25 BLM15B p.31 BLM15BX p.29 BLM15EG p.67 BLM15G p.68 BLM15H p.65 BLM15PD p.23 BLM15PG ..... p.23 BLM15PX ..... p.21 BLM18AG\_S ····· p.41 BLM18AG\_W ..... p.43 BLM18B .... p.44 BLM18EG ..... p.72 BLM18GG .... p.75 BLM18H .... p.69 BLM18KG ..... p.37 BLM18PG .... p.35 BLM18SG .... p.39 BLM21AG ..... p.51 BLM21B .....p.53

Chip EMIFIL®
NFE31ZT p.85 NFE61HT p.86 NFL18ZT p.89 NFM21HC p.87 NFM31HK p.88 NFZ32BW_10 p.90 NFZ32BW_11 p.92
Chip Common Mode Choke Coil

Chip Comm	on Mode Choke Coil
DLW21S · · · DLW31S · · · DLW43S · · · DLW5AT · · · DLW5BS · · · DLW5BT · · · PLT10H · · · ·	p.107 p.108 p.110 p.111 p.105 p.104 p.105 p.105 p.105 p.105

Block Type EMIFIL®	
BNX02□ · · · · · p.125	

Lead Type
BNX012 p.136 DSS1 p.133 VFC2 p.135

Microchip Transformer (Balun)
DXW21B · · · · · p.145

## **Chip Inductors**

BLM21PG ..... p.49 BLM31PG · · · · · p.57 BLM41PG · · · · · p.59

Inductors for Power Lines
LQH2HPZ_JR·····p.183
LQH32CH_23 · · · · · p.187
LQH32CH_33 · · · · · p.187
LQH32CH_53 · · · · · p.188
LQH32DZ_23 · · · · · p.185
LQH32DZ_53 · · · · · p.186
LQH32PZ_N0 · · · · · p.173
LQH32PZ_NC·····p.175
LQH3NPZ_JR·····p.171
LQH43PZ_26 · · · · · p.177
LQH44PZ_GR · · · · · p.179
LQH5BPZ_T0 · · · · · p.181
LQM21P_GC · · · · · · p.160
LQM21PZ_C0 · · · · · p.158
LQM21PZ_G0 · · · · · p.159
LQM21PZ_GR · · · · · · p.161
LQM2HPZ_E0 ····· p.170
LQM2HPZ_G0 · · · · · p.166
LQM2HPZ_GC · · · · · p.169
LQM2HPZ_GS · · · · · p.168
LQM2HPZ_J0 ····· p.164
LQM2HPZ_JC · · · · · p.165
LQM2MPZ_G0 · · · · · p.162

Inductors	for Gen	eral Circu	uits
LQH31HZ LQH43NZ	Z_03 · · · · · · · · Z_03 · · · · · · · · · · · · · · · · · · ·	····· p.198	3 9

RF Inductors
LQG15H_02

## **Introduction of Chip Inductors Web Site**

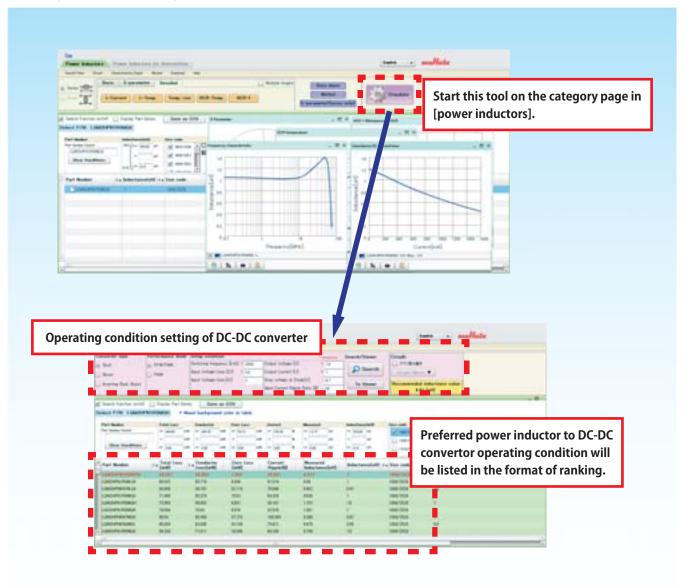
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